



# Section I. Cyclone II Device Family Data Sheet

This section provides information for board layout designers to successfully layout their boards for Cyclone® II devices. It contains the required PCB layout guidelines, device pin tables, and package specifications.

This section includes the following chapters:

- [Chapter 1. Introduction](#)
- [Chapter 2. Cyclone II Architecture](#)
- [Chapter 3. Configuration & Testing](#)
- [Chapter 4. Hot Socketing & Power-On Reset](#)
- [Chapter 5. DC Characteristics and Timing Specifications](#)
- [Chapter 6. Reference & Ordering Information](#)

## Revision History

Refer to each chapter for its own specific revision history. For information on when each chapter was updated, refer to the Chapter Revision Dates section, which appears in the complete handbook.



## Introduction

Following the immensely successful first-generation Cyclone® device family, Altera® Cyclone II FPGAs extend the low-cost FPGA density range to 68,416 logic elements (LEs) and provide up to 622 usable I/O pins and up to 1.1 Mbits of embedded memory. Cyclone II FPGAs are manufactured on 300-mm wafers using TSMC's 90-nm low-k dielectric process to ensure rapid availability and low cost. By minimizing silicon area, Cyclone II devices can support complex digital systems on a single chip at a cost that rivals that of ASICs. Unlike other FPGA vendors who compromise power consumption and performance for low-cost, Altera's latest generation of low-cost FPGAs—Cyclone II FPGAs, offer 60% higher performance and half the power consumption of competing 90-nm FPGAs. The low cost and optimized feature set of Cyclone II FPGAs make them ideal solutions for a wide array of automotive, consumer, communications, video processing, test and measurement, and other end-market solutions. Reference designs, system diagrams, and IP, found at [www.altera.com](http://www.altera.com), are available to help you rapidly develop complete end-market solutions using Cyclone II FPGAs.

### Low-Cost Embedded Processing Solutions

Cyclone II devices support the Nios II embedded processor which allows you to implement custom-fit embedded processing solutions. Cyclone II devices can also expand the peripheral set, memory, I/O, or performance of embedded processors. Single or multiple Nios II embedded processors can be designed into a Cyclone II device to provide additional co-processing power or even replace existing embedded processors in your system. Using Cyclone II and Nios II together allow for low-cost, high-performance embedded processing solutions, which allow you to extend your product's life cycle and improve time to market over standard product solutions.

### Low-Cost DSP Solutions

Use Cyclone II FPGAs alone or as DSP co-processors to improve price-to-performance ratios for digital signal processing (DSP) applications. You can implement high-performance yet low-cost DSP systems with the following Cyclone II features and design support:

- Up to 150  $18 \times 18$  multipliers
- Up to 1.1 Mbit of on-chip embedded memory
- High-speed interfaces to external memory

- DSP intellectual property (IP) cores
- DSP Builder interface to The Mathworks Simulink and Matlab design environment
- DSP Development Kit, Cyclone II Edition

Cyclone II devices include a powerful FPGA feature set optimized for low-cost applications including a wide range of density, memory, embedded multiplier, and packaging options. Cyclone II devices support a wide range of common external memory interfaces and I/O protocols required in low-cost applications. Parameterizable IP cores from Altera and partners make using Cyclone II interfaces and protocols fast and easy.

## Features

The Cyclone II device family offers the following features:

- High-density architecture with 4,608 to 68,416 LEs
  - M4K embedded memory blocks
  - Up to 1.1 Mbits of RAM available without reducing available logic
  - 4,096 memory bits per block (4,608 bits per block including 512 parity bits)
  - Variable port configurations of  $\times 1$ ,  $\times 2$ ,  $\times 4$ ,  $\times 8$ ,  $\times 9$ ,  $\times 16$ ,  $\times 18$ ,  $\times 32$ , and  $\times 36$
  - True dual-port (one read and one write, two reads, or two writes) operation for  $\times 1$ ,  $\times 2$ ,  $\times 4$ ,  $\times 8$ ,  $\times 9$ ,  $\times 16$ , and  $\times 18$  modes
  - Byte enables for data input masking during writes
  - Up to 260-MHz operation
- Embedded multipliers
  - Up to 150 18-  $\times$  18-bit multipliers are each configurable as two independent 9-  $\times$  9-bit multipliers with up to 250-MHz performance
  - Optional input and output registers
- Advanced I/O support
  - High-speed differential I/O standard support, including LVDS, RSDS, mini-LVDS, LVPECL, differential HSTL, and differential SSTL
  - Single-ended I/O standard support, including 2.5-V and 1.8-V, SSTL class I and II, 1.8-V and 1.5-V HSTL class I and II, 3.3-V PCI and PCI-X 1.0, 3.3-, 2.5-, 1.8-, and 1.5-V LVC MOS, and 3.3-, 2.5-, and 1.8-V LVTTTL
  - Peripheral Component Interconnect Special Interest Group (PCI SIG) *PCI Local Bus Specification, Revision 3.0* compliance for 3.3-V operation at 33 or 66 MHz for 32- or 64-bit interfaces
  - PCI Express with an external TI PHY and an Altera PCI Express  $\times 1$  Megacore<sup>®</sup> function

- 133-MHz PCI-X 1.0 specification compatibility
  - High-speed external memory support, including DDR, DDR2, and SDR SDRAM, and QDR II SRAM supported by drop in Altera IP MegaCore functions for ease of use
  - Three dedicated registers per I/O element (IOE): one input register, one output register, and one output-enable register
  - Programmable bus-hold feature
  - Programmable output drive strength feature
  - Programmable delays from the pin to the IOE or logic array
  - I/O bank grouping for unique VCCIO and/or VREF bank settings
  - MultiVolt™ I/O standard support for 1.5-, 1.8-, 2.5-, and 3.3-interfaces
  - Hot-socketing operation support
  - Tri-state with weak pull-up on I/O pins before and during configuration
  - Programmable open-drain outputs
  - Series on-chip termination support
- Flexible clock management circuitry
- Hierarchical clock network for up to 402.5-MHz performance
  - Up to four PLLs per device provide clock multiplication and division, phase shifting, programmable duty cycle, and external clock outputs, allowing system-level clock management and skew control
  - Up to 16 global clock lines in the global clock network that drive throughout the entire device
- Device configuration
- Fast serial configuration allows configuration times less than 100 ms
  - Decompression feature allows for smaller programming file storage and faster configuration times
  - Supports multiple configuration modes: active serial, passive serial, and JTAG-based configuration
  - Supports configuration through low-cost serial configuration devices
  - Device configuration supports multiple voltages (either 3.3, 2.5, or 1.8 V)
- Intellectual property
- Altera megafunction and Altera MegaCore function support, and Altera Megafunctions Partners Program (AMPP<sup>SM</sup>) megafunction support, for a wide range of embedded processors, on-chip and off-chip interfaces, peripheral functions, DSP functions, and communications functions and

protocols. Visit the Altera IP MegaStore at [www.altera.com](http://www.altera.com) to download IP MegaCore functions.

- Nios II Embedded Processor support

The Cyclone II family offers devices with the Fast-On feature, which offers a faster power-on-reset (POR) time. Devices that support the Fast-On feature are designated with an “A” in the device ordering code. For example, EP2C5A, EP2C8A, EP2C15A, and EP2C20A. The EP2C5A is only available in the automotive speed grade. The EP2C8A and EP2C20A are only available in the industrial speed grade. The EP2C15A is only available with the Fast-On feature and is available in both commercial and industrial grades. The Cyclone II “A” devices are identical in feature set and functionality to the non-A devices except for support of the faster POR time.



Cyclone II A devices are offered in automotive speed grade. For more information, refer to the Cyclone II section in the *Automotive-Grade Device Handbook*.



For more information on POR time specifications for Cyclone II A and non-A devices, refer to the *Hot Socketing & Power-On Reset* chapter in the *Cyclone II Device Handbook*.

Table 1–1 lists the Cyclone II device family features. Table 1–2 lists the Cyclone II device package offerings and maximum user I/O pins.

| <b>Table 1–1. Cyclone II FPGA Family Features (Part 1 of 2)</b> |                  |                  |                   |                   |               |               |               |
|-----------------------------------------------------------------|------------------|------------------|-------------------|-------------------|---------------|---------------|---------------|
| <b>Feature</b>                                                  | <b>EP2C5 (2)</b> | <b>EP2C8 (2)</b> | <b>EP2C15 (1)</b> | <b>EP2C20 (2)</b> | <b>EP2C35</b> | <b>EP2C50</b> | <b>EP2C70</b> |
| LEs                                                             | 4,608            | 8,256            | 14,448            | 18,752            | 33,216        | 50,528        | 68,416        |
| M4K RAM blocks (4 Kbits plus 512 parity bits)                   | 26               | 36               | 52                | 52                | 105           | 129           | 250           |
| Total RAM bits                                                  | 119,808          | 165,888          | 239,616           | 239,616           | 483,840       | 594,432       | 1,152,000     |
| Embedded multipliers (3)                                        | 13               | 18               | 26                | 26                | 35            | 86            | 150           |
| PLLs                                                            | 2                | 2                | 4                 | 4                 | 4             | 4             | 4             |

**Table 1–1. Cyclone II FPGA Family Features (Part 2 of 2)**

| Feature               | EP2C5 (2) | EP2C8 (2) | EP2C15 (1) | EP2C20 (2) | EP2C35 | EP2C50 | EP2C70 |
|-----------------------|-----------|-----------|------------|------------|--------|--------|--------|
| Maximum user I/O pins | 158       | 182       | 315        | 315        | 475    | 450    | 622    |

**Notes to Table 1–1:**

- (1) The EP2C15A is only available with the Fast On feature, which offers a faster POR time. This device is available in both commercial and industrial grade.
- (2) The EP2C5, EP2C8, and EP2C20 optionally support the Fast On feature, which is designated with an “A” in the device ordering code. The EP2C5A is only available in the automotive speed grade. The EP2C8A and EP2C20A devices are only available in industrial grade.
- (3) This is the total number of  $18 \times 18$  multipliers. For the total number of  $9 \times 9$  multipliers per device, multiply the total number of  $18 \times 18$  multipliers by 2.

**Table 1–2. Cyclone II Package Options & Maximum User I/O Pins** *Notes (1) (2)*

| Device           | 144-Pin<br>TQFP (3) | 208-Pin<br>PQFP (4) | 240-Pin<br>PQFP | 256-Pin<br>FineLine<br>BGA | 484-Pin<br>FineLine<br>BGA | 484-Pin<br>Ultra<br>FineLine<br>BGA | 672-Pin<br>FineLine<br>BGA | 896-Pin<br>FineLine<br>BGA |
|------------------|---------------------|---------------------|-----------------|----------------------------|----------------------------|-------------------------------------|----------------------------|----------------------------|
| EP2C5 (6) (8)    | 89                  | 142                 | —               | 158 (5)                    | —                          | —                                   | —                          | —                          |
| EP2C8 (6)        | 85                  | 138                 | —               | 182                        | —                          | —                                   | —                          | —                          |
| EP2C8A (6), (7)  | —                   | —                   | —               | 182                        | —                          | —                                   | —                          | —                          |
| EP2C15A (6), (7) | —                   | —                   | —               | 152                        | 315                        | —                                   | —                          | —                          |
| EP2C20 (6)       | —                   | —                   | 142             | 152                        | 315                        | —                                   | —                          | —                          |
| EP2C20A (6), (7) | —                   | —                   | —               | 152                        | 315                        | —                                   | —                          | —                          |
| EP2C35 (6)       | —                   | —                   | —               | —                          | 322                        | 322                                 | 475                        | —                          |
| EP2C50 (6)       | —                   | —                   | —               | —                          | 294                        | 294                                 | 450                        | —                          |
| EP2C70 (6)       | —                   | —                   | —               | —                          | —                          | —                                   | 422                        | 622                        |

**Notes to Table 1–2:**

- (1) Cyclone II devices support vertical migration within the same package (for example, you can migrate between the EP2C20 device in the 484-pin FineLine BGA package and the EP2C35 and EP2C50 devices in the same package).
- (2) The Quartus® II software I/O pin counts include four additional pins, TDI, TDO, TMS, and TCK, which are not available as general purpose I/O pins.
- (3) TQFP: thin quad flat pack.
- (4) PQFP: plastic quad flat pack.
- (5) Vertical migration is supported between the EP2C5F256 and the EP2C8F256 devices. However, not all of the DQ and DQS groups are supported. Vertical migration between the EP2C5 and the EP2C15 in the F256 package is not supported.
- (6) The I/O pin counts for the EP2C5, EP2C8, and EP2C15A devices include 8 dedicated clock pins that can be used for data inputs. The I/O counts for the EP2C20, EP2C35, EP2C50, and EP2C70 devices include 16 dedicated clock pins that can be used for data inputs.
- (7) EP2C8A, EP2C15A, and EP2C20A have a Fast On feature that has a faster POR time. The EP2C15A is only available with the Fast On option.
- (8) The EP2C5 optionally support the Fast On feature, which is designated with an “A” in the device ordering code. The EP2C5A is only available in the automotive speed grade. Refer to the Cyclone II section in the *Automotive-Grade Device Handbook*.

Cyclone II devices support vertical migration within the same package (for example, you can migrate between the EP2C35, EP2C50, and EP2C70 devices in the 672-pin FineLine BGA package). The exception to vertical migration support within the Cyclone II family is noted in [Table 1–3](#).



Vertical migration means that you can migrate to devices whose dedicated pins, configuration pins, and power pins are the same for a given package across device densities.

**Table 1–3. Total Number of Non-Migratable I/O Pins for Cyclone II Vertical Migration Paths**

| Vertical Migration Path | 144-Pin TQFP | 208-Pin PQFP | 256-Pin FineLine BGA<br>(1) | 484-Pin FineLine BGA<br>(2) | 484-Pin Ultra FineLine BGA | 672-Pin FineLine BGA<br>(3) |
|-------------------------|--------------|--------------|-----------------------------|-----------------------------|----------------------------|-----------------------------|
| EP2C5 to EP2C8          | 4            | 4            | 1 (4)                       | —                           | —                          | —                           |
| EP2C8 to EP2C15         | —            | —            | 30                          | —                           | —                          | —                           |
| EP2C15 to EP2C20        | —            | —            | 0                           | 0                           | —                          | —                           |
| EP2C20 to EP2C35        | —            | —            | —                           | 16                          | —                          | —                           |
| EP2C35 to EP2C50        | —            | —            | —                           | 28                          | 28 (5)                     | 28                          |
| EP2C50 to EP2C70        | —            | —            | —                           | —                           | 28                         | 28                          |

**Notes to Table 1–3:**

- (1) Vertical migration between the EP2C5F256 to the EP2C15AF256 and the EP2C5F256 to the EP2C20F256 devices is not supported.
- (2) When migrating from the EP2C20F484 device to the EP2C50F484 device, a total of 39 I/O pins are non-migratable.
- (3) When migrating from the EP2C35F672 device to the EP2C70F672 device, a total of 56 I/O pins are non-migratable.
- (4) In addition to the one non-migratable I/O pin, there are 34 DQ pins that are non-migratable.
- (5) The pinouts of 484 FBGA and 484 UBGA are the same.



When moving from one density to a larger density, I/O pins are often lost because of the greater number of power and ground pins required to support the additional logic within the larger device. For I/O pin migration across densities, you must cross reference the available I/O pins using the device pin-outs for all planned densities of a given package type to identify which I/O pins are migratable.

To ensure that your board layout supports migratable densities within one package offering, enable the applicable vertical migration path within the Quartus II software (go to Assignments menu, then Device, then click the **Migration Devices** button). After compilation, check the information messages for a full list of I/O, DQ, LVDS, and other pins that are not available because of the selected migration path. Table 1–3 lists the Cyclone II device package offerings and shows the total number of non-migratable I/O pins when migrating from one density device to a larger density device.

Cyclone II devices are available in up to three speed grades: -6, -7, and -8, with -6 being the fastest. [Table 1-4](#) shows the Cyclone II device speed-grade offerings.

**Table 1-4. Cyclone II Device Speed Grades**

| Device      | 144-Pin<br>TQFP | 208-Pin<br>PQFP | 240-Pin<br>PQFP | 256-Pin<br>FineLine<br>BGA | 484-Pin<br>FineLine<br>BGA | 484-Pin<br>Ultra<br>FineLine<br>BGA | 672-Pin<br>FineLine<br>BGA | 896-Pin<br>FineLine<br>BGA |
|-------------|-----------------|-----------------|-----------------|----------------------------|----------------------------|-------------------------------------|----------------------------|----------------------------|
| EP2C5 (1)   | -6, -7, -8      | -7, -8          | —               | -6, -7, -8                 | —                          | —                                   | —                          | —                          |
| EP2C8       | -6, -7, -8      | -7, -8          | —               | -6, -7, -8                 | —                          | —                                   | —                          | —                          |
| EP2C8A (2)  | —               | —               | —               | -8                         | —                          | —                                   | —                          | —                          |
| EP2C15A     | —               | —               | —               | -6, -7, -8                 | -6, -7, -8                 | —                                   | —                          | —                          |
| EP2C20      | —               | —               | -8              | -6, -7, -8                 | -6, -7, -8                 | —                                   | —                          | —                          |
| EP2C20A (2) | —               | —               | —               | -8                         | -8                         | —                                   | —                          | —                          |
| EP2C35      | —               | —               | —               | —                          | -6, -7, -8                 | -6, -7, -8                          | -6, -7, -8                 | —                          |
| EP2C50      | —               | —               | —               | —                          | -6, -7, -8                 | -6, -7, -8                          | -6, -7, -8                 | —                          |
| EP2C70      | —               | —               | —               | —                          | —                          | —                                   | -6, -7, -8                 | -6, -7, -8                 |

**Notes to Table 1-4:**

- (1) The EP2C5 optionally support the Fast On feature, which is designated with an “A” in the device ordering code. The EP2C5A is only available in the automotive speed grade. Refer to the Cyclone II section in the [Automotive-Grade Device Handbook](#) for detailed information.
- (2) EP2C8A and EP2C20A are only available in industrial grade.

## Referenced Documents

This chapter references the following documents:

- *Hot Socketing & Power-On Reset* chapter in *Cyclone II Device Handbook*
- *Automotive-Grade Device Handbook*

## Document Revision History

Table 1–5 shows the revision history for this document.

| <b>Table 1–5. Document Revision History</b> |                                                                                                                                                                                            |                                                                                                                                  |
|---------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------|
| <b>Date &amp; Document Version</b>          | <b>Changes Made</b>                                                                                                                                                                        | <b>Summary of Changes</b>                                                                                                        |
| February 2008 v3.2                          | <ul style="list-style-type: none"> <li>Added “Referenced Documents”.</li> <li>Updated “Features” section and Table 1–1, Table 1–2, and Table 1–4 with information about EP2C5A.</li> </ul> | —                                                                                                                                |
| February 2007 v3.1                          | <ul style="list-style-type: none"> <li>Added document revision history.</li> <li>Added new <i>Note (2)</i> to Table 1–2.</li> </ul>                                                        | Note to explain difference between I/O pin count information provided in Table 1–2 and in the Quartus II software documentation. |
| November 2005 v2.1                          | <ul style="list-style-type: none"> <li>Updated Introduction and Features.</li> <li>Updated Table 1–3.</li> </ul>                                                                           | —                                                                                                                                |
| July 2005 v2.0                              | <ul style="list-style-type: none"> <li>Updated technical content throughout.</li> <li>Updated Table 1–2.</li> <li>Added Tables 1–3 and 1–4.</li> </ul>                                     | —                                                                                                                                |
| November 2004 v1.1                          | <ul style="list-style-type: none"> <li>Updated Table 1–2.</li> <li>Updated bullet list in the “Features” section.</li> </ul>                                                               | —                                                                                                                                |
| June 2004 v1.0                              | Added document to the Cyclone II Device Handbook.                                                                                                                                          | —                                                                                                                                |



### Functional Description

Cyclone® II devices contain a two-dimensional row- and column-based architecture to implement custom logic. Column and row interconnects of varying speeds provide signal interconnects between logic array blocks (LABs), embedded memory blocks, and embedded multipliers.

The logic array consists of LABs, with 16 logic elements (LEs) in each LAB. An LE is a small unit of logic providing efficient implementation of user logic functions. LABs are grouped into rows and columns across the device. Cyclone II devices range in density from 4,608 to 68,416 LEs.

Cyclone II devices provide a global clock network and up to four phase-locked loops (PLLs). The global clock network consists of up to 16 global clock lines that drive throughout the entire device. The global clock network can provide clocks for all resources within the device, such as input/output elements (IOEs), LEs, embedded multipliers, and embedded memory blocks. The global clock lines can also be used for other high fan-out signals. Cyclone II PLLs provide general-purpose clocking with clock synthesis and phase shifting as well as external outputs for high-speed differential I/O support.

M4K memory blocks are true dual-port memory blocks with 4K bits of memory plus parity (4,608 bits). These blocks provide dedicated true dual-port, simple dual-port, or single-port memory up to 36-bits wide at up to 260 MHz. These blocks are arranged in columns across the device in between certain LABs. Cyclone II devices offer between 119 to 1,152 Kbits of embedded memory.

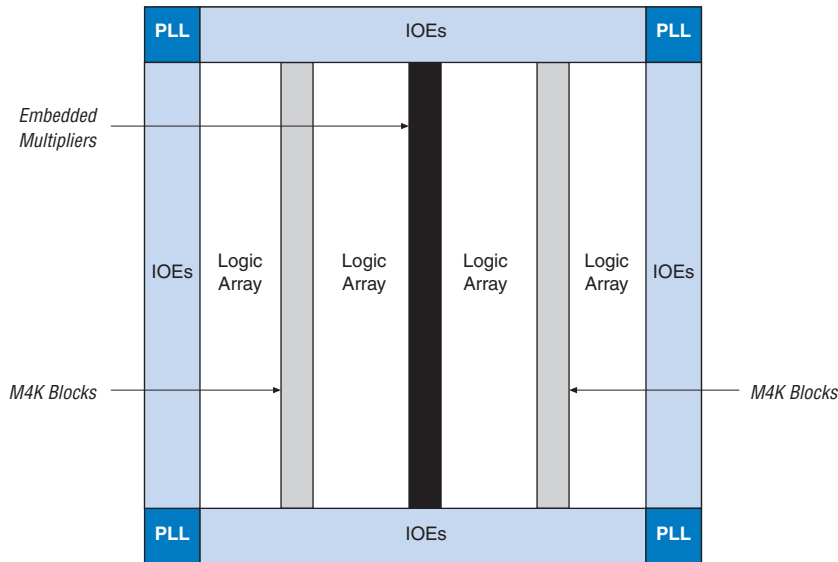
Each embedded multiplier block can implement up to either two  $9 \times 9$ -bit multipliers, or one  $18 \times 18$ -bit multiplier with up to 250-MHz performance. Embedded multipliers are arranged in columns across the device.

Each Cyclone II device I/O pin is fed by an IOE located at the ends of LAB rows and columns around the periphery of the device. I/O pins support various single-ended and differential I/O standards, such as the 66- and 33-MHz, 64- and 32-bit PCI standard, PCI-X, and the LVDS I/O standard at a maximum data rate of 805 megabits per second (Mbps) for inputs and 640 Mbps for outputs. Each IOE contains a bidirectional I/O buffer and three registers for registering input, output, and output-enable signals. Dual-purpose DQS, DQ, and DM pins along with delay chains (used to

phase-align double data rate (DDR) signals) provide interface support for external memory devices such as DDR, DDR2, and single data rate (SDR) SDRAM, and QDRII SRAM devices at up to 167 MHz.

Figure 2–1 shows a diagram of the Cyclone II EP2C20 device.

**Figure 2–1. Cyclone II EP2C20 Device Block Diagram**



The number of M4K memory blocks, embedded multiplier blocks, PLLs, rows, and columns vary per device.

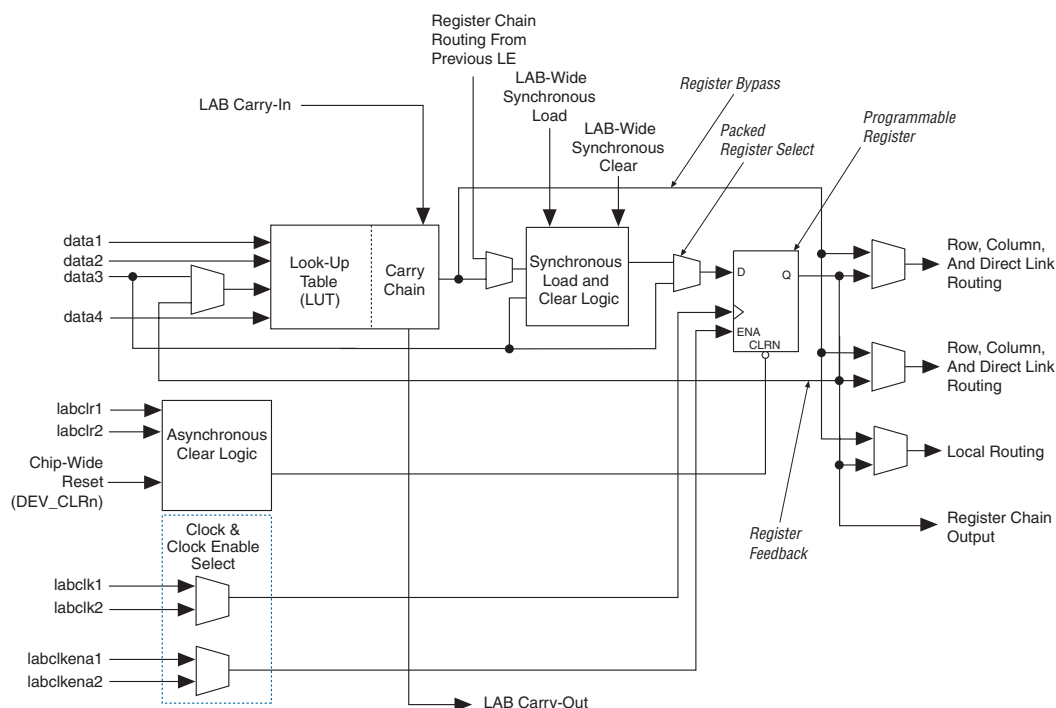
## Logic Elements

The smallest unit of logic in the Cyclone II architecture, the LE, is compact and provides advanced features with efficient logic utilization. Each LE features:

- A four-input look-up table (LUT), which is a function generator that can implement any function of four variables
- A programmable register
- A carry chain connection
- A register chain connection
- The ability to drive all types of interconnects: local, row, column, register chain, and direct link interconnects
- Support for register packing
- Support for register feedback

Figure 2–2 shows a Cyclone II LE.

**Figure 2–2. Cyclone II LE**



Each LE's programmable register can be configured for D, T, JK, or SR operation. Each register has data, clock, clock enable, and clear inputs. Signals that use the global clock network, general-purpose I/O pins, or any internal logic can drive the register's clock and clear control signals. Either general-purpose I/O pins or internal logic can drive the clock enable. For combinational functions, the LUT output bypasses the register and drives directly to the LE outputs.

Each LE has three outputs that drive the local, row, and column routing resources. The LUT or register output can drive these three outputs independently. Two LE outputs drive column or row and direct link routing connections and one drives local interconnect resources, allowing the LUT to drive one output while the register drives another output. This feature, register packing, improves device utilization because the device can use the register and the LUT for unrelated functions. When using register packing, the LAB-wide synchronous load control signal is not available. See [“LAB Control Signals” on page 2–8](#) for more information.

Another special packing mode allows the register output to feed back into the LUT of the same LE so that the register is packed with its own fan-out LUT, providing another mechanism for improved fitting. The LE can also drive out registered and unregistered versions of the LUT output.

In addition to the three general routing outputs, the LEs within an LAB have register chain outputs. Register chain outputs allow registers within the same LAB to cascade together. The register chain output allows an LAB to use LUTs for a single combinational function and the registers to be used for an unrelated shift register implementation. These resources speed up connections between LABs while saving local interconnect resources. See [“MultiTrack Interconnect” on page 2–10](#) for more information on register chain connections.

## LE Operating Modes

The Cyclone II LE operates in one of the following modes:

- Normal mode
- Arithmetic mode

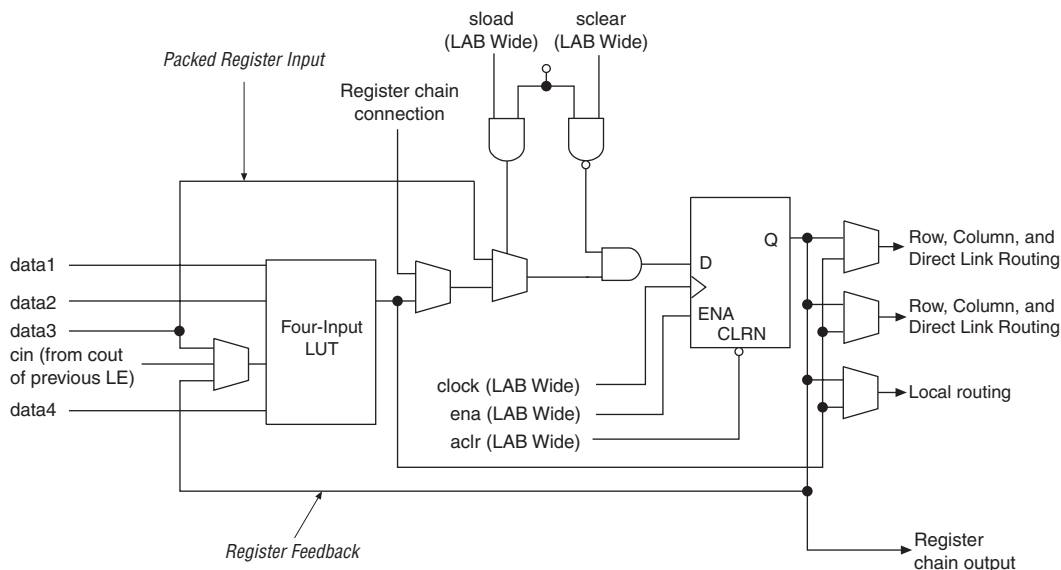
Each mode uses LE resources differently. In each mode, six available inputs to the LE—the four data inputs from the LAB local interconnect, the LAB carry-in from the previous carry-chain LAB, and the register chain connection—are directed to different destinations to implement the desired logic function. LAB-wide signals provide clock, asynchronous clear, synchronous clear, synchronous load, and clock enable control for the register. These LAB-wide signals are available in all LE modes.

The Quartus® II software, in conjunction with parameterized functions such as library of parameterized modules (LPM) functions, automatically chooses the appropriate mode for common functions such as counters, adders, subtractors, and arithmetic functions. If required, you can also create special-purpose functions that specify which LE operating mode to use for optimal performance.

### *Normal Mode*

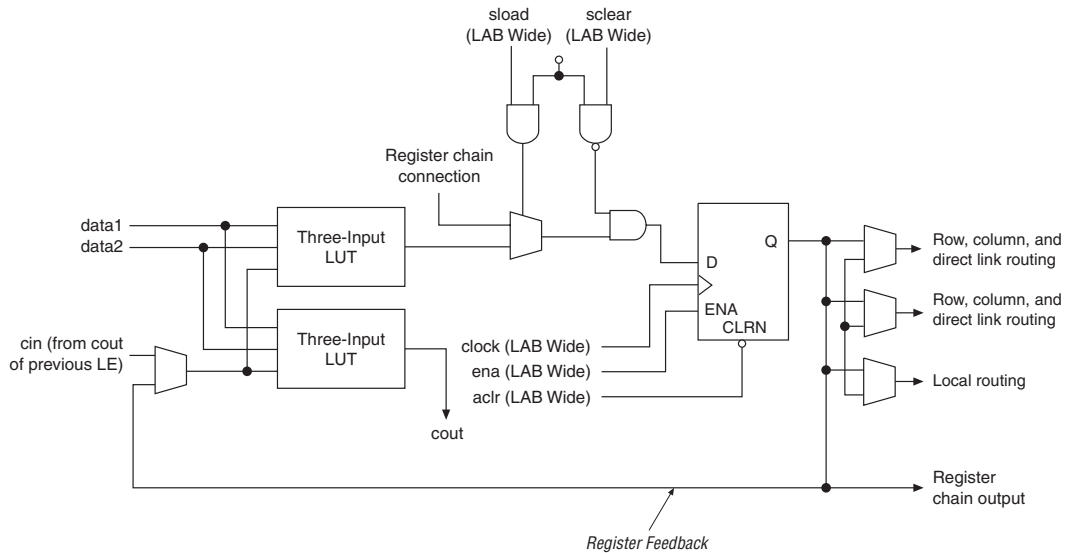
The normal mode is suitable for general logic applications and combinational functions. In normal mode, four data inputs from the LAB local interconnect are inputs to a four-input LUT (see [Figure 2–3](#)). The Quartus II Compiler automatically selects the carry-in or the `data3` signal as one of the inputs to the LUT. LEs in normal mode support packed registers and register feedback.



**Figure 2–3. LE in Normal Mode**

### Arithmetic Mode

The arithmetic mode is ideal for implementing adders, counters, accumulators, and comparators. An LE in arithmetic mode implements a 2-bit full adder and basic carry chain (see Figure 2–4). LEs in arithmetic mode can drive out registered and unregistered versions of the LUT output. Register feedback and register packing are supported when LEs are used in arithmetic mode.

**Figure 2–4. LE in Arithmetic Mode**

The Quartus II Compiler automatically creates carry chain logic during design processing, or you can create it manually during design entry. Parameterized functions such as LPM functions automatically take advantage of carry chains for the appropriate functions.

The Quartus II Compiler creates carry chains longer than 16 LEs by automatically linking LABs in the same column. For enhanced fitting, a long carry chain runs vertically, which allows fast horizontal connections to M4K memory blocks or embedded multipliers through direct link interconnects. For example, if a design has a long carry chain in a LAB column next to a column of M4K memory blocks, any LE output can feed an adjacent M4K memory block through the direct link interconnect. Whereas if the carry chains ran horizontally, any LAB not next to the column of M4K memory blocks would use other row or column interconnects to drive a M4K memory block. A carry chain continues as far as a full column.

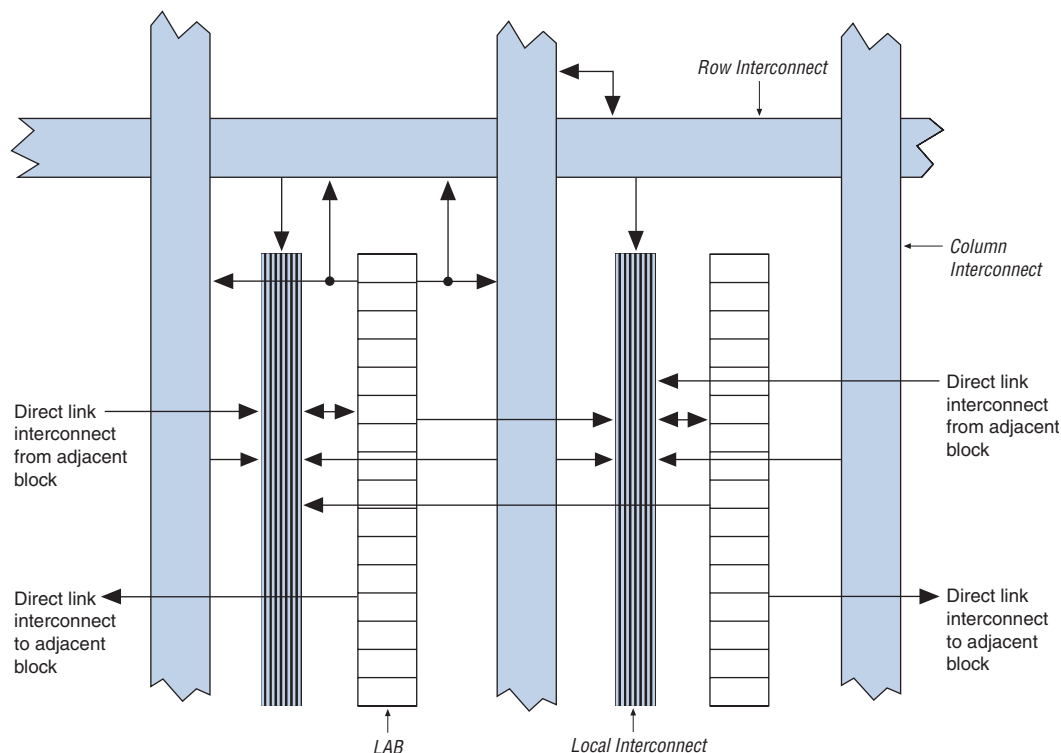
## Logic Array Blocks

Each LAB consists of the following:

- 16 LEs
- LAB control signals
- LE carry chains
- Register chains
- Local interconnect

The local interconnect transfers signals between LEs in the same LAB. Register chain connections transfer the output of one LE's register to the adjacent LE's register within an LAB. The Quartus II Compiler places associated logic within an LAB or adjacent LABs, allowing the use of local, and register chain connections for performance and area efficiency. Figure 2-5 shows the Cyclone II LAB.

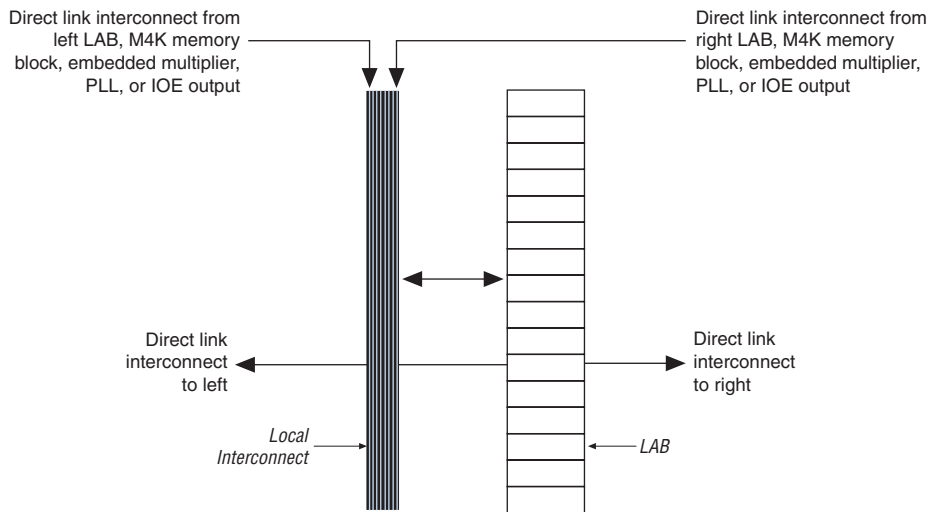
**Figure 2-5. Cyclone II LAB Structure**



## LAB Interconnects

The LAB local interconnect can drive LEs within the same LAB. The LAB local interconnect is driven by column and row interconnects and LE outputs within the same LAB. Neighboring LABs, PLLs, M4K RAM blocks, and embedded multipliers from the left and right can also drive an LAB's local interconnect through the direct link connection. The direct link connection feature minimizes the use of row and column interconnects, providing higher performance and flexibility. Each LE can drive 48 LEs through fast local and direct link interconnects. Figure 2-6 shows the direct link connection.

**Figure 2-6. Direct Link Connection**



## LAB Control Signals

Each LAB contains dedicated logic for driving control signals to its LEs. The control signals include:

- Two clocks
- Two clock enables
- Two asynchronous clears
- One synchronous clear
- One synchronous load

This gives a maximum of seven control signals at a time. When using the LAB-wide synchronous load, the `clkena` of `labclk1` is not available. Additionally, register packing and synchronous load cannot be used simultaneously.

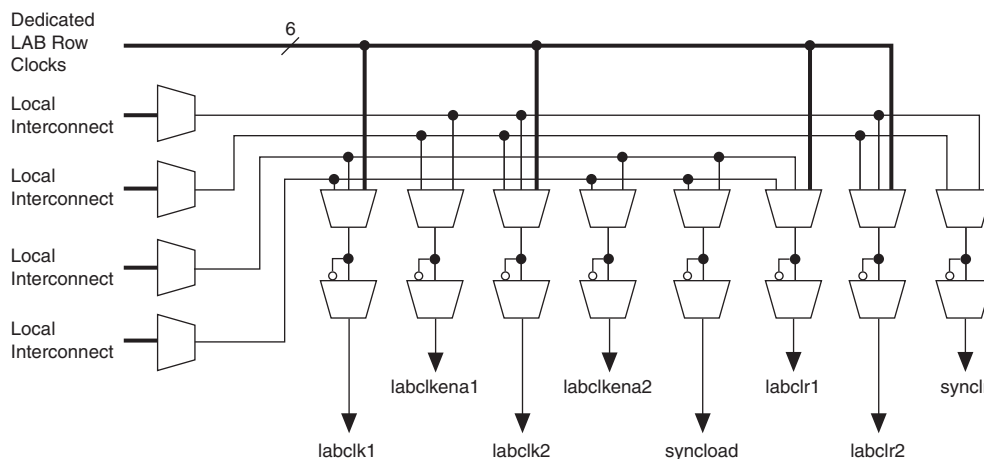
Each LAB can have up to four non-global control signals. Additional LAB control signals can be used as long as they are global signals.

Synchronous clear and load signals are useful for implementing counters and other functions. The synchronous clear and synchronous load signals are LAB-wide signals that affect all registers in the LAB.

Each LAB can use two clocks and two clock enable signals. Each LAB's clock and clock enable signals are linked. For example, any LE in a particular LAB using the `labclk1` signal also uses `labclkena1`. If the LAB uses both the rising and falling edges of a clock, it also uses both LAB-wide clock signals. De-asserting the clock enable signal turns off the LAB-wide clock.

The LAB row clocks [5..0] and LAB local interconnect generate the LAB-wide control signals. The MultiTrack™ interconnect's inherent low skew allows clock and control signal distribution in addition to data. [Figure 2-7](#) shows the LAB control signal generation circuit.

**Figure 2-7. LAB-Wide Control Signals**



LAB-wide signals control the logic for the register's clear signal. The LE directly supports an asynchronous clear function. Each LAB supports up to two asynchronous clear signals (`labclr1` and `labclr2`).

A LAB-wide asynchronous load signal to control the logic for the register's preset signal is not available. The register preset is achieved by using a NOT gate push-back technique. Cyclone II devices can only support either a preset or asynchronous clear signal.

In addition to the clear port, Cyclone II devices provide a chip-wide reset pin (`DEV_CLRn`) that resets all registers in the device. An option set before compilation in the Quartus II software controls this pin. This chip-wide reset overrides all other control signals.

## MultiTrack Interconnect

In the Cyclone II architecture, connections between LEs, M4K memory blocks, embedded multipliers, and device I/O pins are provided by the MultiTrack interconnect structure with DirectDrive™ technology. The MultiTrack interconnect consists of continuous, performance-optimized routing lines of different speeds used for inter- and intra-design block connectivity. The Quartus II Compiler automatically places critical paths on faster interconnects to improve design performance.

DirectDrive technology is a deterministic routing technology that ensures identical routing resource usage for any function regardless of placement within the device. The MultiTrack interconnect and DirectDrive technology simplify the integration stage of block-based designing by eliminating the re-optimization cycles that typically follow design changes and additions.

The MultiTrack interconnect consists of row (direct link, R4, and R24) and column (register chain, C4, and C16) interconnects that span fixed distances. A routing structure with fixed-length resources for all devices allows predictable and repeatable performance when migrating through different device densities.

### Row Interconnects

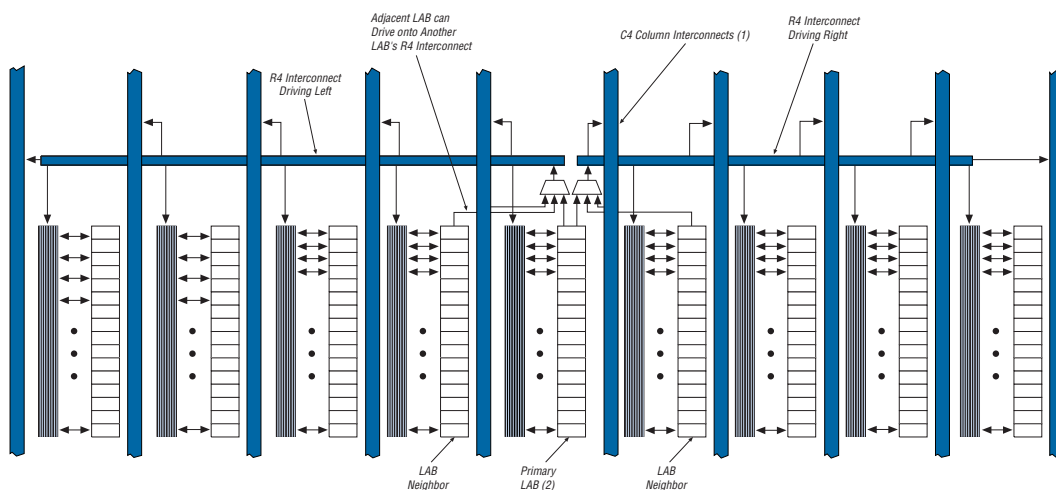
Dedicated row interconnects route signals to and from LABs, PLLs, M4K memory blocks, and embedded multipliers within the same row. These row resources include:

- Direct link interconnects between LABs and adjacent blocks
- R4 interconnects traversing four blocks to the right or left
- R24 interconnects for high-speed access across the length of the device

The direct link interconnect allows an LAB, M4K memory block, or embedded multiplier block to drive into the local interconnect of its left and right neighbors. Only one side of a PLL block interfaces with direct link and row interconnects. The direct link interconnect provides fast communication between adjacent LABs and/or blocks without using row interconnect resources.

The R4 interconnects span four LABs, three LABs and one M4K memory block, or three LABs and one embedded multiplier to the right or left of a source LAB. These resources are used for fast row connections in a four-LAB region. Every LAB has its own set of R4 interconnects to drive either left or right. [Figure 2–8](#) shows R4 interconnect connections from an LAB. R4 interconnects can drive and be driven by LABs, M4K memory blocks, embedded multipliers, PLLs, and row IOEs. For LAB interfacing, a primary LAB or LAB neighbor (see [Figure 2–8](#)) can drive a given R4 interconnect. For R4 interconnects that drive to the right, the primary LAB and right neighbor can drive on to the interconnect. For R4 interconnects that drive to the left, the primary LAB and its left neighbor can drive on to the interconnect. R4 interconnects can drive other R4 interconnects to extend the range of LABs they can drive. Additionally, R4 interconnects can drive R24 interconnects, C4, and C16 interconnects for connections from one row to another.

**Figure 2–8. R4 Interconnect Connections**



**Notes to [Figure 2–8](#):**

- (1) C4 interconnects can drive R4 interconnects.
- (2) This pattern is repeated for every LAB in the LAB row.

R24 row interconnects span 24 LABs and provide the fastest resource for long row connections between non-adjacent LABs, M4K memory blocks, dedicated multipliers, and row IOEs. R24 row interconnects drive to other row or column interconnects at every fourth LAB. R24 row interconnects drive LAB local interconnects via R4 and C4 interconnects and do not drive directly to LAB local interconnects. R24 interconnects can drive R24, R4, C16, and C4 interconnects.

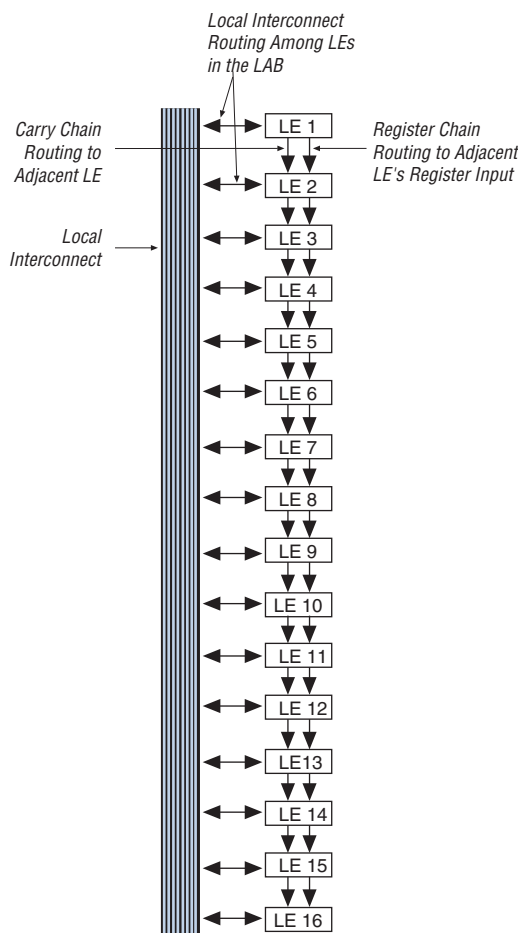
### Column Interconnects

The column interconnect operates similar to the row interconnect. Each column of LABs is served by a dedicated column interconnect, which vertically routes signals to and from LABs, M4K memory blocks, embedded multipliers, and row and column IOEs. These column resources include:

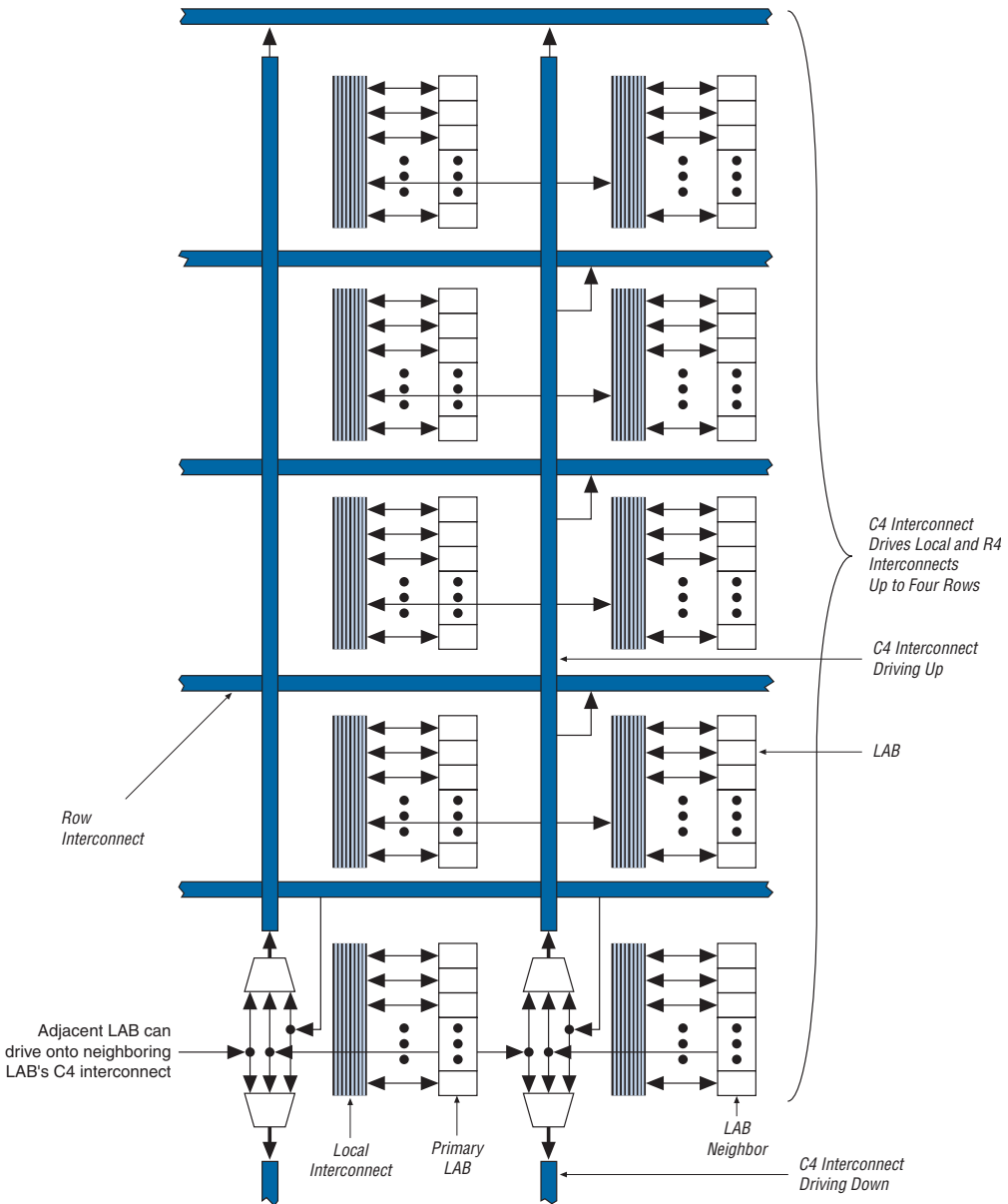
- Register chain interconnects within an LAB
- C4 interconnects traversing a distance of four blocks in an up and down direction
- C16 interconnects for high-speed vertical routing through the device

Cyclone II devices include an enhanced interconnect structure within LABs for routing LE output to LE input connections faster using register chain connections. The register chain connection allows the register output of one LE to connect directly to the register input of the next LE in the LAB for fast shift registers. The Quartus II Compiler automatically takes advantage of these resources to improve utilization and performance. [Figure 2–9](#) shows the register chain interconnects.



**Figure 2–9. Register Chain Interconnects**

The C4 interconnects span four LABs, M4K blocks, or embedded multipliers up or down from a source LAB. Every LAB has its own set of C4 interconnects to drive either up or down. [Figure 2–10](#) shows the C4 interconnect connections from an LAB in a column. The C4 interconnects can drive and be driven by all types of architecture blocks, including PLLs, M4K memory blocks, embedded multiplier blocks, and column and row IOEs. For LAB interconnection, a primary LAB or its LAB neighbor (see [Figure 2–10](#)) can drive a given C4 interconnect. C4 interconnects can drive each other to extend their range as well as drive row interconnects for column-to-column connections.

**Figure 2–10. C4 Interconnect Connections** *Note (1)***Note to Figure 2–10:**

(1) Each C4 interconnect can drive either up or down four rows.

C16 column interconnects span a length of 16 LABs and provide the fastest resource for long column connections between LABs, M4K memory blocks, embedded multipliers, and IOEs. C16 column interconnects drive to other row and column interconnects at every fourth LAB. C16 column interconnects drive LAB local interconnects via C4 and R4 interconnects and do not drive LAB local interconnects directly. C16 interconnects can drive R24, R4, C16, and C4 interconnects.

## Device Routing

All embedded blocks communicate with the logic array similar to LAB-to-LAB interfaces. Each block (for example, M4K memory, embedded multiplier, or PLL) connects to row and column interconnects and has local interconnect regions driven by row and column interconnects. These blocks also have direct link interconnects for fast connections to and from a neighboring LAB.

Table 2–1 shows the Cyclone II device’s routing scheme.

**Table 2–1. Cyclone II Device Routing Scheme (Part 1 of 2)**

| Source                   | Destination    |                    |                          |                 |                  |                 |                  |    |               |                     |     |            |         |
|--------------------------|----------------|--------------------|--------------------------|-----------------|------------------|-----------------|------------------|----|---------------|---------------------|-----|------------|---------|
|                          | Register Chain | Local Interconnect | Direct Link Interconnect | R4 Interconnect | R24 Interconnect | C4 Interconnect | C16 Interconnect | LE | M4K RAM Block | Embedded Multiplier | PLL | Column IOE | Row IOE |
| Register Chain           |                |                    |                          |                 |                  |                 |                  | ✓  |               |                     |     |            |         |
| Local Interconnect       |                |                    |                          |                 |                  |                 |                  | ✓  | ✓             | ✓                   | ✓   | ✓          | ✓       |
| Direct Link Interconnect |                | ✓                  |                          |                 |                  |                 |                  |    |               |                     |     |            |         |
| R4 Interconnect          |                | ✓                  |                          | ✓               | ✓                | ✓               | ✓                |    |               |                     |     |            |         |
| R24 Interconnect         |                |                    |                          | ✓               | ✓                | ✓               | ✓                |    |               |                     |     |            |         |
| C4 Interconnect          |                | ✓                  |                          | ✓               | ✓                | ✓               | ✓                |    |               |                     |     |            |         |
| C16 Interconnect         |                |                    |                          | ✓               | ✓                | ✓               | ✓                |    |               |                     |     |            |         |

**Table 2–1. Cyclone II Device Routing Scheme (Part 2 of 2)**

| Source               | Destination    |                    |                          |                 |                  |                 |                  |    |               |                     |     |            |         |
|----------------------|----------------|--------------------|--------------------------|-----------------|------------------|-----------------|------------------|----|---------------|---------------------|-----|------------|---------|
|                      | Register Chain | Local Interconnect | Direct Link Interconnect | R4 Interconnect | R24 Interconnect | C4 Interconnect | C16 Interconnect | LE | M4K RAM Block | Embedded Multiplier | PLL | Column IOE | Row IOE |
| LE                   | ✓              | ✓                  | ✓                        | ✓               |                  | ✓               |                  |    |               |                     |     |            |         |
| M4K memory Block     |                | ✓                  | ✓                        | ✓               |                  | ✓               |                  |    |               |                     |     |            |         |
| Embedded Multipliers |                | ✓                  | ✓                        | ✓               |                  | ✓               |                  |    |               |                     |     |            |         |
| PLL                  |                |                    | ✓                        | ✓               |                  | ✓               |                  |    |               |                     |     |            |         |
| Column IOE           |                |                    |                          |                 |                  | ✓               | ✓                |    |               |                     |     |            |         |
| Row IOE              |                |                    | ✓                        | ✓               | ✓                | ✓               |                  |    |               |                     |     |            |         |

## Global Clock Network & Phase-Locked Loops

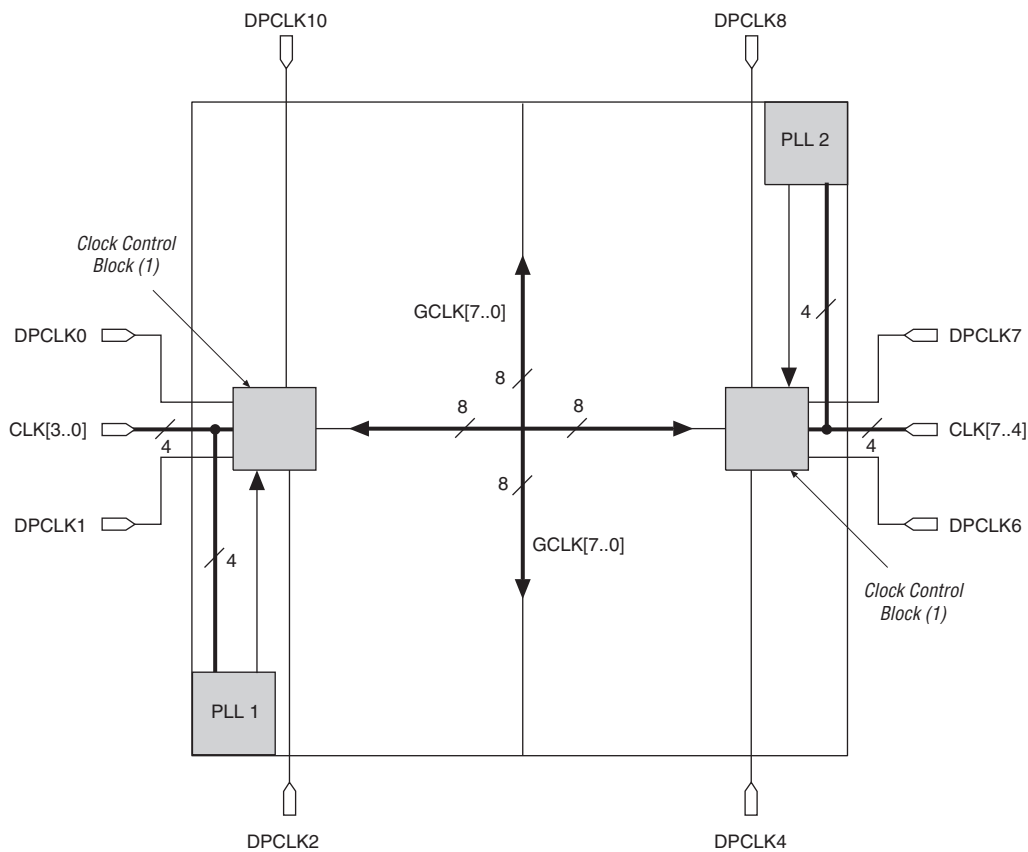
Cyclone II devices provide global clock networks and up to four PLLs for a complete clock management solution. Cyclone II clock network features include:

- Up to 16 global clock networks
- Up to four PLLs
- Global clock network dynamic clock source selection
- Global clock network dynamic enable and disable

Each global clock network has a clock control block to select from a number of input clock sources (PLL clock outputs, CLK [] pins, DPCLK [] pins, and internal logic) to drive onto the global clock network. Table 2–2 lists how many PLLs, CLK [] pins, DPCLK [] pins, and global clock networks are available in each Cyclone II device. CLK [] pins are dedicated clock pins and DPCLK [] pins are dual-purpose clock pins.

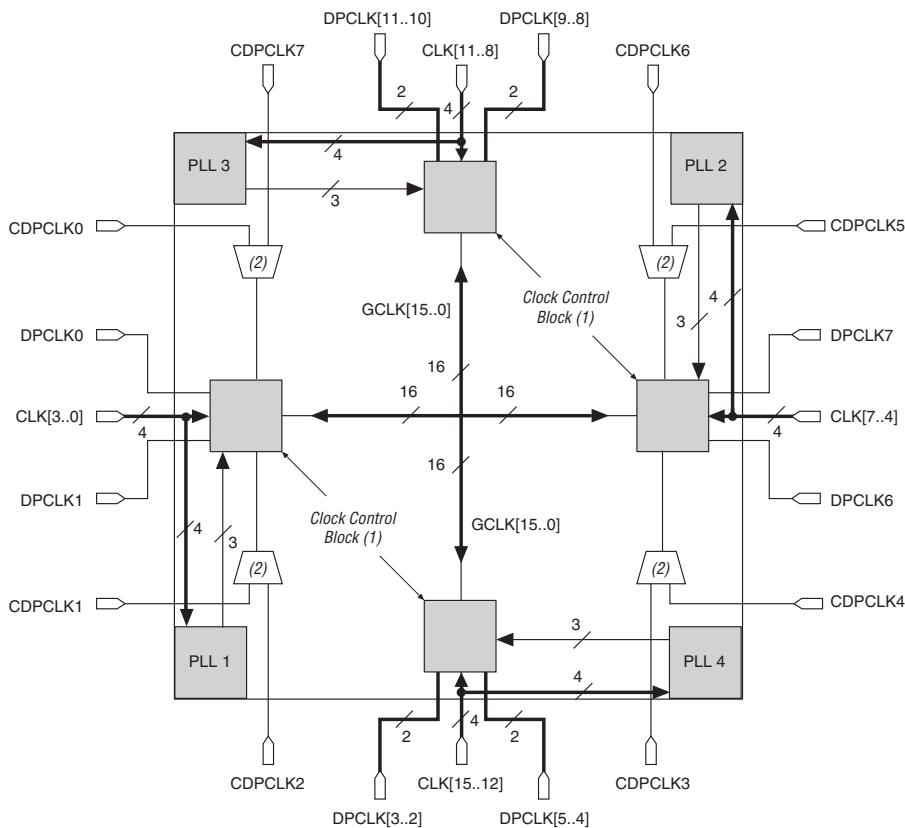
| <i>Table 2–2. Cyclone II Device Clock Resources</i> |                |                    |                      |                                 |
|-----------------------------------------------------|----------------|--------------------|----------------------|---------------------------------|
| Device                                              | Number of PLLs | Number of CLK Pins | Number of DPCLK Pins | Number of Global Clock Networks |
| EP2C5                                               | 2              | 8                  | 8                    | 8                               |
| EP2C8                                               | 2              | 8                  | 8                    | 8                               |
| EP2C15                                              | 4              | 16                 | 20                   | 16                              |
| EP2C20                                              | 4              | 16                 | 20                   | 16                              |
| EP2C35                                              | 4              | 16                 | 20                   | 16                              |
| EP2C50                                              | 4              | 16                 | 20                   | 16                              |
| EP2C70                                              | 4              | 16                 | 20                   | 16                              |

Figures 2–11 and 2–12 show the location of the Cyclone II PLLs, CLK [] inputs, DPCLK [] pins, and clock control blocks.

**Figure 2–11. EP2C5 & EP2C8 PLL, CLK[], DPCLK[] & Clock Control Block Locations**

**Note to Figure 2–11:**

(1) There are four clock control blocks on each side.

**Figure 2–12. EP2C15 & Larger PLL, CLK[], DPCLK[] & Clock Control Block Locations****Notes to Figure 2–12:**

- (1) There are four clock control blocks on each side.
- (2) Only one of the corner CDPCLK pins in each corner can feed the clock control block at a time. The other CDPCLK pins can be used as general-purpose I/O pins.

## Dedicated Clock Pins

Larger Cyclone II devices (EP2C15 and larger devices) have 16 dedicated clock pins (CLK [15 . . 0], four pins on each side of the device). Smaller Cyclone II devices (EP2C5 and EP2C8 devices) have eight dedicated clock pins (CLK [7 . . 0], four pins on left and right sides of the device). These CLK pins drive the global clock network (GCLK), as shown in [Figures 2–11 and 2–12](#).

If the dedicated clock pins are not used to feed the global clock networks, they can be used as general-purpose input pins to feed the logic array using the MultiTrack interconnect. However, if they are used as general-purpose input pins, they do not have support for an I/O register and must use LE-based registers in place of an I/O register.

## Dual-Purpose Clock Pins

Cyclone II devices have either 20 dual-purpose clock pins, DPCLK [19 . . 0] or 8 dual-purpose clock pins, DPCLK [7 . . 0]. In the larger Cyclone II devices (EP2C15 devices and higher), there are 20 DPCLK pins; four on the left and right sides and six on the top and bottom of the device. The corner CDPCLK pins are first multiplexed before they drive into the clock control block. Since the signals pass through a multiplexer before feeding the clock control block, these signals incur more delay to the clock control block than other DPCLK pins that directly feed the clock control block. In the smaller Cyclone II devices (EP2C5 and EP2C8 devices), there are eight DPCLK pins; two on each side of the device (see [Figures 2–11 and 2–12](#)).

A programmable delay chain is available from the DPCLK pin to its fan-out destinations. To set the propagation delay from the DPCLK pin to its fan-out destinations, use the **Input Delay from Dual-Purpose Clock Pin to Fan-Out Destinations** assignment in the Quartus II software.

These dual-purpose pins can connect to the global clock network for high-fanout control signals such as clocks, asynchronous clears, presets, and clock enables, or protocol control signals such as TRDY and IRDY for PCI, or DQS signals for external memory interfaces.



## Global Clock Network

The 16 or 8 global clock networks drive throughout the entire device. Dedicated clock pins (CLK [ ] ), PLL outputs, the logic array, and dual-purpose clock (DPCLK [ ] ) pins can also drive the global clock network.

The global clock network can provide clocks for all resources within the device, such as IOEs, LEs, memory blocks, and embedded multipliers. The global clock lines can also be used for control signals, such as clock enables and synchronous or asynchronous clears fed from the external pin, or DQS signals for DDR SDRAM or QDR II SRAM interfaces. Internal logic can also drive the global clock network for internally generated global clocks and asynchronous clears, clock enables, or other control signals with large fan-out.

### *Clock Control Block*

There is a clock control block for each global clock network available in Cyclone II devices. The clock control blocks are arranged on the device periphery and there are a maximum of 16 clock control blocks available per Cyclone II device. The larger Cyclone II devices (EP2C15 devices and larger) have 16 clock control blocks, four on each side of the device. The smaller Cyclone II devices (EP2C5 and EP2C8 devices) have eight clock control blocks, four on the left and right sides of the device.

The control block has these functions:

- Dynamic global clock network clock source selection
- Dynamic enable/disable of the global clock network

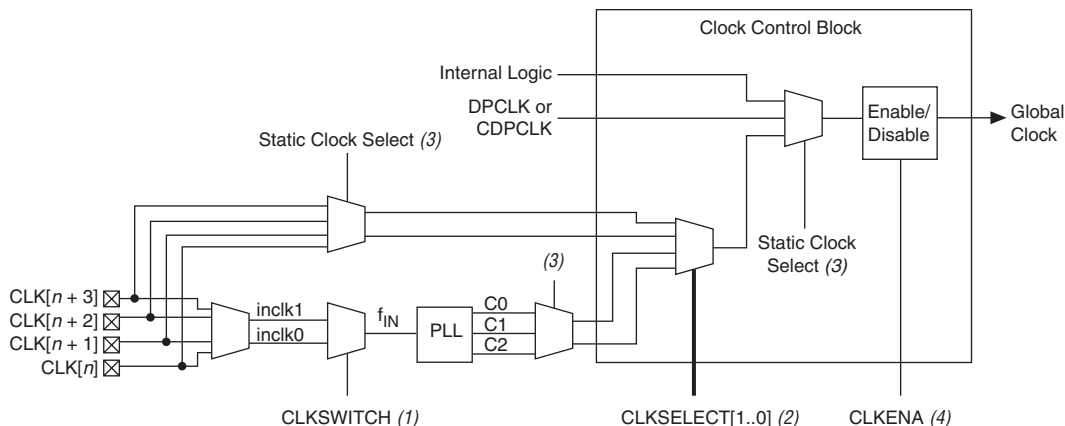
In Cyclone II devices, the dedicated CLK [ ] pins, PLL counter outputs, DPCLK [ ] pins, and internal logic can all feed the clock control block. The output from the clock control block in turn feeds the corresponding global clock network.

The following sources can be inputs to a given clock control block:

- Four clock pins on the same side as the clock control block
- Three PLL clock outputs from a PLL
- Four DPCLK pins (including CDCLK pins) on the same side as the clock control block
- Four internally-generated signals

Of the sources listed, only two clock pins, two PLL clock outputs, one DPCLK pin, and one internally-generated signal are chosen to drive into a clock control block. Figure 2-13 shows a more detailed diagram of the clock control block. Out of these six inputs, the two clock input pins and two PLL outputs can be dynamic selected to feed a global clock network. The clock control block supports static selection of DPCLK and the signal from internal logic.

**Figure 2-13. Clock Control Block**



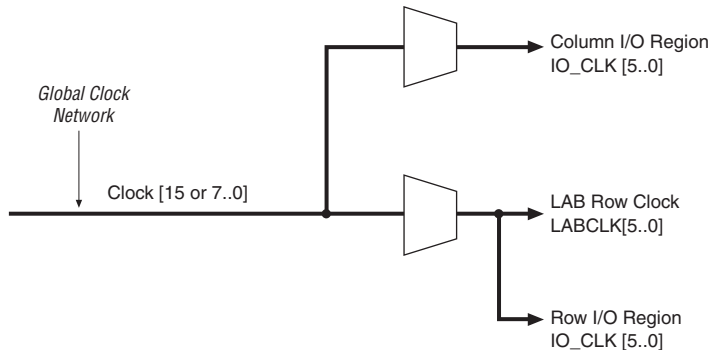
**Notes to Figure 2-13:**

- (1) The CLKSWITCH signal can either be set through the configuration file or it can be dynamically set when using the manual PLL switchover feature. The output of the multiplexer is the input reference clock ( $f_{IN}$ ) for the PLL.
- (2) The CLKSELECT[1..0] signals are fed by internal logic and can be used to dynamically select the clock source for the global clock network when the device is in user mode.
- (3) The static clock select signals are set in the configuration file and cannot be dynamically controlled when the device is in user mode.
- (4) Internal logic can be used to enabled or disabled the global clock network in user mode.

## Global Clock Network Distribution

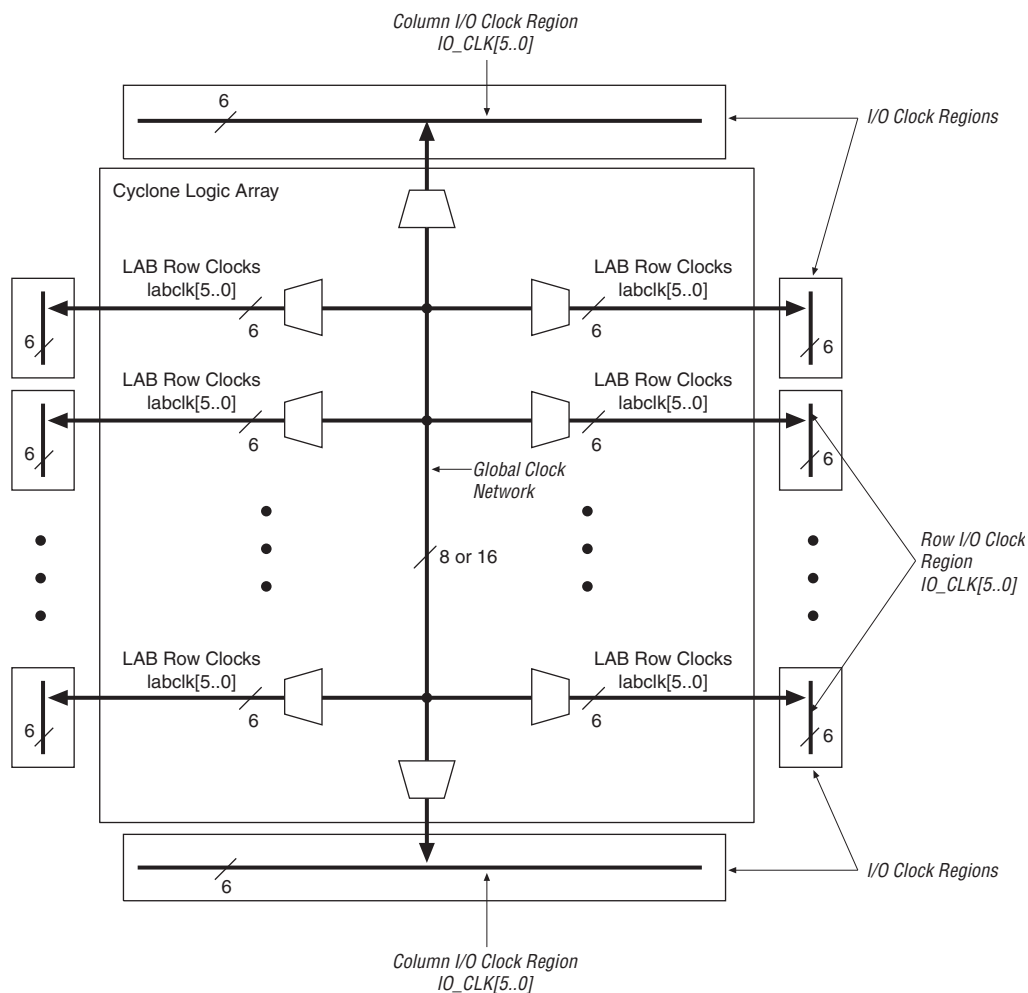
Cyclone II devices contains 16 global clock networks. The device uses multiplexers with these clocks to form six-bit buses to drive column IOE clocks, LAB row clocks, or row IOE clocks (see [Figure 2-14](#)). Another multiplexer at the LAB level selects two of the six LAB row clocks to feed the LE registers within the LAB.

**Figure 2-14. Global Clock Network Multiplexers**



LAB row clocks can feed LEs, M4K memory blocks, and embedded multipliers. The LAB row clocks also extend to the row I/O clock regions.

IOE clocks are associated with row or column block regions. Only six global clock resources feed to these row and column regions. [Figure 2-15](#) shows the I/O clock regions.

**Figure 2–15. LAB & I/O Clock Regions**

For more information on the global clock network and the clock control block, see the PLLs in *Cyclone II Devices* chapter in Volume 1 of the *Cyclone II Device Handbook*.

## PLLs

Cyclone II PLLs provide general-purpose clocking as well as support for the following features:

- Clock multiplication and division
- Phase shifting
- Programmable duty cycle
- Up to three internal clock outputs
- One dedicated external clock output
- Clock outputs for differential I/O support
- Manual clock switchover
- Gated lock signal
- Three different clock feedback modes
- Control signals

Cyclone II devices contain either two or four PLLs. [Table 2–3](#) shows the PLLs available for each Cyclone II device.

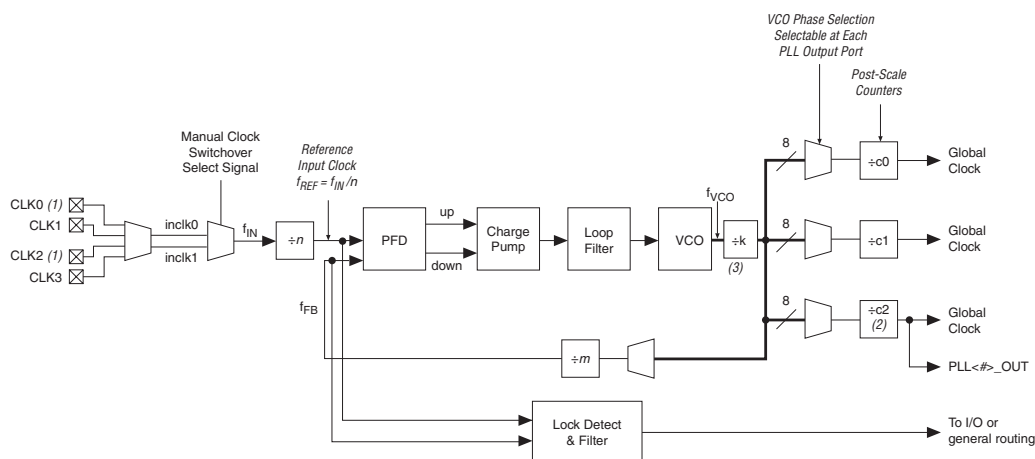
| <b><i>Table 2–3. Cyclone II Device PLL Availability</i></b> |             |             |             |             |
|-------------------------------------------------------------|-------------|-------------|-------------|-------------|
| <b>Device</b>                                               | <b>PLL1</b> | <b>PLL2</b> | <b>PLL3</b> | <b>PLL4</b> |
| EP2C5                                                       | ✓           | ✓           |             |             |
| EP2C8                                                       | ✓           | ✓           |             |             |
| EP2C15                                                      | ✓           | ✓           | ✓           | ✓           |
| EP2C20                                                      | ✓           | ✓           | ✓           | ✓           |
| EP2C35                                                      | ✓           | ✓           | ✓           | ✓           |
| EP2C50                                                      | ✓           | ✓           | ✓           | ✓           |
| EP2C70                                                      | ✓           | ✓           | ✓           | ✓           |

Table 2–4 describes the PLL features in Cyclone II devices.

| <b>Table 2–4. Cyclone II PLL Features</b> |                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|-------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Feature</b>                            | <b>Description</b>                                                                                                                                                                                                                                                                                                                                                                                                                |
| Clock multiplication and division         | $m / (n \times \text{post-scale counter})$<br>$m$ and post-scale counter values (C0 to C2) range from 1 to 32. $n$ ranges from 1 to 4.                                                                                                                                                                                                                                                                                            |
| Phase shift                               | Cyclone II PLLs have an advanced clock shift capability that enables programmable phase shifts in increments of at least 45°. The finest resolution of phase shifting is determined by the voltage control oscillator (VCO) period divided by 8 (for example, 1/1000 MHz/8 = down to 125-ps increments).                                                                                                                          |
| Programmable duty cycle                   | The programmable duty cycle allows PLLs to generate clock outputs with a variable duty cycle. This feature is supported on each PLL post-scale counter (C0-C2).                                                                                                                                                                                                                                                                   |
| Number of internal clock outputs          | The Cyclone II PLL has three outputs which can drive the global clock network. One of these outputs (C2) can also drive a dedicated PLL<#>_OUT pin (single ended or differential).                                                                                                                                                                                                                                                |
| Number of external clock outputs          | The C2 output drives a dedicated PLL<#>_OUT pin. If the C2 output is not used to drive an external clock output, it can be used to drive the internal global clock network. The C2 output can concurrently drive the external clock output and internal global clock network.                                                                                                                                                     |
| Manual clock switchover                   | The Cyclone II PLLs support manual switchover of the reference clock through internal logic. This enables you to switch between two reference input clocks during user mode for applications that may require clock redundancy or support for clocks with two different frequencies.                                                                                                                                              |
| Gated lock signal                         | The lock output indicates that there is a stable clock output signal in phase with the reference clock. Cyclone II PLLs include a programmable counter that holds the lock signal low for a user-selected number of input clock transitions, allowing the PLL to lock before enabling the locked signal. Either a gated locked signal or an ungated locked signal from the locked port can drive internal logic or an output pin. |
| Clock feedback modes                      | In zero delay buffer mode, the external clock output pin is phase-aligned with the clock input pin for zero delay.<br>In normal mode, the PLL compensates for the internal global clock network delay from the input clock pin to the clock port of the IOE output registers or registers in the logic array.<br>In no compensation mode, the PLL does not compensate for any clock networks.                                     |
| Control signals                           | The <code>pllenable</code> signal enables and disables the PLLs.<br>The <code>areset</code> signal resets/resynchronizes the inputs for each PLL.<br>The <code>pfdena</code> signal controls the phase frequency detector (PFD) output with a programmable gate.                                                                                                                                                                  |

Figure 2–16 shows a block diagram of the Cyclone II PLL.

**Figure 2–16. Cyclone II PLL** *Note (1)*



**Notes to Figure 2–16:**

- (1) This input can be single-ended or differential. If you are using a differential I/O standard, then two CLK pins are used. LVDS input is supported via the secondary function of the dedicated CLK pins. For example, the CLK0 pin's secondary function is LVDSCLK1p and the CLK1 pin's secondary function is LVDSCLK1n. If a differential I/O standard is assigned to the PLL clock input pin, the corresponding CLK (n) pin is also completely used. The Figure 2–16 shows the possible clock input connections (CLK0/CLK1) to PLL1.
- (2) This counter output is shared between a dedicated external clock output I/O and the global clock network.



For more information on Cyclone II PLLs, see the PLLs in the *Cyclone II Devices* chapter in Volume 1 of the *Cyclone II Device Handbook*.

## Embedded Memory

The Cyclone II embedded memory consists of columns of M4K memory blocks. The M4K memory blocks include input registers that synchronize writes and output registers to pipeline designs and improve system performance. The output registers can be bypassed, but input registers cannot.

Each M4K block can implement various types of memory with or without parity, including true dual-port, simple dual-port, and single-port RAM, ROM, and first-in first-out (FIFO) buffers. The M4K blocks support the following features:

- 4,608 RAM bits
- 250-MHz performance
- True dual-port memory
- Simple dual-port memory
- Single-port memory
- Byte enable
- Parity bits
- Shift register
- FIFO buffer
- ROM
- Various clock modes
- Address clock enable



Violating the setup or hold time on the memory block address registers could corrupt memory contents. This applies to both read and write operations.

Table 2–5 shows the capacity and distribution of the M4K memory blocks in each Cyclone II device.

| <b>Table 2–5. M4K Memory Capacity &amp; Distribution in Cyclone II Devices</b> |                    |                   |                       |
|--------------------------------------------------------------------------------|--------------------|-------------------|-----------------------|
| <b>Device</b>                                                                  | <b>M4K Columns</b> | <b>M4K Blocks</b> | <b>Total RAM Bits</b> |
| EP2C5                                                                          | 2                  | 26                | 119,808               |
| EP2C8                                                                          | 2                  | 36                | 165,888               |
| EP2C15                                                                         | 2                  | 52                | 239,616               |
| EP2C20                                                                         | 2                  | 52                | 239,616               |
| EP2C35                                                                         | 3                  | 105               | 483,840               |
| EP2C50                                                                         | 3                  | 129               | 594,432               |
| EP2C70                                                                         | 5                  | 250               | 1,152,000             |



Table 2–6 summarizes the features supported by the M4K memory.

| <b>Table 2–6. M4K Memory Features</b>                |                                                                                                                                                                                                                                                                    |
|------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Feature</b>                                       | <b>Description</b>                                                                                                                                                                                                                                                 |
| Maximum performance (1)                              | 250 MHz                                                                                                                                                                                                                                                            |
| Total RAM bits per M4K block (including parity bits) | 4,608                                                                                                                                                                                                                                                              |
| Configurations supported                             | 4K × 1<br>2K × 2<br>1K × 4<br>512 × 8<br>512 × 9<br>256 × 16<br>256 × 18<br>128 × 32 (not available in true dual-port mode)<br>128 × 36 (not available in true dual-port mode)                                                                                     |
| Parity bits                                          | One parity bit for each byte. The parity bit, along with internal user logic, can implement parity checking for error detection to ensure data integrity.                                                                                                          |
| Byte enable                                          | M4K blocks support byte writes when the write port has a data width of 1, 2, 4, 8, 9, 16, 18, 32, or 36 bits. The byte enables allow the input data to be masked so the device can write to specific bytes. The unwritten bytes retain the previous written value. |
| Packed mode                                          | Two single-port memory blocks can be packed into a single M4K block if each of the two independent block sizes are equal to or less than half of the M4K block size, and each of the single-port memory blocks is configured in single-clock mode.                 |
| Address clock enable                                 | M4K blocks support address clock enable, which is used to hold the previous address value for as long as the signal is enabled. This feature is useful in handling misses in cache applications.                                                                   |
| Memory initialization file (.mif)                    | When configured as RAM or ROM, you can use an initialization file to pre-load the memory contents.                                                                                                                                                                 |
| Power-up condition                                   | Outputs cleared                                                                                                                                                                                                                                                    |
| Register clears                                      | Output registers only                                                                                                                                                                                                                                              |
| Same-port read-during-write                          | New data available at positive clock edge                                                                                                                                                                                                                          |
| Mixed-port read-during-write                         | Old data available at positive clock edge                                                                                                                                                                                                                          |

**Note to Table 2–6:**

(1) Maximum performance information is preliminary until device characterization.

## Memory Modes

Table 2–7 summarizes the different memory modes supported by the M4K memory blocks.

| <b>Table 2–7. M4K Memory Modes</b> |                                                                                                                                                                                                 |
|------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Memory Mode</b>                 | <b>Description</b>                                                                                                                                                                              |
| Single-port memory                 | M4K blocks support single-port mode, used when simultaneous reads and writes are not required. Single-port memory supports non-simultaneous reads and writes.                                   |
| Simple dual-port memory            | Simple dual-port memory supports a simultaneous read and write.                                                                                                                                 |
| Simple dual-port with mixed width  | Simple dual-port memory mode with different read and write port widths.                                                                                                                         |
| True dual-port memory              | True dual-port mode supports any combination of two-port operations: two reads, two writes, or one read and one write at two different clock frequencies.                                       |
| True dual-port with mixed width    | True dual-port mode with different read and write port widths.                                                                                                                                  |
| Embedded shift register            | M4K memory blocks are used to implement shift registers. Data is written into each address location at the falling edge of the clock and read from the address at the rising edge of the clock. |
| ROM                                | The M4K memory blocks support ROM mode. A MIF initializes the ROM contents of these blocks.                                                                                                     |
| FIFO buffers                       | A single clock or dual clock FIFO may be implemented in the M4K blocks. Simultaneous read and write from an empty FIFO buffer is not supported.                                                 |



Embedded Memory can be inferred in your HDL code or directly instantiated in the Quartus II software using the MegaWizard® Plug-in Manager Memory Compiler feature.

## Clock Modes

Table 2–8 summarizes the different clock modes supported by the M4K memory.

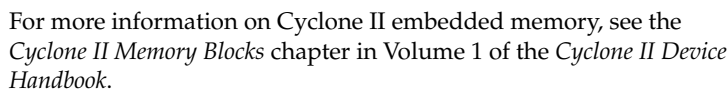
| <b>Table 2–8. M4K Clock Modes</b> |                                                                                                                                                                                                                   |
|-----------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Clock Mode</b>                 | <b>Description</b>                                                                                                                                                                                                |
| Independent                       | In this mode, a separate clock is available for each port (ports A and B). Clock A controls all registers on the port A side, while clock B controls all registers on the port B side.                            |
| Input/output                      | On each of the two ports, A or B, one clock controls all registers for inputs into the memory block: data input, <i>wren</i> , and address. The other clock controls the block's data output registers.           |
| Read/write                        | Up to two clocks are available in this mode. The write clock controls the block's data inputs, <i>wraddress</i> , and <i>wren</i> . The read clock controls the data output, <i>rdaddress</i> , and <i>rden</i> . |
| Single                            | In this mode, a single clock, together with clock enable, is used to control all registers of the memory block. Asynchronous clear signals for the registers are not supported.                                   |

Table 2–9 shows which clock modes are supported by all M4K blocks when configured in the different memory modes.

| <b>Table 2–9. Cyclone II M4K Memory Clock Modes</b> |                            |                              |                         |
|-----------------------------------------------------|----------------------------|------------------------------|-------------------------|
| <b>Clocking Modes</b>                               | <b>True Dual-Port Mode</b> | <b>Simple Dual-Port Mode</b> | <b>Single-Port Mode</b> |
| Independent                                         | ✓                          |                              |                         |
| Input/output                                        | ✓                          | ✓                            | ✓                       |
| Read/write                                          |                            | ✓                            |                         |
| Single clock                                        | ✓                          | ✓                            | ✓                       |

## M4K Routing Interface

The R4, C4, and direct link interconnects from adjacent LABs drive the M4K block local interconnect. The M4K blocks can communicate with LABs on either the left or right side through these row resources or with LAB columns on either the right or left with the column resources. Up to 16 direct link input connections to the M4K block are possible from the left adjacent LAB and another 16 possible from the right adjacent LAB. M4K block outputs can also connect to left and right LABs through each 16 direct link interconnects. Figure 2–17 shows the M4K block to logic array interface.



Cyclone II devices have embedded multiplier blocks optimized for multiplier-intensive digital signal processing (DSP) functions, such as finite impulse response (FIR) filters, fast Fourier transform (FFT) functions, and discrete cosine transform (DCT) functions. You can use the embedded multiplier in one of two basic operational modes, depending on the application needs:

- 2-32**  
**Cyclone II Device Handbook, Volume 1**

Embedded multipliers can operate at up to 250 MHz (for the fastest speed grade) for  $18 \times 18$  and  $9 \times 9$  multiplications when using both input and output registers.

Each Cyclone II device has one to three columns of embedded multipliers that efficiently implement multiplication functions. An embedded multiplier spans the height of one LAB row. Table 2–10 shows the number of embedded multipliers in each Cyclone II device and the multipliers that can be implemented.

| <b>Table 2–10. Number of Embedded Multipliers in Cyclone II Devices</b> <i>Note (1)</i> |                                    |                             |                                            |                                              |
|-----------------------------------------------------------------------------------------|------------------------------------|-----------------------------|--------------------------------------------|----------------------------------------------|
| <b>Device</b>                                                                           | <b>Embedded Multiplier Columns</b> | <b>Embedded Multipliers</b> | <b><math>9 \times 9</math> Multipliers</b> | <b><math>18 \times 18</math> Multipliers</b> |
| EP2C5                                                                                   | 1                                  | 13                          | 26                                         | 13                                           |
| EP2C8                                                                                   | 1                                  | 18                          | 36                                         | 18                                           |
| EP2C15                                                                                  | 1                                  | 26                          | 52                                         | 26                                           |
| EP2C20                                                                                  | 1                                  | 26                          | 52                                         | 26                                           |
| EP2C35                                                                                  | 1                                  | 35                          | 70                                         | 35                                           |
| EP2C50                                                                                  | 2                                  | 86                          | 172                                        | 86                                           |
| EP2C70                                                                                  | 3                                  | 150                         | 300                                        | 150                                          |

**Note to Table 2–10:**

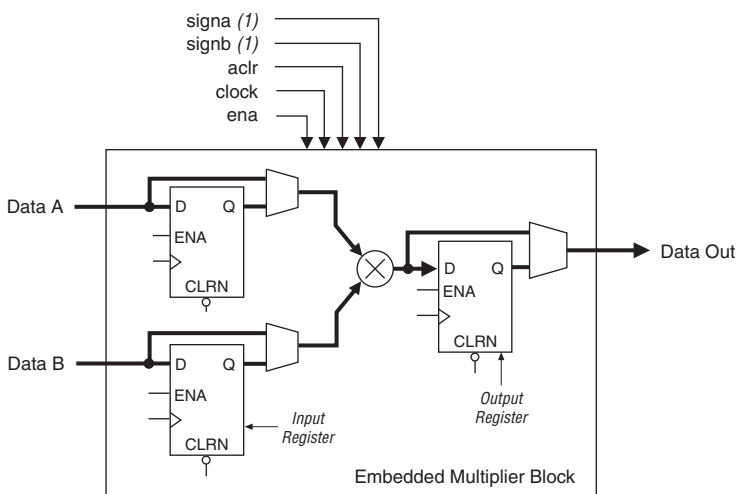
- (1) Each device has either the number of  $9 \times 9$ -, or  $18 \times 18$ -bit multipliers shown. The total number of multipliers for each device is not the sum of all the multipliers.

The embedded multiplier consists of the following elements:

- Multiplier block
- Input and output registers
- Input and output interfaces

Figure 2–18 shows the multiplier block architecture.

**Figure 2–18. Multiplier Block Architecture**



**Note to Figure 2–18:**

- (1) If necessary, these signals can be registered once to match the data signal path.

Each multiplier operand can be a unique signed or unsigned number. Two signals, `signa` and `signb`, control the representation of each operand respectively. A logic 1 value on the `signa` signal indicates that data A is a signed number while a logic 0 value indicates an unsigned number. Table 2–11 shows the sign of the multiplication result for the various operand sign representations. The result of the multiplication is signed if any one of the operands is a signed value.

| <b>Table 2–11. Multiplier Sign Representation</b> |                             |               |
|---------------------------------------------------|-----------------------------|---------------|
| <b>Data A (signa Value)</b>                       | <b>Data B (signb Value)</b> | <b>Result</b> |
| Unsigned                                          | Unsigned                    | Unsigned      |
| Unsigned                                          | Signed                      | Signed        |
| Signed                                            | Unsigned                    | Signed        |
| Signed                                            | Signed                      | Signed        |

There is only one `signa` and one `signb` signal for each dedicated multiplier. Therefore, all of the data A inputs feeding the same dedicated multiplier must have the same sign representation. Similarly, all of the data B inputs feeding the same dedicated multiplier must have the same sign representation. The `signa` and `signb` signals can be changed dynamically to modify the sign representation of the input operands at run time. The multiplier offers full precision regardless of the sign representation and can be registered using dedicated registers located at the input register stage.

## Multiplier Modes

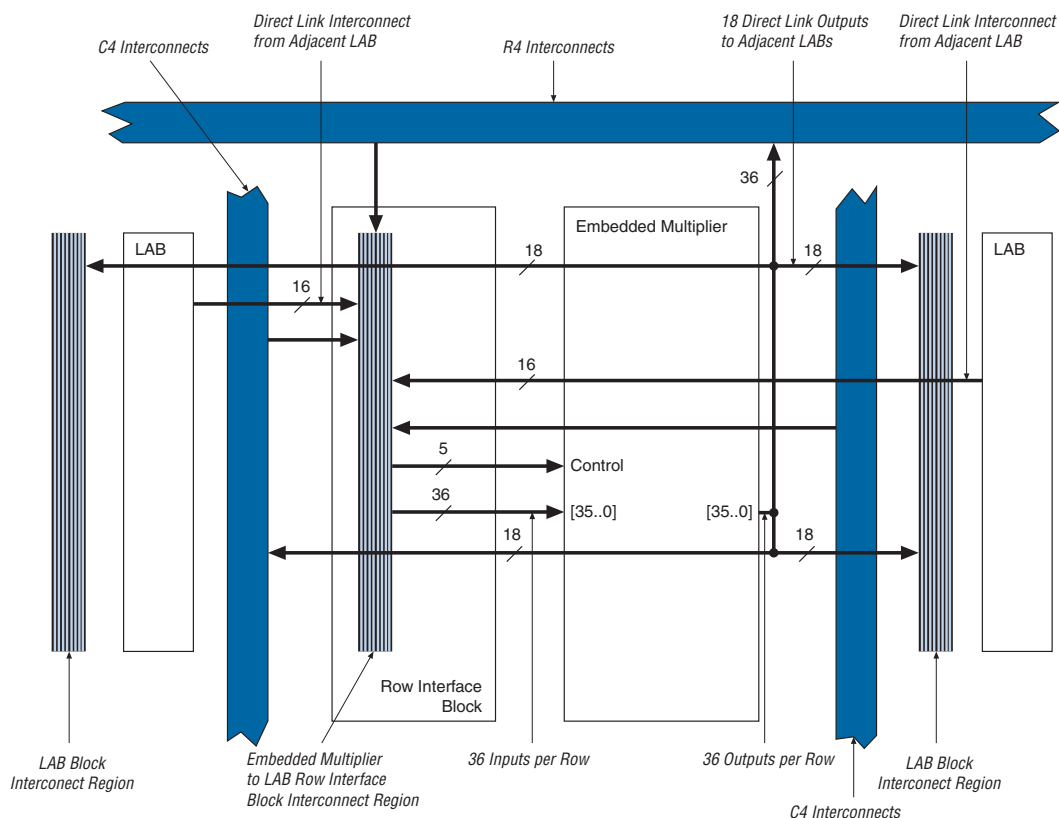
Table 2–12 summarizes the different modes that the embedded multipliers can operate in.

| <b>Table 2–12. Embedded Multiplier Modes</b> |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|----------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Multiplier Mode</b>                       | <b>Description</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 18-bit Multiplier                            | An embedded multiplier can be configured to support a single $18 \times 18$ multiplier for operand widths up to 18 bits. All 18-bit multiplier inputs and results can be registered independently. The multiplier operands can accept signed integers, unsigned integers, or a combination of both.                                                                                                                                                                                                                                                                           |
| 9-bit Multiplier                             | An embedded multiplier can be configured to support two $9 \times 9$ independent multipliers for operand widths up to 9-bits. Both 9-bit multiplier inputs and results can be registered independently. The multiplier operands can accept signed integers, unsigned integers or a combination of both.<br><br>There is only one <code>signa</code> signal to control the sign representation of both data A inputs and one <code>signb</code> signal to control the sign representation of both data B inputs of the 9-bit multipliers within the same dedicated multiplier. |

## Embedded Multiplier Routing Interface

The R4, C4, and direct link interconnects from adjacent LABs drive the embedded multiplier row interface interconnect. The embedded multipliers can communicate with LABs on either the left or right side through these row resources or with LAB columns on either the right or left with the column resources. Up to 16 direct link input connections to the embedded multiplier are possible from the left adjacent LABs and another 16 possible from the right adjacent LAB. Embedded multiplier outputs can also connect to left and right LABs through 18 direct link interconnects each. Figure 2-19 shows the embedded multiplier to logic array interface.

**Figure 2-19. Embedded Multiplier LAB Row Interface**





There are five dynamic control input signals that feed the embedded multiplier: `signa`, `signb`, `clk`, `clkena`, and `aclr`. `signa` and `signb` can be registered to match the data signal input path. The same `clk`, `clkena`, and `aclr` signals feed all registers within a single embedded multiplier.



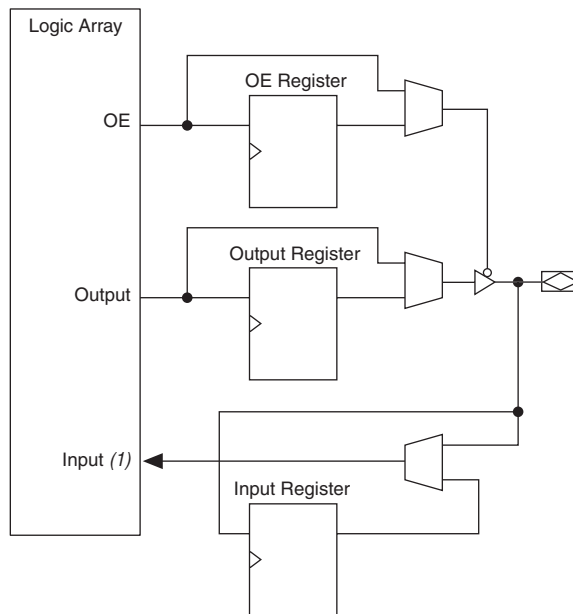
For more information on Cyclone II embedded multipliers, see the *Embedded Multipliers in Cyclone II Devices* chapter.

## I/O Structure & Features

IOEs support many features, including:

- Differential and single-ended I/O standards
- 3.3-V, 64- and 32-bit, 66- and 33-MHz PCI compliance
- Joint Test Action Group (JTAG) boundary-scan test (BST) support
- Output drive strength control
- Weak pull-up resistors during configuration
- Tri-state buffers
- Bus-hold circuitry
- Programmable pull-up resistors in user mode
- Programmable input and output delays
- Open-drain outputs
- DQ and DQS I/O pins
- $V_{REF}$  pins

Cyclone II device IOEs contain a bidirectional I/O buffer and three registers for complete embedded bidirectional single data rate transfer. [Figure 2–20](#) shows the Cyclone II IOE structure. The IOE contains one input register, one output register, and one output enable register. You can use the input registers for fast setup times and output registers for fast clock-to-output times. Additionally, you can use the output enable (OE) register for fast clock-to-output enable timing. The Quartus II software automatically duplicates a single OE register that controls multiple output or bidirectional pins. You can use IOEs as input, output, or bidirectional pins.

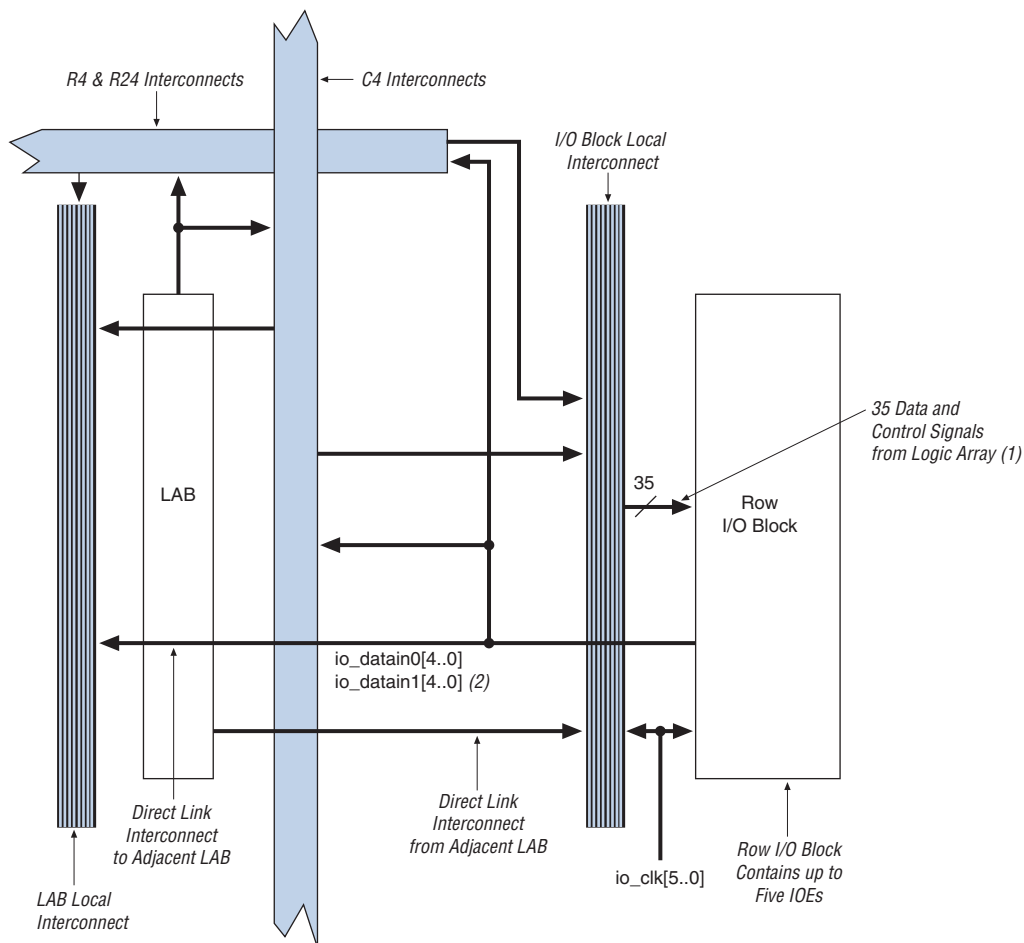
**Figure 2–20. Cyclone II IOE Structure****Note to Figure 2–20:**

- (1) There are two paths available for combinational or registered inputs to the logic array. Each path contains a unique programmable delay chain.

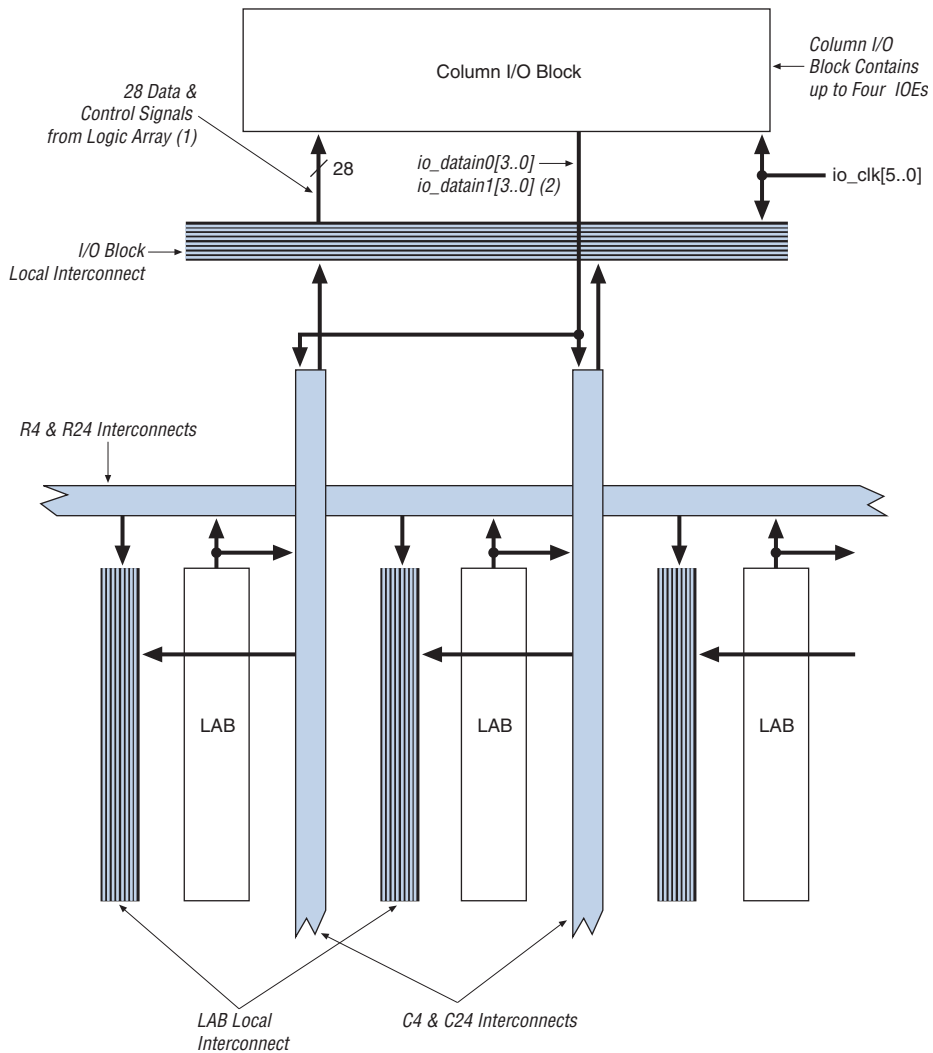
The IOEs are located in I/O blocks around the periphery of the Cyclone II device. There are up to five IOEs per row I/O block and up to four IOEs per column I/O block (column I/O blocks span two columns). The row I/O blocks drive row, column (only C4 interconnects), or direct link interconnects. The column I/O blocks drive column interconnects.

Figure 2–21 shows how a row I/O block connects to the logic array.

Figure 2–22 shows how a column I/O block connects to the logic array.

**Figure 2–21. Row I/O Block Connection to the Interconnect****Notes to Figure 2–21:**

- (1) The 35 data and control signals consist of five data out lines, `io_dataout[4..0]`, five output enables, `io_coe[4..0]`, five input clock enables, `io_cce_in[4..0]`, five output clock enables, `io_cce_out[4..0]`, five clocks, `io_cclk[4..0]`, five asynchronous clear signals, `io_caclr[4..0]`, and five synchronous clear signals, `io_csclr[4..0]`.
- (2) Each of the five IOEs in the row I/O block can have two `io_datain` (combinational or registered) inputs.

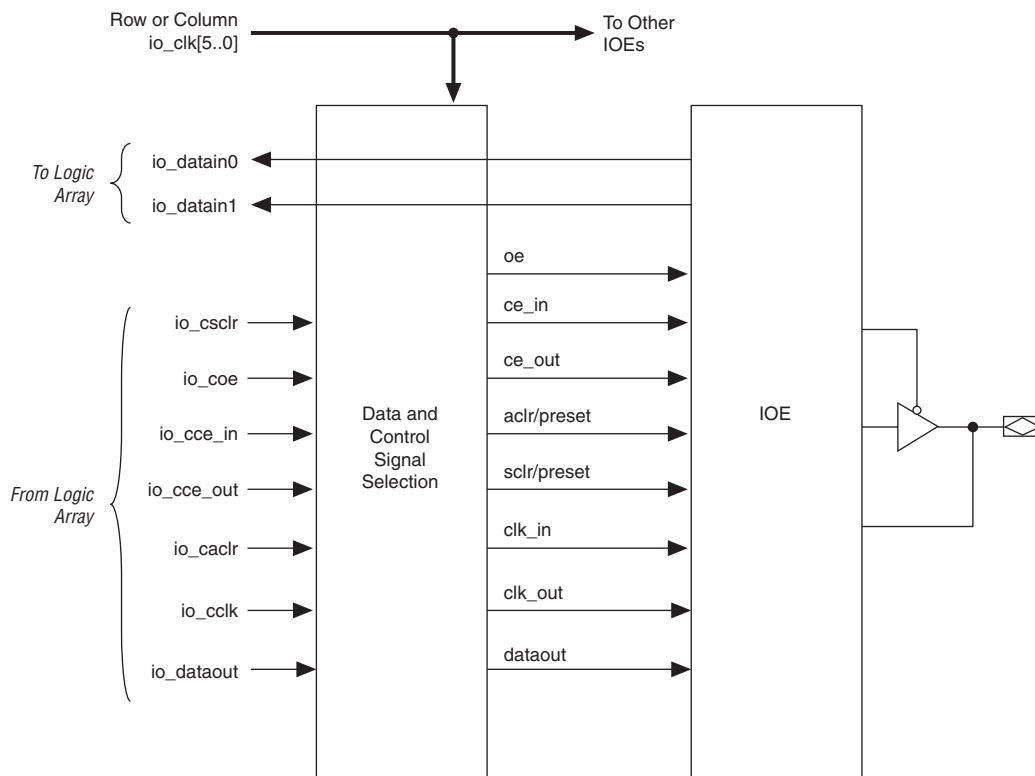
**Figure 2–22. Column I/O Block Connection to the Interconnect****Notes to Figure 2–22:**

- (1) The 28 data and control signals consist of four data out lines,  $io\_dataout[3..0]$ , four output enables,  $io\_coe[3..0]$ , four input clock enables,  $io\_cce\_in[3..0]$ , four output clock enables,  $io\_cce\_out[3..0]$ , four clocks,  $io\_clk[3..0]$ , four asynchronous clear signals,  $io\_cac1r[3..0]$ , and four synchronous clear signals,  $io\_csc1r[3..0]$ .
- (2) Each of the four IOEs in the column I/O block can have two  $io\_datain$  (combinational or registered) inputs.

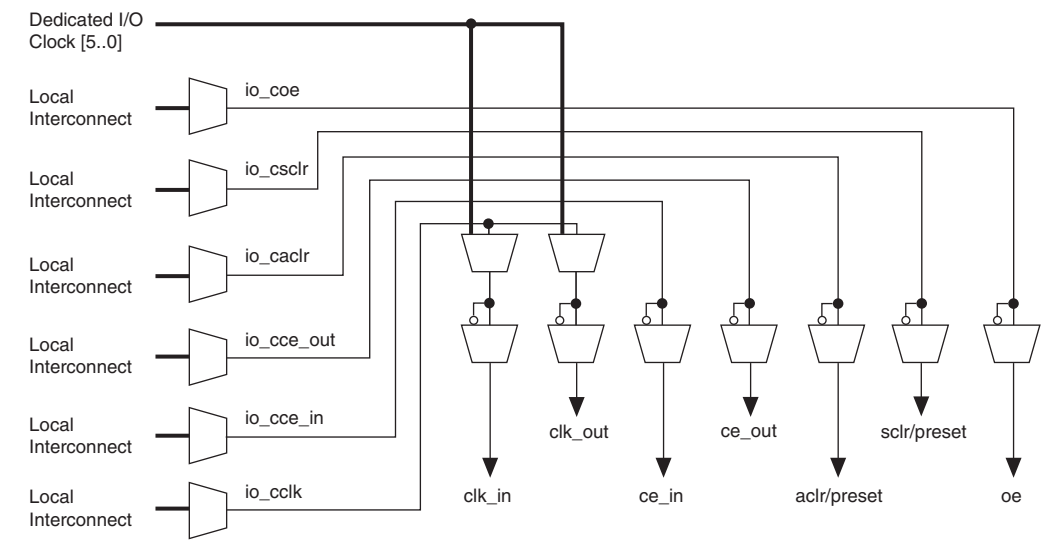
The pin's data in signals can drive the logic array. The logic array drives the control and data signals, providing a flexible routing resource. The row or column IOE clocks, `io_clk[5..0]`, provide a dedicated routing resource for low-skew, high-speed clocks. The global clock network generates the IOE clocks that feed the row or column I/O regions (see “Global Clock Network & Phase-Locked Loops” on page 2-16).

Figure 2-23 illustrates the signal paths through the I/O block.

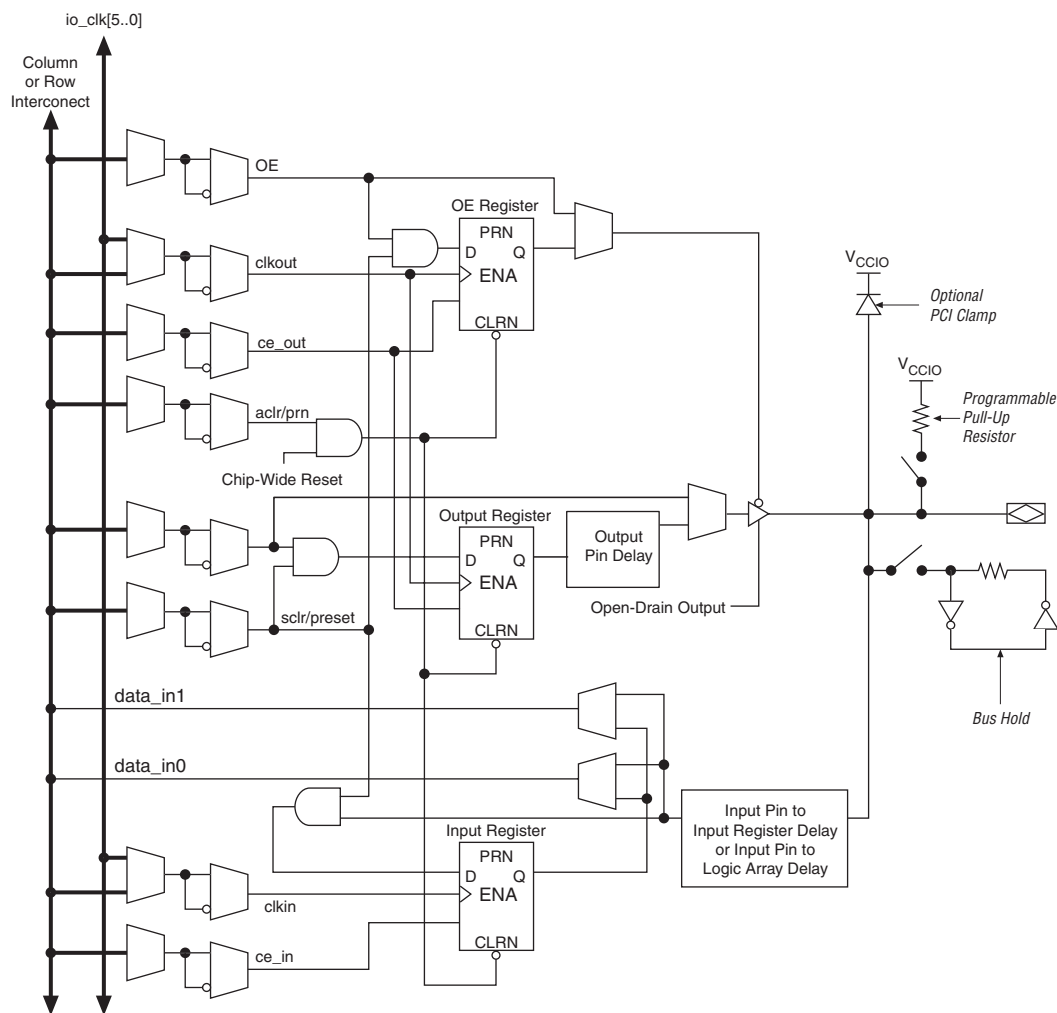
**Figure 2-23. Signal Path Through the I/O Block**



Each IOE contains its own control signal selection for the following control signals: `oe`, `ce_in`, `ce_out`, `aclr/preset`, `sclr/preset`, `clk_in`, and `clk_out`. Figure 2-24 illustrates the control signal selection.

**Figure 2–24. Control Signal Selection per IOE**

In normal bidirectional operation, you can use the input register for input data requiring fast setup times. The input register can have its own clock input and clock enable separate from the OE and output registers. You can use the output register for data requiring fast clock-to-output performance. The OE register is available for fast clock-to-output enable timing. The OE and output register share the same clock source and the same clock enable source from the local interconnect in the associated LAB, dedicated I/O clocks, or the column and row interconnects. All registers share **sclr** and **aclr**, but each register can individually disable **sclr** and **aclr**. [Figure 2–25](#) shows the IOE in bidirectional configuration.

**Figure 2–25. Cyclone II IOE in Bidirectional I/O Configuration**

The Cyclone II device IOE includes programmable delays to ensure zero hold times, minimize setup times, or increase clock to output times.

A path in which a pin directly drives a register may require a programmable delay to ensure zero hold time, whereas a path in which a pin drives a register through combinational logic may not require the delay. Programmable delays decrease input-pin-to-logic-array and IOE input register delays. The Quartus II Compiler can program these delays to automatically minimize setup time while providing a zero hold time.

Programmable delays can increase the register-to-pin delays for output registers. Table 2–13 shows the programmable delays for Cyclone II devices.

| <b>Table 2–13. Cyclone II Programmable Delay Chain</b> |                                          |
|--------------------------------------------------------|------------------------------------------|
| <b>Programmable Delays</b>                             | <b>Quartus II Logic Option</b>           |
| Input pin to logic array delay                         | Input delay from pin to internal cells   |
| Input pin to input register delay                      | Input delay from pin to input register   |
| Output pin delay                                       | Delay from output register to output pin |

There are two paths in the IOE for an input to reach the logic array. Each of the two paths can have a different delay. This allows you to adjust delays from the pin to internal LE registers that reside in two different areas of the device. You set the two combinational input delays by selecting different delays for two different paths under the **Input delay from pin to internal cells logic** option in the Quartus II software. However, if the pin uses the input register, one of delays is disregarded because the IOE only has two paths to internal logic. If the input register is used, the IOE uses one input path. The other input path is then available for the combinational path, and only one input delay assignment is applied.

The IOE registers in each I/O block share the same source for clear or preset. You can program preset or clear for each individual IOE, but both features cannot be used simultaneously. You can also program the registers to power up high or low after configuration is complete. If programmed to power up low, an asynchronous clear can control the registers. If programmed to power up high, an asynchronous preset can control the registers. This feature prevents the inadvertent activation of another device's active-low input upon power up. If one register in an IOE uses a preset or clear signal then all registers in the IOE must use that same signal if they require preset or clear. Additionally a synchronous reset signal is available for the IOE registers.

## External Memory Interfacing

Cyclone II devices support a broad range of external memory interfaces such as SDR SDRAM, DDR SDRAM, DDR2 SDRAM, and QDR II SRAM external memories. Cyclone II devices feature dedicated high-speed interfaces that transfer data between external memory devices at up to 167 MHz/333 Mbps for DDR and DDR2 SDRAM devices and 167 MHz/667 Mbps for QDR II SRAM devices. The programmable DQS delay chain allows you to fine tune the phase shift for the input clocks or strobes to properly align clock edges as needed to capture data.



In Cyclone II devices, all the I/O banks support SDR and DDR SDRAM memory up to 167 MHz/333 Mbps. All I/O banks support DQS signals with the DQ bus modes of  $\times 8/\times 9$ , or  $\times 16/\times 18$ . Table 2–14 shows the external memory interfaces supported in Cyclone II devices.

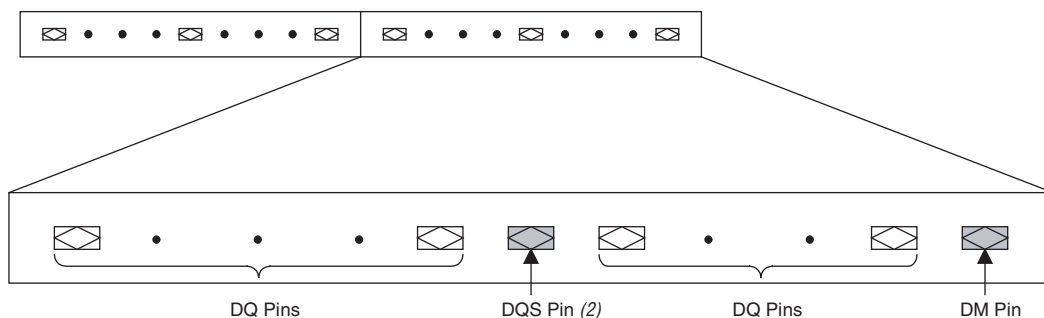
**Table 2–14. External Memory Support in Cyclone II Devices** *Note (1)*

| Memory Standard | I/O Standard            | Maximum Bus Width | Maximum Clock Rate Supported (MHz) | Maximum Data Rate Supported (Mbps) |
|-----------------|-------------------------|-------------------|------------------------------------|------------------------------------|
| SDR SDRAM       | LVTTTL (2)              | 72                | 167                                | 167                                |
| DDR SDRAM       | SSTL-2 class I (2)      | 72                | 167                                | 333 (1)                            |
|                 | SSTL-2 class II (2)     | 72                | 133                                | 267 (1)                            |
| DDR2 SDRAM      | SSTL-18 class I (2)     | 72                | 167                                | 333 (1)                            |
|                 | SSTL-18 class II (3)    | 72                | 125                                | 250 (1)                            |
| QDRII SRAM (4)  | 1.8-V HSTL class I (2)  | 36                | 167                                | 668 (1)                            |
|                 | 1.8-V HSTL class II (3) | 36                | 100                                | 400 (1)                            |

**Notes to Table 2–14:**

- (1) The data rate is for designs using the Clock Delay Control circuitry.
- (2) The I/O standards are supported on all the I/O banks of the Cyclone II device.
- (3) The I/O standards are supported only on the I/O banks on the top and bottom of the Cyclone II device.
- (4) For maximum performance, Altera recommends using the 1.8-V HSTL I/O standard because of higher I/O drive strength. QDRII SRAM devices also support the 1.5-V HSTL I/O standard.

Cyclone II devices use data (DQ), data strobe (DQS), and clock pins to interface with external memory. Figure 2–26 shows the DQ and DQS pins in the  $\times 8/\times 9$  mode.

**Figure 2–26. Cyclone II Device DQ & DQS Groups in  $\times 8/\times 9$  Mode** *Notes (1), (2)***Notes to Figure 2–26:**

- (1) Each DQ group consists of a DQS pin, DM pin, and up to nine DQ pins.
- (2) This is an idealized pin layout. For actual pin layout, refer to the pin table.

Cyclone II devices support the data strobe or read clock signal (DQS) used in DDR and DDR2 SDRAM. Cyclone II devices can use either bidirectional data strobes or unidirectional read clocks. The dedicated external memory interface in Cyclone II devices also includes programmable delay circuitry that can shift the incoming DQS signals to center align the DQS signals within the data window.

The DQS signal is usually associated with a group of data (DQ) pins. The phase-shifted DQS signals drive the global clock network, which is used to clock the DQ signals on internal LE registers.

Table 2–15 shows the number of DQ pin groups per device.

**Table 2–15. Cyclone II DQS & DQ Bus Mode Support (Part 1 of 2)** *Note (1)*

| Device | Package               | Number of $\times 8$ Groups | Number of $\times 9$ Groups (5), (6) | Number of $\times 16$ Groups | Number of $\times 18$ Groups (5), (6) |
|--------|-----------------------|-----------------------------|--------------------------------------|------------------------------|---------------------------------------|
| EP2C5  | 144-pin TQFP (2)      | 3                           | 3                                    | 0                            | 0                                     |
|        | 208-pin PQFP          | 7 (3)                       | 4                                    | 3                            | 3                                     |
| EP2C8  | 144-pin TQFP (2)      | 3                           | 3                                    | 0                            | 0                                     |
|        | 208-pin PQFP          | 7 (3)                       | 4                                    | 3                            | 3                                     |
|        | 256-pin FineLine BGA® | 8 (3)                       | 4                                    | 4                            | 4                                     |
| EP2C15 | 256-pin FineLine BGA  | 8                           | 4                                    | 4                            | 4                                     |
|        | 484-pin FineLine BGA  | 16 (4)                      | 8                                    | 8                            | 8                                     |
| EP2C20 | 256-pin FineLine BGA  | 8                           | 4                                    | 4                            | 4                                     |
|        | 484-pin FineLine BGA  | 16 (4)                      | 8                                    | 8                            | 8                                     |

**Table 2–15. Cyclone II DQS & DQ Bus Mode Support (Part 2 of 2)** *Note (1)*

| Device | Package              | Number of $\times 8$ Groups | Number of $\times 9$ Groups (5), (6) | Number of $\times 16$ Groups | Number of $\times 18$ Groups (5), (6) |
|--------|----------------------|-----------------------------|--------------------------------------|------------------------------|---------------------------------------|
| EP2C35 | 484-pin FineLine BGA | 16 (4)                      | 8                                    | 8                            | 8                                     |
|        | 672-pin FineLine BGA | 20 (4)                      | 8                                    | 8                            | 8                                     |
| EP2C50 | 484-pin FineLine BGA | 16 (4)                      | 8                                    | 8                            | 8                                     |
|        | 672-pin FineLine BGA | 20 (4)                      | 8                                    | 8                            | 8                                     |
| EP2C70 | 672-pin FineLine BGA | 20 (4)                      | 8                                    | 8                            | 8                                     |
|        | 896-pin FineLine BGA | 20 (4)                      | 8                                    | 8                            | 8                                     |

**Notes to Table 2–15:**

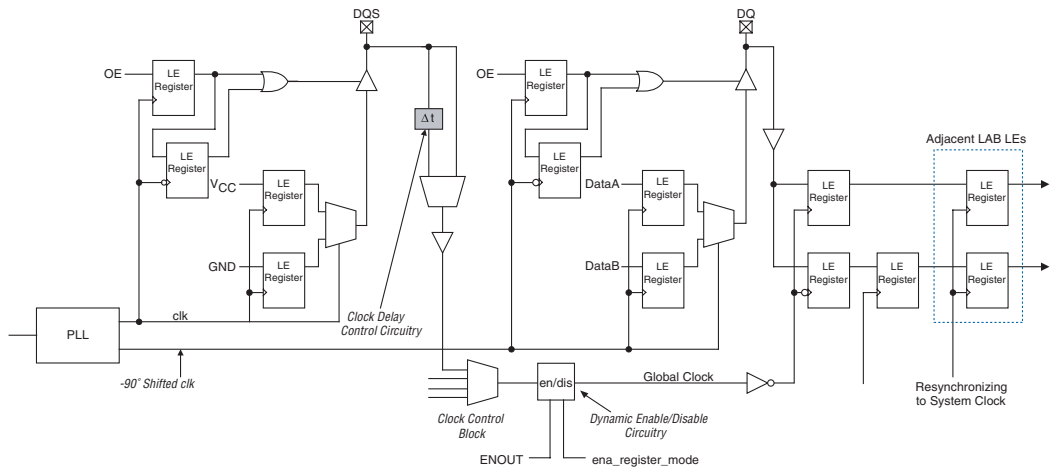
- (1) Numbers are preliminary.
- (2) EP2C5 and EP2C8 devices in the 144-pin TQFP package do not have any DQ pin groups in I/O bank 1.
- (3) Because of available clock resources, only a total of 6 DQ/DQS groups can be implemented.
- (4) Because of available clock resources, only a total of 14 DQ/DQS groups can be implemented.
- (5) The  $\times 9$  DQS/DQ groups are also used as  $\times 8$  DQS/DQ groups. The  $\times 18$  DQS/DQ groups are also used as  $\times 16$  DQS/DQ groups.
- (6) For QDRI implementation, if you connect the D ports (write data) to the Cyclone II DQ pins, the total available  $\times 9$  DQS /DQ and  $\times 18$  DQS/DQ groups are half of that shown in Table 2–15.

You can use any of the DQ pins for the parity pins in Cyclone II devices. The Cyclone II device family supports parity in the  $\times 8/\times 9$ , and  $\times 16/\times 18$  mode. There is one parity bit available per eight bits of data pins.

The data mask, DM, pins are required when writing to DDR SDRAM and DDR2 SDRAM devices. A low signal on the DM pin indicates that the write is valid. If the DM signal is high, the memory masks the DQ signals. In Cyclone II devices, the DM pins are assigned and are the preferred pins. Each group of DQS and DQ signals requires a DM pin.

When using the Cyclone II I/O banks to interface with the DDR memory, at least one PLL with two clock outputs is needed to generate the system and write clock. The system clock is used to clock the DQS write signals, commands, and addresses. The write clock is shifted by  $-90^\circ$  from the system clock and is used to clock the DQ signals during writes.

Figure 2–27 illustrates DDR SDRAM interfacing from the I/O through the dedicated circuitry to the logic array.

**Figure 2–27. DDR SDRAM Interfacing**

For more information on Cyclone II external memory interfaces, see the *External Memory Interfaces* chapter in Volume 1 of the *Cyclone II Device Handbook*.

## Programmable Drive Strength

The output buffer for each Cyclone II device I/O pin has a programmable drive strength control for certain I/O standards. The LVTTL, LVCMOS, SSTL-2 class I and II, SSTL-18 class I and II, HSTL-18 class I and II, and HSTL-1.5 class I and II standards have several levels of drive strength that you can control. Using minimum settings provides signal slew rate control to reduce system noise and signal overshoot. Table 2–16 shows the possible settings for the I/O standards with drive strength control.

| <b>Table 2–16. Programmable Drive Strength (Part 1 of 2)</b> <i>Note (1)</i> |                                                                    |                      |
|------------------------------------------------------------------------------|--------------------------------------------------------------------|----------------------|
| <b>I/O Standard</b>                                                          | <b>I<sub>OH</sub>/I<sub>OL</sub> Current Strength Setting (mA)</b> |                      |
|                                                                              | <b>Top &amp; Bottom I/O Pins</b>                                   | <b>Side I/O Pins</b> |
| LVTTL (3.3 V)                                                                | 4                                                                  | 4                    |
|                                                                              | 8                                                                  | 8                    |
|                                                                              | 12                                                                 | 12                   |
|                                                                              | 16                                                                 | 16                   |
|                                                                              | 20                                                                 | 20                   |
|                                                                              | 24                                                                 | 24                   |
| LVCMOS (3.3 V)                                                               | 4                                                                  | 4                    |
|                                                                              | 8                                                                  | 8                    |
|                                                                              | 12                                                                 | 12                   |
|                                                                              | 16                                                                 |                      |
|                                                                              | 20                                                                 |                      |
|                                                                              | 24                                                                 |                      |
| LVTTL/LVCMOS (2.5 V)                                                         | 4                                                                  | 4                    |
|                                                                              | 8                                                                  | 8                    |
|                                                                              | 12                                                                 |                      |
|                                                                              | 16                                                                 |                      |
| LVTTL/LVCMOS (1.8 V)                                                         | 2                                                                  | 2                    |
|                                                                              | 4                                                                  | 4                    |
|                                                                              | 6                                                                  | 6                    |
|                                                                              | 8                                                                  | 8                    |
|                                                                              | 10                                                                 | 10                   |
|                                                                              | 12                                                                 | 12                   |

**Table 2–16. Programmable Drive Strength (Part 2 of 2)** *Note (1)*

| I/O Standard     | I <sub>OH</sub> /I <sub>OL</sub> Current Strength Setting (mA) |               |
|------------------|----------------------------------------------------------------|---------------|
|                  | Top & Bottom I/O Pins                                          | Side I/O Pins |
| LVCMOS (1.5 V)   | 2                                                              | 2             |
|                  | 4                                                              | 4             |
|                  | 6                                                              | 6             |
|                  | 8                                                              |               |
| SSTL-2 class I   | 8                                                              | 8             |
|                  | 12                                                             | 12            |
| SSTL-2 class II  | 16                                                             | 16            |
|                  | 20                                                             |               |
|                  | 24                                                             |               |
| SSTL-18 class I  | 6                                                              | 6             |
|                  | 8                                                              | 8             |
|                  | 10                                                             | 10            |
|                  | 12                                                             |               |
| SSTL-18 class II | 16                                                             |               |
|                  | 18                                                             |               |
| HSTL-18 class I  | 8                                                              | 8             |
|                  | 10                                                             | 10            |
|                  | 12                                                             | 12            |
| HSTL-18 class II | 16                                                             |               |
|                  | 18                                                             |               |
|                  | 20                                                             |               |
| HSTL-15 class I  | 8                                                              | 8             |
|                  | 10                                                             |               |
|                  | 12                                                             |               |
| HSTL-15 class II | 16                                                             |               |

**Note to Table 2–16:**

- (1) The default current in the Quartus II software is the maximum setting for each I/O standard.

## Open-Drain Output

Cyclone II devices provide an optional open-drain (equivalent to an open-collector) output for each I/O pin. This open-drain output enables the device to provide system-level control signals (that is, interrupt and write-enable signals) that can be asserted by any of several devices.

## Slew Rate Control

Slew rate control is performed by using programmable output drive strength.

## Bus Hold

Each Cyclone II device user I/O pin provides an optional bus-hold feature. The bus-hold circuitry can hold the signal on an I/O pin at its last-driven state. Since the bus-hold feature holds the last-driven state of the pin until the next input signal is present, an external pull-up or pull-down resistor is not necessary to hold a signal level when the bus is tri-stated.

The bus-hold circuitry also pulls undriven pins away from the input threshold voltage where noise can cause unintended high-frequency switching. You can select this feature individually for each I/O pin. The bus-hold output drives no higher than  $V_{CCIO}$  to prevent overdriving signals.



If the bus-hold feature is enabled, the device cannot use the programmable pull-up option. Disable the bus-hold feature when the I/O pin is configured for differential signals. Bus hold circuitry is not available on the dedicated clock pins.

The bus-hold circuitry is only active after configuration. When going into user mode, the bus-hold circuit captures the value on the pin present at the end of configuration.

The bus-hold circuitry uses a resistor with a nominal resistance ( $R_{BH}$ ) of approximately 7 k $\Omega$  to pull the signal level to the last-driven state. Refer to the *DC Characteristics & Timing Specifications* chapter in Volume 1 of the *Cyclone II Device Handbook* for the specific sustaining current for each  $V_{CCIO}$  voltage level driven through the resistor and overdrive current used to identify the next driven input level.

## Programmable Pull-Up Resistor

Each Cyclone II device I/O pin provides an optional programmable pull-up resistor during user mode. If you enable this feature for an I/O pin, the pull-up resistor (typically 25 k $\Omega$ ) holds the output to the  $V_{CCIO}$  level of the output pin's bank.



If the programmable pull-up is enabled, the device cannot use the bus-hold feature. The programmable pull-up resistors are not supported on the dedicated configuration, JTAG, and dedicated clock pins.

## Advanced I/O Standard Support

Table 2–17 shows the I/O standards supported by Cyclone II devices and which I/O pins support them.

| <b>Table 2–17. Cyclone II Supported I/O Standards &amp; Constraints (Part 1 of 2)</b> |                         |                         |        |                       |               |               |         |               |
|---------------------------------------------------------------------------------------|-------------------------|-------------------------|--------|-----------------------|---------------|---------------|---------|---------------|
| I/O Standard                                                                          | Type                    | V <sub>CCIO</sub> Level |        | Top & Bottom I/O Pins |               | Side I/O Pins |         |               |
|                                                                                       |                         | Input                   | Output | CLK, DQS              | User I/O Pins | CLK, DQS      | PLL_OUT | User I/O Pins |
| 3.3-V LVTTTL and LVCMOS (1)                                                           | Single ended            | 3.3 V / 2.5 V           | 3.3 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| 2.5-V LVTTTL and LVCMOS                                                               | Single ended            | 3.3 V / 2.5 V           | 2.5 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| 1.8-V LVTTTL and LVCMOS                                                               | Single ended            | 1.8 V / 1.5 V           | 1.8 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| 1.5-V LVCMOS                                                                          | Single ended            | 1.8 V / 1.5 V           | 1.5 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| SSTL-2 class I                                                                        | Voltage referenced      | 2.5 V                   | 2.5 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| SSTL-2 class II                                                                       | Voltage referenced      | 2.5 V                   | 2.5 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| SSTL-18 class I                                                                       | Voltage referenced      | 1.8 V                   | 1.8 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| SSTL-18 class II                                                                      | Voltage referenced      | 1.8 V                   | 1.8 V  | ✓                     | ✓             | (2)           | (2)     | (2)           |
| HSTL-18 class I                                                                       | Voltage referenced      | 1.8 V                   | 1.8 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| HSTL-18 class II                                                                      | Voltage referenced      | 1.8 V                   | 1.8 V  | ✓                     | ✓             | (2)           | (2)     | (2)           |
| HSTL-15 class I                                                                       | Voltage referenced      | 1.5 V                   | 1.5 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| HSTL-15 class II                                                                      | Voltage referenced      | 1.5 V                   | 1.5 V  | ✓                     | ✓             | (2)           | (2)     | (2)           |
| PCI and PCI-X (1) (3)                                                                 | Single ended            | 3.3 V                   | 3.3 V  |                       |               | ✓             | ✓       | ✓             |
| Differential SSTL-2 class I or class II                                               | Pseudo differential (4) | (5)                     | 2.5 V  |                       |               |               | ✓       |               |
|                                                                                       |                         | 2.5 V                   | (5)    | ✓ (6)                 |               | ✓ (6)         |         |               |
| Differential SSTL-18 class I or class II                                              | Pseudo differential (4) | (5)                     | 1.8 V  |                       |               |               | ✓ (7)   |               |
|                                                                                       |                         | 1.8 V                   | (5)    | ✓ (6)                 |               | ✓ (6)         |         |               |



**Table 2–17. Cyclone II Supported I/O Standards & Constraints (Part 2 of 2)**

| I/O Standard                             | Type                    | V <sub>CCIO</sub> Level             |        | Top & Bottom I/O Pins |               | Side I/O Pins |         |               |
|------------------------------------------|-------------------------|-------------------------------------|--------|-----------------------|---------------|---------------|---------|---------------|
|                                          |                         | Input                               | Output | CLK, DQS              | User I/O Pins | CLK, DQS      | PLL_OUT | User I/O Pins |
| Differential HSTL-15 class I or class II | Pseudo differential (4) | (5)                                 | 1.5 V  |                       |               |               | ✓ (7)   |               |
|                                          |                         | 1.5 V                               | (5)    | ✓ (6)                 |               | ✓ (6)         |         |               |
| Differential HSTL-18 class I or class II | Pseudo differential (4) | (5)                                 | 1.8 V  |                       |               |               | ✓ (7)   |               |
|                                          |                         | 1.8 V                               | (5)    | ✓ (6)                 |               | ✓ (6)         |         |               |
| LVDS                                     | Differential            | 2.5 V                               | 2.5 V  | ✓                     | ✓             | ✓             | ✓       | ✓             |
| RSDS and mini-LVDS (8)                   | Differential            | (5)                                 | 2.5 V  |                       | ✓             |               | ✓       | ✓             |
| LVPECL (9)                               | Differential            | 3.3 V/<br>2.5 V/<br>1.8 V/<br>1.5 V | (5)    | ✓                     |               | ✓             |         |               |

**Notes to Table 2–17:**

- (1) To drive inputs higher than V<sub>CCIO</sub> but less than 4.0 V, disable the PCI clamping diode and turn on the **Allow LVTTTL and LVCMOS input levels to overdrive input buffer** option in the Quartus II software.
- (2) These pins support SSTL-18 class II and 1.8- and 1.5-V HSTL class II inputs.
- (3) PCI-X does not meet the IV curve requirement at the linear region. PCI-clamp diode is not available on top and bottom I/O pins.
- (4) Pseudo-differential HSTL and SSTL outputs use two single-ended outputs with the second output programmed as inverted. Pseudo-differential HSTL and SSTL inputs treat differential inputs as two single-ended HSTL and SSTL inputs and only decode one of them.
- (5) This I/O standard is not supported on these I/O pins.
- (6) This I/O standard is only supported on the dedicated clock pins.
- (7) PLL\_OUT does not support differential SSTL-18 class II and differential 1.8 and 1.5-V HSTL class II.
- (8) mini-LVDS and RSDS are only supported on output pins.
- (9) LVPECL is only supported on clock inputs.



For more information on Cyclone II supported I/O standards, see the *Selectable I/O Standards in Cyclone II Devices* chapter in Volume 1 of the *Cyclone II Device Handbook*.

## High-Speed Differential Interfaces

Cyclone II devices can transmit and receive data through LVDS signals at a data rate of up to 640 Mbps and 805 Mbps, respectively. For the LVDS transmitter and receiver, the Cyclone II device's input and output pins support serialization and deserialization through internal logic.

The reduced swing differential signaling (RSDS) and mini-LVDS standards are derivatives of the LVDS standard. The RSDS and mini-LVDS I/O standards are similar in electrical characteristics to LVDS, but have a smaller voltage swing and therefore provide increased power benefits and reduced electromagnetic interference (EMI). Cyclone II devices support the RSDS and mini-LVDS I/O standards at data rates up to 311 Mbps at the transmitter.

A subset of pins in each I/O bank (on both rows and columns) support the high-speed I/O interface. The dual-purpose LVDS pins require an external-resistor network at the transmitter channels in addition to 100- $\Omega$  termination resistors on receiver channels. These pins do not contain dedicated serialization or deserialization circuitry. Therefore, internal logic performs serialization and deserialization functions.

Cyclone II pin tables list the pins that support the high-speed I/O interface. The number of LVDS channels supported in each device family member is listed in [Table 2–18](#).

| <b>Table 2–18. Cyclone II Device LVDS Channels (Part 1 of 2)</b> |                  |                                    |
|------------------------------------------------------------------|------------------|------------------------------------|
| <b>Device</b>                                                    | <b>Pin Count</b> | <b>Number of LVDS Channels (1)</b> |
| EP2C5                                                            | 144              | 31 (35)                            |
|                                                                  | 208              | 56 (60)                            |
|                                                                  | 256              | 61 (65)                            |
| EP2C8                                                            | 144              | 29 (33)                            |
|                                                                  | 208              | 53 (57)                            |
|                                                                  | 256              | 75 (79)                            |
| EP2C15                                                           | 256              | 52 (60)                            |
|                                                                  | 484              | 128 (136)                          |
| EP2C20                                                           | 240              | 45 (53)                            |
|                                                                  | 256              | 52 (60)                            |
|                                                                  | 484              | 128 (136)                          |
| EP2C35                                                           | 484              | 131 (139)                          |
|                                                                  | 672              | 201 (209)                          |
| EP2C50                                                           | 484              | 119 (127)                          |
|                                                                  | 672              | 189 (197)                          |

**Table 2–18. Cyclone II Device LVDS Channels (Part 2 of 2)**

| Device | Pin Count | Number of LVDS Channels <sup>(1)</sup> |
|--------|-----------|----------------------------------------|
| EP2C70 | 672       | 160 (168)                              |
|        | 896       | 257 (265)                              |

**Note to Table 2–18:**

- (1) The first number represents the number of bidirectional I/O pins which can be used as inputs or outputs. The number in parenthesis includes dedicated clock input pin pairs which can only be used as inputs.

You can use I/O pins and internal logic to implement a high-speed I/O receiver and transmitter in Cyclone II devices. Cyclone II devices do not contain dedicated serialization or deserialization circuitry. Therefore, shift registers, internal PLLs, and IOEs are used to perform serial-to-parallel conversions on incoming data and parallel-to-serial conversion on outgoing data.

The maximum internal clock frequency for a receiver and for a transmitter is 402.5 MHz. The maximum input data rate of 805 Mbps and the maximum output data rate of 640 Mbps is only achieved when DDIO registers are used. The LVDS standard does not require an input reference voltage, but it does require a 100- $\Omega$  termination resistor between the two signals at the input buffer. An external resistor network is required on the transmitter side.



For more information on Cyclone II differential I/O interfaces, see the *High-Speed Differential Interfaces in Cyclone II Devices* chapter in Volume 1 of the *Cyclone II Device Handbook*.

## Series On-Chip Termination

On-chip termination helps to prevent reflections and maintain signal integrity. This also minimizes the need for external resistors in high pin count ball grid array (BGA) packages. Cyclone II devices provide I/O driver on-chip impedance matching and on-chip series termination for single-ended outputs and bidirectional pins.

Cyclone II devices support driver impedance matching to the impedance of the transmission line, typically 25 or 50  $\Omega$ . When used with the output drivers, on-chip termination sets the output driver impedance to 25 or 50  $\Omega$ . Cyclone II devices also support I/O driver series termination ( $R_S = 50 \Omega$ ) for SSTL-2 and SSTL-18. Table 2–19 lists the I/O standards that support impedance matching and series termination.

| <b>Table 2–19. I/O Standards Supporting Series Termination</b> <i>Note (1)</i> |                                                      |                                  |
|--------------------------------------------------------------------------------|------------------------------------------------------|----------------------------------|
| <b>I/O Standards</b>                                                           | <b>Target <math>R_S</math> (<math>\Omega</math>)</b> | <b><math>V_{CCIO}</math> (V)</b> |
| 3.3-V LVTTTL and LVC MOS                                                       | 25 (2)                                               | 3.3                              |
| 2.5-V LVTTTL and LVC MOS                                                       | 50 (2)                                               | 2.5                              |
| 1.8-V LVTTTL and LVC MOS                                                       | 50 (2)                                               | 1.8                              |
| SSTL-2 class I                                                                 | 50 (2)                                               | 2.5                              |
| SSTL-18 class I                                                                | 50 (2)                                               | 1.8                              |

**Notes to Table 2–19:**

- (1) Supported conditions are  $V_{CCIO} = V_{CCIO} \pm 50$  mV.
- (2) These  $R_S$  values are nominal values. Actual impedance varies across process, voltage, and temperature conditions.



The recommended frequency range of operation is pending silicon characterization.

On-chip series termination can be supported on any I/O bank.  $V_{CCIO}$  and  $V_{REF}$  must be compatible for all I/O pins in order to enable on-chip series termination in a given I/O bank. I/O standards that support different  $R_S$  values can reside in the same I/O bank as long as their  $V_{CCIO}$  and  $V_{REF}$  are not conflicting.



When using on-chip series termination, programmable drive strength is not available.

Impedance matching is implemented using the capabilities of the output driver and is subject to a certain degree of variation, depending on the process, voltage and temperature. The actual tolerance is pending silicon characterization.

## I/O Banks

The I/O pins on Cyclone II devices are grouped together into I/O banks and each bank has a separate power bus. EP2C5 and EP2C8 devices have four I/O banks (see [Figure 2–28](#)), while EP2C15, EP2C20, EP2C35, EP2C50, and EP2C70 devices have eight I/O banks (see [Figure 2–29](#)).

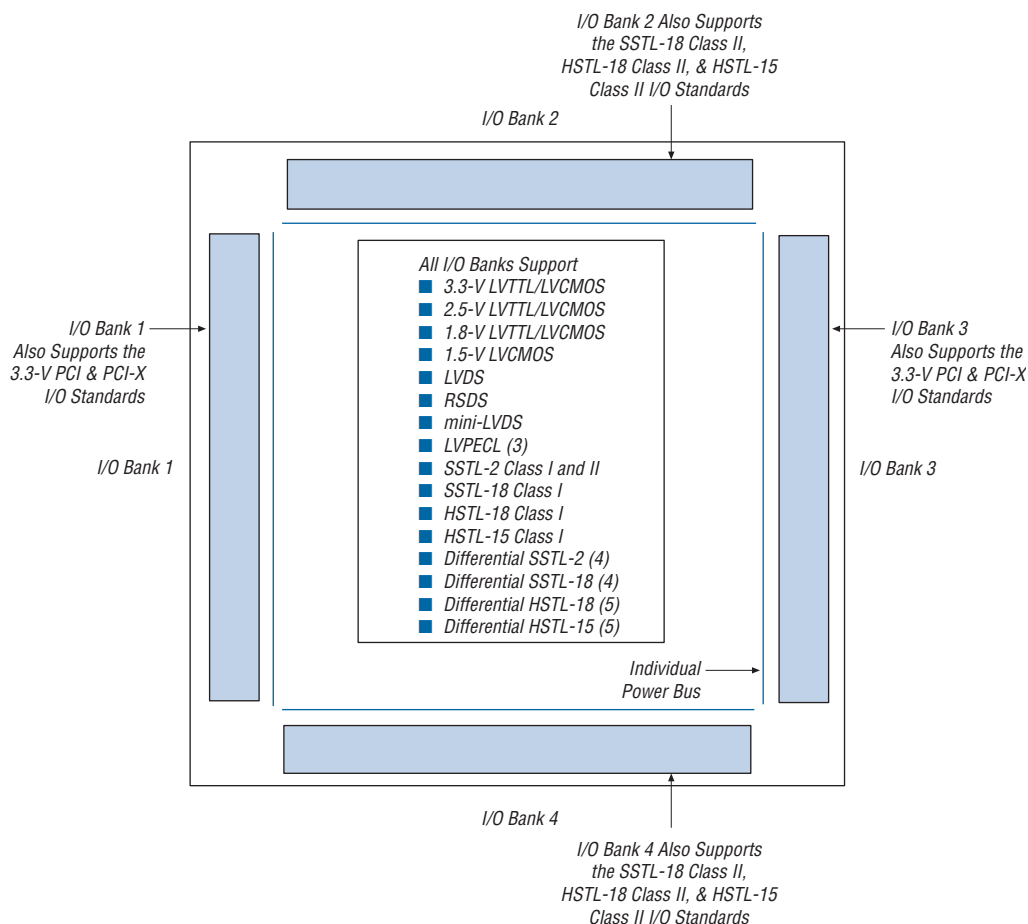
Each device I/O pin is associated with one I/O bank. To accommodate voltage-referenced I/O standards, each Cyclone II I/O bank has a VREF bus. Each bank in EP2C5, EP2C8, EP2C15, EP2C20, EP2C35, and EP2C50 devices supports two VREF pins and each bank of EP2C70 supports four VREF pins. When using the VREF pins, each VREF pin must be properly connected to the appropriate voltage level. In the event these pins are not used as VREF pins, they may be used as regular I/O pins.

The top and bottom I/O banks (banks 2 and 4 in EP2C5 and EP2C8 devices and banks 3, 4, 7, and 8 in EP2C15, EP2C20, EP2C35, EP2C50, and EP2C70 devices) support all I/O standards listed in [Table 2–17](#), except the PCI/PCI-X I/O standards. The left and right side I/O banks (banks 1 and 3 in EP2C5 and EP2C8 devices and banks 1, 2, 5, and 6 in EP2C15, EP2C20, EP2C35, EP2C50, and EP2C70 devices) support I/O standards listed in [Table 2–17](#), except SSTL-18 class II, HSTL-18 class II, and HSTL-15 class II I/O standards. See [Table 2–17](#) for a complete list of supported I/O standards.

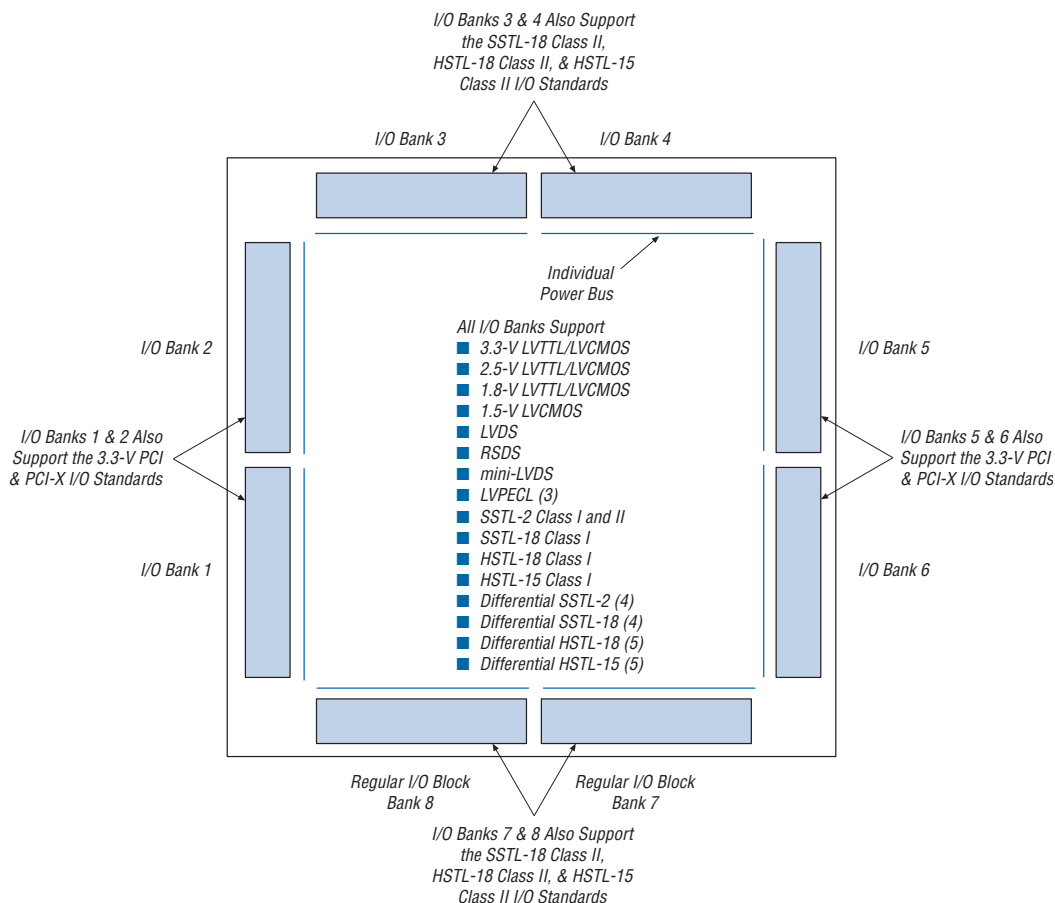
The top and bottom I/O banks (banks 2 and 4 in EP2C5 and EP2C8 devices and banks 3, 4, 7, and 8 in EP2C15, EP2C20, EP2C35, EP2C50, and EP2C70 devices) support DDR2 memory up to 167 MHz/333 Mbps and QDR memory up to 167 MHz/668 Mbps. The left and right side I/O banks (1 and 3 of EP2C5 and EP2C8 devices and 1, 2, 5, and 6 of EP2C15, EP2C20, EP2C35, EP2C50, and EP2C70 devices) only support SDR and DDR SDRAM interfaces. All the I/O banks of the Cyclone II devices support SDR memory up to 167 MHz/167 Mbps and DDR memory up to 167 MHz/333 Mbps.



DDR2 and QDR II interfaces may be implemented in Cyclone II side banks if the use of class I I/O standard is acceptable.

**Figure 2–28. EP2C5 & EP2C8 I/O Banks** *Notes (1), (2)***Notes to Figure 2–28:**

- (1) This is a top view of the silicon die.
- (2) This is a graphic representation only. Refer to the pin list and the Quartus II software for exact pin locations.
- (3) The LVPECL I/O standard is only supported on clock input pins. This I/O standard is not supported on output pins.
- (4) The differential SSTL-18 and SSTL-2 I/O standards are only supported on clock input pins and PLL output clock pins.
- (5) The differential 1.8-V and 1.5-V HSTL I/O standards are only supported on clock input pins and PLL output clock pins.

**Figure 2–29. EP2C15, EP2C20, EP2C35, EP2C50 & EP2C70 I/O Banks** *Notes (1), (2)***Notes to Figure 2–29:**

- (1) This is a top view of the silicon die.
- (2) This is a graphic representation only. Refer to the pin list and the Quartus II software for exact pin locations.
- (3) The LVPECL I/O standard is only supported on clock input pins. This I/O standard is not supported on output pins.
- (4) The differential SSTL-18 and SSTL-2 I/O standards are only supported on clock input pins and PLL output clock pins.
- (5) The differential 1.8-V and 1.5-V HSTL I/O standards are only supported on clock input pins and PLL output clock pins.

Each I/O bank has its own VCCIO pins. A single device can support 1.5-V, 1.8-V, 2.5-V, and 3.3-V interfaces; each individual bank can support a different standard with different I/O voltages. Each bank also has dual-purpose VREF pins to support any one of the voltage-referenced

standards (e.g., SSTL-2) independently. If an I/O bank does not use voltage-referenced standards, the  $V_{REF}$  pins are available as user I/O pins.

Each I/O bank can support multiple standards with the same  $V_{CCIO}$  for input and output pins. For example, when  $V_{CCIO}$  is 3.3-V, a bank can support LVTTTL, LVCMOS, and 3.3-V PCI for inputs and outputs. Voltage-referenced standards can be supported in an I/O bank using any number of single-ended or differential standards as long as they use the same  $V_{REF}$  and a compatible  $V_{CCIO}$  value.

## MultiVolt I/O Interface

The Cyclone II architecture supports the MultiVolt I/O interface feature, which allows Cyclone II devices in all packages to interface with systems of different supply voltages. Cyclone II devices have one set of  $V_{CC}$  pins ( $V_{CCINT}$ ) that power the internal device logic array and input buffers that use the LVPECL, LVDS, HSTL, or SSTL I/O standards. Cyclone II devices also have four or eight sets of  $V_{CC}$  pins ( $V_{CCIO}$ ) that power the I/O output drivers and input buffers that use the LVTTTL, LVCMOS, or PCI I/O standards.

The Cyclone II  $V_{CCINT}$  pins must always be connected to a 1.2-V power supply. If the  $V_{CCINT}$  level is 1.2 V, then input pins are 1.5-V, 1.8-V, 2.5-V, and 3.3-V tolerant. The  $V_{CCIO}$  pins can be connected to either a 1.5-V, 1.8-V, 2.5-V, or 3.3-V power supply, depending on the output requirements. The output levels are compatible with systems of the same voltage as the power supply (i.e., when  $V_{CCIO}$  pins are connected to a 1.5-V power supply, the output levels are compatible with 1.5-V systems). When  $V_{CCIO}$  pins are connected to a 3.3-V power supply, the output high is 3.3-V and is compatible with 3.3-V systems. Table 2–20 summarizes Cyclone II MultiVolt I/O support.

| <b>Table 2–20. Cyclone II MultiVolt I/O Support (Part 1 of 2)</b> <i>Note (1)</i> |                     |              |              |              |                      |              |              |              |
|-----------------------------------------------------------------------------------|---------------------|--------------|--------------|--------------|----------------------|--------------|--------------|--------------|
| <b><math>V_{CCIO}</math> (V)</b>                                                  | <b>Input Signal</b> |              |              |              | <b>Output Signal</b> |              |              |              |
|                                                                                   | <b>1.5 V</b>        | <b>1.8 V</b> | <b>2.5 V</b> | <b>3.3 V</b> | <b>1.5 V</b>         | <b>1.8 V</b> | <b>2.5 V</b> | <b>3.3 V</b> |
| 1.5                                                                               | ✓                   | ✓            | ✓ (2)        | ✓ (2)        | ✓                    |              |              |              |
| 1.8                                                                               | ✓ (4)               | ✓            | ✓ (2)        | ✓ (2)        | ✓ (3)                | ✓            |              |              |
| 2.5                                                                               |                     |              | ✓            | ✓            | ✓ (5)                | ✓ (5)        | ✓            |              |



**Table 2–20. Cyclone II MultiVolt I/O Support (Part 2 of 2)** *Note (1)*

| $V_{CCIO}$ (V) | Input Signal |       |       |       | Output Signal |       |       |       |
|----------------|--------------|-------|-------|-------|---------------|-------|-------|-------|
|                | 1.5 V        | 1.8 V | 2.5 V | 3.3 V | 1.5 V         | 1.8 V | 2.5 V | 3.3 V |
| 3.3            |              |       | ✓ (4) | ✓     | ✓ (6)         | ✓ (6) | ✓ (6) | ✓     |

**Notes to Table 2–20:**

- (1) The PCI clamping diode must be disabled to drive an input with voltages higher than  $V_{CCIO}$ .
- (2) These input values overdrive the input buffer, so the pin leakage current is slightly higher than the default value. To drive inputs higher than  $V_{CCIO}$  but less than 4.0 V, disable the PCI clamping diode and turn on **Allow voltage overdrive for LVTTL/LVCMOS input pins** option in Device setting option in the Quartus II software.
- (3) When  $V_{CCIO} = 1.8\text{-V}$ , a Cyclone II device can drive a 1.5-V device with 1.8-V tolerant inputs.
- (4) When  $V_{CCIO} = 3.3\text{-V}$  and a 2.5-V input signal feeds an input pin or when  $V_{CCIO} = 1.8\text{-V}$  and a 1.5-V input signal feeds an input pin, the  $V_{CCIO}$  supply current will be slightly larger than expected. The reason for this increase is that the input signal level does not drive to the  $V_{CCIO}$  rail, which causes the input buffer to not completely shut off.
- (5) When  $V_{CCIO} = 2.5\text{-V}$ , a Cyclone II device can drive a 1.5-V or 1.8-V device with 2.5-V tolerant inputs.
- (6) When  $V_{CCIO} = 3.3\text{-V}$ , a Cyclone II device can drive a 1.5-V, 1.8-V, or 2.5-V device with 3.3-V tolerant inputs.

## Document Revision History

Table 2–21 shows the revision history for this document.

| <b>Table 2–21. Document Revision History</b> |                                                                                                                                                                                                                                                                                                     |                                                                                                                                                                                      |
|----------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Date &amp; Document Version</b>           | <b>Changes Made</b>                                                                                                                                                                                                                                                                                 | <b>Summary of Changes</b>                                                                                                                                                            |
| February 2007 v3.1                           | <ul style="list-style-type: none"> <li>Added document revision history.</li> <li>Removed Table 2-1.</li> <li>Updated Figure 2–25.</li> <li>Added new <i>Note (1)</i> to Table 2–17.</li> <li>Added handpara note in “I/O Banks” section.</li> <li>Updated <i>Note (2)</i> to Table 2–20.</li> </ul> | <ul style="list-style-type: none"> <li>Removed Drive Strength Control from Figure 2–25.</li> <li>Elaboration of DDR2 and QDRII interfaces supported by I/O bank included.</li> </ul> |
| November 2005 v2.1                           | <ul style="list-style-type: none"> <li>Updated Table 2–7.</li> <li>Updated Figures 2–11 and 2–12.</li> <li>Updated Programmable Drive Strength table.</li> <li>Updated Table 2–16.</li> <li>Updated Table 2–18.</li> <li>Updated Table 2–19.</li> </ul>                                             |                                                                                                                                                                                      |
| July 2005 v2.0                               | <ul style="list-style-type: none"> <li>Updated technical content throughout.</li> <li>Updated Table 2–16.</li> </ul>                                                                                                                                                                                |                                                                                                                                                                                      |
| February 2005 v1.2                           | Updated figure 2-12.                                                                                                                                                                                                                                                                                |                                                                                                                                                                                      |
| November 2004 v1.1                           | Updated Table 2–19.                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                      |
| June 2004 v1.0                               | Added document to the Cyclone II Device Handbook.                                                                                                                                                                                                                                                   |                                                                                                                                                                                      |

### IEEE Std. 1149.1 (JTAG) Boundary Scan Support

All Cyclone® II devices provide JTAG BST circuitry that complies with the IEEE Std. 1149.1. JTAG boundary-scan testing can be performed either before or after, but not during configuration. Cyclone II devices can also use the JTAG port for configuration with the Quartus® II software or hardware using either Jam Files (.jam) or Jam Byte-Code Files (.jbc).

Cyclone II devices support IOE I/O standard reconfiguration through the JTAG BST chain. The JTAG chain can update the I/O standard for all input and output pins any time before or during user mode through the CONFIG\_IO instruction. You can use this capability for JTAG testing before configuration when some of the Cyclone II pins drive or receive from other devices on the board using voltage-referenced standards. Since the Cyclone II device might not be configured before JTAG testing, the I/O pins may not be configured for appropriate electrical standards for chip-to-chip communication. Programming the I/O standards via JTAG allows you to fully test I/O connections to other devices.



For information on I/O reconfiguration, refer to the *MorphIO: An I/O Reconfiguration Solution for Altera Devices White Paper*.

A device operating in JTAG mode uses four required pins: TDI, TDO, TMS, and TCK. The TCK pin has an internal weak pull-down resistor, while the TDI and TMS pins have weak internal pull-up resistors. The TDO output pin and all JTAG input pin voltage is determined by the  $V_{CCIO}$  of the bank where it resides. The bank  $V_{CCIO}$  selects whether the JTAG inputs are 1.5-, 1.8-, 2.5-, or 3.3-V compatible.



Stratix® II, Stratix, Cyclone II and Cyclone devices must be within the first 8 devices in a JTAG chain. All of these devices have the same JTAG controller. If any of the Stratix II, Stratix, Cyclone II or Cyclone devices are in the 9th or further position, they fail configuration. This does not affect Signal Tap II.

Cyclone II devices also use the JTAG port to monitor the logic operation of the device with the SignalTap® II embedded logic analyzer. Cyclone II devices support the JTAG instructions shown in [Table 3-1](#).

**Table 3-1. Cyclone II JTAG Instructions (Part 1 of 2)**

| JTAG Instruction    | Instruction Code | Description                                                                                                                                                                                                                                                                     |
|---------------------|------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SAMPLE/PRELOAD      | 00 0000 0101     | Allows a snapshot of signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern to be output at the device pins. Also used by the SignalTap II embedded logic analyzer.                                         |
| EXTEST (1)          | 00 0000 1111     | Allows the external circuitry and board-level interconnects to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.                                                                                                             |
| BYPASS              | 11 1111 1111     | Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through selected devices to adjacent devices during normal device operation.                                                                                     |
| USERCODE            | 00 0000 0111     | Selects the 32-bit USERCODE register and places it between the TDI and TDO pins, allowing the USERCODE to be serially shifted out of TDO.                                                                                                                                       |
| IDCODE              | 00 0000 0110     | Selects the IDCODE register and places it between TDI and TDO, allowing the IDCODE to be serially shifted out of TDO.                                                                                                                                                           |
| HIGHZ (1)           | 00 0000 1011     | Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through selected devices to adjacent devices during normal device operation, while tri-stating all of the I/O pins.                                              |
| CLAMP (1)           | 00 0000 1010     | Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through selected devices to adjacent devices during normal device operation while holding I/O pins to a state defined by the data in the boundary-scan register. |
| ICR<br>instructions |                  | Used when configuring a Cyclone II device via the JTAG port with a USB Blaster™, ByteBlaster™ II, MasterBlaster™ or ByteBlasterMV™ download cable, or when using a Jam File or JBC File via an embedded processor.                                                              |
| PULSE_NCONFIG       | 00 0000 0001     | Emulates pulsing the nCONFIG pin low to trigger reconfiguration even though the physical pin is unaffected.                                                                                                                                                                     |

**Table 3–1. Cyclone II JTAG Instructions (Part 2 of 2)**

| JTAG Instruction          | Instruction Code | Description                                                                                                                                                                                                                                                                                                                                    |
|---------------------------|------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CONFIG_IO                 | 00 0000 1101     | Allows configuration of I/O standards through the JTAG chain for JTAG testing. Can be executed before, after, or during configuration. Stops configuration if executed during configuration. Once issued, the CONFIG_IO instruction holds nSTATUS low to reset the configuration device. nSTATUS is held low until the device is reconfigured. |
| SignalTap II instructions |                  | Monitors internal device operation with the SignalTap II embedded logic analyzer.                                                                                                                                                                                                                                                              |

**Note to Table 3–1:**

- (1) Bus hold and weak pull-up resistor features override the high-impedance state of HIGHZ, CLAMP, and EXTEST.

The Quartus II software has an Auto Usercode feature where you can choose to use the checksum value of a programming file as the JTAG user code. If selected, the checksum is automatically loaded to the USERCODE register. In the **Settings** dialog box in the Assignments menu, click **Device & Pin Options**, then **General**, and then turn on the **Auto Usercode** option.

The Cyclone II device instruction register length is 10 bits and the USERCODE register length is 32 bits. Tables 3–2 and 3–3 show the boundary-scan register length and device IDCODE information for Cyclone II devices.

**Table 3–2. Cyclone II Boundary-Scan Register Length**

| Device | Boundary-Scan Register Length |
|--------|-------------------------------|
| EP2C5  | 498                           |
| EP2C8  | 597                           |
| EP2C15 | 969                           |
| EP2C20 | 969                           |
| EP2C35 | 1,449                         |
| EP2C50 | 1,374                         |
| EP2C70 | 1,890                         |

**Table 3–3. 32-Bit Cyclone II Device IDCODE**

| Device | IDCODE (32 Bits) (1) |                       |                                 |                 |
|--------|----------------------|-----------------------|---------------------------------|-----------------|
|        | Version (4 Bits)     | Part Number (16 Bits) | Manufacturer Identity (11 Bits) | LSB (1 Bit) (2) |
| EP2C5  | 0000                 | 0010 0000 1011 0001   | 000 0110 1110                   | 1               |
| EP2C8  | 0000                 | 0010 0000 1011 0010   | 000 0110 1110                   | 1               |
| EP2C15 | 0000                 | 0010 0000 1011 0011   | 000 0110 1110                   | 1               |
| EP2C20 | 0000                 | 0010 0000 1011 0011   | 000 0110 1110                   | 1               |
| EP2C35 | 0000                 | 0010 0000 1011 0100   | 000 0110 1110                   | 1               |
| EP2C50 | 0000                 | 0010 0000 1011 0101   | 000 0110 1110                   | 1               |
| EP2C70 | 0000                 | 0010 0000 1011 0110   | 000 0110 1110                   | 1               |

**Notes to Table 3–3:**

- (1) The most significant bit (MSB) is on the left.
- (2) The IDCODE's least significant bit (LSB) is always 1.

For more information on the Cyclone II JTAG specifications, refer to the *DC Characteristics & Timing Specifications* chapter in the *Cyclone II Device Handbook, Volume 1*.

## SignalTap II Embedded Logic Analyzer



Cyclone II devices support the SignalTap II embedded logic analyzer, which monitors design operation over a period of time through the IEEE Std. 1149.1 (JTAG) circuitry. You can analyze internal logic at speed without bringing internal signals to the I/O pins. This feature is particularly important for advanced packages, such as FineLine BGA® packages, because it can be difficult to add a connection to a pin during the debugging process after a board is designed and manufactured.

For more information on the SignalTap II, see the *Signal Tap* chapter of the *Quartus II Handbook, Volume 3*.

## Configuration

The logic, circuitry, and interconnects in the Cyclone II architecture are configured with CMOS SRAM elements. Altera FPGA devices are reconfigurable and every device is tested with a high coverage production test program so you do not have to perform fault testing and can instead focus on simulation and design verification.

Cyclone II devices are configured at system power-up with data stored in an Altera configuration device or provided by a system controller. The Cyclone II device's optimized interface allows the device to act as controller in an active serial configuration scheme with EPCS serial configuration devices. The serial configuration device can be programmed via SRunner, the ByteBlaster II or USB Blaster download cable, the Altera Programming Unit (APU), or third-party programmers.

In addition to EPCS serial configuration devices, Altera offers in-system programmability (ISP)-capable configuration devices that can configure Cyclone II devices via a serial data stream using the Passive serial (PS) configuration mode. The PS interface also enables microprocessors to treat Cyclone II devices as memory and configure them by writing to a virtual memory location, simplifying reconfiguration. After a Cyclone II device has been configured, it can be reconfigured in-circuit by resetting the device and loading new configuration data. Real-time changes can be made during system operation, enabling innovative reconfigurable applications.

## Operating Modes

The Cyclone II architecture uses SRAM configuration elements that require configuration data to be loaded each time the circuit powers up. The process of physically loading the SRAM data into the device is called configuration. During initialization, which occurs immediately after configuration, the device resets registers, enables I/O pins, and begins to operate as a logic device. You can use the 10MHz internal oscillator or the optional CLKUSR pin during the initialization. The 10 MHz internal oscillator is disabled in user mode. Together, the configuration and initialization processes are called command mode. Normal device operation is called user mode.

SRAM configuration elements allow Cyclone II devices to be reconfigured in-circuit by loading new configuration data into the device. With real-time reconfiguration, the device is forced into command mode with the `nCONFIG` pin. The configuration process loads different configuration data, reinitializes the device, and resumes user-mode operation. You can perform in-field upgrades by distributing new configuration files within the system or remotely.

A built-in weak pull-up resistor pulls all user I/O pins to  $V_{CCIO}$  before and during device configuration.

The configuration pins support 1.5-V/1.8-V or 2.5-V/3.3-V I/O standards. The voltage level of the configuration output pins is determined by the  $V_{CCIO}$  of the bank where the pins reside. The bank  $V_{CCIO}$  selects whether the configuration inputs are 1.5-V, 1.8-V, 2.5-V, or 3.3-V compatible.

## Configuration Schemes

You can load the configuration data for a Cyclone II device with one of three configuration schemes (see [Table 3–4](#)), chosen on the basis of the target application. You can use a configuration device, intelligent controller, or the JTAG port to configure a Cyclone II device. A low-cost configuration device can automatically configure a Cyclone II device at system power-up.

Multiple Cyclone II devices can be configured in any of the three configuration schemes by connecting the configuration enable (`nCE`) and configuration enable output (`nCEO`) pins on each device.

**Table 3–4. Data Sources for Configuration**

| Configuration Scheme | Data Source                                                                                                                              |
|----------------------|------------------------------------------------------------------------------------------------------------------------------------------|
| Active serial (AS)   | Low-cost serial configuration device                                                                                                     |
| Passive serial (PS)  | Enhanced or EPC2 configuration device, MasterBlaster, ByteBlasterMV, ByteBlaster II or USB Blaster download cable, or serial data source |
| JTAG                 | MasterBlaster, ByteBlasterMV, ByteBlaster II or USB Blaster download cable or a microprocessor with a Jam or JBC file                    |



For more information on configuration, see the *Configuring Cyclone II Devices* chapter of the *Cyclone II Handbook, Volume 2*.



## Cyclone II Automated Single Event Upset Detection

Cyclone II devices offer on-chip circuitry for automated checking of single event upset (SEU) detection. Some applications that require the device to operate error free at high elevations or in close proximity to earth's North or South Pole require periodic checks to ensure continued data integrity. The error detection cyclic redundancy code (CRC) feature controlled by the **Device & Pin Options** dialog box in the Quartus II software uses a 32-bit CRC circuit to ensure data reliability and is one of the best options for mitigating SEU.

You can implement the error detection CRC feature with existing circuitry in Cyclone II devices, eliminating the need for external logic. For Cyclone II devices, the CRC is pre-computed by Quartus II software and then sent to the device as part of the POF file header. The `CRC_ERROR` pin reports a soft error when configuration SRAM data is corrupted, indicating to the user to perform a device reconfiguration.

### Custom-Built Circuitry

Dedicated circuitry in the Cyclone II devices performs error detection automatically. This error detection circuitry in Cyclone II devices constantly checks for errors in the configuration SRAM cells while the device is in user mode. You can monitor one external pin for the error and use it to trigger a re-configuration cycle. You can select the desired time between checks by adjusting a built-in clock divider.

### Software Interface

In the Quartus II software version 4.1 and later, you can turn on the automated error detection CRC feature in the Device & Pin Options dialog box. This dialog box allows you to enable the feature and set the internal frequency of the CRC checker between 400 kHz to 80 MHz. This controls the rate that the CRC circuitry verifies the internal configuration SRAM bits in the FPGA device.



For more information on CRC, refer to *AN: 357 Error Detection Using CRC in Altera FPGAs*.

## Document Revision History

Table 3–5 shows the revision history for this document.

| <i>Table 3–5. Document Revision History</i> |                                                                                                                                                                                                                                                           |                                                                                                                                                                                         |
|---------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Date & Document Version                     | Changes Made                                                                                                                                                                                                                                              | Summary of Changes                                                                                                                                                                      |
| February 2007 v2.2                          | <ul style="list-style-type: none"><li>Added document revision history.</li><li>Added new handpara nore in “IEEE Std. 1149.1 (JTAG) Boundary Scan Support” section.</li><li>Updated “Cyclone II Automated Single Event Upset Detection” section.</li></ul> | <ul style="list-style-type: none"><li>Added information about limitation of cascading multi devices in the same JTAG chain.</li><li>Corrected information on CRC calculation.</li></ul> |
| July 2005 v2.0                              | Updated technical content.                                                                                                                                                                                                                                |                                                                                                                                                                                         |
| February 2005 v1.2                          | Updated information on JTAG chain limitations.                                                                                                                                                                                                            |                                                                                                                                                                                         |
| November 2004 v1.1                          | Updated Table 3–4.                                                                                                                                                                                                                                        |                                                                                                                                                                                         |
| June 2004 v1.0                              | Added document to the Cyclone II Device Handbook.                                                                                                                                                                                                         |                                                                                                                                                                                         |

### Introduction

Cyclone® II devices offer hot socketing (also known as hot plug-in, hot insertion, or hot swap) and power sequencing support without the use of any external devices. You can insert or remove a Cyclone II board in a system during system operation without causing undesirable effects to the board or to the running system bus.

The hot-socketing feature lessens the board design difficulty when using Cyclone II devices on printed circuit boards (PCBs) that also contain a mixture of 3.3-, 2.5-, 1.8-, and 1.5-V devices. With the Cyclone II hot-socketing feature, you no longer need to ensure a proper power-up sequence for each device on the board.

The Cyclone II hot-socketing feature provides:

- Board or device insertion and removal without external components or board manipulation
- Support for any power-up sequence
- Non-intrusive I/O buffers to system buses during hot insertion

This chapter also discusses the power-on reset (POR) circuitry in Cyclone II devices. The POR circuitry keeps the devices in the reset state until the  $V_{CC}$  is within operating range.

### Cyclone II Hot-Socketing Specifications

Cyclone II devices offer hot-socketing capability with all three features listed above without any external components or special design requirements. The hot-socketing feature in Cyclone II devices offers the following:

- The device can be driven before power-up without any damage to the device itself.
- I/O pins remain tri-stated during power-up. The device does not drive out before or during power-up, thereby affecting other buses in operation.

## Devices Can Be Driven before Power-Up

You can drive signals into the I/O pins, dedicated input pins, and dedicated clock pins of Cyclone II devices before or during power-up or power-down without damaging the device. Cyclone II devices support any power-up or power-down sequence ( $V_{CCIO}$  and  $V_{CCINT}$ ) to simplify system level design.

## I/O Pins Remain Tri-States during Power-Up

A device that does not support hot socketing may interrupt system operation or cause contention by driving out before or during power-up. In a hot-socketing situation, the Cyclone II device's output buffers are turned off during system power-up or power-down. The Cyclone II device also does not drive out until the device is configured and has attained proper operating conditions. The I/O pins are tri-stated until the device enters user mode with a weak pull-up resistor (R) to 3.3V. Refer to [Figure 4-1](#) for more information.



You can power up or power down the  $V_{CCIO}$  and  $V_{CCINT}$  pins in any sequence. The  $V_{CCIO}$  and  $V_{CCINT}$  must have monotonic rise to their steady state levels. (Refer to [Figure 4-3](#) for more information.) The power supply ramp rates can range from 100  $\mu$ s to 100 ms for non "A" devices. Both  $V_{CC}$  supplies must power down within 100 ms of each other to prevent I/O pins from driving out. During hot socketing, the I/O pin capacitance is less than 15 pF and the clock pin capacitance is less than 20 pF. Cyclone II devices meet the following hot-socketing specification.

- The hot-socketing DC specification is  $|I_{IOPIN}| < 300 \mu A$ .
- The hot-socketing AC specification is  $|I_{IOPIN}| < 8 \text{ mA}$  for 10 ns or less.

This specification takes into account the pin capacitance but not board trace and external loading capacitance. You must consider additional capacitance for trace, connector, and loading separately.

$I_{IOPIN}$  is the current at any user I/O pin on the device. The DC specification applies when all  $V_{CC}$  supplies to the device are stable in the powered-up or powered-down conditions. For the AC specification, the peak current duration due to power-up transients is 10 ns or less.

A possible concern for semiconductor devices in general regarding hot socketing is the potential for latch-up. Latch-up can occur when electrical subsystems are hot socketed into an active system. During hot socketing, the signal pins may be connected and driven by the active system before

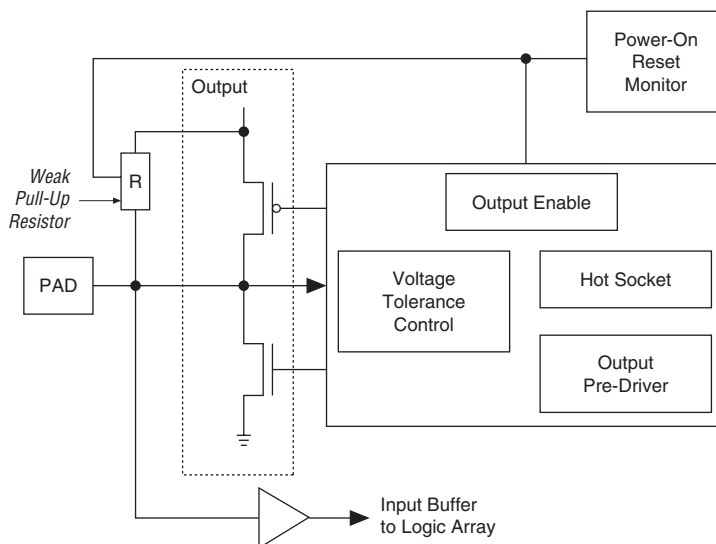
the power supply can provide current to the device's  $V_{CC}$  and ground planes. This condition can lead to latch-up and cause a low-impedance path from  $V_{CC}$  to ground within the device. As a result, the device extends a large amount of current, possibly causing electrical damage.

Altera has ensured by design of the I/O buffers and hot-socketing circuitry, that Cyclone II devices are immune to latch-up during hot socketing.

## Hot-Socketing Feature Implementation in Cyclone II Devices

The hot-socketing feature turns off the output buffer during power up (either  $V_{CCINT}$  or  $V_{CCIO}$  supplies) or power down. The hot-socket circuit generates an internal `HOTSKKT` signal when either  $V_{CCINT}$  or  $V_{CCIO}$  is below the threshold voltage. Designs cannot use the `HOTSKKT` signal for other purposes. The `HOTSKKT` signal cuts off the output buffer to ensure that no DC current (except for weak pull-up leakage current) leaks through the pin. When  $V_{CC}$  ramps up slowly,  $V_{CC}$  is still relatively low even after the internal POR signal (not available to the FPGA fabric used by customer designs) is released and the configuration is finished. The `CONF_DONE`, `nCEO`, and `nSTATUS` pins fail to respond, as the output buffer cannot drive out because the hot-socketing circuitry keeps the I/O pins tristated at this low  $V_{CC}$  voltage. Therefore, the hot-socketing circuit has been removed on these configuration output or bidirectional pins to ensure that they are able to operate during configuration. These pins are expected to drive out during power-up and power-down sequences.

Each I/O pin has the circuitry shown in [Figure 4-1](#).

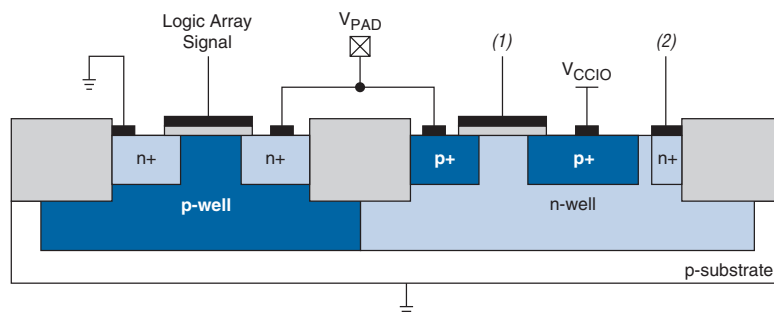
**Figure 4–1. Hot-Socketing Circuit Block Diagram for Cyclone II Devices**

The POR circuit monitors  $V_{CCINT}$  voltage level and keeps I/O pins tri-stated until the device is in user mode. The weak pull-up resistor (R) from the I/O pin to  $V_{CCIO}$  keeps the I/O pins from floating. The voltage tolerance control circuit permits the I/O pins to be driven by 3.3 V before  $V_{CCIO}$  and/or  $V_{CCINT}$  are powered, and it prevents the I/O pins from driving out when the device is not in user mode.



For more information, see the *DC Characteristics & Timing Specifications* chapter in Volume 1 of the *Cyclone II Device Handbook* for the value of the internal weak pull-up resistors.

Figure 4–2 shows a transistor level cross section of the Cyclone II device I/O buffers. This design ensures that the output buffers do not drive when  $V_{CCIO}$  is powered before  $V_{CCINT}$  or if the I/O pad voltage is higher than  $V_{CCIO}$ . This also applies for sudden voltage spikes during hot socketing. The  $V_{PAD}$  leakage current charges the voltage tolerance control circuit capacitance.

**Figure 4–2. Transistor Level Diagram of FPGA Device I/O Buffers****Notes to Figure 4–2:**

- (1) This is the logic array signal or the larger of either the  $V_{CCIO}$  or  $V_{PAD}$  signal.
- (2) This is the larger of either the  $V_{CCIO}$  or  $V_{PAD}$  signal.

## Power-On Reset Circuitry

Cyclone II devices contain POR circuitry to keep the device in a reset state until the power supply voltage levels have stabilized during power-up. The POR circuit monitors the  $V_{CCINT}$  voltage levels and tri-states all user I/O pins until the  $V_{CC}$  reaches the recommended operating levels. In addition, the POR circuitry also monitors the  $V_{CCIO}$  level of the two I/O banks that contains configuration pins (I/O banks 1 and 3 for EP2C5 and EP2C8, I/O banks 2 and 6 for EP2C15A, EP2C20, EP2C35, EP2C50, and EP2C70) and tri-states all user I/O pins until the  $V_{CC}$  reaches the recommended operating levels.

After the Cyclone II device enters user mode, the POR circuit continues to monitor the  $V_{CCINT}$  voltage level so that a brown-out condition during user mode can be detected. If the  $V_{CCINT}$  voltage sags below the POR trip point during user mode, the POR circuit resets the device. If the  $V_{CCIO}$  voltage sags during user mode, the POR circuit does not reset the device.

### "Wake-up" Time for Cyclone II Devices

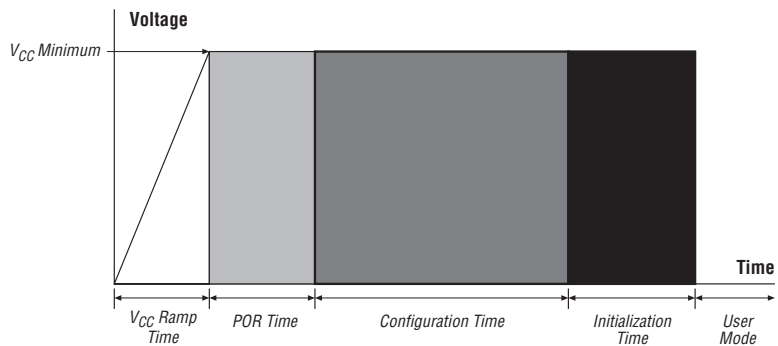
In some applications, it may be necessary for a device to wake up very quickly in order to begin operation. The Cyclone II device family offers the Fast-On feature to support fast wake-up time applications. Devices that support the Fast-On feature are designated with an "A" in the ordering code and have stricter power up requirements compared to non-A devices.

For Cyclone II devices, wake-up time consists of power-up, POR, configuration, and initialization. The device must properly go through all four stages to configure correctly and begin operation. You can calculate wake-up time using the following equation:

$$\text{Wake-Up Time} = V_{CC} \text{ Ramp Time} + \text{POR Time} + \text{Configuration Time} + \text{Initialization Time}$$

Figure 4–3 illustrates the components of wake up time.

**Figure 4–3. Cyclone II Wake-Up Time**



**Note to Figure 4–3:**

- (1)  $V_{CC}$  ramp must be monotonic.

The  $V_{CC}$  ramp time and POR time will depend on the device characteristics and the power supply used in your system. The fast-on devices require a maximum  $V_{CC}$  ramp time of 2 ms and have a maximum POR time of 12 ms.

Configuration time will depend on the configuration mode chosen and the configuration file size. You can calculate configuration time by multiplying the number of bits in the configuration file with the period of the configuration clock. For fast configuration times, you should use Passive Serial (PS) configuration mode with maximum DCLK frequency of 100 MHz. In addition, you can use compression to reduce the configuration file size and speed up the configuration time. The  $t_{CD2UM}$  or  $t_{CD2UMC}$  parameters will determine the initialization time.



For more information on the  $t_{CD2UM}$  or  $t_{CD2UMC}$  parameters, refer to the *Configuring Cyclone II Devices* chapter in the *Cyclone II Device Handbook*.



If you cannot meet the maximum  $V_{CC}$  ramp time requirement, you must use an external component to hold  $\overline{nCONFIG}$  low until the power supplies have reached their minimum recommended operating levels. Otherwise, the device may not properly configure and enter user mode.

## Conclusion

Cyclone II devices are hot socketable and support all power-up and power-down sequences with the one requirement that  $V_{CCIO}$  and  $V_{CCINT}$  be powered up and down within 100 ms of each other to keep the I/O pins from driving out. Cyclone II devices do not require any external devices for hot socketing and power sequencing.

## Document Revision History

Table 4–1 shows the revision history for this document.

| <i>Table 4–1. Document Revision History</i> |                                                                                                                                                                                                                                                       |                                                                                                                                                                                                                                                                                     |
|---------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Date & Document Version                     | Changes Made                                                                                                                                                                                                                                          | Summary of Changes                                                                                                                                                                                                                                                                  |
| February 2007 v3.1                          | <ul style="list-style-type: none"> <li>Added document revision history.</li> <li>Updated “I/O Pins Remain Tri-Stated during Power-Up” section.</li> <li>Updated “Power-On Reset Circuitry” section.</li> <li>Added footnote to Figure 4–3.</li> </ul> | <ul style="list-style-type: none"> <li>Specified <math>V_{CCIO}</math> and <math>V_{CCINT}</math> supplies must be GND when “not powered”.</li> <li>Added clarification about input-tristate behavior.</li> <li>Added information on <math>V_{CC}</math> monotonic ramp.</li> </ul> |
| July 2005 v2.0                              | Updated technical content throughout.                                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                     |
| February 2005 v1.1                          | Removed ESD section.                                                                                                                                                                                                                                  |                                                                                                                                                                                                                                                                                     |
| June 2004 v1.0                              | Added document to the Cyclone II Device Handbook.                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                     |



### Operating Conditions

Cyclone® II devices are offered in commercial, industrial, automotive, and extended temperature grades. Commercial devices are offered in –6 (fastest), –7, and –8 speed grades.

All parameter limits are representative of worst-case supply voltage and junction temperature conditions. Unless otherwise noted, the parameter values in this chapter apply to all Cyclone II devices. AC and DC characteristics are specified using the same numbers for commercial, industrial, and automotive grades. All parameters representing voltages are measured with respect to ground.

Tables 5–1 through 5–4 provide information on absolute maximum ratings.

**Table 5–1. Cyclone II Device Absolute Maximum Ratings** Notes (1), (2)

| Symbol               | Parameter                  | Conditions              | Minimum | Maximum | Unit |
|----------------------|----------------------------|-------------------------|---------|---------|------|
| $V_{CCINT}$          | Supply voltage             | With respect to ground  | –0.5    | 1.8     | V    |
| $V_{CCIO}$           | Output supply voltage      |                         | –0.5    | 4.6     | V    |
| $V_{CCA-PLL}$ [1..4] | PLL supply voltage         |                         | –0.5    | 1.8     | V    |
| $V_{IN}$             | DC input voltage (3)       | —                       | –0.5    | 4.6     | V    |
| $I_{OUT}$            | DC output current, per pin | —                       | –25     | 40      | mA   |
| $T_{STG}$            | Storage temperature        | No bias                 | –65     | 150     | °C   |
| $T_J$                | Junction temperature       | BGA packages under bias | —       | 125     | °C   |

**Notes to Table 5–1:**

- (1) Conditions beyond those listed in this table cause permanent damage to a device. These are stress ratings only. Functional operation at these levels or any other conditions beyond those specified in this chapter is not implied. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effect on the device reliability.
- (2) Refer to the *Operating Requirements for Altera Devices Data Sheet* for more information.
- (3) During transitions, the inputs may overshoot to the voltage shown in Table 5–4 based upon the input duty cycle. The DC case is equivalent to 100% duty cycle. During transition, the inputs may undershoot to –2.0 V for input currents less than 100 mA and periods shorter than 20 ns.

Table 5–2 specifies the recommended operating conditions for Cyclone II devices. It shows the allowed voltage ranges for  $V_{CCINT}$ ,  $V_{CCIO}$ , and the operating junction temperature ( $T_J$ ). The LVTTL and LVCMOS inputs are powered by  $V_{CCIO}$  only. The LVDS and LVPECL input buffers on dedicated clock pins are powered by  $V_{CCINT}$ . The SSTL, HSTL, LVDS input buffers are powered by both  $V_{CCINT}$  and  $V_{CCIO}$ .

**Table 5–2. Recommended Operating Conditions**

| Symbol         | Parameter                                           | Conditions                   | Minimum      | Maximum             | Unit |
|----------------|-----------------------------------------------------|------------------------------|--------------|---------------------|------|
| $V_{CCINT}$    | Supply voltage for internal logic and input buffers | (1)                          | 1.15         | 1.25                | V    |
| $V_{CCIO}$ (2) | Supply voltage for output buffers, 3.3-V operation  | (1)                          | 3.135 (3.00) | 3.465 (3.60)<br>(3) | V    |
|                | Supply voltage for output buffers, 2.5-V operation  | (1)                          | 2.375        | 2.625               | V    |
|                | Supply voltage for output buffers, 1.8-V operation  | (1)                          | 1.71         | 1.89                | V    |
|                | Supply voltage for output buffers, 1.5-V operation  | (1)                          | 1.425        | 1.575               | V    |
| $T_J$          | Operating junction temperature                      | For commercial use           | 0            | 85                  | °C   |
|                |                                                     | For industrial use           | –40          | 100                 | °C   |
|                |                                                     | For extended temperature use | –40          | 125                 | °C   |
|                |                                                     | For automotive use           | –40          | 125                 | °C   |

**Notes to Table 5–2:**

- (1) The  $V_{CC}$  must rise monotonically. The maximum  $V_{CC}$  (both  $V_{CCIO}$  and  $V_{CCINT}$ ) rise time is 100 ms for non-A devices and 2 ms for A devices.
- (2) The  $V_{CCIO}$  range given here spans the lowest and highest operating voltages of all supported I/O standards. The recommended  $V_{CCIO}$  range specific to each of the single-ended I/O standards is given in Table 5–6, and those specific to the differential standards is given in Table 5–8.
- (3) The minimum and maximum values of 3.0 V and 3.6 V, respectively, for  $V_{CCIO}$  only applies to the PCI and PCI-X I/O standards. Refer to Table 5–6 for the voltage range of other I/O standards.

**Table 5–3. DC Characteristics for User I/O, Dual-Purpose, and Dedicated Pins (Part 1 of 2)**

| Symbol       | Parameter                            | Conditions                                                                                            | Minimum  | Typical | Maximum    | Unit    |
|--------------|--------------------------------------|-------------------------------------------------------------------------------------------------------|----------|---------|------------|---------|
| $V_{IN}$     | Input voltage                        | (1), (2)                                                                                              | –0.5     | —       | 4.0        | V       |
| $I_i$        | Input pin leakage current            | $V_{IN} = V_{CCIOmax}$ to 0 V (3)                                                                     | –10      | —       | 10         | $\mu A$ |
| $V_{OUT}$    | Output voltage                       | —                                                                                                     | 0        | —       | $V_{CCIO}$ | V       |
| $I_{OZ}$     | Tri-stated I/O pin leakage current   | $V_{OUT} = V_{CCIOmax}$ to 0 V (3)                                                                    | –10      | —       | 10         | $\mu A$ |
| $I_{CCINT0}$ | $V_{CCINT}$ supply current (standby) | $V_{IN} = \text{ground, no load, no toggling inputs}$<br>$T_J = 25^\circ C$<br>Nominal<br>$V_{CCINT}$ | EP2C5/A  | —       | 0.010      | (4) A   |
|              |                                      |                                                                                                       | EP2C8/A  | —       | 0.017      | (4) A   |
|              |                                      |                                                                                                       | EP2C15A  | —       | 0.037      | (4) A   |
|              |                                      |                                                                                                       | EP2C20/A | —       | 0.037      | (4) A   |
|              |                                      |                                                                                                       | EP2C35   | —       | 0.066      | (4) A   |
|              |                                      |                                                                                                       | EP2C50   | —       | 0.101      | (4) A   |
|              |                                      |                                                                                                       | EP2C70   | —       | 0.141      | (4) A   |
| $I_{CCIO0}$  | $V_{CCIO}$ supply current (standby)  | $V_{IN} = \text{ground, no load, no toggling inputs}$<br>$T_J = 25^\circ C$<br>$V_{CCIO} = 2.5 V$     | EP2C5/A  | —       | 0.7        | (4) mA  |
|              |                                      |                                                                                                       | EP2C8/A  | —       | 0.8        | (4) mA  |
|              |                                      |                                                                                                       | EP2C15A  | —       | 0.9        | (4) mA  |
|              |                                      |                                                                                                       | EP2C20/A | —       | 0.9        | (4) mA  |
|              |                                      |                                                                                                       | EP2C35   | —       | 1.3        | (4) mA  |
|              |                                      |                                                                                                       | EP2C50   | —       | 1.3        | (4) mA  |
|              |                                      |                                                                                                       | EP2C70   | —       | 1.7        | (4) mA  |

**Table 5–3. DC Characteristics for User I/O, Dual-Purpose, and Dedicated Pins (Part 2 of 2)**

| Symbol             | Parameter                                                                                | Conditions                                     | Minimum | Typical | Maximum | Unit      |
|--------------------|------------------------------------------------------------------------------------------|------------------------------------------------|---------|---------|---------|-----------|
| $R_{CONF}$ (5) (6) | Value of I/O pin pull-up resistor before and during configuration                        | $V_{IN} = 0\text{ V}; V_{CCIO} = 3.3\text{ V}$ | 10      | 25      | 50      | $k\Omega$ |
|                    |                                                                                          | $V_{IN} = 0\text{ V}; V_{CCIO} = 2.5\text{ V}$ | 15      | 35      | 70      | $k\Omega$ |
|                    |                                                                                          | $V_{IN} = 0\text{ V}; V_{CCIO} = 1.8\text{ V}$ | 30      | 50      | 100     | $k\Omega$ |
|                    |                                                                                          | $V_{IN} = 0\text{ V}; V_{CCIO} = 1.5\text{ V}$ | 40      | 75      | 150     | $k\Omega$ |
|                    |                                                                                          | $V_{IN} = 0\text{ V}; V_{CCIO} = 1.2\text{ V}$ | 50      | 90      | 170     | $k\Omega$ |
|                    | Recommended value of I/O pin external pull-down resistor before and during configuration | (7)                                            | —       | 1       | 2       | $k\Omega$ |

**Notes to Table 5–3:**

- (1) All pins, including dedicated inputs, clock, I/O, and JTAG pins, may be driven before  $V_{CCINT}$  and  $V_{CCIO}$  are powered.
- (2) The minimum DC input is  $-0.5\text{ V}$ . During transitions, the inputs may undershoot to  $-2.0\text{ V}$  or overshoot to the voltages shown in Table 5–4, based on input duty cycle for input currents less than 100 mA. The overshoot is dependent upon duty cycle of the signal. The DC case is equivalent to 100% duty cycle.
- (3) This value is specified for normal device operation. The value may vary during power-up. This applies for all  $V_{CCIO}$  settings (3.3, 2.5, 1.8, and 1.5 V).
- (4) Maximum values depend on the actual  $T_J$  and design utilization. See the Excel-based PowerPlay Early Power Estimator ([www.altera.com](http://www.altera.com)) or the Quartus II PowerPlay Power Analyzer feature for maximum values. Refer to “Power Consumption” on page 5–13 for more information.
- (5)  $R_{CONF}$  values are based on characterization.  $R_{CONF} = V_{CCIO}/I_{RCONF}$ .  $R_{CONF}$  values may be different if  $V_{IN}$  value is not 0 V. Pin pull-up resistance values will be lower if an external source drives the pin higher than  $V_{CCIO}$ .
- (6) Minimum condition at  $-40^\circ\text{C}$  and high  $V_{CC}$ , typical condition at  $25^\circ\text{C}$  and nominal  $V_{CC}$  and maximum condition at  $125^\circ\text{C}$  and low  $V_{CC}$  for  $R_{CONF}$  values.
- (7) These values apply to all  $V_{CCIO}$  settings.

Table 5–4 shows the maximum  $V_{IN}$  overshoot voltage and the dependency on the duty cycle of the input signal. Refer to Table 5–3 for more information.

**Table 5–4.  $V_{IN}$  Overshoot Voltage for All Input Buffers**

| Maximum $V_{IN}$ (V) | Input Signal Duty Cycle |
|----------------------|-------------------------|
| 4.0                  | 100% (DC)               |
| 4.1                  | 90%                     |
| 4.2                  | 50%                     |
| 4.3                  | 30%                     |
| 4.4                  | 17%                     |
| 4.5                  | 10%                     |

## Single-Ended I/O Standards

Tables 5–6 and 5–7 provide operating condition information when using single-ended I/O standards with Cyclone II devices. Table 5–5 provides descriptions for the voltage and current symbols used in Tables 5–6 and 5–7.

**Table 5–5. Voltage and Current Symbol Definitions**

| Symbol     | Definition                                                                        |
|------------|-----------------------------------------------------------------------------------|
| $V_{CCIO}$ | Supply voltage for single-ended inputs and for output drivers                     |
| $V_{REF}$  | Reference voltage for setting the input switching threshold                       |
| $V_{IL}$   | Input voltage that indicates a low logic level                                    |
| $V_{IH}$   | Input voltage that indicates a high logic level                                   |
| $V_{OL}$   | Output voltage that indicates a low logic level                                   |
| $V_{OH}$   | Output voltage that indicates a high logic level                                  |
| $I_{OL}$   | Output current condition under which $V_{OL}$ is tested                           |
| $I_{OH}$   | Output current condition under which $V_{OH}$ is tested                           |
| $V_{TT}$   | Voltage applied to a resistor termination as specified by HSTL and SSTL standards |

**Table 5–6. Recommended Operating Conditions for User I/O Pins Using Single-Ended I/O Standards**  
*Note (1) (Part 1 of 2)*

| I/O Standard          | $V_{CCIO}$ (V) |     |       | $V_{REF}$ (V) |      |       | $V_{IL}$ (V)                                    | $V_{IH}$ (V)                                    |
|-----------------------|----------------|-----|-------|---------------|------|-------|-------------------------------------------------|-------------------------------------------------|
|                       | Min            | Typ | Max   | Min           | Typ  | Max   | Max                                             | Min                                             |
| 3.3-VLVTTL and LVCMOS | 3.135          | 3.3 | 3.465 | —             | —    | —     | 0.8                                             | 1.7                                             |
| 2.5-VLVTTL and LVCMOS | 2.375          | 2.5 | 2.625 | —             | —    | —     | 0.7                                             | 1.7                                             |
| 1.8-VLVTTL and LVCMOS | 1.710          | 1.8 | 1.890 | —             | —    | —     | $0.35 \times V_{CCIO}$                          | $0.65 \times V_{CCIO}$                          |
| 1.5-V LVCMOS          | 1.425          | 1.5 | 1.575 | —             | —    | —     | $0.35 \times V_{CCIO}$                          | $0.65 \times V_{CCIO}$                          |
| PCI and PCI-X         | 3.000          | 3.3 | 3.600 | —             | —    | —     | $0.3 \times V_{CCIO}$                           | $0.5 \times V_{CCIO}$                           |
| SSTL-2 class I        | 2.375          | 2.5 | 2.625 | 1.19          | 1.25 | 1.31  | $V_{REF} - 0.18$ (DC)<br>$V_{REF} - 0.35$ (AC)  | $V_{REF} + 0.18$ (DC)<br>$V_{REF} + 0.35$ (AC)  |
| SSTL-2 class II       | 2.375          | 2.5 | 2.625 | 1.19          | 1.25 | 1.31  | $V_{REF} - 0.18$ (DC)<br>$V_{REF} - 0.35$ (AC)  | $V_{REF} + 0.18$ (DC)<br>$V_{REF} + 0.35$ (AC)  |
| SSTL-18 class I       | 1.7            | 1.8 | 1.9   | 0.833         | 0.9  | 0.969 | $V_{REF} - 0.125$ (DC)<br>$V_{REF} - 0.25$ (AC) | $V_{REF} + 0.125$ (DC)<br>$V_{REF} + 0.25$ (AC) |

**Table 5–6. Recommended Operating Conditions for User I/O Pins Using Single-Ended I/O Standards**

*Note (1) (Part 2 of 2)*

| I/O Standard        | V <sub>CCIO</sub> (V) |     |       | V <sub>REF</sub> (V) |      |       | V <sub>IL</sub> (V)                                           | V <sub>IH</sub> (V)                                           |
|---------------------|-----------------------|-----|-------|----------------------|------|-------|---------------------------------------------------------------|---------------------------------------------------------------|
|                     | Min                   | Typ | Max   | Min                  | Typ  | Max   | Max                                                           | Min                                                           |
| SSTL-18 class II    | 1.7                   | 1.8 | 1.9   | 0.833                | 0.9  | 0.969 | V <sub>REF</sub> – 0.125 (DC)<br>V <sub>REF</sub> – 0.25 (AC) | V <sub>REF</sub> + 0.125 (DC)<br>V <sub>REF</sub> + 0.25 (AC) |
| 1.8-V HSTL class I  | 1.71                  | 1.8 | 1.89  | 0.85                 | 0.9  | 0.95  | V <sub>REF</sub> – 0.1 (DC)<br>V <sub>REF</sub> – 0.2 (AC)    | V <sub>REF</sub> + 0.1 (DC)<br>V <sub>REF</sub> + 0.2 (AC)    |
| 1.8-V HSTL class II | 1.71                  | 1.8 | 1.89  | 0.85                 | 0.9  | 0.95  | V <sub>REF</sub> – 0.1 (DC)<br>V <sub>REF</sub> – 0.2 (AC)    | V <sub>REF</sub> + 0.1 (DC)<br>V <sub>REF</sub> + 0.2 (AC)    |
| 1.5-V HSTL class I  | 1.425                 | 1.5 | 1.575 | 0.71                 | 0.75 | 0.79  | V <sub>REF</sub> – 0.1 (DC)<br>V <sub>REF</sub> – 0.2 (AC)    | V <sub>REF</sub> + 0.1 (DC)<br>V <sub>REF</sub> + 0.2 (AC)    |
| 1.5-V HSTL class II | 1.425                 | 1.5 | 1.575 | 0.71                 | 0.75 | 0.79  | V <sub>REF</sub> – 0.1 (DC)<br>V <sub>REF</sub> – 0.2 (AC)    | V <sub>REF</sub> + 0.1 (DC)<br>V <sub>REF</sub> + 0.2 (AC)    |

**Note to Table 5–6:**

(1) Nominal values (Nom) are for T<sub>A</sub> = 25° C, V<sub>CCINT</sub> = 1.2 V, and V<sub>CCIO</sub> = 1.5, 1.8, 2.5, and 3.3 V.

**Table 5–7. DC Characteristics of User I/O Pins Using Single-Ended Standards** *Notes (1), (2) (Part 1 of 2)*

| I/O Standard            | Test Conditions      |                      | Voltage Thresholds          |                             |
|-------------------------|----------------------|----------------------|-----------------------------|-----------------------------|
|                         | I <sub>OL</sub> (mA) | I <sub>OH</sub> (mA) | Maximum V <sub>OL</sub> (V) | Minimum V <sub>OH</sub> (V) |
| 3.3-V LVTTTL            | 4                    | –4                   | 0.45                        | 2.4                         |
| 3.3-V LVCMOS            | 0.1                  | –0.1                 | 0.2                         | V <sub>CCIO</sub> – 0.2     |
| 2.5-V LVTTTL and LVCMOS | 1                    | –1                   | 0.4                         | 2.0                         |
| 1.8-V LVTTTL and LVCMOS | 2                    | –2                   | 0.45                        | V <sub>CCIO</sub> – 0.45    |
| 1.5-V LVTTTL and LVCMOS | 2                    | –2                   | 0.25 × V <sub>CCIO</sub>    | 0.75 × V <sub>CCIO</sub>    |
| PCI and PCI-X           | 1.5                  | –0.5                 | 0.1 × V <sub>CCIO</sub>     | 0.9 × V <sub>CCIO</sub>     |
| SSTL-2 class I          | 8.1                  | –8.1                 | V <sub>TT</sub> – 0.57      | V <sub>TT</sub> + 0.57      |
| SSTL-2 class II         | 16.4                 | –16.4                | V <sub>TT</sub> – 0.76      | V <sub>TT</sub> + 0.76      |
| SSTL-18 class I         | 6.7                  | –6.7                 | V <sub>TT</sub> – 0.475     | V <sub>TT</sub> + 0.475     |
| SSTL-18 class II        | 13.4                 | –13.4                | 0.28                        | V <sub>CCIO</sub> – 0.28    |
| 1.8-V HSTL class I      | 8                    | –8                   | 0.4                         | V <sub>CCIO</sub> – 0.4     |
| 1.8-V HSTL class II     | 16                   | –16                  | 0.4                         | V <sub>CCIO</sub> – 0.4     |



**Table 5–7. DC Characteristics of User I/O Pins Using Single-Ended Standards** Notes (1), (2) (Part 2 of 2)

| I/O Standard       | Test Conditions |               | Voltage Thresholds   |                      |
|--------------------|-----------------|---------------|----------------------|----------------------|
|                    | $I_{OL}$ (mA)   | $I_{OH}$ (mA) | Maximum $V_{OL}$ (V) | Minimum $V_{OH}$ (V) |
| 1.5-V HSTL class I | 8               | –8            | 0.4                  | $V_{CCIO} - 0.4$     |
| 1.5V HSTL class II | 16              | –16           | 0.4                  | $V_{CCIO} - 0.4$     |

**Notes to Table 5–7:**

- (1) The values in this table are based on the conditions listed in Tables 5–2 and 5–6.
- (2) This specification is supported across all the programmable drive settings available as shown in the *Cyclone II Architecture* chapter of the *Cyclone II Device Handbook*.

## Differential I/O Standards

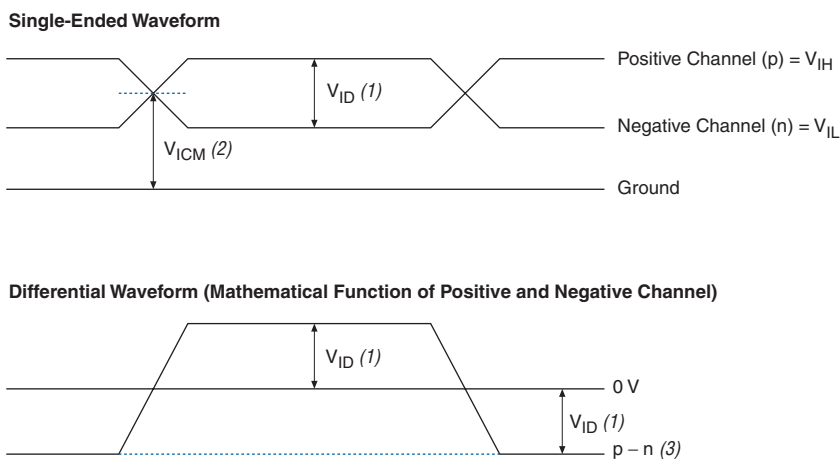
The RSDS and mini-LVDS I/O standards are only supported on output pins. The LVDS I/O standard is supported on both receiver input pins and transmitter output pins.



For more information on how these differential I/O standards are implemented, refer to the *High-Speed Differential Interfaces in Cyclone II Devices* chapter of the *Cyclone II Device Handbook*.

Figure 5–1 shows the receiver input waveforms for all differential I/O standards (LVDS, LVPECL, differential 1.5-V HSTL class I and II, differential 1.8-V HSTL class I and II, differential SSTL-2 class I and II, and differential SSTL-18 class I and II).

**Figure 5–1. Receiver Input Waveforms for Differential I/O Standards**



**Notes to Figure 5–1:**

- (1)  $V_{ID}$  is the differential input voltage.  $V_{ID} = |p - n|$ .
- (2)  $V_{ICM}$  is the input common mode voltage.  $V_{ICM} = (p + n)/2$ .
- (3) The  $p - n$  waveform is a function of the positive channel (p) and the negative channel (n).

Table 5–8 shows the recommended operating conditions for user I/O pins with differential I/O standards.

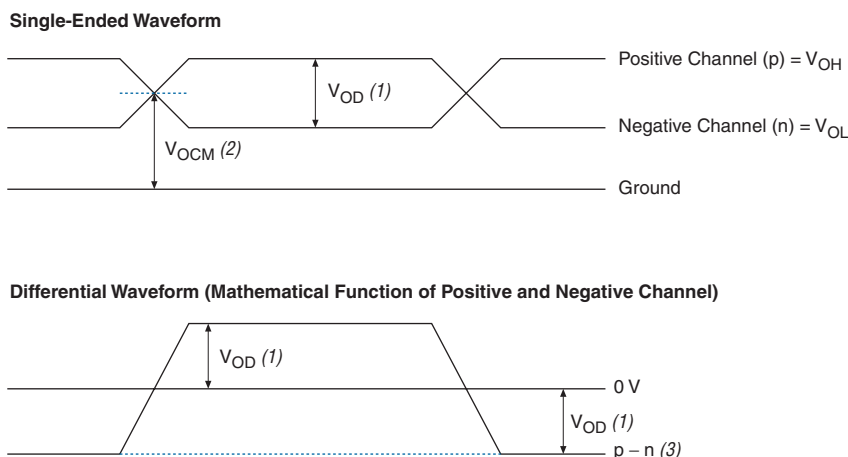
| <b>Table 5–8. Recommended Operating Conditions for User I/O Pins Using Differential Signal I/O Standards</b> |                             |            |            |                               |            |                            |                                     |                            |                                     |                           |                            |                            |            |
|--------------------------------------------------------------------------------------------------------------|-----------------------------|------------|------------|-------------------------------|------------|----------------------------|-------------------------------------|----------------------------|-------------------------------------|---------------------------|----------------------------|----------------------------|------------|
| <b>I/O<br/>Standard</b>                                                                                      | <b>V<sub>CCIO</sub> (V)</b> |            |            | <b>V<sub>ID</sub> (V) (1)</b> |            |                            | <b>V<sub>ICM</sub> (V)</b>          |                            |                                     | <b>V<sub>IL</sub> (V)</b> |                            | <b>V<sub>IH</sub> (V)</b>  |            |
|                                                                                                              | <b>Min</b>                  | <b>Typ</b> | <b>Max</b> | <b>Min</b>                    | <b>Typ</b> | <b>Max</b>                 | <b>Min</b>                          | <b>Typ</b>                 | <b>Max</b>                          | <b>Min</b>                | <b>Max</b>                 | <b>Min</b>                 | <b>Max</b> |
| LVDS                                                                                                         | 2.375                       | 2.5        | 2.625      | 0.1                           | —          | 0.65                       | 0.1                                 | —                          | 2.0                                 | —                         | —                          | —                          | —          |
| Mini-LVDS<br>(2)                                                                                             | 2.375                       | 2.5        | 2.625      | —                             | —          | —                          | —                                   | —                          | —                                   | —                         | —                          | —                          | —          |
| RSDS (2)                                                                                                     | 2.375                       | 2.5        | 2.625      | —                             | —          | —                          | —                                   | —                          | —                                   | —                         | —                          | —                          | —          |
| LVPECL<br>(3) (6)                                                                                            | 3.135                       | 3.3        | 3.465      | 0.1                           | 0.6        | 0.95                       | —                                   | —                          | —                                   | 0                         | 2.2                        | 2.1                        | 2.88       |
| Differential<br>1.5-V HSTL<br>class I<br>and II (4)                                                          | 1.425                       | 1.5        | 1.575      | 0.2                           | —          | V <sub>CCIO</sub><br>+ 0.6 | 0.68                                | —                          | 0.9                                 | —                         | V <sub>REF</sub><br>– 0.20 | V <sub>REF</sub><br>+ 0.20 | —          |
| Differential<br>1.8-V HSTL<br>class I<br>and II (4)                                                          | 1.71                        | 1.8        | 1.89       | —                             | —          | —                          | —                                   | —                          | —                                   | —                         | V <sub>REF</sub><br>– 0.20 | V <sub>REF</sub><br>+ 0.20 | —          |
| Differential<br>SSTL-2<br>class I<br>and II (5)                                                              | 2.375                       | 2.5        | 2.625      | 0.36                          | —          | V <sub>CCIO</sub><br>+ 0.6 | 0.5 ×<br>V <sub>CCIO</sub><br>– 0.2 | 0.5 ×<br>V <sub>CCIO</sub> | 0.5 ×<br>V <sub>CCIO</sub><br>+ 0.2 | —                         | V <sub>REF</sub><br>– 0.35 | V <sub>REF</sub><br>+ 0.35 | —          |
| Differential<br>SSTL-18<br>class I<br>and II (5)                                                             | 1.7                         | 1.8        | 1.9        | 0.25                          | —          | V <sub>CCIO</sub><br>+ 0.6 | 0.5 ×<br>V <sub>CCIO</sub><br>– 0.2 | 0.5 ×<br>V <sub>CCIO</sub> | 0.5 ×<br>V <sub>CCIO</sub><br>+ 0.2 | —                         | V <sub>REF</sub><br>– 0.25 | V <sub>REF</sub><br>+ 0.25 | —          |

**Notes to Table 5–8:**

- (1) Refer to the *High-Speed Differential Interfaces in Cyclone II Devices* chapter of the *Cyclone II Device Handbook* for measurement conditions on V<sub>ID</sub>.
- (2) The RSDS and mini-LVDS I/O standards are only supported on output pins.
- (3) The LVPECL I/O standard is only supported on clock input pins. This I/O standard is not supported on output pins.
- (4) The differential 1.8-V and 1.5-V HSTL I/O standards are only supported on clock input pins and PLL output clock pins.
- (5) The differential SSTL-18 and SSTL-2 I/O standards are only supported on clock input pins and PLL output clock pins.
- (6) The LVPECL clock inputs are powered by V<sub>CCINT</sub> and support all V<sub>CCIO</sub> settings. However, it is recommended to connect V<sub>CCIO</sub> to typical value of 3.3V.

Figure 5–2 shows the transmitter output waveforms for all supported differential output standards (LVDS, mini-LVDS, RSDS, differential 1.5-V HSTL class I and II, differential 1.8-V HSTL class I and II, differential SSTL-2 class I and II, and differential SSTL-18 class I and II).

**Figure 5–2. Transmitter Output Waveforms for Differential I/O Standards**



**Notes to Figure 5–2:**

- (1)  $V_{OD}$  is the output differential voltage.  $V_{OD} = |p - n|$ .
- (2)  $V_{OCM}$  is the output common mode voltage.  $V_{OCM} = (p + n)/2$ .
- (3) The  $p - n$  waveform is a function of the positive channel ( $p$ ) and the negative channel ( $n$ ).

Table 5–9 shows the DC characteristics for user I/O pins with differential I/O standards.

| <b>Table 5–9. DC Characteristics for User I/O Pins Using Differential I/O Standards</b> <i>Note (1)</i> (Part 1 of 2) |               |     |     |                      |     |               |      |       |                  |     |              |     |
|-----------------------------------------------------------------------------------------------------------------------|---------------|-----|-----|----------------------|-----|---------------|------|-------|------------------|-----|--------------|-----|
| I/O Standard                                                                                                          | $V_{OD}$ (mV) |     |     | $\Delta V_{OD}$ (mV) |     | $V_{OCM}$ (V) |      |       | $V_{OH}$ (V)     |     | $V_{OL}$ (V) |     |
|                                                                                                                       | Min           | Typ | Max | Min                  | Max | Min           | Typ  | Max   | Min              | Max | Min          | Max |
| LVDS                                                                                                                  | 250           | —   | 600 | —                    | 50  | 1.125         | 1.25 | 1.375 | —                | —   | —            | —   |
| mini-LVDS (2)                                                                                                         | 300           | —   | 600 | —                    | 50  | 1.125         | 1.25 | 1.375 | —                | —   | —            | —   |
| RSDS (2)                                                                                                              | 100           | —   | 600 | —                    | —   | 1.125         | 1.25 | 1.375 | —                | —   | —            | —   |
| Differential 1.5-V HSTL class I and II (3)                                                                            | —             | —   | —   | —                    | —   | —             | —    | —     | $V_{CCIO} - 0.4$ | —   | —            | 0.4 |

**Table 5–9. DC Characteristics for User I/O Pins Using Differential I/O Standards** *Note (1)* (Part 2 of 2)

| I/O Standard                               | V <sub>OD</sub> (mV) |     |     | $\Delta V_{OD}$ (mV) |     | V <sub>OCM</sub> (V)          |                       |                               | V <sub>OH</sub> (V)      |     | V <sub>OL</sub> (V) |                         |
|--------------------------------------------|----------------------|-----|-----|----------------------|-----|-------------------------------|-----------------------|-------------------------------|--------------------------|-----|---------------------|-------------------------|
|                                            | Min                  | Typ | Max | Min                  | Max | Min                           | Typ                   | Max                           | Min                      | Max | Min                 | Max                     |
| Differential 1.8-V HSTL class I and II (3) | —                    | —   | —   | —                    | —   | —                             | —                     | —                             | V <sub>CCIO</sub> – 0.4  | —   | —                   | 0.4                     |
| Differential SSTL-2 class I (4)            | —                    | —   | —   | —                    | —   | —                             | —                     | —                             | V <sub>TT</sub> + 0.57   | —   | —                   | V <sub>TT</sub> – 0.57  |
| Differential SSTL-2 class II (4)           | —                    | —   | —   | —                    | —   | —                             | —                     | —                             | V <sub>TT</sub> + 0.76   | —   | —                   | V <sub>TT</sub> – 0.76  |
| Differential SSTL-18 class I (4)           | —                    | —   | —   | —                    | —   | $0.5 \times V_{CCIO} - 0.125$ | $0.5 \times V_{CCIO}$ | $0.5 \times V_{CCIO} + 0.125$ | V <sub>TT</sub> + 0.475  | —   | —                   | V <sub>TT</sub> – 0.475 |
| Differential SSTL-18 class II (4)          | —                    | —   | —   | —                    | —   | $0.5 \times V_{CCIO} - 0.125$ | $0.5 \times V_{CCIO}$ | $0.5 \times V_{CCIO} + 0.125$ | V <sub>CCIO</sub> – 0.28 | —   | —                   | 0.28                    |

**Notes to Table 5–9:**

- (1) The LVPECL I/O standard is only supported on clock input pins. This I/O standard is not supported on output pins.
- (2) The RSDS and mini-LVDS I/O standards are only supported on output pins.
- (3) The differential 1.8-V HSTL and differential 1.5-V HSTL I/O standards are only supported on clock input pins and PLL output clock pins.
- (4) The differential SSTL-18 and SSTL-2 I/O standards are only supported on clock input pins and PLL output clock pins.

## DC Characteristics for Different Pin Types

Table 5–10 shows the types of pins that support bus hold circuitry.

**Table 5–10. Bus Hold Support**

| Pin Type                                  | Bus Hold |
|-------------------------------------------|----------|
| I/O pins using single-ended I/O standards | Yes      |
| I/O pins using differential I/O standards | No       |
| Dedicated clock pins                      | No       |
| JTAG                                      | No       |
| Configuration pins                        | No       |

Table 5–11 specifies the bus hold parameters for general I/O pins.

| Table 5–11. Bus Hold Parameters      Note (1) |                                             |                         |      |       |      |       |      |      |
|-----------------------------------------------|---------------------------------------------|-------------------------|------|-------|------|-------|------|------|
| Parameter                                     | Conditions                                  | V <sub>CCIO</sub> Level |      |       |      |       |      | Unit |
|                                               |                                             | 1.8 V                   |      | 2.5 V |      | 3.3 V |      |      |
|                                               |                                             | Min                     | Max  | Min   | Max  | Min   | Max  |      |
| Bus-hold low, sustaining current              | V <sub>IN</sub> > V <sub>IL</sub> (maximum) | 30                      | —    | 50    | —    | 70    | —    | μA   |
| Bus-hold high, sustaining current             | V <sub>IN</sub> < V <sub>IL</sub> (minimum) | –30                     | —    | –50   | —    | –70   | —    | μA   |
| Bus-hold low, overdrive current               | 0 V < V <sub>IN</sub> < V <sub>CCIO</sub>   | —                       | 200  | —     | 300  | —     | 500  | μA   |
| Bus-hold high, overdrive current              | 0 V < V <sub>IN</sub> < V <sub>CCIO</sub>   | —                       | –200 | —     | –300 | —     | –500 | μA   |
| Bus-hold trip point (2)                       | —                                           | 0.68                    | 1.07 | 0.7   | 1.7  | 0.8   | 2.0  | V    |

**Notes to Table 5–11:**

- (1) There is no specification for bus-hold at  $V_{CCIO} = 1.5\text{ V}$  for the HSTL I/O standard.  
 (2) The bus-hold trip points are based on calculated input voltages from the JEDEC standard.

## On-Chip Termination Specifications

Table 5–12 defines the specifications for internal termination resistance tolerance when using series or differential on-chip termination.

| <b>Table 5–12. Series On-Chip Termination Specifications</b> |                                                                        |                          |                      |                |                              |      |
|--------------------------------------------------------------|------------------------------------------------------------------------|--------------------------|----------------------|----------------|------------------------------|------|
| Symbol                                                       | Description                                                            | Conditions               | Resistance Tolerance |                |                              |      |
|                                                              |                                                                        |                          | Commercial Max       | Industrial Max | Extended/Automotive Temp Max | Unit |
| $25\text{-}\Omega R_S$                                       | Internal series termination without calibration (25- $\Omega$ setting) | $V_{CCIO} = 3.3\text{V}$ | $\pm 30$             | $\pm 30$       | $\pm 40$                     | %    |
| $50\text{-}\Omega R_S$                                       | Internal series termination without calibration (50- $\Omega$ setting) | $V_{CCIO} = 2.5\text{V}$ | $\pm 30$             | $\pm 30$       | $\pm 40$                     | %    |
| $50\text{-}\Omega R_S$                                       | Internal series termination without calibration (50- $\Omega$ setting) | $V_{CCIO} = 1.8\text{V}$ | $\pm 30$ (1)         | $\pm 40$       | $\pm 50$                     | %    |

**Note to Table 5–12:**

- (1) For commercial –8 devices, the tolerance is  $\pm 40\%$ .

Table 5–13 shows the Cyclone II device pin capacitance for different I/O pin types.

| <b>Table 5–13. Device Capacitance</b> <i>Note (1)</i> |                                                                                          |                |             |
|-------------------------------------------------------|------------------------------------------------------------------------------------------|----------------|-------------|
| <b>Symbol</b>                                         | <b>Parameter</b>                                                                         | <b>Typical</b> | <b>Unit</b> |
| $C_{IO}$                                              | Input capacitance for user I/O pin.                                                      | 6              | pF          |
| $C_{LVDS}$                                            | Input capacitance for dual-purpose LVDS/user I/O pin.                                    | 6              | pF          |
| $C_{VREF}$                                            | Input capacitance for dual-purpose $V_{REF}$ pin when used as $V_{REF}$ or user I/O pin. | 21             | pF          |
| $C_{CLK}$                                             | Input capacitance for clock pin.                                                         | 5              | pF          |

**Note to Table 5–13:**

- (1) Capacitance is sample-tested only. Capacitance is measured using time-domain reflectometry (TDR). Measurement accuracy is within  $\pm 0.5$  pF.

## Power Consumption

You can calculate the power usage for your design using the PowerPlay Early Power Estimator and the PowerPlay Power Analyzer feature in the Quartus® II software.

The interactive PowerPlay Early Power Estimator is typically used during the early stages of FPGA design, prior to finalizing the project, to get a magnitude estimate of the device power. The Quartus II software PowerPlay Power Analyzer feature is typically used during the later stages of FPGA design. The PowerPlay Power Analyzer also allows you to apply test vectors against your design for more accurate power consumption modeling.

In both cases, only use these calculations as an estimation of power, not as a specification. For more information on PowerPlay tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *Power Estimation and Analysis* section in volume 3 of the *Quartus II Handbook*.



You can obtain the Excel-based PowerPlay Early Power Estimator at [www.altera.com](http://www.altera.com). Refer to Table 5–3 on page 5–3 for typical  $I_{CC}$  standby specifications.

The power-up current required by Cyclone II devices does not exceed the maximum static current. The rate at which the current increases is a function of the system power supply. The exact amount of current consumed varies according to the process, temperature, and power ramp rate. The duration of the  $I_{CCINT}$  power-up requirement depends on the  $V_{CCINT}$  voltage supply rise time.

You should select power supplies and regulators that can supply the amount of current required when designing with Cyclone II devices.

Altera recommends using the Cyclone II PowerPlay Early Power Estimator to estimate the user-mode  $I_{CCINT}$  consumption and then select power supplies or regulators based on the values obtained.

## Timing Specifications

The DirectDrive™ technology and MultiTrack™ interconnect ensure predictable performance, accurate simulation, and accurate timing analysis across all Cyclone II device densities and speed grades. This section describes and specifies the performance, internal, external, high-speed I/O, JTAG, and PLL timing specifications.

This section shows the timing models for Cyclone II devices. Commercial devices meet this timing over the commercial temperature range. Industrial devices meet this timing over the industrial temperature range. Automotive devices meet this timing over the automotive temperature range. Extended devices meet this timing over the extended temperature range. All specifications are representative of worst-case supply voltage and junction temperature conditions.

### Preliminary and Final Timing Specifications

Timing models can have either preliminary or final status. The Quartus II software issues an informational message during the design compilation if the timing models are preliminary. [Table 5–14](#) shows the status of the Cyclone II device timing models.

Preliminary status means the timing model is subject to change. Initially, timing numbers are created using simulation results, process data, and other known parameters. These tests are used to make the preliminary numbers as close to the actual timing parameters as possible.



Final timing numbers are based on actual device operation and testing. These numbers reflect the actual performance of the device under worst-case voltage and junction temperature conditions.

**Table 5–14. Cyclone II Device Timing Model Status**

| Device   | Speed Grade           | Preliminary | Final |
|----------|-----------------------|-------------|-------|
| EP2C5/A  | Commercial/Industrial | —           | ✓     |
|          | Automotive            | ✓           | —     |
| EP2C8/A  | Commercial/Industrial | —           | ✓     |
|          | Automotive            | ✓           | —     |
| EP2C15A  | Commercial/Industrial | —           | ✓     |
|          | Automotive            | ✓           | —     |
| EP2C20/A | Commercial/Industrial | —           | ✓     |
|          | Automotive            | ✓           | —     |
| EP2C35   | Commercial/Industrial | —           | ✓     |
| EP2C50   | Commercial/Industrial | —           | ✓     |
| EP2C70   | Commercial/Industrial | —           | ✓     |

## Performance

Table 5–15 shows Cyclone II performance for some common designs. All performance values were obtained with Quartus II software compilation of LPM, or MegaCore functions for the FIR and FFT designs.

**Table 5–15. Cyclone II Performance (Part 1 of 4)**

| Applications |                         | Resources Used |                   |            | Performance (MHz) |                    |                    |                |
|--------------|-------------------------|----------------|-------------------|------------|-------------------|--------------------|--------------------|----------------|
|              |                         | LEs            | M4K Memory Blocks | DSP Blocks | –6 Speed Grade    | –7 Speed Grade (6) | –7 Speed Grade (7) | –8 Speed Grade |
| LE           | 16-to-1 multiplexer (1) | 21             | 0                 | 0          | 385.35            | 313.97             | 270.85             | 286.04         |
|              | 32-to-1 multiplexer (1) | 38             | 0                 | 0          | 294.2             | 260.75             | 228.78             | 191.02         |
|              | 16-bit counter          | 16             | 0                 | 0          | 401.6             | 349.4              | 310.65             | 310.65         |
|              | 64-bit counter          | 64             | 0                 | 0          | 157.15            | 137.98             | 126.08             | 126.27         |

Table 5–15. Cyclone II Performance (Part 2 of 4)

| Applications     |                                                                                             | Resources Used |                   |            | Performance (MHz) |                    |                    |                |
|------------------|---------------------------------------------------------------------------------------------|----------------|-------------------|------------|-------------------|--------------------|--------------------|----------------|
|                  |                                                                                             | LEs            | M4K Memory Blocks | DSP Blocks | –6 Speed Grade    | –7 Speed Grade (6) | –7 Speed Grade (7) | –8 Speed Grade |
| Memory M4K block | Simple dual-port RAM 128 × 36 bit (3), (5)                                                  | 0              | 1                 | 0          | 235.29            | 194.93             | 163.13             | 163.13         |
|                  | True dual-port RAM 128 × 18 bit (3), (5)                                                    | 0              | 1                 | 0          | 235.29            | 194.93             | 163.13             | 163.13         |
|                  | FIFO 128 × 16 bit (5)                                                                       | 32             | 1                 | 0          | 235.29            | 194.93             | 163.13             | 163.13         |
|                  | Simple dual-port RAM 128 × 36 bit (4),(5)                                                   | 0              | 1                 | 0          | 210.08            | 195.0              | 163.02             | 163.02         |
|                  | True dual-port RAM 128x18 bit (4),(5)                                                       | 0              | 1                 | 0          | 163.02            | 163.02             | 163.02             | 163.02         |
| DSP block        | 9 × 9-bit multiplier (2)                                                                    | 0              | 0                 | 1          | 260.01            | 216.73             | 180.57             | 180.57         |
|                  | 18 × 18-bit multiplier (2)                                                                  | 0              | 0                 | 1          | 260.01            | 216.73             | 180.57             | 180.57         |
|                  | 18-bit, 4 tap FIR filter                                                                    | 113            | 0                 | 8          | 182.74            | 147.47             | 127.74             | 122.98         |
| Larger Designs   | 8-bit, 16 tap parallel FIR filter                                                           | 52             | 0                 | 4          | 153.56            | 131.25             | 110.44             | 110.57         |
|                  | 8-bit, 1024 pt, Streaming, 3 Mults/5 Adders FFT function                                    | 3191           | 22                | 9          | 235.07            | 195.0              | 147.51             | 163.02         |
|                  | 8-bit, 1024 pt, Streaming, 4 Mults/2 Adders FFT function                                    | 3041           | 22                | 12         | 235.07            | 195.0              | 146.3              | 163.02         |
|                  | 8-bit, 1024 pt, Single Output, 1 Parallel FFT Engine, Burst, 3 Mults/5 Adders FFT function  | 1056           | 5                 | 3          | 235.07            | 195.0              | 147.84             | 163.02         |
|                  | 8-bit, 1024 pt, Single Output, 1 Parallel FFT Engine, Burst, 4 Mults/2 Adders FFT function  | 1006           | 5                 | 4          | 235.07            | 195.0              | 149.99             | 163.02         |
|                  | 8-bit, 1024 pt, Single Output, 2 Parallel FFT Engines, Burst, 3 Mults/5 Adders FFT function | 1857           | 10                | 6          | 200.0             | 195.0              | 149.61             | 163.02         |
|                  | 8-bit, 1024 pt, Single Output, 2 Parallel FFT Engines, Burst, 4 Mults/2 Adders FFT function | 1757           | 10                | 8          | 200.0             | 195.0              | 149.34             | 163.02         |
|                  | 8-bit, 1024 pt, Quad Output, 1 Parallel FFT Engine, Burst, 3 Mults/5 Adders FFT function    | 2550           | 10                | 9          | 235.07            | 195.0              | 148.21             | 163.02         |

**Table 5–15. Cyclone II Performance (Part 3 of 4)**

| Applications   |                                                                                                    | Resources Used |                   |            | Performance (MHz) |                    |                    |                |
|----------------|----------------------------------------------------------------------------------------------------|----------------|-------------------|------------|-------------------|--------------------|--------------------|----------------|
|                |                                                                                                    | LEs            | M4K Memory Blocks | DSP Blocks | –6 Speed Grade    | –7 Speed Grade (6) | –7 Speed Grade (7) | –8 Speed Grade |
| Larger Designs | 8-bit, 1024 pt, Quad Output, 1 Parallel FFT Engine, Burst, 4 Mults/2 Adders FFT function           | 2400           | 10                | 12         | 235.07            | 195.0              | 140.11             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 2 Parallel FFT Engines, Burst, 3 Mults/5 Adders FFT function          | 4343           | 14                | 18         | 200.0             | 195.0              | 152.67             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 2 Parallel FFT Engines, Burst, 4 Mults/2 Adders FFT function          | 4043           | 14                | 24         | 200.0             | 195.0              | 149.72             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 4 Parallel FFT Engines, Burst, 3 Mults/5 Adders FFT function          | 7496           | 28                | 36         | 200.0             | 195.0              | 150.01             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 4 Parallel FFT Engines, Burst, 4 Mults/2 Adders FFT function          | 6896           | 28                | 48         | 200.0             | 195.0              | 151.33             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 1 Parallel FFT Engine, Buffered Burst, 3 Mults/5 Adders FFT function  | 2934           | 18                | 9          | 235.07            | 195.0              | 148.89             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 1 Parallel FFT Engine, Buffered Burst, 4 Mults/2 Adders FFT function  | 2784           | 18                | 12         | 235.07            | 195.0              | 151.51             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 2 Parallel FFT Engines, Buffered Burst, 3 Mults/5 Adders FFT function | 4720           | 30                | 18         | 200.0             | 195.0              | 149.76             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 2 Parallel FFT Engines, Buffered Burst, 4 Mults/2 Adders FFT function | 4420           | 30                | 24         | 200.0             | 195.0              | 151.08             | 163.02         |

**Table 5–15. Cyclone II Performance (Part 4 of 4)**

| Applications   |                                                                                                    | Resources Used |                   |            | Performance (MHz) |                    |                    |                |
|----------------|----------------------------------------------------------------------------------------------------|----------------|-------------------|------------|-------------------|--------------------|--------------------|----------------|
|                |                                                                                                    | LEs            | M4K Memory Blocks | DSP Blocks | –6 Speed Grade    | –7 Speed Grade (6) | –7 Speed Grade (7) | –8 Speed Grade |
| Larger Designs | 8-bit, 1024 pt, Quad Output, 4 Parallel FFT Engines, Buffered Burst, 3 Mults/5 Adders FFT function | 8053           | 60                | 36         | 200.0             | 195.0              | 149.23             | 163.02         |
|                | 8-bit, 1024 pt, Quad Output, 4 Parallel FFT Engines, Buffered Burst, 4 Mults/2 Adders FFT function | 7453           | 60                | 48         | 200.0             | 195.0              | 151.28             | 163.02         |

**Notes to Table 5–15 :**

- (1) This application uses registered inputs and outputs.
- (2) This application uses registered multiplier input and output stages within the DSP block.
- (3) This application uses the same clock source for both A and B ports.
- (4) This application uses independent clock sources for A and B ports.
- (5) This application uses PLL clock outputs that are globally routed to connect and drive M4K clock ports. Use of non-PLL clock sources or local routing to drive M4K clock ports may result in lower performance numbers than shown here. Refer to the Quartus II timing report for actual performance numbers.
- (6) These numbers are for commercial devices.
- (7) These numbers are for automotive devices.

## Internal Timing

Refer to Tables 5–16 through 5–19 for the internal timing parameters.

**Table 5–16. LE\_FF Internal Timing Microparameters (Part 1 of 2)**

| Parameter | –6 Speed Grade (1) |     | –7 Speed Grade (2) |     | –8 Speed Grade (3) |     | Unit |
|-----------|--------------------|-----|--------------------|-----|--------------------|-----|------|
|           | Min                | Max | Min                | Max | Min                | Max |      |
| TSU       | –36                | —   | –40                | —   | –40                | —   | ps   |
|           | —                  | —   | –38                | —   | –40                | —   | ps   |
| TH        | 266                | —   | 306                | —   | 306                | —   | ps   |
|           | —                  | —   | 286                | —   | 306                | —   | ps   |
| TCO       | 141                | 250 | 135                | 277 | 135                | 304 | ps   |
|           | —                  | —   | 141                | —   | 141                | —   | ps   |
| TCLR      | 191                | —   | 244                | —   | 244                | —   | ps   |
|           | —                  | —   | 217                | —   | 244                | —   | ps   |

**Table 5–16. LE\_FF Internal Timing Microparameters (Part 2 of 2)**

| Parameter | –6 Speed Grade (1) |     | –7 Speed Grade (2) |     | –8 Speed Grade (3) |     | Unit |
|-----------|--------------------|-----|--------------------|-----|--------------------|-----|------|
|           | Min                | Max | Min                | Max | Min                | Max |      |
| TPRE      | 191                | —   | 244                | —   | 244                | —   | ps   |
|           | —                  | —   | 217                | —   | 244                | —   | ps   |
| TCLKL     | 1000               | —   | 1242               | —   | 1242               | —   | ps   |
|           | —                  | —   | 1111               | —   | 1242               | —   | ps   |
| TCLKH     | 1000               | —   | 1242               | —   | 1242               | —   | ps   |
|           | —                  | —   | 1111               | —   | 1242               | —   | ps   |
| tLUT      | 180                | 438 | 172                | 545 | 172                | 651 | ps   |
|           | —                  | —   | 180                | —   | 180                | —   | ps   |

**Notes to Table 5–16:**

- (1) For the –6 speed grades, the minimum timing is for the commercial temperature grade. The –7 speed grade devices offer the automotive temperature grade. The –8 speed grade devices offer the industrial temperature grade.
- (2) For each parameter of the –7 speed grade columns, the value in the first row represents the minimum timing parameter for automotive devices. The second row represents the minimum timing parameter for commercial devices.
- (3) For each parameter of the –8 speed grade columns, the value in the first row represents the minimum timing parameter for industrial devices. The second row represents the minimum timing parameter for commercial devices.

**Table 5–17. IOE Internal Timing Microparameters (Part 1 of 2)**

| Parameter      | –6 Speed Grade (1) |      | –7 Speed Grade (2) |      | –8 Speed Grade (3) |      | Unit |
|----------------|--------------------|------|--------------------|------|--------------------|------|------|
|                | Min                | Max  | Min                | Max  | Min                | Max  |      |
| TSU            | 76                 | —    | 101                | —    | 101                | —    | ps   |
|                | —                  | —    | 89                 | —    | 101                | —    | ps   |
| TH             | 88                 | —    | 106                | —    | 106                | —    | ps   |
|                | —                  | —    | 97                 | —    | 106                | —    | ps   |
| TCO            | 99                 | 155  | 95                 | 171  | 95                 | 187  | ps   |
|                | —                  | —    | 99                 | —    | 99                 | —    | ps   |
| TPIN2COMBOUT_R | 384                | 762  | 366                | 784  | 366                | 855  | ps   |
|                | —                  | —    | 384                | —    | 384                | —    | ps   |
| TPIN2COMBOUT_C | 385                | 760  | 367                | 783  | 367                | 854  | ps   |
|                | —                  | —    | 385                | —    | 385                | —    | ps   |
| TCOMBIN2PIN_R  | 1344               | 2490 | 1280               | 2689 | 1280               | 2887 | ps   |
|                | —                  | —    | 1344               | —    | 1344               | —    | ps   |

**Table 5–17. IOE Internal Timing Microparameters (Part 2 of 2)**

| Parameter     | –6 Speed Grade (1) |      | –7 Speed Grade (2) |      | –8 Speed Grade (3) |      | Unit |
|---------------|--------------------|------|--------------------|------|--------------------|------|------|
|               | Min                | Max  | Min                | Max  | Min                | Max  |      |
| TCOMBIN2PIN_C | 1418               | 2622 | 1352               | 2831 | 1352               | 3041 | ps   |
|               | —                  | —    | 1418               | —    | 1418               | —    | ps   |
| TCLR          | 137                | —    | 165                | —    | 165                | —    | ps   |
|               | —                  | —    | 151                | —    | 165                | —    | ps   |
| TPRE          | 192                | —    | 233                | —    | 233                | —    | ps   |
|               | —                  | —    | 212                | —    | 233                | —    | ps   |
| TCLKL         | 1000               | —    | 1242               | —    | 1242               | —    | ps   |
|               | —                  | —    | 1111               | —    | 1242               | —    | ps   |
| TCLKH         | 1000               | —    | 1242               | —    | 1242               | —    | ps   |
|               | —                  | —    | 1111               | —    | 1242               | —    | ps   |

**Notes to Table 5–17:**

- (1) For the –6 speed grades, the minimum timing is for the commercial temperature grade. The –7 speed grade devices offer the automotive temperature grade. The –8 speed grade devices offer the industrial temperature grade.
- (2) For each parameter of the –7 speed grade columns, the value in the first row represents the minimum timing parameter for automotive devices. The second row represents the minimum timing parameter for commercial devices.
- (3) For each parameter of the –8 speed grade columns, the value in the first row represents the minimum timing parameter for industrial devices. The second row represents the minimum timing parameter for commercial devices.

**Table 5–18. DSP Block Internal Timing Microparameters (Part 1 of 2)**

| Parameter     | –6 Speed Grade (1) |      | –7 Speed Grade (2) |      | –8 Speed Grade (3) |      | Unit |
|---------------|--------------------|------|--------------------|------|--------------------|------|------|
|               | Min                | Max  | Min                | Max  | Min                | Max  |      |
| TSU           | 47                 | —    | 62                 | —    | 62                 | —    | ps   |
|               | —                  | —    | 54                 | —    | 62                 | —    | ps   |
| TH            | 110                | —    | 113                | —    | 113                | —    | ps   |
|               | —                  | —    | 111                | —    | 113                | —    | ps   |
| TCO           | 0                  | 0    | 0                  | 0    | 0                  | 0    | ps   |
|               | —                  | —    | 0                  | —    | 0                  | —    | ps   |
| TINREG2PIPE9  | 652                | 1379 | 621                | 1872 | 621                | 2441 | ps   |
|               | —                  | —    | 652                | —    | 652                | —    | ps   |
| TINREG2PIPE18 | 652                | 1379 | 621                | 1872 | 621                | 2441 | ps   |
|               | —                  | —    | 652                | —    | 652                | —    | ps   |

**Table 5–18. DSP Block Internal Timing Microparameters (Part 2 of 2)**

| Parameter    | –6 Speed Grade (1) |      | –7 Speed Grade (2) |      | –8 Speed Grade (3) |      | Unit |
|--------------|--------------------|------|--------------------|------|--------------------|------|------|
|              | Min                | Max  | Min                | Max  | Min                | Max  |      |
| TPIPE2OUTREG | 47                 | 104  | 45                 | 142  | 45                 | 185  | ps   |
|              | —                  | —    | 47                 | —    | 47                 | —    | ps   |
| TPD9         | 529                | 2470 | 505                | 3353 | 505                | 4370 | ps   |
|              | —                  | —    | 529                | —    | 529                | —    | ps   |
| TPD18        | 425                | 2903 | 406                | 3941 | 406                | 5136 | ps   |
|              | —                  | —    | 425                | —    | 425                | —    | ps   |
| TCLR         | 2686               | —    | 3572               | —    | 3572               | —    | ps   |
|              | —                  | —    | 3129               | —    | 3572               | —    | ps   |
| TCLKL        | 1923               | —    | 2769               | —    | 2769               | —    | ps   |
|              | —                  | —    | 2307               | —    | 2769               | —    | ps   |
| TCLKH        | 1923               | —    | 2769               | —    | 2769               | —    | ps   |
|              | —                  | —    | 2307               | —    | 2769               | —    | ps   |

**Notes to Table 5–18:**

- (1) For the –6 speed grades, the minimum timing is for the commercial temperature grade. The –7 speed grade devices offer the automotive temperature grade. The –8 speed grade devices offer the industrial temperature grade.
- (2) For each parameter of the –7 speed grade columns, the value in the first row represents the minimum timing parameter for automotive devices. The second row represents the minimum timing parameter for commercial devices.
- (3) For each parameter of the –8 speed grade columns, the value in the first row represents the minimum timing parameter for industrial devices. The second row represents the minimum timing parameter for commercial devices.

**Table 5–19. M4K Block Internal Timing Microparameters (Part 1 of 3)**

| Parameter  | –6 Speed Grade (1) |      | –7 Speed Grade (2) |      | –8 Speed Grade (3) |      | Unit |
|------------|--------------------|------|--------------------|------|--------------------|------|------|
|            | Min                | Max  | Min                | Max  | Min                | Max  |      |
| TM4KRC     | 2387               | 3764 | 2275               | 4248 | 2275               | 4736 | ps   |
|            | —                  | —    | 2387               | —    | 2387               | —    | ps   |
| TM4KWERESU | 35                 | —    | 46                 | —    | 46                 | —    | ps   |
|            | —                  | —    | 40                 | —    | 46                 | —    | ps   |
| TM4KWEREH  | 234                | —    | 267                | —    | 267                | —    | ps   |
|            | —                  | —    | 250                | —    | 267                | —    | ps   |
| TM4KBESU   | 35                 | —    | 46                 | —    | 46                 | —    | ps   |
|            | —                  | —    | 40                 | —    | 46                 | —    | ps   |

**Table 5–19. M4K Block Internal Timing Microparameters (Part 2 of 3)**

| Parameter    | –6 Speed Grade (1) |      | –7 Speed Grade (2) |      | –8 Speed Grade (3) |      | Unit |
|--------------|--------------------|------|--------------------|------|--------------------|------|------|
|              | Min                | Max  | Min                | Max  | Min                | Max  |      |
| TM4KBEH      | 234                | —    | 267                | —    | 267                | —    | ps   |
|              | —                  | —    | 250                | —    | 267                | —    | ps   |
| TM4KDATAASU  | 35                 | —    | 46                 | —    | 46                 | —    | ps   |
|              | —                  | —    | 40                 | —    | 46                 | —    | ps   |
| TM4KDATAAH   | 234                | —    | 267                | —    | 267                | —    | ps   |
|              | —                  | —    | 250                | —    | 267                | —    | ps   |
| TM4KADDRASU  | 35                 | —    | 46                 | —    | 46                 | —    | ps   |
|              | —                  | —    | 40                 | —    | 46                 | —    | ps   |
| TM4KADDRAH   | 234                | —    | 267                | —    | 267                | —    | ps   |
|              | —                  | —    | 250                | —    | 267                | —    | ps   |
| TM4KDATABSU  | 35                 | —    | 46                 | —    | 46                 | —    | ps   |
|              | —                  | —    | 40                 | —    | 46                 | —    | ps   |
| TM4KDATABH   | 234                | —    | 267                | —    | 267                | —    | ps   |
|              | —                  | —    | 250                | —    | 267                | —    | ps   |
| TM4KRADDRBSU | 35                 | —    | 46                 | —    | 46                 | —    | ps   |
|              | —                  | —    | 40                 | —    | 46                 | —    | ps   |
| TM4KRADDRBH  | 234                | —    | 267                | —    | 267                | —    | ps   |
|              | —                  | —    | 250                | —    | 267                | —    | ps   |
| TM4KDATAO1   | 466                | 724  | 445                | 826  | 445                | 930  | ps   |
|              | —                  | —    | 466                | —    | 466                | —    | ps   |
| TM4KDATAO2   | 2345               | 3680 | 2234               | 4157 | 2234               | 4636 | ps   |
|              | —                  | —    | 2345               | —    | 2345               | —    | ps   |
| TM4KCLKH     | 1923               | —    | 2769               | —    | 2769               | —    | ps   |
|              | —                  | —    | 2307               | —    | 2769               | —    | ps   |
| TM4KCLKL     | 1923               | —    | 2769               | —    | 2769               | —    | ps   |
|              | —                  | —    | 2307               | —    | 2769               | —    | ps   |



**Table 5–19. M4K Block Internal Timing Microparameters (Part 3 of 3)**

| Parameter | –6 Speed Grade (1) |     | –7 Speed Grade (2) |     | –8 Speed Grade (3) |     | Unit |
|-----------|--------------------|-----|--------------------|-----|--------------------|-----|------|
|           | Min                | Max | Min                | Max | Min                | Max |      |
| TM4KCLR   | 191                | —   | 244                | —   | 244                | —   | ps   |
|           | —                  | —   | 217                | —   | 244                | —   | ps   |

**Notes to Table 5–19:**

- (1) For the –6 speed grades, the minimum timing is for the commercial temperature grade. The –7 speed grade devices offer the automotive temperature grade. The –8 speed grade devices offer the industrial temperature grade.
- (2) For each parameter of the –7 speed grade columns, the value in the first row represents the minimum timing parameter for automotive devices. The second row represents the minimum timing parameter for commercial devices.
- (3) For each parameter of the –8 speed grade columns, the value in the first row represents the minimum timing parameter for industrial devices. The second row represents the minimum timing parameter for commercial devices.

## Cyclone II Clock Timing Parameters

Refer to Tables 5–20 through 5–34 for Cyclone II clock timing parameters.

**Table 5–20. Cyclone II Clock Timing Parameters**

| Symbol        | Parameter                                              |
|---------------|--------------------------------------------------------|
| $t_{CIN}$     | Delay from clock pad to I/O input register             |
| $t_{COUT}$    | Delay from clock pad to I/O output register            |
| $t_{PLLIN}$   | Delay from PLL <i>inclk</i> pad to I/O input register  |
| $t_{PLLCOUT}$ | Delay from PLL <i>inclk</i> pad to I/O output register |

## EP2C5/A Clock Timing Parameters

Tables 5–21 and 5–22 show the clock timing parameters for EP2C5/A devices.

**Table 5–21. EP2C5/A Column Pins Global Clock Timing Parameters (Part 1 of 2)**

| Parameter   | Fast Corner           |            | –6 Speed Grade | –7 Speed Grade (1) | –7 Speed Grade (2) | –8 Speed Grade | Unit |
|-------------|-----------------------|------------|----------------|--------------------|--------------------|----------------|------|
|             | Industrial/Automotive | Commercial |                |                    |                    |                |      |
| $t_{CIN}$   | 1.283                 | 1.343      | 2.329          | 2.484              | 2.688              | 2.688          | ns   |
| $t_{COUT}$  | 1.297                 | 1.358      | 2.363          | 2.516              | 2.717              | 2.717          | ns   |
| $t_{PLLIN}$ | –0.188                | –0.201     | 0.076          | 0.038              | 0.042              | 0.052          | ns   |

**Table 5–21. EP2C5/A Column Pins Global Clock Timing Parameters (Part 2 of 2)**

| Parameter            | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|----------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                      | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| t <sub>PLLCOUT</sub> | –0.174                    | –0.186     | 0.11           | 0.07                  | 0.071                 | 0.081          | ns   |

Notes to Table 5–21:

(1) These numbers are for commercial devices.

(2) These numbers are for automotive devices.

**Table 5–22. EP2C5/A Row Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|----------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                      | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| t <sub>CIN</sub>     | 1.212                     | 1.267      | 2.210          | 2.351                 | 2.54                  | 2.540          | ns   |
| t <sub>COUT</sub>    | 1.214                     | 1.269      | 2.226          | 2.364                 | 2.548                 | 2.548          | ns   |
| t <sub>PLLCIN</sub>  | –0.259                    | –0.277     | –0.043         | –0.095                | –0.106                | –0.096         | ns   |
| t <sub>PLLCOUT</sub> | –0.257                    | –0.275     | –0.027         | –0.082                | –0.098                | –0.088         | ns   |

Notes to Table 5–22:

(1) These numbers are for commercial devices.

(2) These numbers are for automotive devices.

### EP2C8/A Clock Timing Parameters

Tables 5–23 and 5–24 show the clock timing parameters for EP2C8/A devices.

**Table 5–23. EP2C8/A Column Pins Global Clock Timing Parameters (Part 1 of 2)**

| Parameter           | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|---------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                     | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| t <sub>CIN</sub>    | 1.339                     | 1.404      | 2.405          | 2.565                 | 2.764                 | 2.774          | ns   |
| t <sub>COUT</sub>   | 1.353                     | 1.419      | 2.439          | 2.597                 | 2.793                 | 2.803          | ns   |
| t <sub>PLLCIN</sub> | –0.193                    | –0.204     | 0.055          | 0.015                 | 0.016                 | 0.026          | ns   |

**Table 5–23. EP2C8/A Column Pins Global Clock Timing Parameters (Part 2 of 2)**

| Parameter            | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|----------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                      | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| $t_{\text{PLLCOUT}}$ | –0.179                    | –0.189     | 0.089          | 0.047                 | 0.045                 | 0.055          | ns   |

Notes to Table 5–23:

- (1) These numbers are for commercial devices.  
 (2) These numbers are for automotive devices.

**Table 5–24. EP2C8/A Row Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|----------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                      | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| $t_{\text{CIN}}$     | 1.256                     | 1.314      | 2.270          | 2.416                 | 2.596                 | 2.606          | ns   |
| $t_{\text{COUT}}$    | 1.258                     | 1.316      | 2.286          | 2.429                 | 2.604                 | 2.614          | ns   |
| $t_{\text{PLLCIN}}$  | –0.276                    | –0.294     | –0.08          | –0.134                | –0.152                | –0.142         | ns   |
| $t_{\text{PLLCOUT}}$ | –0.274                    | –0.292     | –0.064         | –0.121                | –0.144                | –0.134         | ns   |

Notes to Table 5–24:

- (1) These numbers are for commercial devices.  
 (2) These numbers are for automotive devices.

### EP2C15A Clock Timing Parameters

Tables 5–25 and 5–26 show the clock timing parameters for EP2C15A devices.

**Table 5–25. EP2C15A Column Pins Global Clock Timing Parameters**

| Parameter           | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|---------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                     | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| $t_{\text{CIN}}$    | 1.621                     | 1.698      | 2.590          | 2.766                 | 3.009                 | 2.989          | ns   |
| $t_{\text{COUT}}$   | 1.635                     | 1.713      | 2.624          | 2.798                 | 3.038                 | 3.018          | ns   |
| $t_{\text{PLLCIN}}$ | –0.351                    | –0.372     | 0.045          | 0.008                 | 0.046                 | 0.016          | ns   |

**Table 5–25. EP2C15A Column Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|----------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                      | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| t <sub>PLLCOUT</sub> | –0.337                    | –0.357     | 0.079          | 0.04                  | 0.075                 | 0.045          | ns   |

Notes to Table 5–25:

(1) These numbers are for commercial devices.

(2) These numbers are for automotive devices.

**Table 5–26. EP2C15A Row Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|----------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                      | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| t <sub>CIN</sub>     | 1.542                     | 1.615      | 2.490          | 2.651                 | 2.886                 | 2.866          | ns   |
| t <sub>COUT</sub>    | 1.544                     | 1.617      | 2.506          | 2.664                 | 2.894                 | 2.874          | ns   |
| t <sub>PLLCIN</sub>  | –0.424                    | –0.448     | –0.057         | –0.107                | –0.077                | –0.107         | ns   |
| t <sub>PLLCOUT</sub> | –0.422                    | –0.446     | –0.041         | –0.094                | –0.069                | –0.099         | ns   |

Notes to Table 5–26:

(1) These numbers are for commercial devices.

(2) These numbers are for automotive devices.

### EP2C20/A Clock Timing Parameters

Tables 5–27 and 5–28 show the clock timing parameters for EP2C20/A devices.

**Table 5–27. EP2C20/A Column Pins Global Clock Timing Parameters (Part 1 of 2)**

| Parameter           | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|---------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                     | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| t <sub>CIN</sub>    | 1.621                     | 1.698      | 2.590          | 2.766                 | 3.009                 | 2.989          | ns   |
| t <sub>COUT</sub>   | 1.635                     | 1.713      | 2.624          | 2.798                 | 3.038                 | 3.018          | ns   |
| t <sub>PLLCIN</sub> | –0.351                    | –0.372     | 0.045          | 0.008                 | 0.046                 | 0.016          | ns   |

**Table 5–27. EP2C20/A Column Pins Global Clock Timing Parameters (Part 2 of 2)**

| Parameter            | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|----------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                      | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| $t_{\text{PLLCOUT}}$ | –0.337                    | –0.357     | 0.079          | 0.04                  | 0.075                 | 0.045          | ns   |

Notes to Table 5–27:

(1) These numbers are for commercial devices.

(2) These numbers are for automotive devices.

**Table 5–28. EP2C20/A Row Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner               |            | –6 Speed Grade | –7 Speed Grade<br>(1) | –7 Speed Grade<br>(2) | –8 Speed Grade | Unit |
|----------------------|---------------------------|------------|----------------|-----------------------|-----------------------|----------------|------|
|                      | Industrial/<br>Automotive | Commercial |                |                       |                       |                |      |
| $t_{\text{CIN}}$     | 1.542                     | 1.615      | 2.490          | 2.651                 | 2.886                 | 2.866          | ns   |
| $t_{\text{COUT}}$    | 1.544                     | 1.617      | 2.506          | 2.664                 | 2.894                 | 2.874          | ns   |
| $t_{\text{PLLCIN}}$  | –0.424                    | –0.448     | –0.057         | –0.107                | –0.077                | –0.107         | ns   |
| $t_{\text{PLLCOUT}}$ | –0.422                    | –0.446     | –0.041         | –0.094                | –0.069                | –0.099         | ns   |

Notes to Table 5–28:

(1) These numbers are for commercial devices.

(2) These numbers are for automotive devices.

### EP2C35 Clock Timing Parameters

Tables 5–29 and 5–30 show the clock timing parameters for EP2C35 devices.

**Table 5–29. EP2C35 Column Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner |            | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | Unit |
|----------------------|-------------|------------|----------------|----------------|----------------|------|
|                      | Industrial  | Commercial |                |                |                |      |
| $t_{\text{CIN}}$     | 1.499       | 1.569      | 2.652          | 2.878          | 3.155          | ns   |
| $t_{\text{COUT}}$    | 1.513       | 1.584      | 2.686          | 2.910          | 3.184          | ns   |
| $t_{\text{PLLCIN}}$  | –0.026      | –0.032     | 0.272          | 0.316          | 0.41           | ns   |
| $t_{\text{PLLCOUT}}$ | –0.012      | –0.017     | 0.306          | 0.348          | 0.439          | ns   |

**Table 5–30. EP2C35 Row Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner |            | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | Unit |
|----------------------|-------------|------------|----------------|----------------|----------------|------|
|                      | Industrial  | Commercial |                |                |                |      |
| $t_{\text{CIN}}$     | 1.410       | 1.476      | 2.514          | 2.724          | 2.986          | ns   |
| $t_{\text{COUT}}$    | 1.412       | 1.478      | 2.530          | 2.737          | 2.994          | ns   |
| $t_{\text{PLLCIN}}$  | –0.117      | –0.127     | 0.134          | 0.162          | 0.241          | ns   |
| $t_{\text{PLLCOUT}}$ | –0.115      | –0.125     | 0.15           | 0.175          | 0.249          | ns   |

*EP2C50 Clock Timing Parameters*

Tables 5–31 and 5–32 show the clock timing parameters for EP2C50 devices.

**Table 5–31. EP2C50 Column Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner |            | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | Unit |
|----------------------|-------------|------------|----------------|----------------|----------------|------|
|                      | Industrial  | Commercial |                |                |                |      |
| $t_{\text{CIN}}$     | 1.575       | 1.651      | 2.759          | 2.940          | 3.174          | ns   |
| $t_{\text{COUT}}$    | 1.589       | 1.666      | 2.793          | 2.972          | 3.203          | ns   |
| $t_{\text{PLLCIN}}$  | –0.149      | –0.158     | 0.113          | 0.075          | 0.089          | ns   |
| $t_{\text{PLLCOUT}}$ | –0.135      | –0.143     | 0.147          | 0.107          | 0.118          | ns   |

**Table 5–32. EP2C50 Row Pins Global Clock Timing Parameters**

| Parameter            | Fast Corner |            | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | Unit |
|----------------------|-------------|------------|----------------|----------------|----------------|------|
|                      | Industrial  | Commercial |                |                |                |      |
| $t_{\text{CIN}}$     | 1.463       | 1.533      | 2.624          | 2.791          | 3.010          | ns   |
| $t_{\text{COUT}}$    | 1.465       | 1.535      | 2.640          | 2.804          | 3.018          | ns   |
| $t_{\text{PLLCIN}}$  | –0.261      | –0.276     | –0.022         | –0.074         | –0.075         | ns   |
| $t_{\text{PLLCOUT}}$ | –0.259      | –0.274     | –0.006         | –0.061         | –0.067         | ns   |

*EP2C70 Clock Timing Parameters*

Tables 5–33 and 5–34 show the clock timing parameters for EP2C70 devices.

**Table 5–33. EP2C70 Column Pins Global Clock Timing Parameters**

| Parameter     | Fast Corner |            | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | Unit |
|---------------|-------------|------------|----------------|----------------|----------------|------|
|               | Industrial  | Commercial |                |                |                |      |
| $t_{CIN}$     | 1.575       | 1.651      | 2.914          | 3.105          | 3.174          | ns   |
| $t_{COUT}$    | 1.589       | 1.666      | 2.948          | 3.137          | 3.203          | ns   |
| $t_{PLLCIN}$  | –0.149      | –0.158     | 0.27           | 0.268          | 0.089          | ns   |
| $t_{PLLCOUT}$ | –0.135      | –0.143     | 0.304          | 0.3            | 0.118          | ns   |

**Table 5–34. EP2C70 Row Pins Global Clock Timing Parameters**

| Parameter     | Fast Corner |            | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | Unit |
|---------------|-------------|------------|----------------|----------------|----------------|------|
|               | Industrial  | Commercial |                |                |                |      |
| $t_{CIN}$     | 1.463       | 1.533      | 2.753          | 2.927          | 3.010          | ns   |
| $t_{COUT}$    | 1.465       | 1.535      | 2.769          | 2.940          | 3.018          | ns   |
| $t_{PLLCIN}$  | –0.261      | –0.276     | 0.109          | 0.09           | –0.075         | ns   |
| $t_{PLLCOUT}$ | –0.259      | –0.274     | 0.125          | 0.103          | –0.067         | ns   |

**Clock Network Skew Adders**

Table 5–35 shows the clock network specifications.

**Table 5–35. Clock Network Specifications**

| Name                                                                    | Description                                    | Max  | Unit |
|-------------------------------------------------------------------------|------------------------------------------------|------|------|
| Clock skew adder<br>EP2C5/A, EP2C8/A (1)                                | Inter-clock network, same bank                 | ±88  | ps   |
|                                                                         | Inter-clock network, same side and entire chip | ±88  | ps   |
| Clock skew adder<br>EP2C15A, EP2C20/A,<br>EP2C35, EP2C50,<br>EP2C70 (1) | Inter-clock network, same bank                 | ±118 | ps   |
|                                                                         | Inter-clock network, same side and entire chip | ±138 | ps   |

**Note to Table 5–35:**

- (1) This is in addition to intra-clock network skew, which is modeled in the Quartus II software.

## IOE Programmable Delay

Refer to Table 5–36 and 5–37 for IOE programmable delay.

**Table 5–36. Cyclone II IOE Programmable Delay on Column Pins** Notes (1), (2)

| Parameter                                | Paths Affected             | Number of Settings | Fast Corner (3) |            | –6 Speed Grade |            | –7 Speed Grade (4) |            | –8 Speed Grade |            | Unit |
|------------------------------------------|----------------------------|--------------------|-----------------|------------|----------------|------------|--------------------|------------|----------------|------------|------|
|                                          |                            |                    | Min Offset      | Max Offset | Min Offset     | Max Offset | Min Offset         | Max Offset | Min Offset     | Max Offset |      |
| Input Delay from Pin to Internal Cells   | Pad -> I/O dataout to core | 7                  | 0               | 2233       | 0              | 3827       | 0                  | 4232       | 0              | 4349       | ps   |
|                                          |                            |                    | 0               | 2344       | —              | —          | 0                  | 4088       | —              | —          | ps   |
| Input Delay from Pin to Input Register   | Pad -> I/O input register  | 8                  | 0               | 2656       | 0              | 4555       | 0                  | 4914       | 0              | 4940       | ps   |
|                                          |                            |                    | 0               | 2788       | —              | —          | 0                  | 4748       | —              | —          | ps   |
| Delay from Output Register to Output Pin | I/O output register -> Pad | 2                  | 0               | 303        | 0              | 563        | 0                  | 638        | 0              | 670        | ps   |
|                                          |                            |                    | 0               | 318        | —              | —          | 0                  | 617        | —              | —          | ps   |

**Notes to Table 5–36:**

- (1) The incremental values for the settings are generally linear. For exact values of each setting, use the latest version of the Quartus II software.
- (2) The minimum and maximum offset timing numbers are in reference to setting “0” as available in the Quartus II software.
- (3) The value in the first row for each parameter represents the fast corner timing parameter for industrial and automotive devices. The second row represents the fast corner timing parameter for commercial devices.
- (4) The value in the first row is for automotive devices. The second row is for commercial devices.

**Table 5–37. Cyclone II IOE Programmable Delay on Row Pins** Notes (1), (2) (Part 1 of 2)

| Parameter                              | Paths Affected             | Number of Settings | Fast Corner (3) |            | –6 Speed Grade |            | –7 Speed Grade (4) |            | –8 Speed Grade |            | Unit |
|----------------------------------------|----------------------------|--------------------|-----------------|------------|----------------|------------|--------------------|------------|----------------|------------|------|
|                                        |                            |                    | Min Offset      | Max Offset | Min Offset     | Max Offset | Min Offset         | Max Offset | Min Offset     | Max Offset |      |
| Input Delay from Pin to Internal Cells | Pad -> I/O dataout to core | 7                  | 0               | 2240       | 0              | 3776       | 0                  | 4174       | 0              | 4290       | ps   |
|                                        |                            |                    | 0               | 2352       | —              | —          | 0                  | 4033       | —              | —          | ps   |



**Table 5–37. Cyclone II IOE Programmable Delay on Row Pins** *Notes (1), (2) (Part 2 of 2)*

| Parameter                                | Paths Affected             | Number of Settings | Fast Corner (3) |            | –6 Speed Grade |            | –7 Speed Grade (4) |            | –8 Speed Grade |            | Unit |
|------------------------------------------|----------------------------|--------------------|-----------------|------------|----------------|------------|--------------------|------------|----------------|------------|------|
|                                          |                            |                    | Min Offset      | Max Offset | Min Offset     | Max Offset | Min Offset         | Max Offset | Min Offset     | Max Offset |      |
| Input Delay from Pin to Input Register   | Pad -> I/O input register  | 8                  | 0               | 2669       | 0              | 4482       | 0                  | 4834       | 0              | 4859       | ps   |
|                                          |                            |                    | 0               | 2802       | —              | —          | 0                  | 4671       | —              | —          | ps   |
| Delay from Output Register to Output Pin | I/O output register -> Pad | 2                  | 0               | 308        | 0              | 572        | 0                  | 648        | 0              | 682        | ps   |
|                                          |                            |                    | 0               | 324        | —              | —          | 0                  | 626        | —              | —          | ps   |

**Notes to Table 5–37 :**

- (1) The incremental values for the settings are generally linear. For exact values of each setting, use the latest version of the Quartus II software.
- (2) The minimum and maximum offset timing numbers are in reference to setting “0” as available in the Quartus II software.
- (3) The value in the first row represents the fast corner timing parameter for industrial and automotive devices. The second row represents the fast corner timing parameter for commercial devices.
- (4) The value in the first row is for automotive devices. The second row is for commercial devices.

## Default Capacitive Loading of Different I/O Standards

Refer to Table 5–38 for default capacitive loading of different I/O standards.

**Table 5–38. Default Loading of Different I/O Standards for Cyclone II Device** *(Part 1 of 2)*

| I/O Standard    | Capacitive Load | Unit |
|-----------------|-----------------|------|
| LVTTTL          | 0               | pF   |
| LVC MOS         | 0               | pF   |
| 2.5V            | 0               | pF   |
| 1.8V            | 0               | pF   |
| 1.5V            | 0               | pF   |
| PCI             | 10              | pF   |
| PCI-X           | 10              | pF   |
| SSTL_2_CLASS_I  | 0               | pF   |
| SSTL_2_CLASS_II | 0               | pF   |
| SSTL_18_CLASS_I | 0               | pF   |

**Table 5–38. Default Loading of Different I/O Standards for Cyclone II Device  
(Part 2 of 2)**

| I/O Standard                    | Capacitive Load | Unit |
|---------------------------------|-----------------|------|
| SSTL_18_CLASS_II                | 0               | pF   |
| 1.5V_HSTL_CLASS_I               | 0               | pF   |
| 1.5V_HSTL_CLASS_II              | 0               | pF   |
| 1.8V_HSTL_CLASS_I               | 0               | pF   |
| 1.8V_HSTL_CLASS_II              | 0               | pF   |
| DIFFERENTIAL_SSTL_2_CLASS_I     | 0               | pF   |
| DIFFERENTIAL_SSTL_2_CLASS_II    | 0               | pF   |
| DIFFERENTIAL_SSTL_18_CLASS_I    | 0               | pF   |
| DIFFERENTIAL_SSTL_18_CLASS_II   | 0               | pF   |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_I  | 0               | pF   |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_II | 0               | pF   |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_I  | 0               | pF   |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_II | 0               | pF   |
| LVDS                            | 0               | pF   |
| 1.2V_HSTL                       | 0               | pF   |
| 1.2V_DIFFERENTIAL_HSTL          | 0               | pF   |

## I/O Delays

Refer to [Tables 5–39 through 5–43](#) for I/O delays.

**Table 5–39. I/O Delay Parameters**

| Symbol      | Parameter                                    |
|-------------|----------------------------------------------|
| $t_{DIP}$   | Delay from I/O datain to output pad          |
| $t_{OP}$    | Delay from I/O output register to output pad |
| $t_{PCOUT}$ | Delay from input pad to I/O dataout to core  |
| $t_{PI}$    | Delay from input pad to I/O input register   |

**Table 5–40. Cyclone II I/O Input Delay for Column Pins (Part 1 of 3)**

| I/O Standard     | Parameter   | Fast Corner               |                  | –6<br>Speed<br>Grade | –7<br>Speed<br>Grade<br>(1) | –7<br>Speed<br>Grade<br>(2) | –8<br>Speed<br>Grade | Unit |
|------------------|-------------|---------------------------|------------------|----------------------|-----------------------------|-----------------------------|----------------------|------|
|                  |             | Industrial/<br>Automotive | Commer-<br>-cial |                      |                             |                             |                      |      |
| LVTTTL           | $t_{PI}$    | 581                       | 609              | 1222                 | 1228                        | 1282                        | 1282                 | ps   |
|                  | $t_{PCOUT}$ | 367                       | 385              | 760                  | 783                         | 854                         | 854                  | ps   |
| 2.5V             | $t_{PI}$    | 624                       | 654              | 1192                 | 1238                        | 1283                        | 1283                 | ps   |
|                  | $t_{PCOUT}$ | 410                       | 430              | 730                  | 793                         | 855                         | 855                  | ps   |
| 1.8V             | $t_{PI}$    | 725                       | 760              | 1372                 | 1428                        | 1484                        | 1484                 | ps   |
|                  | $t_{PCOUT}$ | 511                       | 536              | 910                  | 983                         | 1056                        | 1056                 | ps   |
| 1.5V             | $t_{PI}$    | 790                       | 828              | 1439                 | 1497                        | 1556                        | 1556                 | ps   |
|                  | $t_{PCOUT}$ | 576                       | 604              | 977                  | 1052                        | 1128                        | 1128                 | ps   |
| LVCMOS           | $t_{PI}$    | 581                       | 609              | 1222                 | 1228                        | 1282                        | 1282                 | ps   |
|                  | $t_{PCOUT}$ | 367                       | 385              | 760                  | 783                         | 854                         | 854                  | ps   |
| SSTL_2_CLASS_I   | $t_{PI}$    | 533                       | 558              | 990                  | 1015                        | 1040                        | 1040                 | ps   |
|                  | $t_{PCOUT}$ | 319                       | 334              | 528                  | 570                         | 612                         | 612                  | ps   |
| SSTL_2_CLASS_II  | $t_{PI}$    | 533                       | 558              | 990                  | 1015                        | 1040                        | 1040                 | ps   |
|                  | $t_{PCOUT}$ | 319                       | 334              | 528                  | 570                         | 612                         | 612                  | ps   |
| SSTL_18_CLASS_I  | $t_{PI}$    | 577                       | 605              | 1027                 | 1035                        | 1045                        | 1045                 | ps   |
|                  | $t_{PCOUT}$ | 363                       | 381              | 565                  | 590                         | 617                         | 617                  | ps   |
| SSTL_18_CLASS_II | $t_{PI}$    | 577                       | 605              | 1027                 | 1035                        | 1045                        | 1045                 | ps   |
|                  | $t_{PCOUT}$ | 363                       | 381              | 565                  | 590                         | 617                         | 617                  | ps   |

**Table 5–40. Cyclone II I/O Input Delay for Column Pins (Part 2 of 3)**

| I/O Standard                     | Parameter          | Fast Corner               |                  | –6<br>Speed<br>Grade | –7<br>Speed<br>Grade<br>(1) | –7<br>Speed<br>Grade<br>(2) | –8<br>Speed<br>Grade | Unit |
|----------------------------------|--------------------|---------------------------|------------------|----------------------|-----------------------------|-----------------------------|----------------------|------|
|                                  |                    | Industrial/<br>Automotive | Commer-<br>-cial |                      |                             |                             |                      |      |
| 1.5V_HSTL_CLASS_I                | t <sub>PI</sub>    | 589                       | 617              | 1145                 | 1176                        | 1208                        | 1208                 | ps   |
|                                  | t <sub>PCOUT</sub> | 375                       | 393              | 683                  | 731                         | 780                         | 780                  | ps   |
| 1.5V_HSTL_CLASS_II               | t <sub>PI</sub>    | 589                       | 617              | 1145                 | 1176                        | 1208                        | 1208                 | ps   |
|                                  | t <sub>PCOUT</sub> | 375                       | 393              | 683                  | 731                         | 780                         | 780                  | ps   |
| 1.8V_HSTL_CLASS_I                | t <sub>PI</sub>    | 577                       | 605              | 1027                 | 1035                        | 1045                        | 1045                 | ps   |
|                                  | t <sub>PCOUT</sub> | 363                       | 381              | 565                  | 590                         | 617                         | 617                  | ps   |
| 1.8V_HSTL_CLASS_II               | t <sub>PI</sub>    | 577                       | 605              | 1027                 | 1035                        | 1045                        | 1045                 | ps   |
|                                  | t <sub>PCOUT</sub> | 363                       | 381              | 565                  | 590                         | 617                         | 617                  | ps   |
| DIFFERENTIAL_SSTL_2_ CLASS_I     | t <sub>PI</sub>    | 533                       | 558              | 990                  | 1015                        | 1040                        | 1040                 | ps   |
|                                  | t <sub>PCOUT</sub> | 319                       | 334              | 528                  | 570                         | 612                         | 612                  | ps   |
| DIFFERENTIAL_SSTL_2_ CLASS_II    | t <sub>PI</sub>    | 533                       | 558              | 990                  | 1015                        | 1040                        | 1040                 | ps   |
|                                  | t <sub>PCOUT</sub> | 319                       | 334              | 528                  | 570                         | 612                         | 612                  | ps   |
| DIFFERENTIAL_SSTL_18_ CLASS_I    | t <sub>PI</sub>    | 577                       | 605              | 1027                 | 1035                        | 1045                        | 1045                 | ps   |
|                                  | t <sub>PCOUT</sub> | 363                       | 381              | 565                  | 590                         | 617                         | 617                  | ps   |
| DIFFERENTIAL_SSTL_18_ CLASS_II   | t <sub>PI</sub>    | 577                       | 605              | 1027                 | 1035                        | 1045                        | 1045                 | ps   |
|                                  | t <sub>PCOUT</sub> | 363                       | 381              | 565                  | 590                         | 617                         | 617                  | ps   |
| 1.8V_DIFFERENTIAL_HSTL_ CLASS_I  | t <sub>PI</sub>    | 577                       | 605              | 1027                 | 1035                        | 1045                        | 1045                 | ps   |
|                                  | t <sub>PCOUT</sub> | 363                       | 381              | 565                  | 590                         | 617                         | 617                  | ps   |
| 1.8V_DIFFERENTIAL_HSTL_ CLASS_II | t <sub>PI</sub>    | 577                       | 605              | 1027                 | 1035                        | 1045                        | 1045                 | ps   |
|                                  | t <sub>PCOUT</sub> | 363                       | 381              | 565                  | 590                         | 617                         | 617                  | ps   |
| 1.5V_DIFFERENTIAL_HSTL_ CLASS_I  | t <sub>PI</sub>    | 589                       | 617              | 1145                 | 1176                        | 1208                        | 1208                 | ps   |
|                                  | t <sub>PCOUT</sub> | 375                       | 393              | 683                  | 731                         | 780                         | 780                  | ps   |
| 1.5V_DIFFERENTIAL_HSTL_ CLASS_II | t <sub>PI</sub>    | 589                       | 617              | 1145                 | 1176                        | 1208                        | 1208                 | ps   |
|                                  | t <sub>PCOUT</sub> | 375                       | 393              | 683                  | 731                         | 780                         | 780                  | ps   |
| LVDS                             | t <sub>PI</sub>    | 623                       | 653              | 1072                 | 1075                        | 1078                        | 1078                 | ps   |
|                                  | t <sub>PCOUT</sub> | 409                       | 429              | 610                  | 630                         | 650                         | 650                  | ps   |
| 1.2V_HSTL                        | t <sub>PI</sub>    | 570                       | 597              | 1263                 | 1324                        | 1385                        | 1385                 | ps   |
|                                  | t <sub>PCOUT</sub> | 356                       | 373              | 801                  | 879                         | 957                         | 957                  | ps   |

**Table 5–40. Cyclone II I/O Input Delay for Column Pins (Part 3 of 3)**

| I/O Standard           | Parameter          | Fast Corner               |                  | –6<br>Speed<br>Grade | –7<br>Speed<br>Grade<br>(1) | –7<br>Speed<br>Grade<br>(2) | –8<br>Speed<br>Grade | Unit |
|------------------------|--------------------|---------------------------|------------------|----------------------|-----------------------------|-----------------------------|----------------------|------|
|                        |                    | Industrial/<br>Automotive | Commer-<br>-cial |                      |                             |                             |                      |      |
| 1.2V_DIFFERENTIAL_HSTL | t <sub>PI</sub>    | 570                       | 597              | 1263                 | 1324                        | 1385                        | 1385                 | ps   |
|                        | t <sub>PCOUT</sub> | 356                       | 373              | 801                  | 879                         | 957                         | 957                  | ps   |

Notes to Table 5–40 :

(1) These numbers are for commercial devices.

(2) These numbers are for automotive devices.

**Table 5–41. Cyclone II I/O Input Delay for Row Pins (Part 1 of 2)**

| I/O Standard      | Parameter          | Fast Corner               |                  | –6<br>Speed<br>Grade | –7<br>Speed<br>Grade<br>(1) | –7<br>Speed<br>Grade<br>(2) | –8<br>Speed<br>Grade | Unit |
|-------------------|--------------------|---------------------------|------------------|----------------------|-----------------------------|-----------------------------|----------------------|------|
|                   |                    | Industrial/<br>Automotive | Commer-<br>-cial |                      |                             |                             |                      |      |
| LVTTTL            | t <sub>PI</sub>    | 583                       | 611              | 1129                 | 1160                        | 1240                        | 1240                 | ps   |
|                   | t <sub>PCOUT</sub> | 366                       | 384              | 762                  | 784                         | 855                         | 855                  | ps   |
| 2.5V              | t <sub>PI</sub>    | 629                       | 659              | 1099                 | 1171                        | 1244                        | 1244                 | ps   |
|                   | t <sub>PCOUT</sub> | 412                       | 432              | 732                  | 795                         | 859                         | 859                  | ps   |
| 1.8V              | t <sub>PI</sub>    | 729                       | 764              | 1278                 | 1360                        | 1443                        | 1443                 | ps   |
|                   | t <sub>PCOUT</sub> | 512                       | 537              | 911                  | 984                         | 1058                        | 1058                 | ps   |
| 1.5V              | t <sub>PI</sub>    | 794                       | 832              | 1345                 | 1429                        | 1513                        | 1513                 | ps   |
|                   | t <sub>PCOUT</sub> | 577                       | 605              | 978                  | 1053                        | 1128                        | 1128                 | ps   |
| LVCMOS            | t <sub>PI</sub>    | 583                       | 611              | 1129                 | 1160                        | 1240                        | 1240                 | ps   |
|                   | t <sub>PCOUT</sub> | 366                       | 384              | 762                  | 784                         | 855                         | 855                  | ps   |
| SSTL_2_CLASS_I    | t <sub>PI</sub>    | 536                       | 561              | 896                  | 947                         | 998                         | 998                  | ps   |
|                   | t <sub>PCOUT</sub> | 319                       | 334              | 529                  | 571                         | 613                         | 613                  | ps   |
| SSTL_2_CLASS_II   | t <sub>PI</sub>    | 536                       | 561              | 896                  | 947                         | 998                         | 998                  | ps   |
|                   | t <sub>PCOUT</sub> | 319                       | 334              | 529                  | 571                         | 613                         | 613                  | ps   |
| SSTL_18_CLASS_I   | t <sub>PI</sub>    | 581                       | 609              | 933                  | 967                         | 1004                        | 1004                 | ps   |
|                   | t <sub>PCOUT</sub> | 364                       | 382              | 566                  | 591                         | 619                         | 619                  | ps   |
| SSTL_18_CLASS_II  | t <sub>PI</sub>    | 581                       | 609              | 933                  | 967                         | 1004                        | 1004                 | ps   |
|                   | t <sub>PCOUT</sub> | 364                       | 382              | 566                  | 591                         | 619                         | 619                  | ps   |
| 1.5V_HSTL_CLASS_I | t <sub>PI</sub>    | 593                       | 621              | 1051                 | 1109                        | 1167                        | 1167                 | ps   |
|                   | t <sub>PCOUT</sub> | 376                       | 394              | 684                  | 733                         | 782                         | 782                  | ps   |

**Table 5–41. Cyclone II I/O Input Delay for Row Pins (Part 2 of 2)**

| I/O Standard                     | Parameter          | Fast Corner               |                  | –6<br>Speed<br>Grade | –7<br>Speed<br>Grade<br>(1) | –7<br>Speed<br>Grade<br>(2) | –8<br>Speed<br>Grade | Unit |
|----------------------------------|--------------------|---------------------------|------------------|----------------------|-----------------------------|-----------------------------|----------------------|------|
|                                  |                    | Industrial/<br>Automotive | Commer-<br>-cial |                      |                             |                             |                      |      |
| 1.5V_HSTL_CLASS_II               | t <sub>PI</sub>    | 593                       | 621              | 1051                 | 1109                        | 1167                        | 1167                 | ps   |
|                                  | t <sub>PCOUT</sub> | 376                       | 394              | 684                  | 733                         | 782                         | 782                  | ps   |
| 1.8V_HSTL_CLASS_I                | t <sub>PI</sub>    | 581                       | 609              | 933                  | 967                         | 1004                        | 1004                 | ps   |
|                                  | t <sub>PCOUT</sub> | 364                       | 382              | 566                  | 591                         | 619                         | 619                  | ps   |
| 1.8V_HSTL_CLASS_II               | t <sub>PI</sub>    | 581                       | 609              | 933                  | 967                         | 1004                        | 1004                 | ps   |
|                                  | t <sub>PCOUT</sub> | 364                       | 382              | 566                  | 591                         | 619                         | 619                  | ps   |
| DIFFERENTIAL_SSTL_2_ CLASS_I     | t <sub>PI</sub>    | 536                       | 561              | 896                  | 947                         | 998                         | 998                  | ps   |
|                                  | t <sub>PCOUT</sub> | 319                       | 334              | 529                  | 571                         | 613                         | 613                  | ps   |
| DIFFERENTIAL_SSTL_2_ CLASS_II    | t <sub>PI</sub>    | 536                       | 561              | 896                  | 947                         | 998                         | 998                  | ps   |
|                                  | t <sub>PCOUT</sub> | 319                       | 334              | 529                  | 571                         | 613                         | 613                  | ps   |
| DIFFERENTIAL_SSTL_18_ CLASS_I    | t <sub>PI</sub>    | 581                       | 609              | 933                  | 967                         | 1004                        | 1004                 | ps   |
|                                  | t <sub>PCOUT</sub> | 364                       | 382              | 566                  | 591                         | 619                         | 619                  | ps   |
| DIFFERENTIAL_SSTL_18_ CLASS_II   | t <sub>PI</sub>    | 581                       | 609              | 933                  | 967                         | 1004                        | 1004                 | ps   |
|                                  | t <sub>PCOUT</sub> | 364                       | 382              | 566                  | 591                         | 619                         | 619                  | ps   |
| 1.8V_DIFFERENTIAL_HSTL_ CLASS_I  | t <sub>PI</sub>    | 581                       | 609              | 933                  | 967                         | 1004                        | 1004                 | ps   |
|                                  | t <sub>PCOUT</sub> | 364                       | 382              | 566                  | 591                         | 619                         | 619                  | ps   |
| 1.8V_DIFFERENTIAL_HSTL_ CLASS_II | t <sub>PI</sub>    | 581                       | 609              | 933                  | 967                         | 1004                        | 1004                 | ps   |
|                                  | t <sub>PCOUT</sub> | 364                       | 382              | 566                  | 591                         | 619                         | 619                  | ps   |
| 1.5V_DIFFERENTIAL_HSTL_ CLASS_I  | t <sub>PI</sub>    | 593                       | 621              | 1051                 | 1109                        | 1167                        | 1167                 | ps   |
|                                  | t <sub>PCOUT</sub> | 376                       | 394              | 684                  | 733                         | 782                         | 782                  | ps   |
| 1.5V_DIFFERENTIAL_HSTL_ CLASS_II | t <sub>PI</sub>    | 593                       | 621              | 1051                 | 1109                        | 1167                        | 1167                 | ps   |
|                                  | t <sub>PCOUT</sub> | 376                       | 394              | 684                  | 733                         | 782                         | 782                  | ps   |
| LVDS                             | t <sub>PI</sub>    | 651                       | 682              | 1036                 | 1075                        | 1113                        | 1113                 | ps   |
|                                  | t <sub>PCOUT</sub> | 434                       | 455              | 669                  | 699                         | 728                         | 728                  | ps   |
| PCI                              | t <sub>PI</sub>    | 595                       | 623              | 1113                 | 1156                        | 1232                        | 1232                 | ps   |
|                                  | t <sub>PCOUT</sub> | 378                       | 396              | 746                  | 780                         | 847                         | 847                  | ps   |
| PCI-X                            | t <sub>PI</sub>    | 595                       | 623              | 1113                 | 1156                        | 1232                        | 1232                 | ps   |
|                                  | t <sub>PCOUT</sub> | 378                       | 396              | 746                  | 780                         | 847                         | 847                  | ps   |

**Notes to Table 5–41 :**

- (1) These numbers are for commercial devices.  
 (2) These numbers are for automotive devices.

**Table 5–42. Cyclone II I/O Output Delay for Column Pins (Part 1 of 6)**

| I/O Standard | Drive Strength | Parameter        | Fast Corner               |                  | –6 Speed Grade | –7 Speed Grade<br>(2) | –7 Speed Grade<br>(3) | –8 Speed Grade | Unit |
|--------------|----------------|------------------|---------------------------|------------------|----------------|-----------------------|-----------------------|----------------|------|
|              |                |                  | Industrial/<br>Automotive | Commer-<br>-cial |                |                       |                       |                |      |
| LVTTTL       | 4 mA           | t <sub>OP</sub>  | 1524                      | 1599             | 2903           | 3125                  | 3341                  | 3348           | ps   |
|              |                | t <sub>DIP</sub> | 1656                      | 1738             | 3073           | 3319                  | 3567                  | 3567           | ps   |
|              | 8 mA           | t <sub>OP</sub>  | 1343                      | 1409             | 2670           | 2866                  | 3054                  | 3061           | ps   |
|              |                | t <sub>DIP</sub> | 1475                      | 1548             | 2840           | 3060                  | 3280                  | 3280           | ps   |
|              | 12 mA          | t <sub>OP</sub>  | 1287                      | 1350             | 2547           | 2735                  | 2917                  | 2924           | ps   |
|              |                | t <sub>DIP</sub> | 1419                      | 1489             | 2717           | 2929                  | 3143                  | 3143           | ps   |
|              | 16 mA          | t <sub>OP</sub>  | 1239                      | 1299             | 2478           | 2665                  | 2844                  | 2851           | ps   |
|              |                | t <sub>DIP</sub> | 1371                      | 1438             | 2648           | 2859                  | 3070                  | 3070           | ps   |
|              | 20 mA          | t <sub>OP</sub>  | 1228                      | 1288             | 2456           | 2641                  | 2820                  | 2827           | ps   |
|              |                | t <sub>DIP</sub> | 1360                      | 1427             | 2626           | 2835                  | 3046                  | 3046           | ps   |
|              | 24 mA<br>(1)   | t <sub>OP</sub>  | 1220                      | 1279             | 2452           | 2637                  | 2815                  | 2822           | ps   |
|              |                | t <sub>DIP</sub> | 1352                      | 1418             | 2622           | 2831                  | 3041                  | 3041           | ps   |
| LVCMOS       | 4 mA           | t <sub>OP</sub>  | 1346                      | 1412             | 2509           | 2695                  | 2873                  | 2880           | ps   |
|              |                | t <sub>DIP</sub> | 1478                      | 1551             | 2679           | 2889                  | 3099                  | 3099           | ps   |
|              | 8 mA           | t <sub>OP</sub>  | 1240                      | 1300             | 2473           | 2660                  | 2840                  | 2847           | ps   |
|              |                | t <sub>DIP</sub> | 1372                      | 1439             | 2643           | 2854                  | 3066                  | 3066           | ps   |
|              | 12 mA          | t <sub>OP</sub>  | 1221                      | 1280             | 2428           | 2613                  | 2790                  | 2797           | ps   |
|              |                | t <sub>DIP</sub> | 1353                      | 1419             | 2598           | 2807                  | 3016                  | 3016           | ps   |
|              | 16 mA          | t <sub>OP</sub>  | 1203                      | 1262             | 2403           | 2587                  | 2765                  | 2772           | ps   |
|              |                | t <sub>DIP</sub> | 1335                      | 1401             | 2573           | 2781                  | 2991                  | 2991           | ps   |
|              | 20 mA          | t <sub>OP</sub>  | 1194                      | 1252             | 2378           | 2562                  | 2738                  | 2745           | ps   |
|              |                | t <sub>DIP</sub> | 1326                      | 1391             | 2548           | 2756                  | 2964                  | 2964           | ps   |
|              | 24 mA<br>(1)   | t <sub>OP</sub>  | 1192                      | 1250             | 2382           | 2566                  | 2742                  | 2749           | ps   |
|              |                | t <sub>DIP</sub> | 1324                      | 1389             | 2552           | 2760                  | 2968                  | 2968           | ps   |

**Table 5–42. Cyclone II I/O Output Delay for Column Pins (Part 2 of 6)**

| I/O Standard | Drive Strength | Parameter        | Fast Corner               |                  | –6 Speed Grade | –7 Speed Grade<br>(2) | –7 Speed Grade<br>(3) | –8 Speed Grade | Unit |
|--------------|----------------|------------------|---------------------------|------------------|----------------|-----------------------|-----------------------|----------------|------|
|              |                |                  | Industrial/<br>Automotive | Commer-<br>-cial |                |                       |                       |                |      |
| 2.5V         | 4 mA           | t <sub>OP</sub>  | 1208                      | 1267             | 2478           | 2614                  | 2743                  | 2750           | ps   |
|              |                | t <sub>DIP</sub> | 1340                      | 1406             | 2648           | 2808                  | 2969                  | 2969           | ps   |
|              | 8 mA           | t <sub>OP</sub>  | 1190                      | 1248             | 2307           | 2434                  | 2554                  | 2561           | ps   |
|              |                | t <sub>DIP</sub> | 1322                      | 1387             | 2477           | 2628                  | 2780                  | 2780           | ps   |
|              | 12 mA          | t <sub>OP</sub>  | 1154                      | 1210             | 2192           | 2314                  | 2430                  | 2437           | ps   |
|              |                | t <sub>DIP</sub> | 1286                      | 1349             | 2362           | 2508                  | 2656                  | 2656           | ps   |
|              | 16 mA<br>(1)   | t <sub>OP</sub>  | 1140                      | 1195             | 2152           | 2263                  | 2375                  | 2382           | ps   |
|              |                | t <sub>DIP</sub> | 1272                      | 1334             | 2322           | 2457                  | 2601                  | 2601           | ps   |
| 1.8V         | 2 mA           | t <sub>OP</sub>  | 1682                      | 1765             | 3988           | 4279                  | 4563                  | 4570           | ps   |
|              |                | t <sub>DIP</sub> | 1814                      | 1904             | 4158           | 4473                  | 4789                  | 4789           | ps   |
|              | 4 mA           | t <sub>OP</sub>  | 1567                      | 1644             | 3301           | 3538                  | 3768                  | 3775           | ps   |
|              |                | t <sub>DIP</sub> | 1699                      | 1783             | 3471           | 3732                  | 3994                  | 3994           | ps   |
|              | 6 mA           | t <sub>OP</sub>  | 1475                      | 1547             | 2993           | 3195                  | 3391                  | 3398           | ps   |
|              |                | t <sub>DIP</sub> | 1607                      | 1686             | 3163           | 3389                  | 3617                  | 3617           | ps   |
|              | 8 mA           | t <sub>OP</sub>  | 1451                      | 1522             | 2882           | 3074                  | 3259                  | 3266           | ps   |
|              |                | t <sub>DIP</sub> | 1583                      | 1661             | 3052           | 3268                  | 3485                  | 3485           | ps   |
|              | 10 mA          | t <sub>OP</sub>  | 1438                      | 1508             | 2853           | 3041                  | 3223                  | 3230           | ps   |
|              |                | t <sub>DIP</sub> | 1570                      | 1647             | 3023           | 3235                  | 3449                  | 3449           | ps   |
|              | 12 mA<br>(1)   | t <sub>OP</sub>  | 1438                      | 1508             | 2853           | 3041                  | 3223                  | 3230           | ps   |
|              |                | t <sub>DIP</sub> | 1570                      | 1647             | 3023           | 3235                  | 3449                  | 3449           | ps   |
| 1.5V         | 2 mA           | t <sub>OP</sub>  | 2083                      | 2186             | 4477           | 4870                  | 5256                  | 5263           | ps   |
|              |                | t <sub>DIP</sub> | 2215                      | 2325             | 4647           | 5064                  | 5482                  | 5482           | ps   |
|              | 4 mA           | t <sub>OP</sub>  | 1793                      | 1881             | 3649           | 3965                  | 4274                  | 4281           | ps   |
|              |                | t <sub>DIP</sub> | 1925                      | 2020             | 3819           | 4159                  | 4500                  | 4500           | ps   |
|              | 6 mA           | t <sub>OP</sub>  | 1770                      | 1857             | 3527           | 3823                  | 4112                  | 4119           | ps   |
|              |                | t <sub>DIP</sub> | 1902                      | 1996             | 3697           | 4017                  | 4338                  | 4338           | ps   |
|              | 8 mA<br>(1)    | t <sub>OP</sub>  | 1703                      | 1787             | 3537           | 3827                  | 4111                  | 4118           | ps   |
|              |                | t <sub>DIP</sub> | 1835                      | 1926             | 3707           | 4021                  | 4337                  | 4337           | ps   |



**Table 5–42. Cyclone II I/O Output Delay for Column Pins (Part 3 of 6)**

| I/O Standard       | Drive Strength | Parameter        | Fast Corner           |            | –6 Speed Grade | –7 Speed Grade (2) | –7 Speed Grade (3) | –8 Speed Grade | Unit |
|--------------------|----------------|------------------|-----------------------|------------|----------------|--------------------|--------------------|----------------|------|
|                    |                |                  | Industrial/Automotive | Commercial |                |                    |                    |                |      |
| SSTL_2_ CLASS_I    | 8 mA           | t <sub>OP</sub>  | 1196                  | 1254       | 2388           | 2516               | 2638               | 2645           | ps   |
|                    |                | t <sub>DIP</sub> | 1328                  | 1393       | 2558           | 2710               | 2864               | 2864           | ps   |
|                    | 12 mA (1)      | t <sub>OP</sub>  | 1174                  | 1231       | 2277           | 2401               | 2518               | 2525           | ps   |
|                    |                | t <sub>DIP</sub> | 1306                  | 1370       | 2447           | 2595               | 2744               | 2744           | ps   |
| SSTL_2_ CLASS_II   | 16 mA          | t <sub>OP</sub>  | 1158                  | 1214       | 2245           | 2365               | 2479               | 2486           | ps   |
|                    |                | t <sub>DIP</sub> | 1290                  | 1353       | 2415           | 2559               | 2705               | 2705           | ps   |
|                    | 20 mA          | t <sub>OP</sub>  | 1152                  | 1208       | 2231           | 2351               | 2464               | 2471           | ps   |
|                    |                | t <sub>DIP</sub> | 1284                  | 1347       | 2401           | 2545               | 2690               | 2690           | ps   |
|                    | 24 mA (1)      | t <sub>OP</sub>  | 1152                  | 1208       | 2225           | 2345               | 2458               | 2465           | ps   |
|                    |                | t <sub>DIP</sub> | 1284                  | 1347       | 2395           | 2539               | 2684               | 2684           | ps   |
| SSTL_18_ CLASS_I   | 6 mA           | t <sub>OP</sub>  | 1472                  | 1544       | 3140           | 3345               | 3542               | 3549           | ps   |
|                    |                | t <sub>DIP</sub> | 1604                  | 1683       | 3310           | 3539               | 3768               | 3768           | ps   |
|                    | 8 mA           | t <sub>OP</sub>  | 1469                  | 1541       | 3086           | 3287               | 3482               | 3489           | ps   |
|                    |                | t <sub>DIP</sub> | 1601                  | 1680       | 3256           | 3481               | 3708               | 3708           | ps   |
|                    | 10 mA          | t <sub>OP</sub>  | 1466                  | 1538       | 2980           | 3171               | 3354               | 3361           | ps   |
|                    |                | t <sub>DIP</sub> | 1598                  | 1677       | 3150           | 3365               | 3580               | 3580           | ps   |
|                    | 12 mA (1)      | t <sub>OP</sub>  | 1466                  | 1538       | 2980           | 3171               | 3354               | 3361           | ps   |
|                    |                | t <sub>DIP</sub> | 1598                  | 1677       | 3150           | 3365               | 3580               | 3580           | ps   |
| SSTL_18_ CLASS_II  | 16 mA          | t <sub>OP</sub>  | 1454                  | 1525       | 2905           | 3088               | 3263               | 3270           | ps   |
|                    |                | t <sub>DIP</sub> | 1586                  | 1664       | 3075           | 3282               | 3489               | 3489           | ps   |
|                    | 18 mA (1)      | t <sub>OP</sub>  | 1453                  | 1524       | 2900           | 3082               | 3257               | 3264           | ps   |
|                    |                | t <sub>DIP</sub> | 1585                  | 1663       | 3070           | 3276               | 3483               | 3483           | ps   |
| 1.8V_HSTL_ CLASS_I | 8 mA           | t <sub>OP</sub>  | 1460                  | 1531       | 3222           | 3424               | 3618               | 3625           | ps   |
|                    |                | t <sub>DIP</sub> | 1592                  | 1670       | 3392           | 3618               | 3844               | 3844           | ps   |
|                    | 10 mA          | t <sub>OP</sub>  | 1462                  | 1534       | 3090           | 3279               | 3462               | 3469           | ps   |
|                    |                | t <sub>DIP</sub> | 1594                  | 1673       | 3260           | 3473               | 3688               | 3688           | ps   |
|                    | 12 mA (1)      | t <sub>OP</sub>  | 1462                  | 1534       | 3090           | 3279               | 3462               | 3469           | ps   |
|                    |                | t <sub>DIP</sub> | 1594                  | 1673       | 3260           | 3473               | 3688               | 3688           | ps   |

**Table 5–42. Cyclone II I/O Output Delay for Column Pins (Part 4 of 6)**

| I/O Standard                 | Drive Strength | Parameter        | Fast Corner           |            | –6 Speed Grade | –7 Speed Grade (2) | –7 Speed Grade (3) | –8 Speed Grade | Unit |
|------------------------------|----------------|------------------|-----------------------|------------|----------------|--------------------|--------------------|----------------|------|
|                              |                |                  | Industrial/Automotive | Commercial |                |                    |                    |                |      |
| 1.8V_HSTL_CLASS_II           | 16 mA          | t <sub>OP</sub>  | 1449                  | 1520       | 2936           | 3107               | 3271               | 3278           | ps   |
|                              |                | t <sub>DIP</sub> | 1581                  | 1659       | 3106           | 3301               | 3497               | 3497           | ps   |
|                              | 18 mA          | t <sub>OP</sub>  | 1450                  | 1521       | 2924           | 3101               | 3272               | 3279           | ps   |
|                              |                | t <sub>DIP</sub> | 1582                  | 1660       | 3094           | 3295               | 3498               | 3498           | ps   |
|                              | 20 mA (1)      | t <sub>OP</sub>  | 1452                  | 1523       | 2926           | 3096               | 3259               | 3266           | ps   |
|                              |                | t <sub>DIP</sub> | 1584                  | 1662       | 3096           | 3290               | 3485               | 3485           | ps   |
| 1.5V_HSTL_CLASS_I            | 8 mA           | t <sub>OP</sub>  | 1779                  | 1866       | 4292           | 4637               | 4974               | 4981           | ps   |
|                              |                | t <sub>DIP</sub> | 1911                  | 2005       | 4462           | 4831               | 5200               | 5200           | ps   |
|                              | 10 mA          | t <sub>OP</sub>  | 1784                  | 1872       | 4031           | 4355               | 4673               | 4680           | ps   |
|                              |                | t <sub>DIP</sub> | 1916                  | 2011       | 4201           | 4549               | 4899               | 4899           | ps   |
|                              | 12 mA (1)      | t <sub>OP</sub>  | 1784                  | 1872       | 4031           | 4355               | 4673               | 4680           | ps   |
|                              |                | t <sub>DIP</sub> | 1916                  | 2011       | 4201           | 4549               | 4899               | 4899           | ps   |
| 1.5V_HSTL_CLASS_II           | 16 mA (1)      | t <sub>OP</sub>  | 1750                  | 1836       | 3844           | 4125               | 4399               | 4406           | ps   |
|                              |                | t <sub>DIP</sub> | 1882                  | 1975       | 4014           | 4319               | 4625               | 4625           | ps   |
| DIFFERENTIAL_SSTL_2_CLASS_I  | 8 mA           | t <sub>OP</sub>  | 1196                  | 1254       | 2388           | 2516               | 2638               | 2645           | ps   |
|                              |                | t <sub>DIP</sub> | 1328                  | 1393       | 2558           | 2710               | 2864               | 2864           | ps   |
|                              | 12 mA (1)      | t <sub>OP</sub>  | 1174                  | 1231       | 2277           | 2401               | 2518               | 2525           | ps   |
|                              |                | t <sub>DIP</sub> | 1306                  | 1370       | 2447           | 2595               | 2744               | 2744           | ps   |
| DIFFERENTIAL_SSTL_2_CLASS_II | 16 mA          | t <sub>OP</sub>  | 1158                  | 1214       | 2245           | 2365               | 2479               | 2486           | ps   |
|                              |                | t <sub>DIP</sub> | 1290                  | 1353       | 2415           | 2559               | 2705               | 2705           | ps   |
|                              | 20 mA          | t <sub>OP</sub>  | 1152                  | 1208       | 2231           | 2351               | 2464               | 2471           | ps   |
|                              |                | t <sub>DIP</sub> | 1284                  | 1347       | 2401           | 2545               | 2690               | 2690           | ps   |
|                              | 24 mA (1)      | t <sub>OP</sub>  | 1152                  | 1208       | 2225           | 2345               | 2458               | 2465           | ps   |
|                              |                | t <sub>DIP</sub> | 1284                  | 1347       | 2395           | 2539               | 2684               | 2684           | ps   |

**Table 5–42. Cyclone II I/O Output Delay for Column Pins (Part 5 of 6)**

| I/O Standard                    | Drive Strength | Parameter        | Fast Corner               |                  | –6 Speed Grade | –7 Speed Grade<br>(2) | –7 Speed Grade<br>(3) | –8 Speed Grade | Unit |
|---------------------------------|----------------|------------------|---------------------------|------------------|----------------|-----------------------|-----------------------|----------------|------|
|                                 |                |                  | Industrial/<br>Automotive | Commer-<br>-cial |                |                       |                       |                |      |
| DIFFERENTIAL_SSTL_18_CLASS_I    | 6 mA           | t <sub>OP</sub>  | 1472                      | 1544             | 3140           | 3345                  | 3542                  | 3549           | ps   |
|                                 |                | t <sub>DIP</sub> | 1604                      | 1683             | 3310           | 3539                  | 3768                  | 3768           | ps   |
|                                 | 8 mA           | t <sub>OP</sub>  | 1469                      | 1541             | 3086           | 3287                  | 3482                  | 3489           | ps   |
|                                 |                | t <sub>DIP</sub> | 1601                      | 1680             | 3256           | 3481                  | 3708                  | 3708           | ps   |
|                                 | 10 mA          | t <sub>OP</sub>  | 1466                      | 1538             | 2980           | 3171                  | 3354                  | 3361           | ps   |
|                                 |                | t <sub>DIP</sub> | 1598                      | 1677             | 3150           | 3365                  | 3580                  | 3580           | ps   |
|                                 | 12 mA<br>(1)   | t <sub>OP</sub>  | 1466                      | 1538             | 2980           | 3171                  | 3354                  | 3361           | ps   |
|                                 |                | t <sub>DIP</sub> | 1598                      | 1677             | 3150           | 3365                  | 3580                  | 3580           | ps   |
| DIFFERENTIAL_SSTL_18_CLASS_II   | 16 mA          | t <sub>OP</sub>  | 1454                      | 1525             | 2905           | 3088                  | 3263                  | 3270           | ps   |
|                                 |                | t <sub>DIP</sub> | 1586                      | 1664             | 3075           | 3282                  | 3489                  | 3489           | ps   |
|                                 | 18 mA<br>(1)   | t <sub>OP</sub>  | 1453                      | 1524             | 2900           | 3082                  | 3257                  | 3264           | ps   |
|                                 |                | t <sub>DIP</sub> | 1585                      | 1663             | 3070           | 3276                  | 3483                  | 3483           | ps   |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_I  | 8 mA           | t <sub>OP</sub>  | 1460                      | 1531             | 3222           | 3424                  | 3618                  | 3625           | ps   |
|                                 |                | t <sub>DIP</sub> | 1592                      | 1670             | 3392           | 3618                  | 3844                  | 3844           | ps   |
|                                 | 10 mA          | t <sub>OP</sub>  | 1462                      | 1534             | 3090           | 3279                  | 3462                  | 3469           | ps   |
|                                 |                | t <sub>DIP</sub> | 1594                      | 1673             | 3260           | 3473                  | 3688                  | 3688           | ps   |
|                                 | 12 mA<br>(1)   | t <sub>OP</sub>  | 1462                      | 1534             | 3090           | 3279                  | 3462                  | 3469           | ps   |
|                                 |                | t <sub>DIP</sub> | 1594                      | 1673             | 3260           | 3473                  | 3688                  | 3688           | ps   |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_II | 16 mA          | t <sub>OP</sub>  | 1449                      | 1520             | 2936           | 3107                  | 3271                  | 3278           | ps   |
|                                 |                | t <sub>DIP</sub> | 1581                      | 1659             | 3106           | 3301                  | 3497                  | 3497           | ps   |
|                                 | 18 mA          | t <sub>OP</sub>  | 1450                      | 1521             | 2924           | 3101                  | 3272                  | 3279           | ps   |
|                                 |                | t <sub>DIP</sub> | 1582                      | 1660             | 3094           | 3295                  | 3498                  | 3498           | ps   |
|                                 | 20 mA<br>(1)   | t <sub>OP</sub>  | 1452                      | 1523             | 2926           | 3096                  | 3259                  | 3266           | ps   |
|                                 |                | t <sub>DIP</sub> | 1584                      | 1662             | 3096           | 3290                  | 3485                  | 3485           | ps   |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_I  | 8 mA           | t <sub>OP</sub>  | 1779                      | 1866             | 4292           | 4637                  | 4974                  | 4981           | ps   |
|                                 |                | t <sub>DIP</sub> | 1911                      | 2005             | 4462           | 4831                  | 5200                  | 5200           | ps   |
|                                 | 10 mA          | t <sub>OP</sub>  | 1784                      | 1872             | 4031           | 4355                  | 4673                  | 4680           | ps   |
|                                 |                | t <sub>DIP</sub> | 1916                      | 2011             | 4201           | 4549                  | 4899                  | 4899           | ps   |
|                                 | 12 mA<br>(1)   | t <sub>OP</sub>  | 1784                      | 1872             | 4031           | 4355                  | 4673                  | 4680           | ps   |
|                                 |                | t <sub>DIP</sub> | 1916                      | 2011             | 4201           | 4549                  | 4899                  | 4899           | ps   |

**Table 5–42. Cyclone II I/O Output Delay for Column Pins (Part 6 of 6)**

| I/O Standard                    | Drive Strength | Parameter        | Fast Corner               |                 | –6 Speed Grade | –7 Speed Grade<br>(2) | –7 Speed Grade<br>(3) | –8 Speed Grade | Unit |
|---------------------------------|----------------|------------------|---------------------------|-----------------|----------------|-----------------------|-----------------------|----------------|------|
|                                 |                |                  | Industrial/<br>Automotive | Commer-<br>cial |                |                       |                       |                |      |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_II | 16 mA<br>(1)   | t <sub>OP</sub>  | 1750                      | 1836            | 3844           | 4125                  | 4399                  | 4406           | ps   |
|                                 |                | t <sub>DIP</sub> | 1882                      | 1975            | 4014           | 4319                  | 4625                  | 4625           | ps   |
| LVDS                            | —              | t <sub>OP</sub>  | 1258                      | 1319            | 2243           | 2344                  | 2438                  | 2445           | ps   |
|                                 |                | t <sub>DIP</sub> | 1390                      | 1458            | 2413           | 2538                  | 2664                  | 2664           | ps   |
| RSDS                            | —              | t <sub>OP</sub>  | 1258                      | 1319            | 2243           | 2344                  | 2438                  | 2445           | ps   |
|                                 |                | t <sub>DIP</sub> | 1390                      | 1458            | 2413           | 2538                  | 2664                  | 2664           | ps   |
| MINI_LVDS                       | —              | t <sub>OP</sub>  | 1258                      | 1319            | 2243           | 2344                  | 2438                  | 2445           | ps   |
|                                 |                | t <sub>DIP</sub> | 1390                      | 1458            | 2413           | 2538                  | 2664                  | 2664           | ps   |
| SIMPLE_RSDS                     | —              | t <sub>OP</sub>  | 1221                      | 1280            | 2258           | 2435                  | 2605                  | 2612           | ps   |
|                                 |                | t <sub>DIP</sub> | 1353                      | 1419            | 2428           | 2629                  | 2831                  | 2831           | ps   |
| 1.2V_HSTL                       | —              | t <sub>OP</sub>  | 2403                      | 2522            | 4635           | 5344                  | 6046                  | 6053           | ps   |
|                                 |                | t <sub>DIP</sub> | 2535                      | 2661            | 4805           | 5538                  | 6272                  | 6272           | ps   |
| 1.2V_DIFFERENTIAL_HSTL          | —              | t <sub>OP</sub>  | 2403                      | 2522            | 4635           | 5344                  | 6046                  | 6053           | ps   |
|                                 |                | t <sub>DIP</sub> | 2535                      | 2661            | 4805           | 5538                  | 6272                  | 6272           | ps   |

**Notes to Table 5–42:**

- (1) This is the default setting in the Quartus II software.
- (2) These numbers are for commercial devices.
- (3) These numbers are for automotive devices.

**Table 5–43. Cyclone II I/O Output Delay for Row Pins (Part 1 of 4)**

| I/O Standard | Drive Strength | Parameter        | Fast Corner             |            | –6 Speed Grade | –7 Speed Grade (2) | –7 Speed Grade (3) | –8 Speed Grade | Unit |
|--------------|----------------|------------------|-------------------------|------------|----------------|--------------------|--------------------|----------------|------|
|              |                |                  | Industrial /Auto-motive | Commercial |                |                    |                    |                |      |
| LVTTTL       | 4 mA           | t <sub>OP</sub>  | 1343                    | 1408       | 2539           | 2694               | 2885               | 2891           | ps   |
|              |                | t <sub>DIP</sub> | 1467                    | 1540       | 2747           | 2931               | 3158               | 3158           | ps   |
|              | 8 mA           | t <sub>OP</sub>  | 1198                    | 1256       | 2411           | 2587               | 2756               | 2762           | ps   |
|              |                | t <sub>DIP</sub> | 1322                    | 1388       | 2619           | 2824               | 3029               | 3029           | ps   |
|              | 12 mA          | t <sub>OP</sub>  | 1156                    | 1212       | 2282           | 2452               | 2614               | 2620           | ps   |
|              |                | t <sub>DIP</sub> | 1280                    | 1344       | 2490           | 2689               | 2887               | 2887           | ps   |
|              | 16 mA          | t <sub>OP</sub>  | 1124                    | 1178       | 2286           | 2455               | 2618               | 2624           | ps   |
|              |                | t <sub>DIP</sub> | 1248                    | 1310       | 2494           | 2692               | 2891               | 2891           | ps   |
|              | 20 mA          | t <sub>OP</sub>  | 1112                    | 1165       | 2245           | 2413               | 2574               | 2580           | ps   |
|              |                | t <sub>DIP</sub> | 1236                    | 1297       | 2453           | 2650               | 2847               | 2847           | ps   |
|              | 24 mA (1)      | t <sub>OP</sub>  | 1105                    | 1158       | 2253           | 2422               | 2583               | 2589           | ps   |
|              |                | t <sub>DIP</sub> | 1229                    | 1290       | 2461           | 2659               | 2856               | 2856           | ps   |
| LVCMOS       | 4 mA           | t <sub>OP</sub>  | 1200                    | 1258       | 2231           | 2396               | 2555               | 2561           | ps   |
|              |                | t <sub>DIP</sub> | 1324                    | 1390       | 2439           | 2633               | 2828               | 2828           | ps   |
|              | 8 mA           | t <sub>OP</sub>  | 1125                    | 1179       | 2260           | 2429               | 2591               | 2597           | ps   |
|              |                | t <sub>DIP</sub> | 1249                    | 1311       | 2468           | 2666               | 2864               | 2864           | ps   |
|              | 12 mA (1)      | t <sub>OP</sub>  | 1106                    | 1159       | 2217           | 2383               | 2543               | 2549           | ps   |
|              |                | t <sub>DIP</sub> | 1230                    | 1291       | 2425           | 2620               | 2816               | 2816           | ps   |
| 2.5V         | 4 mA           | t <sub>OP</sub>  | 1126                    | 1180       | 2350           | 2477               | 2598               | 2604           | ps   |
|              |                | t <sub>DIP</sub> | 1250                    | 1312       | 2558           | 2714               | 2871               | 2871           | ps   |
|              | 8 mA (1)       | t <sub>OP</sub>  | 1105                    | 1158       | 2177           | 2296               | 2409               | 2415           | ps   |
|              |                | t <sub>DIP</sub> | 1229                    | 1290       | 2385           | 2533               | 2682               | 2682           | ps   |

**Table 5–43. Cyclone II I/O Output Delay for Row Pins (Part 2 of 4)**

| I/O Standard     | Drive Strength | Parameter        | Fast Corner             |             | –6 Speed Grade | –7 Speed Grade (2) | –7 Speed Grade (3) | –8 Speed Grade | Unit |
|------------------|----------------|------------------|-------------------------|-------------|----------------|--------------------|--------------------|----------------|------|
|                  |                |                  | Industrial /Auto-motive | Commer-cial |                |                    |                    |                |      |
| 1.8V             | 2 mA           | t <sub>OP</sub>  | 1503                    | 1576        | 3657           | 3927               | 4190               | 4196           | ps   |
|                  |                | t <sub>DIP</sub> | 1627                    | 1708        | 3865           | 4164               | 4463               | 4463           | ps   |
|                  | 4 mA           | t <sub>OP</sub>  | 1400                    | 1468        | 3010           | 3226               | 3434               | 3440           | ps   |
|                  |                | t <sub>DIP</sub> | 1524                    | 1600        | 3218           | 3463               | 3707               | 3707           | ps   |
|                  | 6 mA           | t <sub>OP</sub>  | 1388                    | 1455        | 2857           | 3050               | 3236               | 3242           | ps   |
|                  |                | t <sub>DIP</sub> | 1512                    | 1587        | 3065           | 3287               | 3509               | 3509           | ps   |
|                  | 8 mA           | t <sub>OP</sub>  | 1347                    | 1412        | 2714           | 2897               | 3072               | 3078           | ps   |
|                  |                | t <sub>DIP</sub> | 1471                    | 1544        | 2922           | 3134               | 3345               | 3345           | ps   |
|                  | 10 mA          | t <sub>OP</sub>  | 1347                    | 1412        | 2714           | 2897               | 3072               | 3078           | ps   |
|                  |                | t <sub>DIP</sub> | 1471                    | 1544        | 2922           | 3134               | 3345               | 3345           | ps   |
|                  | 12 mA (1)      | t <sub>OP</sub>  | 1332                    | 1396        | 2678           | 2856               | 3028               | 3034           | ps   |
|                  |                | t <sub>DIP</sub> | 1456                    | 1528        | 2886           | 3093               | 3301               | 3301           | ps   |
| 1.5V             | 2 mA           | t <sub>OP</sub>  | 1853                    | 1943        | 4127           | 4492               | 4849               | 4855           | ps   |
|                  |                | t <sub>DIP</sub> | 1977                    | 2075        | 4335           | 4729               | 5122               | 5122           | ps   |
|                  | 4 mA           | t <sub>OP</sub>  | 1694                    | 1776        | 3452           | 3747               | 4036               | 4042           | ps   |
|                  |                | t <sub>DIP</sub> | 1818                    | 1908        | 3660           | 3984               | 4309               | 4309           | ps   |
|                  | 6 mA (1)       | t <sub>OP</sub>  | 1694                    | 1776        | 3452           | 3747               | 4036               | 4042           | ps   |
|                  |                | t <sub>DIP</sub> | 1818                    | 1908        | 3660           | 3984               | 4309               | 4309           | ps   |
| SSTL_2_ CLASS_I  | 8 mA           | t <sub>OP</sub>  | 1090                    | 1142        | 2152           | 2268               | 2376               | 2382           | ps   |
|                  |                | t <sub>DIP</sub> | 1214                    | 1274        | 2360           | 2505               | 2649               | 2649           | ps   |
|                  | 12 mA (1)      | t <sub>OP</sub>  | 1097                    | 1150        | 2131           | 2246               | 2354               | 2360           | ps   |
|                  |                | t <sub>DIP</sub> | 1221                    | 1282        | 2339           | 2483               | 2627               | 2627           | ps   |
| SSTL_2_ CLASS_II | 16 mA (1)      | t <sub>OP</sub>  | 1068                    | 1119        | 2067           | 2177               | 2281               | 2287           | ps   |
|                  |                | t <sub>DIP</sub> | 1192                    | 1251        | 2275           | 2414               | 2554               | 2554           | ps   |
| SSTL_18_ CLASS_I | 6 mA           | t <sub>OP</sub>  | 1371                    | 1437        | 2828           | 3018               | 3200               | 3206           | ps   |
|                  |                | t <sub>DIP</sub> | 1495                    | 1569        | 3036           | 3255               | 3473               | 3473           | ps   |
|                  | 8 mA           | t <sub>OP</sub>  | 1365                    | 1431        | 2832           | 3024               | 3209               | 3215           | ps   |
|                  |                | t <sub>DIP</sub> | 1489                    | 1563        | 3040           | 3261               | 3482               | 3482           | ps   |
|                  | 10 mA (1)      | t <sub>OP</sub>  | 1374                    | 1440        | 2806           | 2990               | 3167               | 3173           | ps   |
|                  |                | t <sub>DIP</sub> | 1498                    | 1572        | 3014           | 3227               | 3440               | 3440           | ps   |

Table 5–43. Cyclone II I/O Output Delay for Row Pins (Part 3 of 4)

| I/O Standard                   | Drive Strength | Parameter        | Fast Corner             |            | –6 Speed Grade | –7 Speed Grade (2) | –7 Speed Grade (3) | –8 Speed Grade | Unit |
|--------------------------------|----------------|------------------|-------------------------|------------|----------------|--------------------|--------------------|----------------|------|
|                                |                |                  | Industrial /Auto-motive | Commercial |                |                    |                    |                |      |
| 1.8V_HSTL_CLASS_I              | 8 mA           | t <sub>OP</sub>  | 1364                    | 1430       | 2853           | 3017               | 3178               | 3184           | ps   |
|                                |                | t <sub>DIP</sub> | 1488                    | 1562       | 3061           | 3254               | 3451               | 3451           | ps   |
|                                | 10 mA          | t <sub>OP</sub>  | 1332                    | 1396       | 2842           | 3011               | 3173               | 3179           | ps   |
|                                |                | t <sub>DIP</sub> | 1456                    | 1528       | 3050           | 3248               | 3446               | 3446           | ps   |
|                                | 12 mA (1)      | t <sub>OP</sub>  | 1332                    | 1396       | 2842           | 3011               | 3173               | 3179           | ps   |
|                                |                | t <sub>DIP</sub> | 1456                    | 1528       | 3050           | 3248               | 3446               | 3446           | ps   |
| 1.5V_HSTL_CLASS_I              | 8 mA (1)       | t <sub>OP</sub>  | 1657                    | 1738       | 3642           | 3917               | 4185               | 4191           | ps   |
|                                |                | t <sub>DIP</sub> | 1781                    | 1870       | 3850           | 4154               | 4458               | 4458           | ps   |
| DIFFERENTIAL_SSTL_2_CLASS_I    | 8 mA           | t <sub>OP</sub>  | 1090                    | 1142       | 2152           | 2268               | 2376               | 2382           | ps   |
|                                |                | t <sub>DIP</sub> | 1214                    | 1274       | 2360           | 2505               | 2649               | 2649           | ps   |
|                                | 12 mA (1)      | t <sub>OP</sub>  | 1097                    | 1150       | 2131           | 2246               | 2354               | 2360           | ps   |
|                                |                | t <sub>DIP</sub> | 1221                    | 1282       | 2339           | 2483               | 2627               | 2627           | ps   |
| DIFFERENTIAL_SSTL_2_CLASS_II   | 16 mA (1)      | t <sub>OP</sub>  | 1068                    | 1119       | 2067           | 2177               | 2281               | 2287           | ps   |
|                                |                | t <sub>DIP</sub> | 1192                    | 1251       | 2275           | 2414               | 2554               | 2554           | ps   |
| DIFFERENTIAL_SSTL_18_CLASS_I   | 6 mA           | t <sub>OP</sub>  | 1371                    | 1437       | 2828           | 3018               | 3200               | 3206           | ps   |
|                                |                | t <sub>DIP</sub> | 1495                    | 1569       | 3036           | 3255               | 3473               | 3473           | ps   |
|                                | 8 mA           | t <sub>OP</sub>  | 1365                    | 1431       | 2832           | 3024               | 3209               | 3215           | ps   |
|                                |                | t <sub>DIP</sub> | 1489                    | 1563       | 3040           | 3261               | 3482               | 3482           | ps   |
|                                | 10 mA (1)      | t <sub>OP</sub>  | 1374                    | 1440       | 2806           | 2990               | 3167               | 3173           | ps   |
|                                |                | t <sub>DIP</sub> | 1498                    | 1572       | 3014           | 3227               | 3440               | 3440           | ps   |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_I | 8 mA           | t <sub>OP</sub>  | 1364                    | 1430       | 2853           | 3017               | 3178               | 3184           | ps   |
|                                |                | t <sub>DIP</sub> | 1488                    | 1562       | 3061           | 3254               | 3451               | 3451           | ps   |
|                                | 10 mA          | t <sub>OP</sub>  | 1332                    | 1396       | 2842           | 3011               | 3173               | 3179           | ps   |
|                                |                | t <sub>DIP</sub> | 1456                    | 1528       | 3050           | 3248               | 3446               | 3446           | ps   |
|                                | 12 mA (1)      | t <sub>OP</sub>  | 1332                    | 1396       | 2842           | 3011               | 3173               | 3179           | ps   |
|                                |                | t <sub>DIP</sub> | 1456                    | 1528       | 3050           | 3248               | 3446               | 3446           | ps   |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_I | 8 mA (1)       | t <sub>OP</sub>  | 1657                    | 1738       | 3642           | 3917               | 4185               | 4191           | ps   |
|                                |                | t <sub>DIP</sub> | 1781                    | 1870       | 3850           | 4154               | 4458               | 4458           | ps   |

**Table 5–43. Cyclone II I/O Output Delay for Row Pins (Part 4 of 4)**

| I/O Standard | Drive Strength | Parameter        | Fast Corner             |            | –6 Speed Grade | –7 Speed Grade (2) | –7 Speed Grade (3) | –8 Speed Grade | Unit |
|--------------|----------------|------------------|-------------------------|------------|----------------|--------------------|--------------------|----------------|------|
|              |                |                  | Industrial /Auto-motive | Commercial |                |                    |                    |                |      |
| LVDS         | —              | t <sub>OP</sub>  | 1216                    | 1275       | 2089           | 2184               | 2272               | 2278           | ps   |
|              |                | t <sub>DIP</sub> | 1340                    | 1407       | 2297           | 2421               | 2545               | 2545           | ps   |
| RSDS         | —              | t <sub>OP</sub>  | 1216                    | 1275       | 2089           | 2184               | 2272               | 2278           | ps   |
|              |                | t <sub>DIP</sub> | 1340                    | 1407       | 2297           | 2421               | 2545               | 2545           | ps   |
| MINI_LVDS    | —              | t <sub>OP</sub>  | 1216                    | 1275       | 2089           | 2184               | 2272               | 2278           | ps   |
|              |                | t <sub>DIP</sub> | 1340                    | 1407       | 2297           | 2421               | 2545               | 2545           | ps   |
| PCI          | —              | t <sub>OP</sub>  | 989                     | 1036       | 2070           | 2214               | 2352               | 2358           | ps   |
|              |                | t <sub>DIP</sub> | 1113                    | 1168       | 2278           | 2451               | 2625               | 2625           | ps   |
| PCI-X        | —              | t <sub>OP</sub>  | 989                     | 1036       | 2070           | 2214               | 2352               | 2358           | ps   |
|              |                | t <sub>DIP</sub> | 1113                    | 1168       | 2278           | 2451               | 2625               | 2625           | ps   |

**Notes to Table 5–43:**

- (1) This is the default setting in the Quartus II software.
- (2) These numbers are for commercial devices.
- (3) These numbers are for automotive devices.

## Maximum Input and Output Clock Rate

Maximum clock toggle rate is defined as the maximum frequency achievable for a clock type signal at an I/O pin. The I/O pin can be a regular I/O pin or a dedicated clock I/O pin.

The maximum clock toggle rate is different from the maximum data bit rate. If the maximum clock toggle rate on a regular I/O pin is 300 MHz, the maximum data bit rate for dual data rate (DDR) could be potentially as high as 600 Mbps on the same I/O pin.

Table 5–44 specifies the maximum input clock toggle rates. Table 5–45 specifies the maximum output clock toggle rates at default load.

Table 5–46 specifies the derating factors for the output clock toggle rate for non-default load.

To calculate the output toggle rate for a non-default load, use this formula:

The toggle rate for a non-default load



$$= 1000 / (1000 / \text{toggle rate at default load} + \text{derating factor} * \text{load value in pF} / 1000)$$

For example, the output toggle rate at 0 pF (default) load for SSTL-18 Class II 18mA I/O standard is 270 MHz on a –6 device column I/O pin. The derating factor is 29 ps/pF. For a 10pF load, the toggle rate is calculated as:

$$1000 / (1000 / 270 + 29 \times 10 / 1000) = 250 \text{ (MHz)}$$

Tables 5–44 through 5–46 show the I/O toggle rates for Cyclone II devices.

**Table 5–44. Maximum Input Clock Toggle Rate on Cyclone II Devices (Part 1 of 2)**

| I/O Standard                 | Maximum Input Clock Toggle Rate on Cyclone II Devices (MHz) |                      |                      |                      |                      |                      |                        |                      |                      |
|------------------------------|-------------------------------------------------------------|----------------------|----------------------|----------------------|----------------------|----------------------|------------------------|----------------------|----------------------|
|                              | Column I/O Pins                                             |                      |                      | Row I/O Pins         |                      |                      | Dedicated Clock Inputs |                      |                      |
|                              | –6<br>Speed<br>Grade                                        | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade | –6<br>Speed<br>Grade | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade | –6<br>Speed<br>Grade   | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade |
| LVTTTL                       | 450                                                         | 405                  | 360                  | 450                  | 405                  | 360                  | 420                    | 380                  | 340                  |
| 2.5V                         | 450                                                         | 405                  | 360                  | 450                  | 405                  | 360                  | 450                    | 405                  | 360                  |
| 1.8V                         | 450                                                         | 405                  | 360                  | 450                  | 405                  | 360                  | 450                    | 405                  | 360                  |
| 1.5V                         | 300                                                         | 270                  | 240                  | 300                  | 270                  | 240                  | 300                    | 270                  | 240                  |
| LVC MOS                      | 450                                                         | 405                  | 360                  | 450                  | 405                  | 360                  | 420                    | 380                  | 340                  |
| SSTL_2_CLASS_I               | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| SSTL_2_CLASS_II              | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| SSTL_18_CLASS_I              | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| SSTL_18_CLASS_II             | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| 1.5V_HSTL_CLASS_I            | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| 1.5V_HSTL_CLASS_II           | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| 1.8V_HSTL_CLASS_I            | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| 1.8V_HSTL_CLASS_II           | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| PCI                          | —                                                           | —                    | —                    | 350                  | 315                  | 280                  | 350                    | 315                  | 280                  |
| PCI-X                        | —                                                           | —                    | —                    | 350                  | 315                  | 280                  | 350                    | 315                  | 280                  |
| DIFFERENTIAL_SSTL_2_CLASS_I  | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| DIFFERENTIAL_SSTL_2_CLASS_II | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |

**Table 5–44. Maximum Input Clock Toggle Rate on Cyclone II Devices (Part 2 of 2)**

| I/O Standard                    | Maximum Input Clock Toggle Rate on Cyclone II Devices (MHz) |                      |                      |                      |                      |                      |                        |                      |                      |
|---------------------------------|-------------------------------------------------------------|----------------------|----------------------|----------------------|----------------------|----------------------|------------------------|----------------------|----------------------|
|                                 | Column I/O Pins                                             |                      |                      | Row I/O Pins         |                      |                      | Dedicated Clock Inputs |                      |                      |
|                                 | –6<br>Speed<br>Grade                                        | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade | –6<br>Speed<br>Grade | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade | –6<br>Speed<br>Grade   | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade |
| DIFFERENTIAL_SSTL_18_CLASS_I    | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| DIFFERENTIAL_SSTL_18_CLASS_II   | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_I  | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_II | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_I  | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_II | 500                                                         | 500                  | 500                  | 500                  | 500                  | 500                  | 500                    | 500                  | 500                  |
| LVPECL                          | —                                                           | —                    | —                    | —                    | —                    | —                    | 402                    | 402                  | 402                  |
| LVDS                            | 402                                                         | 402                  | 402                  | 402                  | 402                  | 402                  | 402                    | 402                  | 402                  |
| 1.2V_HSTL                       | 110                                                         | 90                   | 80                   | —                    | —                    | —                    | 110                    | 90                   | 80                   |
| 1.2V_DIFFERENTIAL_HSTL          | 110                                                         | 90                   | 80                   | —                    | —                    | —                    | 110                    | 90                   | 80                   |

**Table 5–45. Maximum Output Clock Toggle Rate on Cyclone II Devices (Part 1 of 4)**

| I/O Standard | Drive Strength | Maximum Output Clock Toggle Rate on Cyclone II Devices (MHz) |                      |                      |                      |                      |                      |                         |                      |                      |
|--------------|----------------|--------------------------------------------------------------|----------------------|----------------------|----------------------|----------------------|----------------------|-------------------------|----------------------|----------------------|
|              |                | Column I/O Pins (1)                                          |                      |                      | Row I/O Pins (1)     |                      |                      | Dedicated Clock Outputs |                      |                      |
|              |                | –6<br>Speed<br>Grade                                         | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade | –6<br>Speed<br>Grade | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade | –6<br>Speed<br>Grade    | –7<br>Speed<br>Grade | –8<br>Speed<br>Grade |
| LVTTTL       | 4 mA           | 120                                                          | 100                  | 80                   | 120                  | 100                  | 80                   | 120                     | 100                  | 80                   |
|              | 8 mA           | 200                                                          | 170                  | 140                  | 200                  | 170                  | 140                  | 200                     | 170                  | 140                  |
|              | 12 mA          | 280                                                          | 230                  | 190                  | 280                  | 230                  | 190                  | 280                     | 230                  | 190                  |
|              | 16 mA          | 290                                                          | 240                  | 200                  | 290                  | 240                  | 200                  | 290                     | 240                  | 200                  |
|              | 20 mA          | 330                                                          | 280                  | 230                  | 330                  | 280                  | 230                  | 330                     | 280                  | 230                  |
|              | 24 mA          | 360                                                          | 300                  | 250                  | 360                  | 300                  | 250                  | 360                     | 300                  | 250                  |

**Table 5–45. Maximum Output Clock Toggle Rate on Cyclone II Devices (Part 2 of 4)**

| I/O Standard    | Drive Strength | Maximum Output Clock Toggle Rate on Cyclone II Devices (MHz) |                |                |                         |                |                |                         |                |                |
|-----------------|----------------|--------------------------------------------------------------|----------------|----------------|-------------------------|----------------|----------------|-------------------------|----------------|----------------|
|                 |                | Column I/O Pins <i>(1)</i>                                   |                |                | Row I/O Pins <i>(1)</i> |                |                | Dedicated Clock Outputs |                |                |
|                 |                | –6 Speed Grade                                               | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade          | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade          | –7 Speed Grade | –8 Speed Grade |
| LVCMOS          | 4 mA           | 250                                                          | 210            | 170            | 250                     | 210            | 170            | 250                     | 210            | 170            |
|                 | 8 mA           | 280                                                          | 230            | 190            | 280                     | 230            | 190            | 280                     | 230            | 190            |
|                 | 12 mA          | 310                                                          | 260            | 210            | 310                     | 260            | 210            | 310                     | 260            | 210            |
|                 | 16 mA          | 320                                                          | 270            | 220            | —                       | —              | —              | —                       | —              | —              |
|                 | 20 mA          | 350                                                          | 290            | 240            | —                       | —              | —              | —                       | —              | —              |
|                 | 24 mA          | 370                                                          | 310            | 250            | —                       | —              | —              | —                       | —              | —              |
| 2.5V            | 4 mA           | 180                                                          | 150            | 120            | 180                     | 150            | 120            | 180                     | 150            | 120            |
|                 | 8 mA           | 280                                                          | 230            | 190            | 280                     | 230            | 190            | 280                     | 230            | 190            |
|                 | 12 mA          | 440                                                          | 370            | 300            | —                       | —              | —              | —                       | —              | —              |
|                 | 16 mA          | 450                                                          | 405            | 350            | —                       | —              | —              | —                       | —              | —              |
| 1.8V            | 2 mA           | 120                                                          | 100            | 80             | 120                     | 100            | 80             | 120                     | 100            | 80             |
|                 | 4 mA           | 180                                                          | 150            | 120            | 180                     | 150            | 120            | 180                     | 150            | 120            |
|                 | 6 mA           | 220                                                          | 180            | 150            | 220                     | 180            | 150            | 220                     | 180            | 150            |
|                 | 8 mA           | 240                                                          | 200            | 160            | 240                     | 200            | 160            | 240                     | 200            | 160            |
|                 | 10 mA          | 300                                                          | 250            | 210            | 300                     | 250            | 210            | 300                     | 250            | 210            |
|                 | 12 mA          | 350                                                          | 290            | 240            | 350                     | 290            | 240            | 350                     | 290            | 240            |
| 1.5V            | 2 mA           | 80                                                           | 60             | 50             | 80                      | 60             | 50             | 80                      | 60             | 50             |
|                 | 4 mA           | 130                                                          | 110            | 90             | 130                     | 110            | 90             | 130                     | 110            | 90             |
|                 | 6 mA           | 180                                                          | 150            | 120            | 180                     | 150            | 120            | 180                     | 150            | 120            |
|                 | 8 mA           | 230                                                          | 190            | 160            | —                       | —              | —              | —                       | —              | —              |
| SSTL_2_CLASS_I  | 8 mA           | 400                                                          | 340            | 280            | 400                     | 340            | 280            | 400                     | 340            | 280            |
|                 | 12 mA          | 400                                                          | 340            | 280            | 400                     | 340            | 280            | 400                     | 340            | 280            |
| SSTL_2_CLASS_II | 16 mA          | 350                                                          | 290            | 240            | 350                     | 290            | 240            | 350                     | 290            | 240            |
|                 | 20 mA          | 400                                                          | 340            | 280            | —                       | —              | —              | —                       | —              | —              |
|                 | 24 mA          | 400                                                          | 340            | 280            | —                       | —              | —              | —                       | —              | —              |
| SSTL_18_CLASS_I | 6 mA           | 260                                                          | 220            | 180            | 260                     | 220            | 180            | 260                     | 220            | 180            |
|                 | 8 mA           | 260                                                          | 220            | 180            | 260                     | 220            | 180            | 260                     | 220            | 180            |
|                 | 10 mA          | 270                                                          | 220            | 180            | 270                     | 220            | 180            | 270                     | 220            | 180            |
|                 | 12 mA          | 280                                                          | 230            | 190            | —                       | —              | —              | —                       | —              | —              |

**Table 5–45. Maximum Output Clock Toggle Rate on Cyclone II Devices (Part 3 of 4)**

| I/O Standard                    | Drive Strength | Maximum Output Clock Toggle Rate on Cyclone II Devices (MHz) |                |                |                  |                |                |                         |                |                |
|---------------------------------|----------------|--------------------------------------------------------------|----------------|----------------|------------------|----------------|----------------|-------------------------|----------------|----------------|
|                                 |                | Column I/O Pins (1)                                          |                |                | Row I/O Pins (1) |                |                | Dedicated Clock Outputs |                |                |
|                                 |                | –6 Speed Grade                                               | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade   | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade          | –7 Speed Grade | –8 Speed Grade |
| SSTL_18_CLASS_II                | 16 mA          | 260                                                          | 220            | 180            | —                | —              | —              | —                       | —              | —              |
|                                 | 18 mA          | 270                                                          | 220            | 180            | —                | —              | —              | —                       | —              | —              |
| 1.8V_HSTL_CLASS_I               | 8 mA           | 260                                                          | 220            | 180            | 260              | 220            | 180            | 260                     | 220            | 180            |
|                                 | 10 mA          | 300                                                          | 250            | 210            | 300              | 250            | 210            | 300                     | 250            | 210            |
|                                 | 12 mA          | 320                                                          | 270            | 220            | 320              | 270            | 220            | 320                     | 270            | 220            |
| 1.8V_HSTL_CLASS_II              | 16 mA          | 230                                                          | 190            | 160            | —                | —              | —              | —                       | —              | —              |
|                                 | 18 mA          | 240                                                          | 200            | 160            | —                | —              | —              | —                       | —              | —              |
|                                 | 20 mA          | 250                                                          | 210            | 170            | —                | —              | —              | —                       | —              | —              |
| 1.5V_HSTL_CLASS_I               | 8 mA           | 210                                                          | 170            | 140            | 210              | 170            | 140            | 210                     | 170            | 140            |
|                                 | 10 mA          | 220                                                          | 180            | 150            | —                | —              | —              | —                       | —              | —              |
|                                 | 12 mA          | 230                                                          | 190            | 160            | —                | —              | —              | —                       | —              | —              |
| 1.5V_HSTL_CLASS_II              | 16 mA          | 210                                                          | 170            | 140            | —                | —              | —              | —                       | —              | —              |
| DIFFERENTIAL_SSTL_2_CLASS_I     | 8 mA           | 400                                                          | 340            | 280            | 400              | 340            | 280            | 400                     | 340            | 280            |
|                                 | 12 mA          | 400                                                          | 340            | 280            | 400              | 340            | 280            | 400                     | 340            | 280            |
| DIFFERENTIAL_SSTL_2_CLASS_II    | 16 mA          | 350                                                          | 290            | 240            | 350              | 290            | 240            | 350                     | 290            | 240            |
|                                 | 20 mA          | 400                                                          | 340            | 280            | —                | —              | —              | —                       | —              | —              |
|                                 | 24 mA          | 400                                                          | 340            | 280            | —                | —              | —              | —                       | —              | —              |
| DIFFERENTIAL_SSTL_18_CLASS_I    | 6 mA           | 260                                                          | 220            | 180            | 260              | 220            | 180            | 260                     | 220            | 180            |
|                                 | 8 mA           | 260                                                          | 220            | 180            | 260              | 220            | 180            | 260                     | 220            | 180            |
|                                 | 10 mA          | 270                                                          | 220            | 180            | 270              | 220            | 180            | 270                     | 220            | 180            |
|                                 | 12 mA          | 280                                                          | 230            | 190            | —                | —              | —              | —                       | —              | —              |
| DIFFERENTIAL_SSTL_18_CLASS_II   | 16 mA          | 260                                                          | 220            | 180            | —                | —              | —              | —                       | —              | —              |
|                                 | 18 mA          | 270                                                          | 220            | 180            | —                | —              | —              | —                       | —              | —              |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_I  | 8 mA           | 260                                                          | 220            | 180            | 260              | 220            | 180            | 260                     | 220            | 180            |
|                                 | 10 mA          | 300                                                          | 250            | 210            | 300              | 250            | 210            | 300                     | 250            | 210            |
|                                 | 12 mA          | 320                                                          | 270            | 220            | 320              | 270            | 220            | 320                     | 270            | 220            |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_II | 16 mA          | 230                                                          | 190            | 160            | —                | —              | —              | —                       | —              | —              |
|                                 | 18 mA          | 240                                                          | 200            | 160            | —                | —              | —              | —                       | —              | —              |
|                                 | 20 mA          | 250                                                          | 210            | 170            | —                | —              | —              | —                       | —              | —              |

**Table 5–45. Maximum Output Clock Toggle Rate on Cyclone II Devices (Part 4 of 4)**

| I/O Standard                            | Drive Strength  | Maximum Output Clock Toggle Rate on Cyclone II Devices (MHz) |                |                |                  |                |                |                         |                |                |
|-----------------------------------------|-----------------|--------------------------------------------------------------|----------------|----------------|------------------|----------------|----------------|-------------------------|----------------|----------------|
|                                         |                 | Column I/O Pins (1)                                          |                |                | Row I/O Pins (1) |                |                | Dedicated Clock Outputs |                |                |
|                                         |                 | –6 Speed Grade                                               | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade   | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade          | –7 Speed Grade | –8 Speed Grade |
| 1.5V_<br>DIFFERENTIAL_HSTL<br>_CLASS_I  | 8 mA            | 210                                                          | 170            | 140            | 210              | 170            | 140            | 210                     | 170            | 140            |
|                                         | 10 mA           | 220                                                          | 180            | 150            | —                | —              | —              | —                       | —              | —              |
|                                         | 12 mA           | 230                                                          | 190            | 160            | —                | —              | —              | —                       | —              | —              |
| 1.5V_<br>DIFFERENTIAL_HSTL<br>_CLASS_II | 16 mA           | 210                                                          | 170            | 140            | —                | —              | —              | —                       | —              | —              |
| LVDS                                    | —               | 400                                                          | 340            | 280            | 400              | 340            | 280            | 400                     | 340            | 280            |
| RSDS                                    | —               | 400                                                          | 340            | 280            | 400              | 340            | 280            | 400                     | 340            | 280            |
| MINI_LVDS                               | —               | 400                                                          | 340            | 280            | 400              | 340            | 280            | 400                     | 340            | 280            |
| SIMPLE_RSDS                             | —               | 380                                                          | 320            | 260            | 380              | 320            | 260            | 380                     | 320            | 260            |
| 1.2V_HSTL                               | —               | 80                                                           | 80             | 80             | —                | —              | —              | —                       | —              | —              |
| 1.2V_<br>DIFFERENTIAL_HSTL              | —               | 80                                                           | 80             | 80             | —                | —              | —              | —                       | —              | —              |
| PCI                                     | —               | —                                                            | —              | —              | 350              | 315            | 280            | 350                     | 315            | 280            |
| PCI-X                                   | —               | —                                                            | —              | —              | 350              | 315            | 280            | 350                     | 315            | 280            |
| LVTTL                                   | OCT_25_<br>OHMS | 360                                                          | 300            | 250            | 360              | 300            | 250            | 360                     | 300            | 250            |
| LVC MOS                                 | OCT_25_<br>OHMS | 360                                                          | 300            | 250            | 360              | 300            | 250            | 360                     | 300            | 250            |
| 2.5V                                    | OCT_50_<br>OHMS | 240                                                          | 200            | 160            | 240              | 200            | 160            | 240                     | 200            | 160            |
| 1.8V                                    | OCT_50_<br>OHMS | 290                                                          | 240            | 200            | 290              | 240            | 200            | 290                     | 240            | 200            |
| SSTL_2_CLASS_I                          | OCT_50_<br>OHMS | 240                                                          | 200            | 160            | 240              | 200            | 160            | —                       | —              | —              |
| SSTL_18_CLASS_I                         | OCT_50_<br>OHMS | 290                                                          | 240            | 200            | 290              | 240            | 200            | —                       | —              | —              |

**Note to Table 5–45:**

(1) This is based on single data rate I/Os.

**Table 5–46. Maximum Output Clock Toggle Rate Derating Factors (Part 1 of 4)**

| I/O Standard   | Drive Strength | Maximum Output Clock Toggle Rate Derating Factors (ps/pF) |                |                |                |                |                |                         |                |                |
|----------------|----------------|-----------------------------------------------------------|----------------|----------------|----------------|----------------|----------------|-------------------------|----------------|----------------|
|                |                | Column I/O Pins                                           |                |                | Row I/O Pins   |                |                | Dedicated Clock Outputs |                |                |
|                |                | –6 Speed Grade                                            | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade          | –7 Speed Grade | –8 Speed Grade |
| LVTTTL         | 4 mA           | 438                                                       | 439            | 439            | 338            | 362            | 387            | 338                     | 362            | 387            |
|                | 8 mA           | 306                                                       | 321            | 336            | 267            | 283            | 299            | 267                     | 283            | 299            |
|                | 12 mA          | 139                                                       | 179            | 220            | 193            | 198            | 202            | 193                     | 198            | 202            |
|                | 16 mA          | 145                                                       | 158            | 172            | 139            | 147            | 156            | 139                     | 147            | 156            |
|                | 20 mA          | 65                                                        | 77             | 90             | 74             | 79             | 84             | 74                      | 79             | 84             |
|                | 24 mA          | 19                                                        | 20             | 21             | 14             | 18             | 22             | 14                      | 18             | 22             |
| LVCMOS         | 4 mA           | 298                                                       | 305            | 313            | 197            | 205            | 214            | 197                     | 205            | 214            |
|                | 8 mA           | 190                                                       | 205            | 219            | 112            | 118            | 125            | 112                     | 118            | 125            |
|                | 12 mA          | 43                                                        | 72             | 101            | 27             | 31             | 35             | 27                      | 31             | 35             |
|                | 16 mA          | 87                                                        | 99             | 110            | —              | —              | —              | —                       | —              | —              |
|                | 20 mA          | 36                                                        | 46             | 56             | —              | —              | —              | —                       | —              | —              |
|                | 24 mA          | 24                                                        | 25             | 27             | —              | —              | —              | —                       | —              | —              |
| 2.5V           | 4 mA           | 228                                                       | 233            | 237            | 270            | 306            | 343            | 270                     | 306            | 343            |
|                | 8 mA           | 173                                                       | 177            | 180            | 191            | 199            | 208            | 191                     | 199            | 208            |
|                | 12 mA          | 119                                                       | 121            | 123            | —              | —              | —              | —                       | —              | —              |
|                | 16 mA          | 64                                                        | 65             | 66             | —              | —              | —              | —                       | —              | —              |
| 1.8V           | 2 mA           | 452                                                       | 457            | 461            | 332            | 367            | 403            | 332                     | 367            | 403            |
|                | 4 mA           | 321                                                       | 347            | 373            | 244            | 291            | 337            | 244                     | 291            | 337            |
|                | 6 mA           | 227                                                       | 255            | 283            | 178            | 222            | 266            | 178                     | 222            | 266            |
|                | 8 mA           | 37                                                        | 118            | 199            | 58             | 133            | 207            | 58                      | 133            | 207            |
|                | 10 mA          | 41                                                        | 72             | 103            | 46             | 85             | 123            | 46                      | 85             | 123            |
|                | 12 mA          | 7                                                         | 8              | 10             | 13             | 28             | 44             | 13                      | 28             | 44             |
| 1.5V           | 2 mA           | 738                                                       | 764            | 789            | 540            | 604            | 669            | 540                     | 604            | 669            |
|                | 4 mA           | 499                                                       | 518            | 536            | 300            | 354            | 408            | 300                     | 354            | 408            |
|                | 6 mA           | 261                                                       | 271            | 282            | 60             | 103            | 146            | 60                      | 103            | 146            |
|                | 8 mA           | 22                                                        | 25             | 29             | —              | —              | —              | —                       | —              | —              |
| SSTL_2_CLASS_I | 8 mA           | 46                                                        | 47             | 49             | 25             | 40             | 56             | 25                      | 40             | 56             |
|                | 12 mA          | 67                                                        | 69             | 70             | 23             | 42             | 60             | 23                      | 42             | 60             |

**Table 5–46. Maximum Output Clock Toggle Rate Derating Factors (Part 2 of 4)**

| I/O Standard                 | Drive Strength | Maximum Output Clock Toggle Rate Derating Factors (ps/pF) |                |                |                |                |                |                         |                |                |
|------------------------------|----------------|-----------------------------------------------------------|----------------|----------------|----------------|----------------|----------------|-------------------------|----------------|----------------|
|                              |                | Column I/O Pins                                           |                |                | Row I/O Pins   |                |                | Dedicated Clock Outputs |                |                |
|                              |                | –6 Speed Grade                                            | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade          | –7 Speed Grade | –8 Speed Grade |
| SSTL_2_CLASS_II              | 16 mA          | 42                                                        | 43             | 45             | 15             | 29             | 42             | 15                      | 29             | 42             |
|                              | 20 mA          | 41                                                        | 42             | 44             | —              | —              | —              | —                       | —              | —              |
|                              | 24 mA          | 40                                                        | 42             | 43             | —              | —              | —              | —                       | —              | —              |
| SSTL_18_CLASS_I              | 6 mA           | 20                                                        | 22             | 24             | 46             | 47             | 49             | 46                      | 47             | 49             |
|                              | 8 mA           | 20                                                        | 22             | 24             | 47             | 49             | 51             | 47                      | 49             | 51             |
|                              | 10 mA          | 20                                                        | 22             | 25             | 23             | 25             | 27             | 23                      | 25             | 27             |
|                              | 12 mA          | 19                                                        | 23             | 26             | —              | —              | —              | —                       | —              | —              |
| SSTL_18_CLASS_II             | 16 mA          | 30                                                        | 33             | 36             | —              | —              | —              | —                       | —              | —              |
|                              | 18 mA          | 29                                                        | 29             | 29             | —              | —              | —              | —                       | —              | —              |
| 1.8V_HSTL_CLASS_I            | 8 mA           | 26                                                        | 28             | 29             | 59             | 61             | 63             | 59                      | 61             | 63             |
|                              | 10 mA          | 46                                                        | 47             | 48             | 65             | 66             | 68             | 65                      | 66             | 68             |
|                              | 12 mA          | 67                                                        | 67             | 67             | 71             | 71             | 72             | 71                      | 71             | 72             |
| 1.8V_HSTL_CLASS_II           | 16 mA          | 62                                                        | 65             | 68             | —              | —              | —              | —                       | —              | —              |
|                              | 18 mA          | 59                                                        | 62             | 65             | —              | —              | —              | —                       | —              | —              |
|                              | 20 mA          | 57                                                        | 59             | 62             | —              | —              | —              | —                       | —              | —              |
| 1.5V_HSTL_CLASS_I            | 8 mA           | 40                                                        | 40             | 41             | 28             | 32             | 36             | 28                      | 32             | 36             |
|                              | 10 mA          | 41                                                        | 42             | 42             | —              | —              | —              | —                       | —              | —              |
|                              | 12 mA          | 43                                                        | 43             | 43             | —              | —              | —              | —                       | —              | —              |
| 1.5V_HSTL_CLASS_II           | 16 mA          | 18                                                        | 20             | 21             | —              | —              | —              | —                       | —              | —              |
|                              | 18 mA          | 18                                                        | 20             | 21             | —              | —              | —              | —                       | —              | —              |
| DIFFERENTIAL_SSTL_2_CLASS_I  | 8 mA           | 46                                                        | 47             | 49             | 25             | 40             | 56             | 25                      | 40             | 56             |
|                              | 12 mA          | 67                                                        | 69             | 70             | 23             | 42             | 60             | 23                      | 42             | 60             |
| DIFFERENTIAL_SSTL_2_CLASS_II | 16 mA          | 42                                                        | 43             | 45             | 15             | 29             | 42             | 15                      | 29             | 42             |
|                              | 20 mA          | 41                                                        | 42             | 44             | —              | —              | —              | —                       | —              | —              |
|                              | 24 mA          | 40                                                        | 42             | 43             | —              | —              | —              | —                       | —              | —              |
| DIFFERENTIAL_SSTL_18_CLASS_I | 6 mA           | 20                                                        | 22             | 24             | 46             | 47             | 49             | 46                      | 47             | 49             |
|                              | 8 mA           | 20                                                        | 22             | 24             | 47             | 49             | 51             | 47                      | 49             | 51             |
|                              | 10 mA          | 20                                                        | 22             | 25             | 23             | 25             | 27             | 23                      | 25             | 27             |
|                              | 12 mA          | 19                                                        | 23             | 26             | —              | —              | —              | —                       | —              | —              |

**Table 5–46. Maximum Output Clock Toggle Rate Derating Factors (Part 3 of 4)**

| I/O Standard                    | Drive Strength | Maximum Output Clock Toggle Rate Derating Factors (ps/pF) |                |                |                |                |                |                         |                |                |
|---------------------------------|----------------|-----------------------------------------------------------|----------------|----------------|----------------|----------------|----------------|-------------------------|----------------|----------------|
|                                 |                | Column I/O Pins                                           |                |                | Row I/O Pins   |                |                | Dedicated Clock Outputs |                |                |
|                                 |                | –6 Speed Grade                                            | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade          | –7 Speed Grade | –8 Speed Grade |
| DIFFERENTIAL_SSTL_18_CLASS_II   | 16 mA          | 30                                                        | 33             | 36             | —              | —              | —              | —                       | —              | —              |
|                                 | 18 mA          | 29                                                        | 29             | 29             | —              | —              | —              | —                       | —              | —              |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_I  | 8 mA           | 26                                                        | 28             | 29             | 59             | 61             | 63             | 59                      | 61             | 63             |
|                                 | 10 mA          | 46                                                        | 47             | 48             | 65             | 66             | 68             | 65                      | 66             | 68             |
|                                 | 12 mA          | 67                                                        | 67             | 67             | 71             | 71             | 72             | 71                      | 71             | 72             |
| 1.8V_DIFFERENTIAL_HSTL_CLASS_II | 16 mA          | 62                                                        | 65             | 68             | —              | —              | —              | —                       | —              | —              |
|                                 | 18 mA          | 59                                                        | 62             | 65             | —              | —              | —              | —                       | —              | —              |
|                                 | 20 mA          | 57                                                        | 59             | 62             | —              | —              | —              | —                       | —              | —              |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_I  | 8 mA           | 40                                                        | 40             | 41             | 28             | 32             | 36             | 28                      | 32             | 36             |
|                                 | 10 mA          | 41                                                        | 42             | 42             | —              | —              | —              | —                       | —              | —              |
|                                 | 12 mA          | 43                                                        | 43             | 43             | —              | —              | —              | —                       | —              | —              |
| 1.5V_DIFFERENTIAL_HSTL_CLASS_II | 16 mA          | 18                                                        | 20             | 21             | —              | —              | —              | —                       | —              | —              |
| LVDS                            | —              | 11                                                        | 13             | 16             | 11             | 13             | 15             | 11                      | 13             | 15             |
| RSDS                            | —              | 11                                                        | 13             | 16             | 11             | 13             | 15             | 11                      | 13             | 15             |
| MINI_LVDS                       | —              | 11                                                        | 13             | 16             | 11             | 13             | 15             | 11                      | 13             | 15             |
| SIMPLE_RSDS                     | —              | 15                                                        | 19             | 23             | 15             | 19             | 23             | 15                      | 19             | 23             |
| 1.2V_HSTL                       | —              | 130                                                       | 132            | 133            | —              | —              | —              | —                       | —              | —              |
| 1.2V_DIFFERENTIAL_HSTL          | —              | 130                                                       | 132            | 133            | —              | —              | —              | —                       | —              | —              |
| PCI                             | —              | —                                                         | —              | —              | 99             | 120            | 142            | 99                      | 120            | 142            |
| PCI-X                           | —              | —                                                         | —              | —              | 99             | 121            | 143            | 99                      | 121            | 143            |
| LVTTL                           | OCT_25_OHMS    | 13                                                        | 14             | 14             | 21             | 27             | 33             | 21                      | 27             | 33             |
| LVC MOS                         | OCT_25_OHMS    | 13                                                        | 14             | 14             | 21             | 27             | 33             | 21                      | 27             | 33             |
| 2.5V                            | OCT_50_OHMS    | 346                                                       | 369            | 392            | 324            | 326            | 327            | 324                     | 326            | 327            |
| 1.8V                            | OCT_50_OHMS    | 198                                                       | 203            | 209            | 202            | 203            | 204            | 202                     | 203            | 204            |



**Table 5–46. Maximum Output Clock Toggle Rate Derating Factors (Part 4 of 4)**

| I/O Standard    | Drive Strength | Maximum Output Clock Toggle Rate Derating Factors (ps/pF) |                |                |                |                |                |                         |                |                |
|-----------------|----------------|-----------------------------------------------------------|----------------|----------------|----------------|----------------|----------------|-------------------------|----------------|----------------|
|                 |                | Column I/O Pins                                           |                |                | Row I/O Pins   |                |                | Dedicated Clock Outputs |                |                |
|                 |                | –6 Speed Grade                                            | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade | –7 Speed Grade | –8 Speed Grade | –6 Speed Grade          | –7 Speed Grade | –8 Speed Grade |
| SSTL_2_CLASS_I  | OCT_50 _OHMS   | 67                                                        | 69             | 70             | 25             | 42             | 60             | 25                      | 42             | 60             |
| SSTL_18_CLASS_I | OCT_50 _OHMS   | 30                                                        | 33             | 36             | 47             | 49             | 51             | 47                      | 49             | 51             |

## High Speed I/O Timing Specifications

The timing analysis for LVDS, mini-LVDS, and RSDS is different compared to other I/O standards because the data communication is source-synchronous.

You should also consider board skew, cable skew, and clock jitter in your calculation. This section provides details on the timing parameters for high-speed I/O standards in Cyclone II devices.

Table 5–47 defines the parameters of the timing diagram shown in Figure 5–3.

**Table 5–47. High-Speed I/O Timing Definitions (Part 1 of 2)**

| Parameter                | Symbol              | Description                                                                                                                                                                                                                               |
|--------------------------|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| High-speed clock         | $f_{\text{HSCKLK}}$ | High-speed receiver and transmitter input and output clock frequency.                                                                                                                                                                     |
| Duty cycle               | $t_{\text{DUTY}}$   | Duty cycle on high-speed transmitter output clock.                                                                                                                                                                                        |
| High-speed I/O data rate | HSIODR              | High-speed receiver and transmitter input and output data rate.                                                                                                                                                                           |
| Time unit interval       | TUI                 | $\text{TUI} = 1/\text{HSIODR}$ .                                                                                                                                                                                                          |
| Channel-to-channel skew  | TCCS                | The timing difference between the fastest and slowest output edges, including $t_{\text{CO}}$ variation and clock skew. The clock is included in the TCCS measurement.<br>$\text{TCCS} = \text{TUI} - \text{SW} - (2 \times \text{RSKM})$ |

**Table 5–47. High-Speed I/O Timing Definitions (Part 2 of 2)**

| Parameter                    | Symbol     | Description                                                                                                                                                                                                                                                                                  |
|------------------------------|------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Sampling window              | SW         | The period of time during which the data must be valid in order for you to capture it correctly. Sampling window is the sum of the setup time, hold time, and jitter. The window of $t_{SU} + t_H$ is expected to be centered in the sampling window.<br>$SW = TUI - TCCS - (2 \times RSKM)$ |
| Receiver input skew margin   | RSKM       | RSKM is defined by the total margin left after accounting for the sampling window and TCCS.<br>$RSKM = (TUI - SW - TCCS) / 2$                                                                                                                                                                |
| Input jitter (peak to peak)  | —          | Peak-to-peak input jitter on high-speed PLLs.                                                                                                                                                                                                                                                |
| Output jitter (peak to peak) | —          | Peak-to-peak output jitter on high-speed PLLs.                                                                                                                                                                                                                                               |
| Signal rise time             | $t_{RISE}$ | Low-to-high transmission time.                                                                                                                                                                                                                                                               |
| Signal fall time             | $t_{FALL}$ | High-to-low transmission time.                                                                                                                                                                                                                                                               |
| Lock time                    | $t_{LOCK}$ | Lock time for high-speed transmitter and receiver PLLs.                                                                                                                                                                                                                                      |

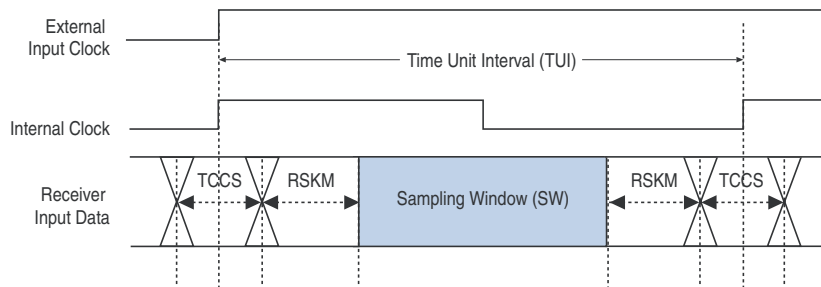
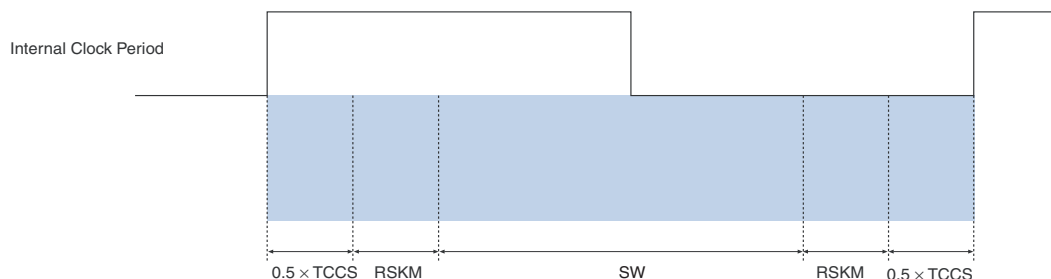
**Figure 5–3. High-Speed I/O Timing Diagram**

Figure 5–4 shows the high-speed I/O timing budget.

**Figure 5–4. High-Speed I/O Timing Budget** *Note (1)***Note to Figure 5–4:**

- (1) The equation for the high-speed I/O timing budget is:  
 $\text{period} = TCCS + RSKM + SW + RSKM$ .

Table 5–48 shows the RSDS timing budget for Cyclone II devices at 311 Mbps. RSDS is supported for transmitting from Cyclone II devices. Cyclone II devices cannot receive RSDS data because the devices are intended for applications where they will be driving display drivers. Cyclone II devices support a maximum RSDS data rate of 311 Mbps using DDIO registers. Cyclone II devices support RSDS only in the commercial temperature range.

**Table 5–48. RSDS Transmitter Timing Specification (Part 1 of 2)**

| Symbol                                | Conditions | –6 Speed Grade |     |        | –7 Speed Grade |     |        | –8 Speed Grade |     |        | Unit |
|---------------------------------------|------------|----------------|-----|--------|----------------|-----|--------|----------------|-----|--------|------|
|                                       |            | Min            | Typ | Max(1) | Min            | Typ | Max(1) | Min            | Typ | Max(1) |      |
| $f_{HCLK}$<br>(input clock frequency) | ×10        | 10             | —   | 155.5  | 10             | —   | 155.5  | 10             | —   | 155.5  | MHz  |
|                                       | ×8         | 10             | —   | 155.5  | 10             | —   | 155.5  | 10             | —   | 155.5  | MHz  |
|                                       | ×7         | 10             | —   | 155.5  | 10             | —   | 155.5  | 10             | —   | 155.5  | MHz  |
|                                       | ×4         | 10             | —   | 155.5  | 10             | —   | 155.5  | 10             | —   | 155.5  | MHz  |
|                                       | ×2         | 10             | —   | 155.5  | 10             | —   | 155.5  | 10             | —   | 155.5  | MHz  |
|                                       | ×1         | 10             | —   | 311    | 10             | —   | 311    | 10             | —   | 311    | MHz  |
| Device operation in Mbps              | ×10        | 100            | —   | 311    | 100            | —   | 311    | 100            | —   | 311    | Mbps |
|                                       | ×8         | 80             | —   | 311    | 80             | —   | 311    | 80             | —   | 311    | Mbps |
|                                       | ×7         | 70             | —   | 311    | 70             | —   | 311    | 70             | —   | 311    | Mbps |
|                                       | ×4         | 40             | —   | 311    | 40             | —   | 311    | 40             | —   | 311    | Mbps |
|                                       | ×2         | 20             | —   | 311    | 20             | —   | 311    | 20             | —   | 311    | Mbps |
|                                       | ×1         | 10             | —   | 311    | 10             | —   | 311    | 10             | —   | 311    | Mbps |
| $t_{DUTY}$                            | —          | 45             | —   | 55     | 45             | —   | 55     | 45             | —   | 55     | %    |

**Table 5–48. RSDS Transmitter Timing Specification (Part 2 of 2)**

| Symbol                       | Conditions                          | –6 Speed Grade |     |        | –7 Speed Grade |     |        | –8 Speed Grade |     |        | Unit |
|------------------------------|-------------------------------------|----------------|-----|--------|----------------|-----|--------|----------------|-----|--------|------|
|                              |                                     | Min            | Typ | Max(1) | Min            | Typ | Max(1) | Min            | Typ | Max(1) |      |
| TCCS                         | —                                   | —              | —   | 200    | —              | —   | 200    | —              | —   | 200    | ps   |
| Output jitter (peak to peak) | —                                   | —              | —   | 500    | —              | —   | 500    | —              | —   | 500    | ps   |
| t <sub>RISE</sub>            | 20–80%,<br>C <sub>LOAD</sub> = 5 pF | —              | 500 | —      | —              | 500 | —      | —              | 500 | —      | ps   |
| t <sub>FALL</sub>            | 80–20%,<br>C <sub>LOAD</sub> = 5 pF | —              | 500 | —      | —              | 500 | —      | —              | 500 | —      | ps   |
| t <sub>LOCK</sub>            | —                                   | —              | —   | 100    | —              | —   | 100    | —              | —   | 100    | μs   |

**Note to Table 5–48:**

- (1) These specifications are for a three-resistor RSDS implementation. For single-resistor RSDS in ×10 through ×2 modes, the maximum data rate is 170 Mbps and the corresponding maximum input clock frequency is 85 MHz. For single-resistor RSDS in ×1 mode, the maximum data rate is 170 Mbps, and the maximum input clock frequency is 170 MHz. For more information about the different RSDS implementations, refer to the *High-Speed Differential Interfaces in Cyclone II Devices* chapter of the Cyclone II Device Handbook.

In order to determine the transmitter timing requirements, RSDS receiver timing requirements on the other end of the link must be taken into consideration. RSDS receiver timing parameters are typically defined as t<sub>SU</sub> and t<sub>H</sub> requirements. Therefore, the transmitter timing parameter specifications are t<sub>CO</sub> (minimum) and t<sub>CO</sub> (maximum). Refer to [Figure 5–4](#) for the timing budget.

The AC timing requirements for RSDS are shown in [Figure 5–5](#).

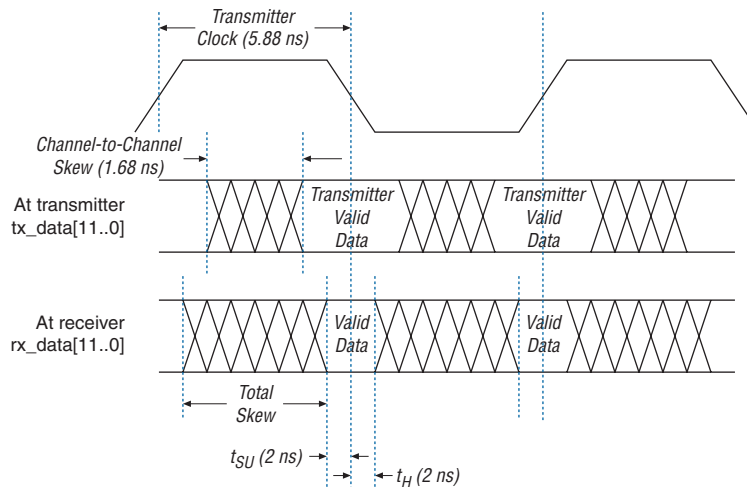
**Figure 5–5. RSDS Transmitter Clock to Data Relationship**

Table 5–49 shows the mini-LVDS transmitter timing budget for Cyclone II devices at 311 Mbps. Cyclone II devices cannot receive mini-LVDS data because the devices are intended for applications where they will be driving display drivers. A maximum mini-LVDS data rate of 311 Mbps is supported for Cyclone II devices using DDIO registers. Cyclone II devices support mini-LVDS only in the commercial temperature range.

**Table 5–49. Mini-LVDS Transmitter Timing Specification (Part 1 of 2)**

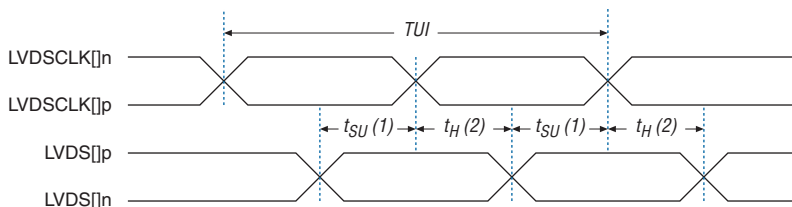
| Symbol                                 | Conditions | –6 Speed Grade |     |       | –7 Speed Grade |     |       | –8 Speed Grade |     |       | Unit |
|----------------------------------------|------------|----------------|-----|-------|----------------|-----|-------|----------------|-----|-------|------|
|                                        |            | Min            | Typ | Max   | Min            | Typ | Max   | Min            | Typ | Max   |      |
| $f_{HSCLK}$<br>(input clock frequency) | ×10        | 10             | —   | 155.5 | 10             | —   | 155.5 | 10             | —   | 155.5 | MHz  |
|                                        | ×8         | 10             | —   | 155.5 | 10             | —   | 155.5 | 10             | —   | 155.5 | MHz  |
|                                        | ×7         | 10             | —   | 155.5 | 10             | —   | 155.5 | 10             | —   | 155.5 | MHz  |
|                                        | ×4         | 10             | —   | 155.5 | 10             | —   | 155.5 | 10             | —   | 155.5 | MHz  |
|                                        | ×2         | 10             | —   | 155.5 | 10             | —   | 155.5 | 10             | —   | 155.5 | MHz  |
|                                        | ×1         | 10             | —   | 311   | 10             | —   | 311   | 10             | —   | 311   | MHz  |

**Table 5–49. Mini-LVDS Transmitter Timing Specification (Part 2 of 2)**

| Symbol                       | Conditions | –6 Speed Grade |     |     | –7 Speed Grade |     |     | –8 Speed Grade |     |     | Unit |
|------------------------------|------------|----------------|-----|-----|----------------|-----|-----|----------------|-----|-----|------|
|                              |            | Min            | Typ | Max | Min            | Typ | Max | Min            | Typ | Max |      |
| Device operation in Mbps     | ×10        | 100            | —   | 311 | 100            | —   | 311 | 100            | —   | 311 | Mbps |
|                              | ×8         | 80             | —   | 311 | 80             | —   | 311 | 80             | —   | 311 | Mbps |
|                              | ×7         | 70             | —   | 311 | 70             | —   | 311 | 70             | —   | 311 | Mbps |
|                              | ×4         | 40             | —   | 311 | 40             | —   | 311 | 40             | —   | 311 | Mbps |
|                              | ×2         | 20             | —   | 311 | 20             | —   | 311 | 20             | —   | 311 | Mbps |
|                              | ×1         | 10             | —   | 311 | 10             | —   | 311 | 10             | —   | 311 | Mbps |
| $t_{\text{DUTY}}$            | —          | 45             | —   | 55  | 45             | —   | 55  | 45             | —   | 55  | %    |
| TCCS                         | —          | —              | —   | 200 | —              | —   | 200 | —              | —   | 200 | ps   |
| Output jitter (peak to peak) | —          | —              | —   | 500 | —              | —   | 500 | —              | —   | 500 | ps   |
| $t_{\text{RISE}}$            | 20–80%     | —              | —   | 500 | —              | —   | 500 | —              | —   | 500 | ps   |
| $t_{\text{FALL}}$            | 80–20%     | —              | —   | 500 | —              | —   | 500 | —              | —   | 500 | ps   |
| $t_{\text{LOCK}}$            | —          | —              | —   | 100 | —              | —   | 100 | —              | —   | 100 | μs   |

In order to determine the transmitter timing requirements, mini-LVDS receiver timing requirements on the other end of the link must be taken into consideration. The mini-LVDS receiver timing parameters are typically defined as  $t_{\text{SU}}$  and  $t_{\text{H}}$  requirements. Therefore, the transmitter timing parameter specifications are  $t_{\text{CO}}$  (minimum) and  $t_{\text{CO}}$  (maximum). Refer to [Figure 5–4](#) for the timing budget.

The AC timing requirements for mini-LVDS are shown in [Figure 5–6](#).

**Figure 5–6. mini-LVDS Transmitter AC Timing Specification**

**Notes to [Figure 5–6](#):**

- (1) The data setup time,  $t_{\text{SU}}$ , is  $0.225 \times \text{TUI}$ .
- (2) The data hold time,  $t_{\text{H}}$ , is  $0.225 \times \text{TUI}$ .

Tables 5–50 and 5–51 show the LVDS timing budget for Cyclone II devices. Cyclone II devices support LVDS receivers at data rates up to 805 Mbps, and LVDS transmitters at data rates up to 640 Mbps.

**Table 5–50. LVDS Transmitter Timing Specification (Part 1 of 2)**

| Symbol                                       | Conditions | –6 Speed Grade |     |            |            | –7 Speed Grade |     |            |            | –8 Speed Grade |     |              |              | Unit |
|----------------------------------------------|------------|----------------|-----|------------|------------|----------------|-----|------------|------------|----------------|-----|--------------|--------------|------|
|                                              |            | Min            | Typ | Max<br>(1) | Max<br>(2) | Min            | Typ | Max<br>(1) | Max<br>(2) | Min            | Typ | Max<br>(1)   | Max<br>(2)   |      |
| $f_{\text{HCLK}}$<br>(input clock frequency) | ×10        | 10             | —   | 320        | 320        | 10             | —   | 275        | 320        | 10             | —   | 155.5<br>(4) | 320<br>(6)   | MHz  |
|                                              | ×8         | 10             | —   | 320        | 320        | 10             | —   | 275        | 320        | 10             | —   | 155.5<br>(4) | 320<br>(6)   | MHz  |
|                                              | ×7         | 10             | —   | 320        | 320        | 10             | —   | 275        | 320        | 10             | —   | 155.5<br>(4) | 320<br>(6)   | MHz  |
|                                              | ×4         | 10             | —   | 320        | 320        | 10             | —   | 275        | 320        | 10             | —   | 155.5<br>(4) | 320<br>(6)   | MHz  |
|                                              | ×2         | 10             | —   | 320        | 320        | 10             | —   | 275        | 320        | 10             | —   | 155.5<br>(4) | 320<br>(6)   | MHz  |
|                                              | ×1         | 10             | —   | 402.5      | 402.5      | 10             | —   | 402.5      | 402.5      | 10             | —   | 402.5<br>(8) | 402.5<br>(8) | MHz  |
| HSIODR                                       | ×10        | 100            | —   | 640        | 640        | 100            | —   | 550        | 640        | 100            | —   | 311<br>(5)   | 550<br>(7)   | Mbps |
|                                              | ×8         | 80             | —   | 640        | 640        | 80             | —   | 550        | 640        | 80             | —   | 311<br>(5)   | 550<br>(7)   | Mbps |
|                                              | ×7         | 70             | —   | 640        | 640        | 70             | —   | 550        | 640        | 70             | —   | 311<br>(5)   | 550<br>(7)   | Mbps |
|                                              | ×4         | 40             | —   | 640        | 640        | 40             | —   | 550        | 640        | 40             | —   | 311<br>(5)   | 550<br>(7)   | Mbps |
|                                              | ×2         | 20             | —   | 640        | 640        | 20             | —   | 550        | 640        | 20             | —   | 311<br>(5)   | 550<br>(7)   | Mbps |
|                                              | ×1         | 10             | —   | 402.5      | 402.5      | 10             | —   | 402.5      | 402.5      | 10             | —   | 402.5<br>(9) | 402.5<br>(9) | Mbps |
| $t_{\text{DUTY}}$                            | —          | 45             | —   | 55         | —          | 45             | —   | 55         | —          | 45             | —   | 55           | —            | %    |
|                                              | —          | —              | —   | —          | 160        | —              | —   | —          | 312.5      | —              | —   | —            | 363.6        | ps   |
| TCCS<br>(3)                                  | —          | —              | —   | 200        |            | —              | —   | 200        |            | —              | —   | 200          |              | ps   |
| Output jitter<br>(peak to peak)              | —          | —              | —   | 500        |            | —              | —   | 500        |            | —              | —   | 550 (10)     |              | ps   |
| $t_{\text{RISE}}$                            | 20–80%     | 150            | 200 | 250        |            | 150            | 200 | 250        |            | 150            | 200 | 250 (11)     |              | ps   |

**Table 5–50. LVDS Transmitter Timing Specification (Part 2 of 2)**

| Symbol     | Conditions | –6 Speed Grade |     |            |            | –7 Speed Grade |     |            |            | –8 Speed Grade |     |            |            | Unit |
|------------|------------|----------------|-----|------------|------------|----------------|-----|------------|------------|----------------|-----|------------|------------|------|
|            |            | Min            | Typ | Max<br>(1) | Max<br>(2) | Min            | Typ | Max<br>(1) | Max<br>(2) | Min            | Typ | Max<br>(1) | Max<br>(2) |      |
| $t_{FALL}$ | 80–20%     | 150            | 200 | 250        |            | 150            | 200 | 250        |            | 150            | 200 | 250 (11)   |            | ps   |
| $t_{LOCK}$ | —          | —              | —   | 100        |            | —              | —   | 100        |            | —              | —   | 100 (12)   |            | μs   |

**Notes to Table 5–50:**

- (1) The maximum data rate that complies with duty cycle distortion of 45–55%.
- (2) The maximum data rate when taking duty cycle in absolute ps into consideration that may not comply with 45–55% duty cycle distortion. If the downstream receiver can handle duty cycle distortion beyond the 45–55% range, you may use the higher data rate values from this column. You can calculate the duty cycle distortion as a percentage using the absolute ps value. For example, for a data rate of 640 Mbps (UI = 1562.5 ps) and a  $t_{DUTY}$  of 250 ps, the duty cycle distortion is  $\pm t_{DUTY} / (UI * 2) * 100\% = \pm 250 \text{ ps} / (1562.5 * 2) * 100\% = \pm 8\%$ , which gives you a duty cycle distortion of 42–58%.
- (3) The TCCS specification applies to the entire bank of LVDS, as long as the SERDES logic is placed within the LAB adjacent to the output pins.
- (4) For extended temperature devices, the maximum input clock frequency for ×10 through ×2 modes is 137.5 MHz.
- (5) For extended temperature devices, the maximum data rate for ×10 through ×2 modes is 275 Mbps.
- (6) For extended temperature devices, the maximum input clock frequency for ×10 through ×2 modes is 200 MHz.
- (7) For extended temperature devices, the maximum data rate for ×10 through ×2 modes is 400 Mbps.
- (8) For extended temperature devices, the maximum input clock frequency for ×1 mode is 340 MHz.
- (9) For extended temperature devices, the maximum data rate for ×1 mode is 340 Mbps.
- (10) For extended temperature devices, the maximum output jitter (peak to peak) is 600 ps.
- (11) For extended temperature devices, the maximum  $t_{RISE}$  and  $t_{FALL}$  are 300 ps.
- (12) For extended temperature devices, the maximum lock time is 500 us.



**Table 5–51. LVDS Receiver Timing Specification**

| Symbol                                       | Conditions | –6 Speed Grade |     |       | –7 Speed Grade |     |       | –8 Speed Grade |     |           | Unit |
|----------------------------------------------|------------|----------------|-----|-------|----------------|-----|-------|----------------|-----|-----------|------|
|                                              |            | Min            | Typ | Max   | Min            | Typ | Max   | Min            | Typ | Max       |      |
| $f_{\text{HCLK}}$<br>(input clock frequency) | ×10        | 10             | —   | 402.5 | 10             | —   | 320   | 10             | —   | 320 (1)   | MHz  |
|                                              | ×8         | 10             | —   | 402.5 | 10             | —   | 320   | 10             | —   | 320 (1)   | MHz  |
|                                              | ×7         | 10             | —   | 402.5 | 10             | —   | 320   | 10             | —   | 320 (1)   | MHz  |
|                                              | ×4         | 10             | —   | 402.5 | 10             | —   | 320   | 10             | —   | 320 (1)   | MHz  |
|                                              | ×2         | 10             | —   | 402.5 | 10             | —   | 320   | 10             | —   | 320 (1)   | MHz  |
|                                              | ×1         | 10             | —   | 402.5 | 10             | —   | 402.5 | 10             | —   | 402.5 (3) | MHz  |
| HSIODR                                       | ×10        | 100            | —   | 805   | 100            | —   | 640   | 100            | —   | 640 (2)   | Mbps |
|                                              | ×8         | 80             | —   | 805   | 80             | —   | 640   | 80             | —   | 640 (2)   | Mbps |
|                                              | ×7         | 70             | —   | 805   | 70             | —   | 640   | 70             | —   | 640 (2)   | Mbps |
|                                              | ×4         | 40             | —   | 805   | 40             | —   | 640   | 40             | —   | 640 (2)   | Mbps |
|                                              | ×2         | 20             | —   | 805   | 20             | —   | 640   | 20             | —   | 640 (2)   | Mbps |
|                                              | ×1         | 10             | —   | 402.5 | 10             | —   | 402.5 | 10             | —   | 402.5 (4) | Mbps |
| SW                                           | —          | —              | —   | 300   | —              | —   | 400   | —              | —   | 400       | ps   |
| Input jitter tolerance                       | —          | —              | —   | 500   | —              | —   | 500   | —              | —   | 550       | ps   |
| $t_{\text{LOCK}}$                            | —          | —              | —   | 100   | —              | —   | 100   | —              | —   | 100 (5)   | ps   |

**Notes to Table 5–51:**

- (1) For extended temperature devices, the maximum input clock frequency for ×10 through ×2 modes is 275 MHz.
- (2) For extended temperature devices, the maximum data rate for ×10 through ×2 modes is 550 Mbps.
- (3) For extended temperature devices, the maximum input clock frequency for ×1 mode is 340 MHz.
- (4) For extended temperature devices, the maximum data rate for ×1 mode is 340 Mbps.
- (5) For extended temperature devices, the maximum lock time is 500 us.

## External Memory Interface Specifications

Table 5–52 shows the DQS bus clock skew adder specifications.

**Table 5–52. DQS Bus Clock Skew Adder Specifications**

| Mode | DQS Clock Skew Adder | Unit |
|------|----------------------|------|
| ×9   | 155                  | ps   |
| ×18  | 190                  | ps   |

**Note to Table 5–52:**

- (1) This skew specification is the absolute maximum and minimum skew. For example, skew on a ×9 DQ group is 155 ps or ±77.5 ps.

## JTAG Timing Specifications

Figure 5–7 shows the timing requirements for the JTAG signals.

**Figure 5–7. Cyclone II JTAG Waveform**

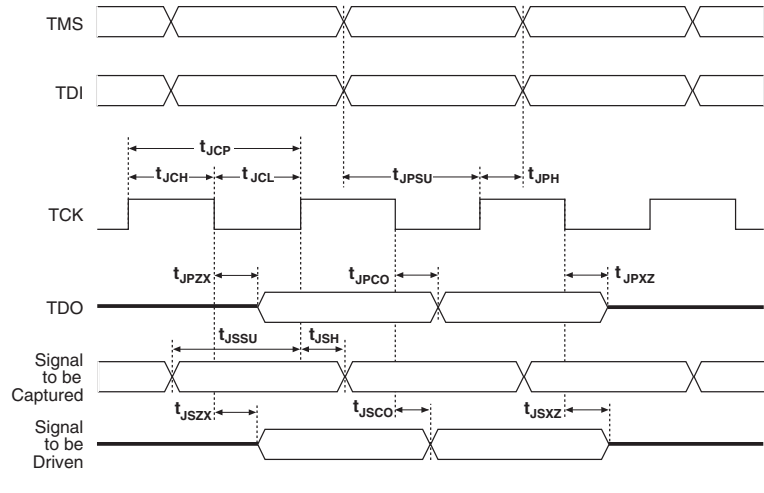


Table 5–53 shows the JTAG timing parameters and values for Cyclone II devices.

**Table 5–53. Cyclone II JTAG Timing Parameters and Values**

| Symbol     | Parameter                                      | Min | Max | Unit |
|------------|------------------------------------------------|-----|-----|------|
| $t_{JCP}$  | TCK clock period                               | 40  | —   | ns   |
| $t_{JCH}$  | TCK clock high time                            | 20  | —   | ns   |
| $t_{JCL}$  | TCK clock low time                             | 20  | —   | ns   |
| $t_{JPSU}$ | JTAG port setup time (2)                       | 5   | —   | ns   |
| $t_{JPH}$  | JTAG port hold time                            | 10  | —   | ns   |
| $t_{JPCO}$ | JTAG port clock to output (2)                  | —   | 13  | ns   |
| $t_{JPZX}$ | JTAG port high impedance to valid output (2)   | —   | 13  | ns   |
| $t_{JPXZ}$ | JTAG port valid output to high impedance (2)   | —   | 13  | ns   |
| $t_{JSSU}$ | Capture register setup time (2)                | 5   | —   | ns   |
| $t_{JSH}$  | Capture register hold time                     | 10  | —   | ns   |
| $t_{JSCO}$ | Update register clock to output                | —   | 25  | ns   |
| $t_{JSZX}$ | Update register high impedance to valid output | —   | 25  | ns   |
| $t_{JSXZ}$ | Update register valid output to high impedance | —   | 25  | ns   |

**Notes to Table 5–53:**

- (1) This information is preliminary.
- (2) This specification is shown for 3.3-V LVTTTL/LVCMOS and 2.5-V LVTTTL/LVCMOS operation of the JTAG pins. For 1.8-V LVTTTL/LVCMOS and 1.5-V LVCMOS, the JTAG port and capture register clock setup time is 3 ns and port clock to output time is 15 ns.



Cyclone II devices must be within the first 17 devices in a JTAG chain. All of these devices have the same JTAG controller. If any of the Cyclone II devices are in the 18th position or after they will fail configuration. This does not affect the SignalTap® II logic analyzer.



For more information on JTAG, refer to the [IEEE 1149.1 \(JTAG\) Boundary-Scan Testing for Cyclone II Devices](#) chapter in the *Cyclone II Handbook*.

## PLL Timing Specifications

Table 5–54 describes the Cyclone II PLL specifications when operating in the commercial junction temperature range (0° to 85° C), the industrial junction temperature range (–40° to 100° C), the automotive junction temperature range (–40° to 125° C), and the extended temperature range (–40° to 125° C). Follow the PLL specifications for –8 speed grade devices when operating in the industrial, automotive, or extended temperature range.

**Table 5–54. PLL Specifications** *Note (1) (Part 1 of 2)*

| Symbol                                 | Parameter                                                           | Min | Typ | Max     | Unit |
|----------------------------------------|---------------------------------------------------------------------|-----|-----|---------|------|
| $f_{IN}$                               | Input clock frequency (–6 speed grade)                              | 10  | —   | (4)     | MHz  |
|                                        | Input clock frequency (–7 speed grade)                              | 10  | —   | (4)     | MHz  |
|                                        | Input clock frequency (–8 speed grade)                              | 10  | —   | (4)     | MHz  |
| $f_{INPFD}$                            | PFD input frequency (–6 speed grade)                                | 10  | —   | 402.5   | MHz  |
|                                        | PFD input frequency (–7 speed grade)                                | 10  | —   | 402.5   | MHz  |
|                                        | PFD input frequency (–8 speed grade)                                | 10  | —   | 402.5   | MHz  |
| $f_{INDUTY}$                           | Input clock duty cycle                                              | 40  | —   | 60      | %    |
| $t_{INJITTER}$ (5)                     | Input clock period jitter                                           | —   | 200 | —       | ps   |
| $f_{OUT\_EXT}$ (external clock output) | PLL output frequency (–6 speed grade)                               | 10  | —   | (4)     | MHz  |
|                                        | PLL output frequency (–7 speed grade)                               | 10  | —   | (4)     | MHz  |
|                                        | PLL output frequency (–8 speed grade)                               | 10  | —   | (4)     | MHz  |
| $f_{OUT}$ (to global clock)            | PLL output frequency (–6 speed grade)                               | 10  | —   | 500     | MHz  |
|                                        | PLL output frequency (–7 speed grade)                               | 10  | —   | 450     | MHz  |
|                                        | PLL output frequency (–8 speed grade)                               | 10  | —   | 402.5   | MHz  |
| $t_{OUTDUTY}$                          | Duty cycle for external clock output (when set to 50%)              | 45  | —   | 55      | %    |
| $t_{JITTER}$ (p-p) (2)                 | Period jitter for external clock output<br>$f_{OUT\_EXT} > 100$ MHz | —   | —   | 300     | ps   |
|                                        | $f_{OUT\_EXT} \leq 100$ MHz                                         | —   | —   | 30      | mUI  |
| $t_{LOCK}$                             | Time required to lock from end of device configuration              | —   | —   | 100 (6) | μs   |
| $t_{PLL\_PSERR}$                       | Accuracy of PLL phase shift                                         | —   | —   | ±60     | ps   |

**Table 5–54. PLL Specifications** *Note (1) (Part 2 of 2)*

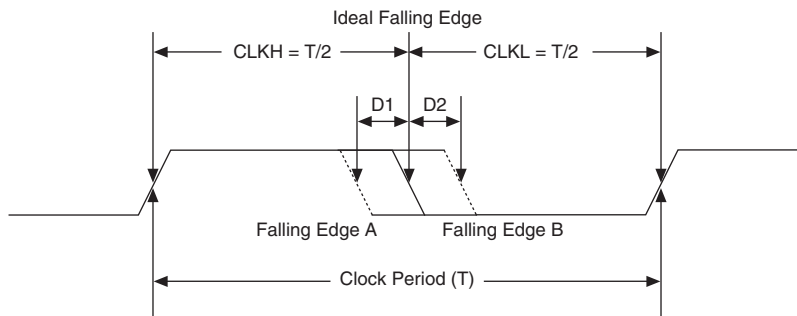
| Symbol        | Parameter                                          | Min | Typ | Max   | Unit |
|---------------|----------------------------------------------------|-----|-----|-------|------|
| $f_{VCO}$ (3) | PLL internal VCO operating range                   | 300 | —   | 1,000 | MHz  |
| $t_{ARESET}$  | Minimum pulse width on <code>areset</code> signal. | 10  | —   | —     | ns   |

**Notes to Table 5–54:**

- (1) These numbers are preliminary and pending silicon characterization.
- (2) The  $t_{JITTER}$  specification for the `PLL[4..11]_OUT` pins are dependent on the I/O pins in its `VCCIO` bank, how many of them are switching outputs, how much they toggle, and whether or not they use programmable current strength.
- (3) If the VCO post-scale counter = 2, a 300- to 500-MHz internal VCO frequency is available.
- (4) This parameter is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.
- (5) Cyclone II PLLs can track a spread-spectrum input clock that has an input jitter within  $\pm 200$  ps.
- (6) For extended temperature devices, the maximum lock time is 500  $\mu$ s.

## Duty Cycle Distortion

Duty cycle distortion (DCD) describes how much the falling edge of a clock is off from its ideal position. The ideal position is when both the clock high time (CLKH) and the clock low time (CLKL) equal half of the clock period (T), as shown in Figure 5–8. DCD is the deviation of the non-ideal falling edge from the ideal falling edge, such as D1 for the falling edge A and D2 for the falling edge B (Figure 5–8). The maximum DCD for a clock is the larger value of D1 and D2.

**Figure 5–8. Duty Cycle Distortion**

DCD expressed in absolute derivation, for example, D1 or D2 in Figure 5–8, is clock-period independent. DCD can also be expressed as a percentage, and the percentage number is clock-period dependent. DCD as a percentage is defined as:

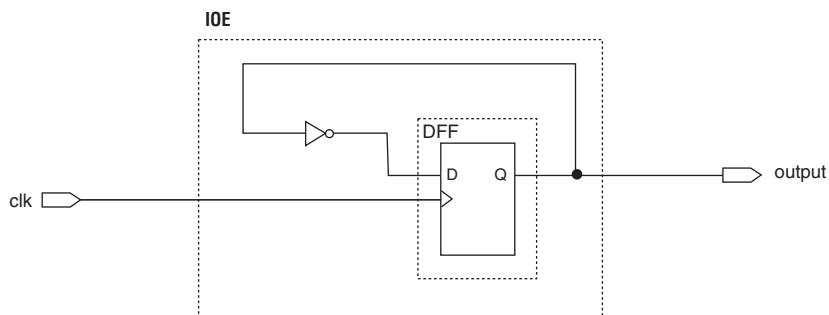
$$(T/2 - D1) / T \text{ (the low percentage boundary)}$$
$$(T/2 + D2) / T \text{ (the high percentage boundary)}$$

### DCD Measurement Techniques

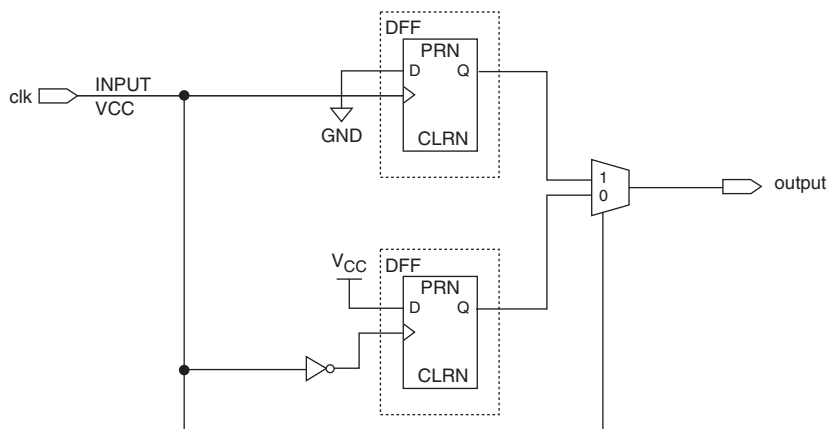
DCD is measured at an FPGA output pin driven by registers inside the corresponding I/O element (IOE) block. When the output is a single data rate signal (non-DDIO), only one edge of the register input clock (positive or negative) triggers output transitions (Figure 5–9). Therefore, any DCD present on the input clock signal, or caused by the clock input buffer, or different input I/O standard, does not transfer to the output signal.

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**Figure 5–9. DCD Measurement Technique for Non-DDIO (Single-Data Rate) Outputs**



However, when the output is a double data rate input/output (DDIO) signal, both edges of the input clock signal (positive and negative) trigger output transitions (Figure 5–10). Therefore, any distortion on the input clock and the input clock buffer affect the output DCD.

**Figure 5–10. DCD Measurement Technique for DDIO (Double-Data Rate) Outputs**

When an FPGA PLL generates the internal clock, the PLL output clocks the IOE block. As the PLL only monitors the positive edge of the reference clock input and internally re-creates the output clock signal, any DCD present on the reference clock is filtered out. Therefore, the DCD for a DDIO output with PLL in the clock path is better than the DCD for a DDIO output without PLL in the clock path.

Tables 5–55 through 5–58 give the maximum DCD in absolute derivation for different I/O standards on Cyclone II devices. Examples are also provided that show how to calculate DCD as a percentage.

**Table 5–55. Maximum DCD for Single Data Outputs (SDR) on Row I/O Pins** Notes (1), (2) (Part 1 of 2)

| Row I/O Output Standard | C6  | C7  | C8  | Unit |
|-------------------------|-----|-----|-----|------|
| LVC MOS                 | 165 | 230 | 230 | ps   |
| LVTTL                   | 195 | 255 | 255 | ps   |
| 2.5-V                   | 120 | 120 | 135 | ps   |
| 1.8-V                   | 115 | 115 | 175 | ps   |
| 1.5-V                   | 130 | 130 | 135 | ps   |
| SSTL-2 Class I          | 60  | 90  | 90  | ps   |
| SSTL-2 Class II         | 65  | 75  | 75  | ps   |
| SSTL-18 Class I         | 90  | 165 | 165 | ps   |
| HSTL-15 Class I         | 145 | 145 | 205 | ps   |
| HSTL-18 Class I         | 85  | 155 | 155 | ps   |

**Table 5–55. Maximum DCD for Single Data Outputs (SDR) on Row I/O Pins** *Notes (1), (2) (Part 2 of 2)*

| Row I/O Output Standard      | C6  | C7  | C8  | Unit |
|------------------------------|-----|-----|-----|------|
| Differential SSTL-2 Class I  | 60  | 90  | 90  | ps   |
| Differential SSTL-2 Class II | 65  | 75  | 75  | ps   |
| Differential SSTL-18 Class I | 90  | 165 | 165 | ps   |
| Differential HSTL-18 Class I | 85  | 155 | 155 | ps   |
| Differential HSTL-15 Class I | 145 | 145 | 205 | ps   |
| LVDS                         | 60  | 60  | 60  | ps   |
| Simple RSDS                  | 60  | 60  | 60  | ps   |
| Mini LVDS                    | 60  | 60  | 60  | ps   |
| PCI                          | 195 | 255 | 255 | ps   |
| PCI-X                        | 195 | 255 | 255 | ps   |

**Notes to Table 5–55:**

- (1) The DCD specification is characterized using the maximum drive strength available for each I/O standard.
- (2) Numbers are applicable for commercial, industrial, and automotive devices.

Here is an example for calculating the DCD as a percentage for an SDR output on a row I/O on a –6 device:

If the SDR output I/O standard is SSTL-2 Class II, the maximum DCD is 65 ps (refer to Table 5–55). If the clock frequency is 167 MHz, the clock period T is:

$$T = 1 / f = 1 / 167 \text{ MHz} = 6 \text{ ns} = 6000 \text{ ps}$$

To calculate the DCD as a percentage:

$$(T/2 - \text{DCD}) / T = (6000 \text{ ps}/2 - 65 \text{ ps}) / 6000 \text{ ps} = 48.91\% \text{ (for low boundary)}$$

$$(T/2 + \text{DCD}) / T = (6000 \text{ ps}/2 + 65 \text{ ps}) / 6000 \text{ ps} = 51.08\% \text{ (for high boundary)}$$

**Table 5–56. Maximum DCD for SDR Output on Column I/O** *Notes (1), (2) (Part 1 of 2)*

| Column I/O Output Standard | C6  | C7  | C8  | Unit |
|----------------------------|-----|-----|-----|------|
| LVC MOS                    | 195 | 285 | 285 | ps   |
| LVTTL                      | 210 | 305 | 305 | ps   |



**Table 5–56. Maximum DCD for SDR Output on Column I/O** *Notes (1), (2)*  
(Part 2 of 2)

| Column I/O Output Standard    | C6  | C7  | C8  | Unit |
|-------------------------------|-----|-----|-----|------|
| 2.5-V                         | 140 | 140 | 155 | ps   |
| 1.8-V                         | 115 | 115 | 165 | ps   |
| 1.5-V                         | 745 | 745 | 770 | ps   |
| SSTL-2 Class I                | 60  | 60  | 75  | ps   |
| SSTL-2 Class II               | 60  | 60  | 80  | ps   |
| SSTL-18 Class I               | 60  | 130 | 130 | ps   |
| SSTL-18 Class II              | 60  | 135 | 135 | ps   |
| HSTL-18 Class I               | 60  | 115 | 115 | ps   |
| HSTL-18 Class II              | 75  | 75  | 100 | ps   |
| HSTL-15 Class I               | 150 | 150 | 150 | ps   |
| HSTL-15 Class II              | 135 | 135 | 155 | ps   |
| Differential SSTL-2 Class I   | 60  | 60  | 75  | ps   |
| Differential SSTL-2 Class II  | 60  | 60  | 80  | ps   |
| Differential SSTL-18 Class I  | 60  | 130 | 130 | ps   |
| Differential SSTL-18 Class II | 60  | 135 | 135 | ps   |
| Differential HSTL-18 Class I  | 60  | 115 | 115 | ps   |
| Differential HSTL-18 Class II | 75  | 75  | 100 | ps   |
| Differential HSTL-15 Class I  | 150 | 150 | 150 | ps   |
| Differential HSTL-15 Class II | 135 | 135 | 155 | ps   |
| LVDS                          | 60  | 60  | 60  | ps   |
| Simple RSDS                   | 60  | 70  | 70  | ps   |
| Mini-LVDS                     | 60  | 60  | 60  | ps   |

**Notes to Table 5–56:**

- (1) The DCD specification is characterized using the maximum drive strength available for each I/O standard.
- (2) Numbers are applicable for commercial, industrial, and automotive devices.

**Table 5–57. Maximum for DDIO Output on Row Pins with PLL in the Clock Path** *Notes (1), (2)* (Part 1 of 2)

| Row Pins with PLL in the Clock Path | C6  | C7  | C8  | Unit |
|-------------------------------------|-----|-----|-----|------|
| LVC MOS                             | 270 | 310 | 310 | ps   |
| LVTTL                               | 285 | 305 | 335 | ps   |
| 2.5-V                               | 180 | 180 | 220 | ps   |
| 1.8-V                               | 165 | 175 | 205 | ps   |

**Table 5–57. Maximum for DDIO Output on Row Pins with PLL in the Clock Path** *Notes (1), (2) (Part 2 of 2)*

| Row Pins with PLL in the Clock Path | C6  | C7  | C8  | Unit |
|-------------------------------------|-----|-----|-----|------|
| 1.5-V                               | 280 | 280 | 280 | ps   |
| SSTL-2 Class I                      | 150 | 190 | 230 | ps   |
| SSTL-2 Class II                     | 155 | 200 | 230 | ps   |
| SSTL-18 Class I                     | 180 | 240 | 260 | ps   |
| HSTL-18 Class I                     | 180 | 235 | 235 | ps   |
| HSTL-15 Class I                     | 205 | 220 | 220 | ps   |
| Differential SSTL-2 Class I         | 150 | 190 | 230 | ps   |
| Differential SSTL-2 Class II        | 155 | 200 | 230 | ps   |
| Differential SSTL-18 Class I        | 180 | 240 | 260 | ps   |
| Differential HSTL-18 Class I        | 180 | 235 | 235 | ps   |
| Differential HSTL-15 Class I        | 205 | 220 | 220 | ps   |
| LVDS                                | 95  | 110 | 120 | ps   |
| Simple RSDS                         | 100 | 155 | 155 | ps   |
| Mini LVDS                           | 95  | 110 | 120 | ps   |
| PCI                                 | 285 | 305 | 335 | ps   |
| PCI-X                               | 285 | 305 | 335 | ps   |

**Notes to Table 5–57:**

- (1) The DCD specification is characterized using the maximum drive strength available for each I/O standard.
- (2) Numbers are applicable for commercial, industrial, and automotive devices.

For DDIO outputs, you can calculate actual half period from the following equation:

$$\text{Actual half period} = \text{ideal half period} - \text{maximum DCD}$$

For example, if the DDR output I/O standard is SSTL-2 Class II, the maximum DCD for a –5 device is 155 ps (refer to Table 5–57). If the clock frequency is 167 MHz, the half-clock period  $T/2$  is:

$$T/2 = 1/(2 \cdot f) = 1/(2 \cdot 167 \text{ MHz}) = 3 \text{ ns} = 3000 \text{ ps}$$

The actual half period is then = 3000 ps – 155 ps = 2845 ps

**Table 5–58. Maximum DCD for DDIO Output on Column I/O Pins with PLL in the Clock Path** *Notes (1), (2)*

| Column I/O Pins in the Clock Path | C6  | C7  | C8  | Unit |
|-----------------------------------|-----|-----|-----|------|
| LVC MOS                           | 285 | 400 | 445 | ps   |
| LVTTL                             | 305 | 405 | 460 | ps   |
| 2.5-V                             | 175 | 195 | 285 | ps   |
| 1.8-V                             | 190 | 205 | 260 | ps   |
| 1.5-V                             | 605 | 645 | 645 | ps   |
| SSTL-2 Class I                    | 125 | 210 | 245 | ps   |
| SSTL-2 Class II                   | 195 | 195 | 195 | ps   |
| SSTL-18 Class I                   | 130 | 240 | 245 | ps   |
| SSTL-18 Class II                  | 135 | 270 | 330 | ps   |
| HSTL-18 Class I                   | 135 | 240 | 240 | ps   |
| HSTL-18 Class II                  | 165 | 240 | 285 | ps   |
| HSTL-15 Class I                   | 220 | 335 | 335 | ps   |
| HSTL-15 Class II                  | 190 | 210 | 375 | ps   |
| Differential SSTL-2 Class I       | 125 | 210 | 245 | ps   |
| Differential SSTL-2 Class II      | 195 | 195 | 195 | ps   |
| Differential SSTL-18 Class I      | 130 | 240 | 245 | ps   |
| Differential SSTL-18 Class II     | 132 | 270 | 330 | ps   |
| Differential HSTL-18 Class I      | 135 | 240 | 240 | ps   |
| Differential HSTL-18 Class II     | 165 | 240 | 285 | ps   |
| Differential HSTL-15 Class I      | 220 | 335 | 335 | ps   |
| Differential HSTL-15 Class II     | 190 | 210 | 375 | ps   |
| LVDS                              | 110 | 120 | 125 | ps   |
| Simple RSDS                       | 125 | 125 | 275 | ps   |
| Mini-LVDS                         | 110 | 120 | 125 | ps   |

**Notes to Table 5–58:**

- (1) The DCD specification is characterized using the maximum drive strength available for each I/O standard.
- (2) Numbers are applicable for commercial, industrial, and automotive devices.

## Referenced Documents

This chapter references the following documents:

- *Cyclone II Architecture* chapter in *Cyclone II Device Handbook*
- *High-Speed Differential Interfaces in Cyclone II Devices* chapter of the *Cyclone II Device Handbook*
- *IEEE 1149.1 (JTAG) Boundary-Scan Testing for Cyclone II Devices* chapter in the *Cyclone II Handbook*
- *Operating Requirements for Altera Devices Data Sheet*
- *PowerPlay Early Power Estimator User Guide*
- *PowerPlay Power Analysis* chapters in volume 3 of the *Quartus II Handbook*

## Document Revision History

Table 5–59 shows the revision history for this document.

| <i>Table 5–59. Document Revision History</i> |                                                                                                                                                                                                                                                                                                                                                     |                                                                    |
|----------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------|
| Date and Document Version                    | Changes Made                                                                                                                                                                                                                                                                                                                                        | Summary of Changes                                                 |
| February 2008<br>v4.0                        | <ul style="list-style-type: none"> <li>● Updated the following tables with I/O timing numbers for automotive-grade devices:<br/>Tables 5–2, 5–12, 5–13, 5–15, 5–16, 5–17, 5–18, 5–19, 5–21, 5–22, 5–23, 5–25, 5–26, 5–27, 5–28, 5–36, 5–37, 5–40, 5–41, 5–42, 5–43, 5–55, 5–56, 5–57, and 5–58.</li> <li>● Added “Referenced Documents”.</li> </ul> | Added I/O timing numbers for automotive-grade devices.             |
| April 2007<br>v3.2                           | <ul style="list-style-type: none"> <li>● Updated Table 5–3.</li> </ul>                                                                                                                                                                                                                                                                              | Updated R <sub>CONF</sub> typical and maximum values in Table 5–3. |

|                       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |   |
|-----------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|
| February 2007<br>v3.1 | <ul style="list-style-type: none"> <li>• Added document revision history.</li> <li>• Added <math>V_{CCA}</math> minimum and maximum limitations in <a href="#">Table 5–1</a>.</li> <li>• Updated <a href="#">Note (1)</a> in <a href="#">Table 5–2</a>.</li> <li>• Updated the maximum <math>V_{CC}</math> rise time for Cyclone II “A” devices in <a href="#">Table 5–2</a>.</li> <li>• Updated <math>R_{CONF}</math> information in <a href="#">Table 5–3</a>.</li> <li>• Changed <math>V_I</math> to <math>I_I</math> in <a href="#">Table 5–3</a>.</li> <li>• Updated LVPECL clock inputs in <a href="#">Note (6)</a> to <a href="#">Table 5–8</a>.</li> <li>• Updated <a href="#">Note (1)</a> to <a href="#">Table 5–12</a>.</li> <li>• Updated <math>C_{VREF}</math> capacitance description in <a href="#">Table 5–13</a>.</li> <li>• Updated “Timing Specifications” section.</li> <li>• Updated <a href="#">Table 5–45</a>.</li> <li>• Added <a href="#">Table 5–46</a> with information on toggle rate derating factors.</li> <li>• Corrected calculation of the period based on a 640 Mbps data rate as 1562.5 ps in <a href="#">Note (2)</a> to <a href="#">Table 5–50</a>.</li> <li>• Updated “PLL Timing Specifications” section.</li> <li>• Updated <math>V_{CO}</math> range of 300–500 MHz in <a href="#">Note (3)</a> to <a href="#">Table 5–54</a>.</li> <li>• Updated chapter with extended temperature information.</li> </ul> | — |
| December 2005<br>v2.2 | Updated PLL Timing Specifications                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | — |
| November 2005<br>v2.1 | Updated technical content throughout.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | — |
| July 2005<br>v2.0     | Updated technical content throughout.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | — |
| November 2004<br>v1.1 | Updated the “Differential I/O Standards” section.<br>Updated <a href="#">Table 5–54</a> .                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | — |
| June 2004<br>v1.0     | Added document to the Cyclone II Device Handbook.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | — |



### Software

Cyclone® II devices are supported by the Altera® Quartus® II design software, which provides a comprehensive environment for system-on-a-programmable-chip (SOPC) design. The Quartus II software includes HDL and schematic design entry, compilation and logic synthesis, full simulation and advanced timing analysis, SignalTap® II logic analyzer, and device configuration. See the *Quartus II Handbook* for more information on the Quartus II software features.

The free Quartus II Web Edition software, available at [www.Altera.com](http://www.Altera.com), supports Microsoft Windows XP and Windows 2000. The full version of Quartus II software is available through the Altera subscription program. The full version of Quartus II software supports all Altera devices, is available for Windows XP, Windows 2000, Sun Solaris, and Red Hat Linux operating systems, and includes a free suite of popular IP MegaCore® functions for DSP applications and interfacing to external memory devices. Quartus II software and Quartus II Web Edition software support seamless integration with your favorite third party EDA tools.

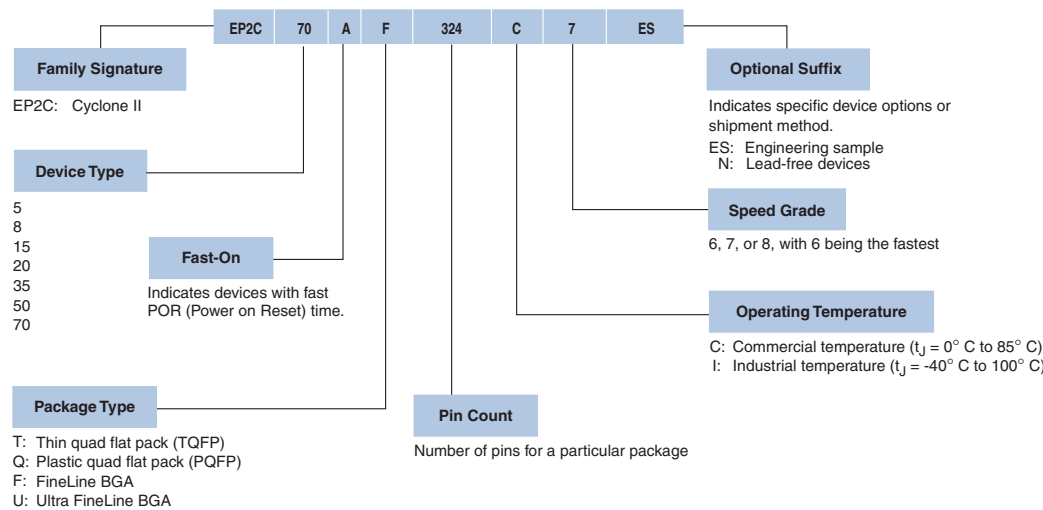
### Device Pin-Outs

Device pin-outs for Cyclone II devices are available on the Altera web site ([www.altera.com](http://www.altera.com)). For more information contact Altera Applications.

### Ordering Information

[Figure 6-1](#) describes the ordering codes for Cyclone II devices. For more information on a specific package, contact Altera Applications.

Figure 6–1. Cyclone II Device Packaging Ordering Information



**Document Revision History** Table 6–1 shows the revision history for this document.

| Table 6–1. Document Revision History |                                                                                                              |                                                                                                                            |
|--------------------------------------|--------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|
| Date & Document Version              | Changes Made                                                                                                 | Summary of Changes                                                                                                         |
| February 2007 v1.5                   | <ul style="list-style-type: none"><li>Added document revision history.</li><li>Updated Figure 6–1.</li></ul> | <ul style="list-style-type: none"><li>Added Ultra FineLine BGA detail in UBGA Package information in Figure 6–1.</li></ul> |
| November 2005 v1.2                   | Updated software introduction.                                                                               |                                                                                                                            |
| November 2004 v1.1                   | Updated Figure 6–1.                                                                                          |                                                                                                                            |
| June 2004 v1.0                       | Added document to the Cyclone II Device Handbook.                                                            |                                                                                                                            |





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